ADSP-21065L SHARC® DSP User's Manual

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PREFACE

Congratulations on your purchase of Analog Devices ADSP-21065L SHARC[®] DSP, the high-performance Digital Signal Processor of choice!

The ADSP-21065L is a 32-bit DSP with 544K bits of on-chip memory that is designed to support a wide variety of applications—audio, automotive, communications, industrial, and instrumentation.

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What's This Book About and Who's It For?

The ADSP-21065L documentation set contains two manuals, the *ADSP-21065L SHARC DSP User's Manual* and the *ADSP-21065L SHARC DSP Technical Reference*. These manuals are reference guides for hardware and software engineers who want to develop applications using the ADSP-21065L. These manuals assume the user has a working knowledge of the ADSP-21065L's Super Harvard Architecture.

The ADSP-21065L SHARC DSP User's Manual describes the architecture and operation of the ADSP-21065L's individual components, intercomponent connections and access, off-chip connections and access, and the processor's hardware/software interface. This information includes:

- Pin definitions and instructions for connecting the pins to external devices and peripherals in single- and multiprocessor systems.
- Processor features and instructions for configuring the processor for specific operation options.

- Internal and external data paths and instructions for moving data between internal components and between the processor and external devices and peripherals.
- Timing, sequencing, and throughput of control signals and data accesses.

The *ADSP-21065L SHARC DSP Technical Reference* provides detailed technical information on programming the ADSP-21065L. This information includes:

- A description of each instruction in the processor's instruction set, supported numeric formats, and the default bit definitions for all of the processor's control and status registers.
- A description of the pins and the control and data registers of the JTAG test access port.
- A list of all vector interrupts and their addresses.

To supplement the information in these manuals, users can attend scheduled workshops sponsored by Analog Devices, Inc. (ADI) and access other ADI documentation related specifically to this product. For details, see "Related Documents" on page xxiv.

How to Use This Manual

For information on	See
ALU operation	Chapter 2, Computation Units; Appendix B, Compute Operation Reference
Address generation	Chapter 4, Data Addressing; Chapter 5, Mem- ory; Chapter 6, DMA
Booting	Chapter 5, Memory; Chapter 7, System Design
Clock generation	Chapter 9, Serial Ports; Chapter 11, Pro- grammable Timers and I/O Ports; Chapter 12, System Design
Computation units	Chapter 2, Computation Units; Appendix B, Compute Operation Reference; Appendix C, Numeric Formats
Data delays, latencies, throughput	Chapter 10, SDRAM Interface; Chapter 12, System Design
Data packing	Chapter 6, DMA; Chapter 8, Host Interface; Chapter 9, Serial Ports
DMA	Chapter 6, DMA; Chapter 7, Multiprocessing; Chapter 8, Host Interface
External port	Chapter 6, DMA; Chapter 7, Multiprocessing; Chapter 8, Host Interface
High-frequency design issues	Chapter 12, System Design
Host interface	Chapter 8, Host Interface
Instruction cache	Chapter 3, Program Sequencing; Chapter 5, Memory

For information on	See
Instruction set	Appendix A, Instruction Set Reference; Appendix B, Compute Operation Reference; Appendix C, Numeric Formats
Internal buses	Chapter 5, Memory; Chapter 6, DMA; Chapter 8, Host Interface
Interrupts	Chapter 3, Program Sequencing; Chapter 5, Memory; Appendix F, Interrupt Vector Addresses
JTAG test port	Chapter 12, System Design; Appendix D, JTAG Test Access Port
Memory	Chapter 5, Memory
Multiplier operation	Chapter2, Computation Units; Appendix B, Compute Operation Reference
Multiprocessing	Chapter 7, Multiprocessing
Pin definitions	Chapter 12, System Design
Processor architecture	Chapter 1, Introduction
Processor configuration	Appendix E, Control and Status Registers
Program flow	Chapter 3, Program Sequencing
Programmable I/O ports	Chapter 11, Programmable Timers and I/O Ports
Programmable timers	Chapter 11, Programmable Timers and I/O Ports
Programming considerations	Chapter 13, Programming Considerations

For information on	See
Reset	Chapter 7, Multiprocessing; Chapter 9, Serial Ports; Chapter 12, System Design
SDRAM interface	Chapter 10 SDRAM Interface
Serial ports	Chapter 9, Serial Ports
Shifter operation	Chapter 2, Computation Units; Appendix B, Compute Operation Reference
System Design	Chapter 12, System Design
Wait states	Chapter 5, Memory; Chapter 12, System Design; Appendix E, Control and Status Reg- isters
Indexes	Both manuals are cross-indexed. Pages with an alphabetic prefix (as C-12) reference information in <i>ADSP-21065L SHARC DSP Techni-</i> <i>cal Reference</i> . Pages with a numeric prefix (as 5-41) reference information in <i>ADSP-21065L SHARC DSP User's Manual</i> .

Related Documents

For information on related products, see the following documents available from Analog Devices, Inc.:

- ADSP-21065L SHARC DSP, 198 MFLOPS, 3.3v Data Sheet (Rev. C, 6/03)
- VisualDSP++ Quick Installation Reference Card
- VisualDSP++ 3.0 User's Guide for SHARC DSPs
- VisualDSP++ 3.0 Getting Started Guide for SHARC DSPs

- VisualDSP++ 3.0 C/C++ Compiler and Library Manual for SHARC DSPs
- VisualDSP++ 3.0 Linker and Utilities Manual for SHARC DSPs
- VisualDSP++ 3.0 Assembler and Preprocessor Manual for SHARC DSPs
- VisualDSP++ 3.0 Kernel (VDK) User's Guide
- VisualDSP++ 3.0 Component Software Engineering User's Guide

Conventions of Notation

The following conventions apply to all chapters within this manual. Additional conventions that apply to specific chapters only are documented at the beginning of the chapter in which they appear.

This notation	Denotes
Letter Gothic font	Code, software or command line options or key- words; input you must enter from the keyboard.
Italics	Special terminology; titles of books.
æ	A hint or tip.
Carlos Ca	A warning or caution.

Conventions of Notation

1 INTRODUCTION

The ADSP-21065L SHARC DSP is a high-performance, 32-bit digital signal processor for communications, digital audio, and industrial instrumentation applications.

Along with a high-performance, 198 MFLOPS core, the ADSP-21065L has a dual-ported, on-chip SRAM and integrated I/O peripherals supported by a dedicated I/O processor. With its on-chip instruction cache, the processor can execute every instruction in a single cycle. The ADSP-21065L is code-compatible with other members of the SHARC family.

Four independent buses for dual data, instructions, and I/O, and crossbar-switch memory connections implement the ADSP-21065L's Super Harvard Architecture.

The ADSP-21065L provides these features:

- 32-Bit IEEE floating-point computation units—Multiplier, ALU, and Shifter—that support 198 MFLOPS or 198, 32-bit fixed-point MOPS
- Data Register File
- Data Address Generators (DAG1, DAG2)
- Program Sequencer with Instruction Cache
- 544K bits of user-configurable, dual-ported SRAM
- External port for glueless interface to SDRAM and other off-chip memory and peripherals

- Host port and multiprocessor interface
- DMA controller to support ten DMA channels
- Serial ports with two receivers and two transmitters that support TDM and $\mathrm{I}^2\mathrm{S}$
- Two programmable timers and twelve programmable, general-purpose I/O ports
- JTAG test access port

Figure 1-1 shows the ADSP-21065L's Super Harvard Architecture, which consists of a crossbar bus switch connecting the DSP core's numeric processor to an independent I/O processor, dual-ported memory, and parallel system bus port.



Figure 1-1. Super Harvard Architecture



Figure 1-2, a detailed block diagram of the processor, shows its architectural features.

Figure 1-2. ADSP-21065L block diagram

Figure 1-2 also shows the ADSP-21065L's on-chip buses: the PM (Program Memory) bus, made up of the PMA (Program Memory Address) and PMD (Program Memory Data) buses; the DM (Data Memory) bus, made up of the DMA (Data Memory Address) and DMD (Data Memory Data) buses; and the I/O bus, made up of the IOA (I/O Address) and IOD (I/O Data) buses.

The PM bus can access either instructions or data. During a single cycle, the processor can access two data operands, one over the PM bus and one over the DM bus, access an instruction from the cache, and perform a DMA transfer.

The ADSP-21065L's external port provides the processor's interface to external memory, which is glueless to an SDRAM; memory-mapped I/O; a host processor; and another multiprocessing ADSP-21065L. The external port performs internal and external bus arbitration and supplies control signals to shared, global memory and I/O devices.

The documentation set, *ADSP-21065L SHARC DSP User's Manual* and *ADSP-21065L SHARC DSP Technical Reference*, contain ADSP-21065L architectural information and the processor's instruction set, which developers need to design and program ADSP-21065L-based systems. For timing, electrical, and package specifications, see the processor's data sheet.

Features and Benefits

The ADSP-21065L possesses the five central requirements for DSPs established in the ADSP-2106x SHARC DSP family of 32-bit floating-point DSPs:

- Fast, flexible arithmetic computation units
- Unconstrained data flow to and from the computation units
- Extended precision and dynamic range in the computation units
- Dual address generators
- Efficient program sequencing

Fast, Flexible Arithmetic. The ADSP-21065L executes all instructions in a single cycle. It provides fast cycle times, and, in addition to traditional multiplication, addition, subtraction, and combined multiplication/addition, it also provides a complete set of arithmetic operations, including Seed 1/X, Seed $1\sqrt{X}$, Min, Max, Clip, Shift, and Rotate. The ADSP-21065L is IEEE floating-point compatible and supports either interrupt-on-arithmetic or latched-status exception handling.

Unconstrained Data Flow. The ADSP-21065L has an enhanced Super Harvard architecture combined with a 10-port data register file. In every cycle, the processor can:

- Read or write two operands to or from the Register File,
- Supply two operands to the ALU,
- Supply two operands to the multiplier, and
- Receive two results from the ALU and multiplier.

The processor's 48-bit orthogonal instruction word supports fully parallel data transfer and arithmetic operations in the same instruction.

Features and Benefits

40-Bit Extended Precision. The ADSP-21065L handles 32-bit IEEE floating-point format, 32-bit integer and fractional formats (twos-complement and unsigned), and extended-precision, 40-bit IEEE floating-point format. The processor carries extended precision throughout its computation units, limiting intermediate data truncation errors. When working with data on-chip, the processor can transfer the extended-precision, 32-bit mantissa to and from all computation units. The fixed-point formats have an 80-bit accumulator for true 32-bit fixed-point computations.

Dual Address Generators. The ADSP-21065L has two data address generators (DAGs) that provide immediate or indirect (pre and postmodify) addressing. It supports modulus and bit-reverse operations with no constraints on data buffer placement.

Efficient Program Sequencing. In addition to zero-overhead loops, the ADSP-21065L supports single-cycle setup and exit for loops. Loops are both nestable (six levels in hardware) and interruptible. The processors support both delayed and non-delayed branches.

System-Level Enhancements

The ADSP-21065L includes several enhancements that simplify system development. The enhancements occur in three key areas:

- Architectural features supporting high-level languages and operating systems
- IEEE 1149.1 JTAG serial scan path and on-chip emulation features
- Support of IEEE floating-point formats

High-Level Languages. The ADSP-21065L's architecture has several features that directly support high-level language compilers and operating systems:

- General purpose data and address register files
- 32-bit native data types
- Large address space
- Pre- and postmodify addressing
- Unconstrained circular data buffer placement
- On-chip program, loop, and interrupt stacks

Additionally, the ADSP-21065L architecture is designed specifically to support ANSI-standard Numerical C extensions—the first compiled language to support vector data types and operators for numeric and signal processing.

Serial Scan and Emulation Features. The ADSP-21065L supports the IEEE standard P1149.1 Joint Test Action Group (JTAG) standard for system test. This standard defines a method for serially scanning the I/O status of each component in a system. The ADSP-21065L EZ-ICE[®] in-circuit emulator also uses the JTAG serial port to access the processor's on-chip emulation features.

IEEE Formats. The ADSP-21065L supports IEEE floating-point data formats. This means that algorithms developed on IEEE-compatible processors and workstations are portable across processors without concern for possible instability introduced by biased rounding or inconsistent error handling.

Why Floating-Point DSP?

A digital signal processor's data format determines its ability to handle signals of differing precision, dynamic range, and signal-to-noise ratios. However, ease-of-use and time-to-market considerations are often equally important.

Precision. The number of bits of precision of A/D converters has continued to increase, and the trend is for both precision and sampling rates to increase.

Dynamic Range. Compression and decompression algorithms have traditionally operated on signals of known bandwidth. These algorithms were developed to behave regularly, to keep costs down and implementations easy. Increasingly, however, the trend in algorithm development is to unconstrain the regularity and dynamic range of intermediate results. Adaptive filtering and imaging are two applications that require a wide dynamic range.

Signal-to-Noise Ratio. Audio, video, imaging, and speech recognition require wide dynamic range to discern selected signals occurring in noisy environments.

Ease-of-Use. In general, 32-bit, floating-point DSPs are easier to use and enable a quicker time-to-market than 16-bit, fixed-point processors. The extent to which this is true depends on the floating-point processor's architecture. Consistency with IEEE workstation simulations and the elimination of scaling are two clear ease-of-use advantages. High-level language programmability, large address spaces, and wide dynamic range enable system development time to focus on algorithms and signal processing concerns, rather than assembly language coding, code paging, and error handling.

ADSP-21065L Architecture

The rest of this chapter summarizes the architectural features of the ADSP-21065L SHARC DSP:

- DSP core
- Dual-ported memory
- External port interface
- Host processor interface
- I/O Processor
- Serial ports
- DMA controller
- Booting
- Development tools

The remaining chapters of this manual describe these features in detail.

DSP Core

The ADSP-21065L's DSP core consists of:

- Three computation units
- A data Register File
- A Program Sequencer and two Data Address Generators
- An Instruction Cache
- DSP core buses

- Two programmable timers and 12 general-purpose I/Os
- Four external hardware interrupts

These additional features support and enhance the DSP core's components:

- Context switching
- Comprehensive instruction set

Computation Units

The DSP core contains three independent computation units:

• ALU

Performs a standard set of arithmetic and logic operations in both fixed-point and floating-point formats.

• Multiplier with a fixed-point accumulator

Performs floating-point and fixed-point multiplication, and fixed-point multiply/add and multiply/subtract operations.

• Shifter

Performs logical and arithmetic shifts, bit manipulation, field deposit and extraction, and exponent derivation operations on 32-bit operands.

For meeting a wide variety of processing needs, the computation units process data in three formats:

- 32-bit, fixed-point
- 32-bit, floating-point
- 40-bit, floating-point
The floating-point operations are single-precision, IEEE-compatible. The 32-bit floating-point format is the standard IEEE format, while the 40-bit IEEE extended-precision format has eight additional LSBs of mantissa for greater accuracy.

The computation units perform single-cycle operations—there is no computation pipeline. The units connect in parallel rather than serially. On the next cycle, the output of any unit can be the input of any other unit. In a multifunction computation, the ALU and multiplier perform independent, simultaneous operations.

Register File

Applications use a general-purpose data Register File to transfer data between the computation units and the data buses and to store intermediate results.

For fast context switching, the Register File has two sets (primary and alternate) of 16 registers. All of the registers are 40-bits wide. The Register File, combined with the core's Super Harvard Architecture, enables unconstrained data flow between the computation units and internal memory.

Program Sequencer and Data Address Generators

A Program Sequencer and two dedicated address generators supply addresses for memory accesses. Together the Program Sequencer and Data Address Generators (DAGs) enable computational operations to execute with maximum efficiency since they free up the computation units to process data exclusively.

Using its instruction cache, the ADSP-21065L can simultaneously fetch an instruction (from the cache) and access two data operands (from memory).

The Data Address Generators implement circular data buffers in hardware.

The Program Sequencer supplies instruction addresses to program memory. It controls loop iterations and evaluates conditional instructions. Using an internal loop counter and loop stack, the processor executes looped code with zero overhead. To loop or to decrement and test the counter requires no explicit jump instructions.

The processor uses pipelined *fetch*, *decode*, and *execute* cycles to achieve its fast execution rate. If an application uses external memories, the processor provides more time to complete an access than accesses requiring no decode cycle.

The DAGs generate memory addresses when data is transferred between memory and registers. Dual data address generators enable the processor to output simultaneous addresses for two operand reads or writes.

DAG1 supplies 32-bit addresses to data memory. DAG2 supplies 24-bit addresses to program memory for program memory data accesses.

Each DAG keeps track of up to eight address pointers, eight modifiers, and eight length values. You can modify a pointer used for indirect addressing with a value in a specified register, either before (premodify) or after (postmodify) the access. To perform automatic modulo addressing for circular data buffers, you can associate a length value with each pointer. And, you can locate circular buffers at arbitrary boundaries in memory. Each DAG register has an alternate register that you can activate for fast context switching.

Circular buffers enable efficient implementation of delay lines and other data structures required in digital signal processing and commonly used in digital filters and Fourier transforms. The DAG's automatic handling of address pointer wraparound reduces overhead, increases performance, and simplifies implementation.

Instruction Cache

The Program Sequencer includes a 32-word instruction cache that enables three-bus operation for fetching an instruction and two data values. The cache is selective—only instructions whose fetches conflict with program memory data accesses are cached. This feature enables full-speed execution of core looped operations, such as digital filter, multiply-accumulates, and FFT butterfly processing.

DSP Core Buses

The DSP core has four buses:

Program Memory Address

Transfers the addresses for instructions.

• Data Memory Address

Transfers the addresses for data.

• Program Memory Data

Transfers instructions.

Since the PM Data bus is 48 bits wide, it can accommodate the 48-bit instruction width. Fixed-point and single-precision floating-point data is aligned to the upper 32 bits of this bus.

• Data Memory Data

Transfers data.

The DM Data bus is 40 bits wide and provides a path to transfer the contents of any register in the processor to any other register or to any data memory location in a single cycle. Fixed-point and single-precision floating-point data is aligned to the upper 32 bits of this bus.

On the ADSP-21065L, data memory stores data operands, and program memory stores both instructions and data (filter coefficients, for example). This configuration enables the processor to perform dual data fetches when the instruction cache supplies the instruction.

The data memory address comes from one of two sources—an absolute value specified in the instruction code (direct addressing) or the output of a data address generator (indirect addressing).

Nearly every register in the ADSP-21065L's core is classified as a universal register. Instructions are provided specifically for transferring data between universal registers or between a universal register and memory and for performing bitwise operations on their contents. Control registers, status registers, and individual data registers in the Register File are all universal registers.

The PX (bus connect) registers provide the path to pass data between the 48-bit PM Data bus and the 40-bit DM Data bus or between the 40-bit Register File and the PM Data bus. The hardware that implements these registers handles the 8-bit difference in width.

Programmable Timers and General-Purpose I/O Ports

The ADSP-21065L provides two independent programmable timer blocks. Each block can function in one of two modes—Timer Counter mode or Pulse Count and Capture mode.

In Timer Counter mode, the processor can generate a waveform with an arbitrary pulse width within a maximum period of 71.5 seconds. In Pulse Count and Capture mode, the processor can measure either the high or the low pulse width and period of an input waveform.

The ADSP-21065L provides twelve programmable, general-purpose I/O pins that can function as either input or output. As output, these pins can signal peripheral devices; as input, they can provide the test for conditional branching.

Interrupts

The ADSP-21065L has four external hardware interrupts: three general-purpose interrupts \overline{IRQ}_{2-0} , and a special interrupt for reset. The processor also has internally generated interrupts for the timer, DMA controller operations, circular buffer overflow, stack overflows, arithmetic exceptions, multiprocessor vector interrupts, and user-defined software interrupts.

For the general-purpose external interrupts and the internal timer interrupt, the ADSP-21065L automatically stacks the arithmetic status and mode (MODE1) registers in parallel with the interrupt servicing. This enables four nesting levels of very fast service for these interrupts.

Context Switching

Many of the processor's registers have alternate registers that applications can activate and use during interrupt servicing to implement a fast context switch.

Each of the data registers in the Register File, the DAG registers, and the multiplier result register have alternates. Registers active at reset are called *primary* registers, and the others are called *alternate* (or *secondary*) registers. Control bits in a mode control register determine which set of registers is active at any particular time.

Comprehensive Instruction Set

The ADSP-21065L instruction set provides a wide variety of programming capabilities. Multifunction instructions enable computations in parallel with data transfers and as simultaneous multiplier and ALU operations.

The addressing power of the ADSP-21065L provides flexibility in moving data both internally and externally. Every instruction can be executed in a single processor cycle. The ADSP-2106x SHARC DSP family assembly

language uses an algebraic syntax for ease of coding and readability. A comprehensive set of development tools supports program development.

Dual-Ported Memory

The ADSP-21065L contains 544K bits of on-chip SRAM, organized into two banks: Bank 0 has 288K bits, and Bank 1 has 256K bits. Bank 0 is configured with nine columns of 2Kx16 bits, and Bank 1 is configured with eight columns of 2Kx16 bits. Each memory block is dual-ported for single-cycle, independent accesses by the processor's core and either its I/O processor or DMA controller. The dual-ported memory and separate on-chip buses allow two data transfers from the core and one from I/O, all in a single cycle.

On the ADSP-21065L, the memory can be configured as a maximum of 16K words of 32-bit data, 34K words for 16-bit data, 10K words of 48-bit instructions (and 40-bit data) or combinations of different word sizes up to 544K bits. All the memory can be accessed as 16 bit, 32 bit, or 48 bit.

The ADSP-21065L supports a 16-bit floating-point storage format, which effectively doubles the amount of data that it can store on-chip. Conversion between the 32-bit floating-point and 16-bit floating-point formats is done in a single instruction.

While each memory block can store combinations of code and data, accesses are most efficient when one block stores data, using the DM bus for transfers, and the other block stores instructions and data, using the PM bus for transfers. Using the DM and PM buses in this way, with one dedicated to each memory block, assures single-cycle execution with two data transfers, providing the instruction is available in the cache. Single-cycle execution is also maintained when one of the data operands is transferred to or from off-chip, through the ADSP-21065L's external port.

External Port Interface

The ADSP-21065L's external port provides the processor's interface to off-chip memory and peripherals. The $64M \times 32$ -bit word, off-chip address space is included in the ADSP-21065L's unified address space. The separate on-chip buses—for PM addresses, PM data, DM addresses, DM data, I/O addresses, and I/O data—are multiplexed at the external port to create an external system bus with a single 24-bit address bus and a single 32-bit data bus.

The ADSP-21065L provides an on-chip SDRAM controller that supports a glueless interface to standard 16Mb and 64Mb SDRAMs.

The on-chip decoding of high-order address lines to generate memory bank select signals facilitates the addressing of external memory devices.

The ADSP-21065L provides programmable memory wait states and external memory acknowledge controls to enable the processor to interface with peripherals with variable access, hold, and disable time requirements.

Host Interface

The ADSP-21065L's host interface provides a connection to standard 8-, 16-, or 32-bit microprocessor buses that is easy and requires little additional hardware.

The ADSP-21065L supports asynchronous transfers at speeds up to the processor's full clock rate. The ADSP-21065L's external port provides access to the processor's host interface, which is memory mapped into the processor's unified address space.

Two channels of DMA are available for the host interface, and they perform code and data transfers with low software overhead. The host can directly read and write the IOP registers of the ADSP-21065L and can access the DMA channel setup and mailbox registers. Vector interrupt support provides efficient execution of host commands.

I/O Processor

The ADSP-21065L's I/O Processor (IOP) includes two serial ports, each with two transmitters and two receivers, and a DMA controller.

Serial Ports

The ADSP-21065L features two synchronous serial ports that provide an inexpensive interface to a wide variety of digital and mixed-signal peripheral devices.

The serial ports can operate at the full clock rate of the processor, providing each with a maximum data rate of 30M bit/s. Each serial port has a primary and a secondary set of Tx and Rx channels, as shown in Figure 1-3.



Figure 1-3. Serial port input/output configuration

Independent transmit and receive functions provide greater flexibility for serial communications. Serial port data can be automatically transferred to and from on-chip memory through DMA. Each of the serial ports supports three operation modes: Standard mode, I²S mode (an interface

commonly used by audio codecs), and TDM (Time Division Multiplex) multichannel mode.

The serial ports can operate with little-endian or big-endian transmission formats, with selectable word lengths of 3 to 32 bits. They offer selectable synchronization and transmit modes and optional μ -law or A-law companding. Serial port clocks and frame syncs can be internally or externally generated. The serial ports also include keyword and keymask features to enhance interprocessor communication.

DMA Controller

The ADSP-21065L's on-chip DMA controller enables zero-overhead data transfers without processor intervention. The DMA controller operates independently and invisibly to the processor's core, enabling DMA operations to occur while the core is simultaneously executing its program. Applications can use DMA transfers to download both code and data to the ADSP-21065L.

DMA transfers can occur between the ADSP-21065L's internal memory and external memory, the processor's serial ports, external peripherals, or a host processor. DMA transfers between external memory and external peripheral devices are another option. During DMA transfers, the DMA controller automatically packs and unpacks external bus words.

Ten channels of DMA are available on the ADSP-21065L—eight via the serial ports and two via the processor's external port (for either host processor or other ADSP-21065L memory or I/O transfers).

Asynchronous off-chip peripherals can control the two external port DMA channels using the DMA request and grant lines (\overline{DMAR}_{1-2} and \overline{DMAG}_{1-2}).

Other DMA features include interrupt generation upon completion of DMA transfers and DMA chaining for automatically linked DMA transfers.

Booting

Applications can boot the internal memory of the ADSP-21065L at system powerup from an 8-bit EPROM, a host processor, or external memory. The BMS (Boot Memory Select) and BSEL (EPROM Boot) pins select the boot source. Either 8-, 16-, or a 32-bit host processor can boot the ADSP-21065L.

Development Tools

The ADSP-21065L is supported with a complete set of software and hard-ware development tools, including the EZ-ICE In-Circuit Emulator and VisualDSP++^M and SHARC tools development software.

The same EZ-ICE hardware that you use for the ADSP-21060/62, also fully emulates the ADSP-21065L, with the exception of displaying and modifying the two new SPORTs registers. The emulator will not display these two registers, but your code can still use them.

Both the SHARC DSP development tools family and the VisualDSP++ integrated project management and debugging environment support the ADSP-21065L. The VisualDSP++ project management environment enables you to develop and debug an application from within a single integrated program.

The SHARC DSP development tools include an easy to use assembler with instructions based on an algebraic syntax, a linker, a loader, a cycle-accurate instruction-level simulator, a C compiler, and a C run-time library that includes DSP and mathematical functions.

Debugging both C and assembly programs with the VisualDSP++ debugger, you can:

- View mixed C and assembly code
- Insert breakpoints

- Set watchpoints
- Trace program execution
- Profile program execution
- Fill and dump memory
- Create custom debugger windows

The VisualDSP++ Integrated Development Environment (IDE) enables you to define and manage multiuser projects. Its dialog boxes and property pages enable you to configure and manage all of the SHARC DSP development tools. This capability enables you to:

- Control how the development tools process inputs and generate outputs.
- Maintain a one-to-one correspondence with the tool's command-line switches.

The EZ-ICE emulator uses the IEEE 1149.1 JTAG test access port of the ADSP-21065L processor to monitor and control the target board processor during emulation. The EZ-ICE provides full-speed emulation to enable inspection and modification of memory, registers, and processor stacks. Use of the processor's JTAG interface assures nonintrusive in-circuit emulation—the emulator does not affect target system loading or timing.

In addition to the software and hardware development tools available from Analog Devices, third parties provide a wide range of tools supporting the SHARC processor family.

Summary of Features

This section summarizes the functional features and benefits of the ADSP-21065L, the design features that balance its DSP core with its I/O components, and lists additional, related ADI literature.

Features and Benefits

Feature	Benefits
32-bit processing	 More precise processing of 16-bit signals.
	 32-bit words essential for pro- cessing 20- and 24-bit input sig- nals.
	 Improved signal-to-noise ratio at low levels.
	 Faster processing due to compact code.
	• Wide dynamic range.
Fixed- and float-	• Greater flexibility.
The point on one chip	 Reduced development time because need to rewrite standard floating- or fixed-point algorithms is elim- inated.
66 MIPS/198 MFLOPS	 More processing implemented with a single chip.
	• Eliminates bus bottlenecks.

Table 1-1. Summary of ADSP-21065L features and benefits

Feature	Benefits					
16K × 32bit (544K bits) of user-configurable	 Reduces bottlenecks over accesses of off-chip memory. 					
	 Reduces overall system cost, size, and power consumption. 					
	 Provides freedom in allocating data and program memory. 					
240M bit/sec. I/O • 2 serial Tx and	 Process more audio channels using just one DSP. 					
2 serial Rx serial ports	 Multiple channels supported in communication systems. 					
• I ² S Interface						
10 DMA channels	Implement multifunction applications on one chip.					
TDM serial ports	• Direct interface to T1 and E1 lines.					
	 Ability to communicate with other ADSP-21065Ls. 					
Glueless SDRAM interface	• Maximize synchronous data transfer rate.					
	• Reduce overall system cost.					

Table 1-1. Summary of ADSP-21065L features and benefits (Cont'd)

Summary of Features

Balanced Performance

Figure 1-4 shows how the ADSP-21065L's design optimally balances its high-performance DSP core with its high-speed I/Os.



Figure 1-4. Balanced performance between the DSP core and I/O

Additional Literature

The following publications can be ordered from any Analog Devices sales office.

```
ADSP-21065L SHARC DSP, 198 MFLOPS, 3.3v Data Sheet
(Rev. C, 6/03)
VisualDSP++ 3.0 User's Guide for SHARC DSPs
VisualDSP++ 3.0 Getting Started Guide for SHARC DSPs
VisualDSP++ 3.0 C/C++ Compiler and Library Manual for SHARC DSPs
VisualDSP++ 3.0 Linker and Utilities Manual for SHARC DSPs
VisualDSP++ 3.0 Assembler and Preprocessor Manual for SHARC DSPs
VisualDSP++ 3.0 Kernel (VDK) User's Guide
VisualDSP++ 3.0 Component Software Engineering User's Guide
```

2 COMPUTATION UNITS

The processor's computation units provide the numeric processing power for performing DSP algorithms, performing operations on both fixed-point and floating-point numbers. Each computation unit executes instructions in a single cycle.

The processor contains three computation units:

• An arithmetic/logic unit (ALU)

Performs a standard set of arithmetic and logic operations in both fixed-point and floating-point formats.

• A multiplier

Performs floating-point and fixed-point multiplication as well as fixed-point dual multiply/add or multiply/subtract operations.

• A shifter

Performs logical and arithmetic shifts, bit manipulation, field deposit and extraction operations on 32-bit operands and can derive exponents as well.



Figure 2-1. Computation units block diagram

The computation units are architecturally arranged in parallel, as shown in Figure 2-1. The output from any computation unit can be input to any computation unit on the next cycle.

The computation units store input operands and results locally in a ten-port register file. The Register File is accessible to the processor's program memory data (PMD) bus and its data memory data (DMD) bus. Both of these buses transfer data between the computation units and internal memory, external memory, or other parts of the processor.

This chapter covers these topics:

- Data formats
- Register File data storage and transfers
- ALU architecture and operations

- Multiplier architecture and operations
- Shifter architecture and operations
- Multifunction operations

Data Formats

The processor's computation units operate on a variety of data formats and support two rounding modes:

- IEEE 754/854 standard for single-precision floating-point format
- Extended-precision floating-point format
- Short word (16-bit) floating-point format
- 32-bit fixed-point format
- Round-toward-nearest and round-toward-zero rounding modes

The processor also provides exception handling for floating-point operations.

Single-Precision Floating-Point Format

The processor's Multiplier and ALU units support the single-precision, floating-point format specified in the IEEE 754/854 standard, as described in Appendix C, Numeric Formats. The processor is IEEE 754/854 compatible for single-precision, floating-point operations in all respects, except that:

- The processor does not provide inexact flags.
- NAN (*Not-A-Number*) inputs generate an invalid exception and return a quiet NAN (all 1s).
- The processor flushes denormal operands to 0 when they are input to a computation unit and do not generate an underflow exception.

It flushes to 0 any denormal or underflow result from an arithmetic operation and generates an underflow exception.

• The processor supports round-to-nearest and round-toward-zero modes, but does not support rounding to +Infinity or to -Infinity.

The processor also supports a 40-bit extended precision, floating-point mode, which includes eight additional LSBs of the mantissa and is compliant with the 754/854 standards. However, results in this format are more precise than the IEEE single-precision standard specifies.

Extended-Precision FLoating-Point

Floating-point data can be either 32- or 40-bits wide. The RND32 bit in the MODE1 register determines the width:

- RND32=0 Selects extended precision, floating-point format (eight bits of exponent and thirty-two bits of mantissa).
- RND32=1 Selects normal IEEE precision (eight bits of exponent and twenty-four bits of mantissa).

The computation unit sets the eight LSBs of floating-point inputs to 0s before performing the operation.

It rounds the mantissa of a result to twenty-three bits (not including the hidden bit) and sets the eight LSBs of the 40-bit result to 0s to form a 32-bit number that is equivalent to the IEEE standard result.

Short Word Floating-Point Format

The processor supports a 16-bit, floating-point data type and provides conversion instructions for it. The short float data format has an 11-bit mantissa with a 4-bit exponent and a sign bit. The 16-bit floating-point numbers reside in the lower sixteen bits of the 32-bit floating-point field.

Two shifter instructions, FPACK and FUNPACK, perform the packing and unpacking conversions between 32-bit and 16-bit floating-point

Data Formats

words. FPACK converts a 32-bit IEEE floating-point number to a 16-bit floating-point number. FUNPACK converts the 16-bit floating-point numbers back to 32-bit IEEE floating-point. Both instructions execute in a single cycle.

The short float type supports gradual underflow. This type sacrifices precision for dynamic range. When packing a number that would have underflowed, the Shifter sets the exponent to 0 and right-shifts the mantissa (including the hidden 1) the appropriate amount. The packed result is a denormal, which applications can unpack into a normal IEEE floating-point number.

Exception Handling for FLoating-Point Operations

Both the Multiplier and ALU provide exception information when executing floating-point operations. Each unit updates overflow, underflow, and invalid operation flags in the arithmetic status (ASTAT) register and in the sticky status (STKY) register. An underflow, overflow, or invalid operation from any computation unit also generates a maskable interrupt. So, applications have three ways to handle floating-point exceptions:

• Interrupts

When your application must correct all exceptions as they occur, use an interrupt service routine to handle the exception condition immediately.

• ASTAT register

When your application needs to monitor a particular floating-point operation, test the exception flags in the ASTAT register that pertain to a particular arithmetic operation after the processor has performed the operation. • STKY register

When exception handling is noncritical, examine the exception flags in the STKY register at the end of a series of operations. If any flags are set, some of the results are incorrect.

Fixed-Point Format

The processor always represents fixed-point numbers in 32-bit, left-justified (occupy the thirty-two MSBs) format in its 40-bit data fields. You can treat these numbers as fractions or integers and as unsigned or twos-complement.

Each computation unit has its own restrictions on how you can mix these formats in a given operation.

The computation units read 32-bit operands from 40-bit registers, ignoring the eight LSBs, and write 32-bit results, zero-filling the eight LSBs.

Rounding Modes

The processor supports two modes of rounding. Both modes follow the IEEE 754 standard definitions.

• Round-Toward-Zero

If the processor cannot represent exactly the result before rounding in the destination format, it rounds the result to the number that is nearer to 0.

This method is equivalent to truncation.

Data Formats

• Round-Toward-Nearest

If the processor cannot represent exactly the result before rounding in the destination format, it rounds the result to the number that is nearer to the result before rounding.

If the result before rounding is exactly halfway between two numbers in the destination format (differing by an LSB), the processor rounds the result to the number that has an LSB equal to 0.

Statistically, rounding up occurs as often as rounding down, so this method has no large sample bias.

Because the maximum floating-point value is one LSB less than the value that represents Infinity, in this mode, a result that is halfway between the maximum floating-point value and Infinity rounds to Infinity.

Register File

The Register File provides the interface between the processor's internal data buses and its computation units. It also provides local storage for operands and results.

The Register File has these structural and functional characteristics:

- Consists of sixteen primary registers and sixteen alternate (secondary) registers.
- All of the individual data registers are forty bits wide.
- 32-bit data from the computation units is always left-justified.
- On register reads, the processor ignores the eight LSBs, and on register writes, it writes the eight LSBs with zeros (0).

Accesses of the Register File have these characteristics:

- Program memory data accesses and data memory accesses occur on the PM Data bus and DM Data bus, respectively.
- One PM Data bus and/or one DM Data bus access can occur in one cycle.
- Transfers between the Register File and the 40-bit DM Data bus are always forty bits wide.
- The Register File transfers data to and from the 48-bit PM Data bus in the most significant forty bits, writing zeros (0) in the lower eight bits on transfers to the PM Data bus.

• If the same location in the Register File is specified as both the source of an operand and the destination of a result or memory fetch, the read occurs in the first half of the cycle, and the write occurs in the second half.

This enables the processor to use the old data as the operand before it updates the location with the resulting new data.

• If writes to the same location take place in the same cycle, only the write with higher precedence actually occurs. The source of the write data determines the precedence.

In order of precedence, the sources for write data are:

- Data memory or universal register
- Program memory
- ALU
- Multiplier
- Shifter

Individual Data Registers

In assembly language source code, the individual registers of the Register File carry a prefix. An F indicates floating-point computations, and an R indicates fixed-point computations.

The following instructions, for example, use the same registers:

F0=F1 * F2; floating-point multiply

R0=R1 * R2; fixed-point multiply

The F and R prefixes do not affect the 32-bit (or 40-bit) data transfer; they determine how the ALU, Multiplier, or Shifter treat the data only. You

can use either uppercase or lowercase letters for these prefixes since the assembler is case-insensitive.

Alternate Registers

To implement fast context switching, the Register File has an a set of alternate registers. Each half of the Register File—the lower half, R0 through R7, and the upper half, R8 through R15—can independently activate its alternate register set.

Two bits in the MODE1 register select the active sets. To share data between contexts, you place the data to share in one half of the Register File and activate the alternate register set of the other half.

Bit	Name	Definition
7	SRRFH	Register file alternate select for R15-R8 (F15-F8)
10	SRRFL	Register file alternate select for R7-R0 (F7-F0)

Table 2-1. MODE1 bits that select the active register sets

Note that one cycle of effect latency occurs from the time the instruction sets the bit in MODE1 to when the alternate registers are accessible.

For example,

```
BIT SET MODE1 SRRFL;/* activate alternate registers */
NOP; /* wait until alternate registers
activate */
RO=7;
```

Arithmetic Logic Unit (ALU)

The ALU performs arithmetic operations on fixed-point and floating-point data and logical operations on fixed-point data.

ALU fixed-point instructions operate on 32-bit, fixed-point operands and output 32-bit, fixed-point results.

ALU floating-point instructions operate on 32- or 40-bit, floating-point operands and output 32- or 40-bit, floating-point results.

ALU instructions include:

- Floating-point: addition, subtraction, dual addition/subtraction, average.
- Fixed-point: addition, subtraction, dual addition/subtraction, average.
- Floating-point manipulation: binary log, scale, mantissa.
- Fixed-point: add with carry, subtract with borrow, increment, decrement.
- Logical AND, OR, XOR, NOT.
- Functions: absolute value, pass, min, max, clip, compare.
- Format conversion.
- Reciprocal and reciprocal square root primitives.

For details on dual add/subtract and parallel ALU and multiplier operation, see "Multifunction Operations" on page 2-50.

ALU Operations

ALU operations take one or two input operands, the X input and the Y input. These operands can be any data register in the Register File.

ALU operations usually return one result. The exceptions are:

• Dual add/subtract operations

These operations return two results.

• Compare operations

These operations return no result. They only update flags.

You can return ALU results to any location in the Register File.

The processor transfers input operands from the Register File during the first half of the cycle. It transfers results to the Register File during the second half of the cycle. This scheme enables the ALU to read and write the same location in the Register File in a single cycle.

For fixed-point operations, the processor treats both X and Y inputs as 32-bit, fixed-point operands and transfers the upper thirty-two bits from the source location in the Register File.

The results of fixed-point operations are always 32-bit, fixed-point values. Some floating-point operations (LOGB, MANT and FIX) can also yield fixed-point results. The processor transfers fixed-point results to the upper thirty-two bits of a location in the Register File and clears the lower eight bits of the location.

The format of fixed-point operands and results depends on the operation. Most arithmetic operations do not need to distinguish between integer and fraction formats. The processor treats fixed-point inputs to operations, such as scaling a floating-point value, as integers. For determining status, such as overflow, the processor treats fixed-point arithmetic operands and results as twos-complement numbers.

ALU Operating Modes

Three bits in the MODE1 register affect the ALU:

• Saturation bit (ALUSAT)

This bit affects ALU operations that yield fixed-point results.

- Rounding mode bit (TRUNC)
- Rounding boundary bit (RND32)

Both rounding bits affect floating-point operations in both the ALU and the Multiplier.

Table 2-2. MODE1 ALU-related bits

Bit	Name	Description									
13	ALUSAT	Saturation mode.									
		<pre>- = Disable ALU saturation</pre>									
		1 = Enable ALU saturation (full scale in fixed-point)									
15	TRUNC	Rounding mode.									
		0 = Round-to-nearest									
		1 = Truncation									
16	RND32	Rounding boundary.									
		0 = Round to 40 bits									
		1 = Round to 32 bits									

Fixed-Point Saturation Mode

In saturation mode, all positive, fixed-point overflows cause the processor to return the maximum positive, fixed-point number (0x7FFF FFFF), and

all negative overflows cause the processor to return the maximum negative number ($0 \times 8000 0000$).

- ALUSAT=0 Fixed-point results that overflow remain unsaturated; that is, the upper thirty-two bits of the result return unaltered.
- ALUSAT=1 Fixed-point results that overflow are saturated; that is, for positive overflows, the processor returns 0x7FFF FFFF, and for negative overflows, it returns 0x8000 0000.

The ALU overflow flag reflects the ALU result before saturation.

Floating-Point Rounding Modes

The ALU supports two IEEE rounding modes. The TRUNC bit in the MODE1 register determines which rounding mode the processor uses for all ALU operations:

- TRUNC=0 Selects the round-to-nearest mode.
- TRUNC=1 Selects the round-to-zero mode.

Floating-Point Rounding Boundary

The results of floating-point ALU operations can be either 32-or 40-bit, floating-point data.

- RND32=0 ALU inputs 40-bit operands unchanged and outputs 40-bit results from floating-point operations. Writes all 40 bits to the specified location in the Register File.
- RND32=1 ALU flushes the eight LSBs of each input operand to 0s before performing the operation (except for the RND operation) and outputs floating-point results in the 32-bit IEEE format. It clears the lower eight bits of the result.

In fixed-point to floating-point conversion, the rounding boundary is always forty bits, even if RND32=1.

ALU Status Flags

The ALU updates seven status flags in the ASTAT register at the end of each operation. Table 2-3 lists and describes these ASTAT status flag bits.

Bit	Name	Description
0	AZ	ALU result zero or floating-point underflow
1	AV	ALU overflow
2	AN	ALU result negative
3	AC	ALU fixed-point carry
4	AS	ALU X input sign (ABS, MANT operations)
5	ΑI	ALU floating-point invalid operation
10	AF	Last ALU operation was a floating-point opera- tion
24-31	CACC	Compare Accumulation register (results of last eight compare operations)

Table 2-3. ASTAT bit definitions for ALU status flags

The states of the seven flags reflect the result of the most recent ALU operation. The ALU updates the compare accumulation (CACC) bits in ASTAT at the end of every compare operation.

The ALU also updates four *sticky* status flags in the STKY register, as shown in Table 2-4. Once set, a sticky flag remains high until explicitly cleared.

Table 2-4. STKY bit definitions for ALU status flags

Bit	Name	Description
0	AUS	ALU floating-point underflow
1	AVS	ALU floating-point overflow
2	AOS	ALU fixed-point overflow
5	AIS	ALU floating-point invalid operation

The ALU updates a flag at the end of the cycle in which the status is generated, and the new value is available on the next cycle.

If an application explicitly writes the ASTAT register or the STKY register in the same cycle that the ALU is performing an operation, the write to ASTAT or STKY supersedes the flag update that the ALU operation generates.

ALU Zero Flag (AZ)

The ALU determines the zero flag for all fixed-point and floating-point ALU operations. It sets AZ whenever the result of an ALU operation is 0; otherwise, the ALU clears this bit.

AZ also signifies floating-point underflow (see "ALU Underflow Flags (AZ, AUS)").

ALU Underflow Flags (AZ, AUS)

The ALU determines underflow for all ALU operations that return a floating-point result and for floating-point to fixed-point conversions. The ALU sets AUS whenever the result of an ALU operation is smaller than the smallest number the processor can represent in the output format.

The ALU sets AZ whenever a floating-point result is smaller than the smallest number the processor can represent in the output format.

ALU Negative Flag (AN)

The ALU determines the negative flag for all ALU operations. The ALU sets AN whenever the result of an ALU operation is negative. Otherwise, the ALU clears this bit.

ALU Overflow Flags (AV, AOS, AVS)

The ALU determines overflow for all fixed-point and floating-point ALU operations. For fixed-point results, the ALU sets AV and AOS whenever the XOR of the two most significant bits is 1. Otherwise, it clears AV.

For floating-point results, the ALU sets AV and AVS whenever the post-rounded result overflows (unbiased exponent > 127). Otherwise, it clears AV.

ALU Fixed-Point Carry Flag (AC)

The ALU determines the carry flag for all fixed-point ALU operations. For fixed-point arithmetic operations, the ALU sets AC if a carry out of the most significant bit of the result occurs. Otherwise, it clears AC.

The ALU clears AC for fixed-point logic, PASS, MIN, MAX, COMP, ABS, and CLIP operations. The ALU reads the AC flag in fixed-point addition with carry operations and in fixed-point subtraction with carry operations.

ALU Sign Flag (AS)

The ALU determines the sign flag for the fixed-point and floating-point ABS operations and the MANT operation only. The ALU sets AS if the input operand is negative. Otherwise, it clears AS.

This functionality differs from that of other ADSP-2100 family processors, which do not update the AS flag on operations other than ABS.

ALU Invalid FLag (AI, AIS)

The ALU determines the invalid flag for all floating-point ALU operations.

The ALU sets AI and AIS whenever:

- An input operand is a NAN.
- The processor attempts to add oppositely signed Infinities.
- The processor attempts to subtract identically signed Infinities.
- Saturation mode is disabled, and a floating-point to fixed-point conversion results in an overflow or operates on an Infinity.

Otherwise, the ALU clears AI.

ALU Floating-Point Flag (AF)

The ALU determines AF for all fixed-point and floating-point ALU operations. The ALU sets AF if the last operation was a floating-point operation. Otherwise, it clears AF.

ALU Compare Accumulation Operations

Bits 31:24 in the ASTAT register store the flag results of up to eight ALU compare operations. These bits form a right-shift register.

When the processor executes an ALU compare operation, it shifts the eight bits toward the LSB (bit 24 is lost). Then it writes the MSB, bit 31, with the result of the compare operation. If the X operand is greater than the Y operand in the compare instruction, the processor sets bit 31. Otherwise, it clears bit 31.

Graphics applications can use the accumulated compare flags to implement two- and three-dimensional clipping operations.

ALU Instruction Set Summary

Instruction	ASTAT Status Flags									STKY Status Flags			
Instruction	A Z	A V	A N	A C	A S	A I	A F	C A C C	A U S	A V S	A O S	A I S	
Fixed-Point													
Rn=Rx+Ry [†]	*	*	*	*	0	0	0	_	_	_	**	_	
Rn=Rx-RY [†]	*	*	*	*	0	0	0	—			**		
Rn=Rx+Ry+CI [†]	*	*	*	*	0	0	0	_	l	l	**	l	
Rn=Rx-Ry+CI-1 [†]	*	*	*	*	0	0	0	_	_	_	**	_	
Rn=(Rx+Ry)/2	*	0	*	*	0	0	0	—				-	
COMP(Rx,Ry)	*	0	*	0	0	0	0	*					
Rn=Rx+CI	*	*	*	*	0	0	0	—	_	_	**	-	
Rn, Rx, Ry = Any 1 fixed-poin	ocat t	cion	int	the	Regi	ster	Fi	le; t	reate	ed as			
<pre>Fn, Fx, Fy = Any location in the Register File; treated as float- ing-point</pre>									ıt-				
<pre>t = ADSP-21xx-compatible instruction</pre>													
<pre>* = Set or cleared depending on results of instruction</pre>													
<pre>** = Can be set, but not cleared, depending on results of instruc- tion</pre>													
- = Not affected													

Table 2-5. Summary of ALU instructions

Arithmetic Logic Unit (ALU)

Instruction	ASTAT Status Flags									STKY Status Flags			
	A Z	A V	A N	A C	A S	A I	A F	C A C C	A U S	A V S	A O S	A I S	
Rn=Rx+CI-1	*	*	*	*	0	0	0	_	_	_	**	_	
Rn=Rx+1	*	*	*	*	0	0	0	_	_	_	**	_	
Rn=Rx-1	*	*	*	*	0	0	0	_	_	_	**	_	
Rn=-Rx [†]	*	*	*	*	0	0	0	_	_	_	**	_	
Rn=ABS Rx [†]	*	*	0	0	*	0	0	_	-	_	**	-	
Rn=PASS Rx	*	0	*	0	0	0	0	-	_	-	_	_	
Rn=Rx AND Ry [†]	*	0	*	0	0	0	0	_	_	_	_	_	
Rn=Rx OR Ry [†]	*	0	*	0	0	0	0	_	_	_	_	_	
Rn=Rx XOR Ry [†]	*	0	*	0	0	0	0	_	_	-	_	_	
Rn, Rx, Ry = Any fixed-poin	locat t	cion	in	the	Regi	ster	r Fi	le; t	reate	ed as			
Fn, Fx, Fy = Any ing-point	locat	cion	in	the	Regi	ster	r Fi	le; t	reate	ed as	floa	at-	
<pre>t = ADSP-21xx-compatible instruction</pre>													
* = Set or cleared depending on results of instruction													
<pre>** = Can be set, but not cleared, depending on results of instruc- tion</pre>									°UC-				
- = Not affected													

Table 2-5. Summary of ALU instructions (Cont'd)
Instruction		AS	ΤΑΤ	Stat	us F	lags	S		ST	KY St Flaç	catus gs	
	A Z	A V	A N	A C	A S	A I	A F	C A C C	A U S	A V S	A O S	A I S
Rn=NOT Rx [†]	*	0	*	0	0	0	0	_	_	_	_	_
Rn=MIN(Rx, Ry)	*	0	*	0	0	0	0	_	_	_	_	_
Rn=MAX(Rx, Ry)	*	0	*	0	0	0	0	_	_	_	_	_
Rn=CLIP Rx BY Ry	*	0	*	0	0	0	0	—	—	—	—	-
Floating-Point												
Fn=Fx+Fy	*	*	*	0	0	*	1	—	**	**	—	**
Fn=Fx-Fy	*	*	*	0	0	*	1	_	**	**	—	**
Fn=ABS(Fx+Fy)	*	*	0	0	0	*	1	_	**	**	_	**
Fn=ABS(Fx-Fy)	*	*	0	0	0	*	1	-	**	**	_	**
Fn=(Fx+Fy)/2	*	0	*	0	0	*	1	—	**	—	—	**
Rn, Rx, Ry = Any fixed-poin	ocat t	cion	in	the	Regi	ster	r Fi	le; t	reate	ed as		
Fn, Fx, Fy = Any T ing-point	ocat	cion	in	the	Regi	ster	r Fi	le; t	reate	ed as	floa	ıt-
t = ADSP-21xx-comp	patik	ole '	inst	ruct	ion							
* = Set or cleared	d dep	bend	ing (on r	esul	ts c	ofi	nstru	ctior	١		
** = Can be set, b tion	out r	not (clea	red,	dep	endi	ing (on re	sults	5 Of	instr	`uc-
<pre>- = Not affected</pre>												

Table 2-5. Summary of ALU instructions (Cont'd)

Arithmetic Logic Unit (ALU)

Instruction	ASTAT Status Flags								STKY Status Flags			
	A Z	A V	A N	A C	A S	A I	A F	C A C C	A U S	A V S	A O S	A I S
COMP(Fx, Fy)	*	0	*	0	0	*	1	*	_	_	_	**
Fn=-Fx	*	*	*	0	0	*	1	_	_	**	_	**
Fn=ABS Fx	*	*	0	0	*	*	1	_	_	**	_	**
Fn=PASS Fx	*	0	*	0	0	*	1	_	_	_	_	**
Fn=RND Fx	*	*	*	0	0	*	1	_	_	**	_	**
Fn=SCALB Fx BY Ry	*	*	*	0	0	*	1	_	**	**	_	**
Rn=MANT Fx	*	*	0	0	*	*	1	_	_	**	_	**
Rn=LOGB Fx	*	*	*	0	0	*	1	-	_	**	_	**
Rn=FIX Fx BY Ry	*	*	*	0	0	*	1	_	**	**	_	**
Rn=FIX Fx	*	*	*	0	0	*	1	_	**	**	_	**
Rn, Rx, Ry = Any T fixed-poin	locat t	cion	in	the	Regi	ster	r Fi	le; t	reate	ed as		
Fn, Fx, Fy = Any ing-point	ocat	cion	in	the	Regi	ster	r Fi	le; t	reate	ed as	floa	àt-
t = ADSP-21xx-comp	patib	ole '	inst	ruct	ion							
* = Set or cleared	d dep	pend	ing (on r	esul	ts d	ofi	nstru	ctior	1		
** = Can be set, b tion	out r	not (clear	red,	dep	endi	ing (on re	sults	s of	instr	°UC-
- = Not affected												

Table 2-5. Summary of ALU instructions (Cont'd)

Instruction		ASTAT Status Flags STKY Status Flags										
	A Z	A V	A N	A C	A S	A I	A F	C A C C	A U S	A V S	A O S	A I S
Fn=Float Rx by Ry	*	*	*	0	0	0	1		**	**		-
Fn=FLOAT Rx	*	0	*	0	0	0	1			—		
Fn=RECIPS Fx	*	*	*	0	0	*	1	-	**	**		**
Fn=RSQRTS Fx	*	*	*	0	0	*	1	l	l	**	l	**
Fn=Fx COPYSIGN Fy	*	0	*	0	0	*	1	l	l	—	l	**
Fn=MIN(Fx, Fy)	*	0	*	0	0	*	1	-		_		**
Fn=MAX(Fx, Fy)	*	0	*	0	0	*	1	l	l	_	l	**
Fn=CLIP Fx BY Fy	*	0	*	0	0	*	1	_	_	_	_	**
Rn, Rx, Ry = Any 1 fixed-poin	ocat t	cion	in	the	Regi	ster	· Fi	le; t	reate	ed as		
Fn, Fx, Fy = Any 1 ing-point	ocat	ion	in	the	Regi	ster	Fi ⁻	le; t	reate	ed as	floa	ıt-
t = ADSP-21xx-comp	patib	ole '	inst	ruct	ion							
* = Set or cleared	d dep	pend	ing (on r	esul	ts c	of in	nstru	ctior	۱		
** = Can be set, b tion	out r	not (clear	red,	dep	endi	ng (on re	sults	s of	instr	`UC-
- = Not affected												

Table 2-5. Summary of ALU instructions (Cont'd)

For details on each of the ALU instructions, see "ALU Operations" on page B-2, in *ADSP-21065L SHARC DSP Technical Reference*.

Multiplier Unit

The Multiplier performs fixed-point or floating-point multiplication and fixed-point, multiply and accumulate operations.

It can perform fixed-point, multiply and accumulates with either cumulative addition or cumulative subtraction.

Through parallel operation of the ALU and Multiplier, using multifunction instructions, applications can perform floating-point, multiply and accumulates. See "Multifunction Operations" on page 2-50.

Multiplier fixed-point instructions operate on 32-bit, fixed-point data and produce 80-bit results. These instructions treat inputs as fractional or integer, unsigned or twos-complement.

Multiplier floating-point instructions operate on 32- or 40-bit floating-point operands and output 32- or 40-bit floating-point results.

Multiplier instructions include:

- 32-bit, fixed-point multiplication.
- Fixed-point multiply and accumulate to eighty bits (with addition), with rounding optional.
- Fixed-point multiply and accumulate to eighty bits (with subtraction), rounding optional.
- Round result register.
- Saturate result register.
- Clear result register.
- Floating-point multiplication.

Multiplier Operations

The Multiplier takes two input operands, the X-input and the Y-input. These operands can be any of the data registers in the Register File.

Fixed-point operations can accumulate fixed-point results in either of the Multiplier's two local result registers (MR) or write results back to the Register File. The processor can round or saturate results stored in the MR registers in separate operations.

Floating-point operations yield floating-point results, which the processor always writes directly back to the Register File.

The processor transfers input operands during the first half of the cycle and results during the second half of the cycle. This enables the Multiplier to read and write the same location in the Register File within a single cycle.

In fixed-point operations that use inputs from the Register File, the processor reads from the upper thirty-two bits of the source location.

You can input fixed-point operands in either integer or fractional format, but both operands must in the same format. The format of the result is the same as the format of the inputs.

You can input each fixed-point operand as either an unsigned or a twos-complement number. If both inputs are fractional and signed, the Multiplier automatically shifts the result left one bit to remove the redundant sign bit.

You specify the input data type within the multiplier instruction.

Fixed-Point Results

Fixed-point operations yield 80-bit results in the MR register. The location of a result in the 80-bit field depends on whether the result is in fraction or integer format, as shown in Figure 2-2.



Figure 2-2. Placement of fixed-point results

If it sends the result directly to the Register File, the processor transfers the thirty-two bits that have the same format as the input data; that is, bits 63:32 for a fraction result or bits 31:0 for an integer result. The processor zero-fills the eight LSBs of the 40-bit location in the Register File.

For fraction results, you can specify rounding-to-nearest before the processor transfers the results to the Register File (for details, see "Rounding MR Register" on page 2-30 and "Rounding Mode" on page 2-33). Otherwise, the processor truncates (rounds-to-zero) fraction results, discarding bits 31:0.

Using the MR Registers

The processor can send an entire result to one of two dedicated, 80-bit result registers (MR). Both MR registers are subdivided into three subregisters, MR_2 , MR_1 , and MR_0 . You can access each of these subregisters individually to read from or write to the Register File.

When reading data from MR2, the processor sign-extends the data to thirty-two bits (see Figure 2-3). When reading data from MR_2 , MR_1 , or MR_0 and writing it to the Register File, the processor zero-fills the eight LSBs of the 40-bit location in the Register File.



Figure 2-3. MR transfer formats

The processor writes into MR_2 , MR_1 , or MR_0 data from the thirty-two MSBs of a location in the Register File, ignoring the eight LSBs. It sign-extends into MR_2 the data it wrote into MR_1 ; that is, the processor repeats the MSB of MR_1 in the sixteen bits of MR_2 . The processor does not sign-extend the data it writes to MR_0 .

The two MR registers are designated MRF (foreground) and MRB (background). Foreground registers are those that the SRCU bit in the MODE1 register is currently activating, and background registers are those it is currently deactivating.

In the case where only one MR register is used at a time, the SRCU bit activates one or the other to implement context switching. However, unlike other registers for which alternate sets exist, both MR register sets are accessible at the same time.

All (fixed-point) accumulation instructions can specify either result register for accumulation, regardless of the state of the SRCU bit. So, instead of using the MR registers as primary and alternate registers, you can use them as two parallel accumulators. This feature supports complex math operations.

Transfers between MR registers and the Register File are considered computation unit operations since they involve the Multiplier. So, although the syntax for the transfer is the same as for any other transfer to or from the Register File, you specify an MR transfer in an instruction where a computation is normally specified. For example, the processor can perform a multiply and accumulate in parallel with a data memory read, as in:

```
MRF=MRF-R5*R0, R6=DM(I1,M2),
```

or it can perform an MR transfer instead of the computation, as in:

R5=MR1F, R6=DM(I1,M2)

Fixed-Point MR Register Operations

In addition to multiplication, fixed-point operations include accumulation, rounding, and saturation of fixed-point data. The three MR register operations are:

- Clear MR register
- Round MR register
- Saturate MR register

Clear MR Register

This operation resets the specified MR register to 0. Performed at the start of a multiply and accumulate operation, it removes results left over from the previous operation.

Rounding MR Register

Rounding of a fixed-point result occurs either as part of a multiply, a multiply and accumulate, or an explicit operation on the MR register. This operation applies only to fraction results (integer results are not affected) and rounds the 80-bit MR value to nearest at bit 32; that is, at the MR_1 - MR_0 boundary.

Applications can send the rounded result in MR_1 either to the Register File or back to the same MR register.

To round a fraction result to 0 (truncation) instead of to nearest, you simply transfer the unrounded result from MR_1 , discarding the lower thirty-two bits in MR_0 .

Saturate MR Register

This operation sets MR to a maximum value if the MR value has overflowed. Overflow occurs when the MR value is greater than the maximum value for the data format (unsigned or twos-complement and integer or fractional) that is specified in the saturate instruction.

This operation has six possible maximum values (values are in hexadecimal), as shown in Table 2-6.

Data Format	MR2	MR1	MRO	Sign
Max. 2s-comp., Fractional	0000	7FFF FFFF	FFFF FFFF	+
	FFFF	8000 0000	0000 0000	-
Max. 2s-comp.,	0000	0000 0000	7FFF FFFF	+
Integer	FFFF	FFFF FFFF	8000 0000	-
Max. unsigned, Fractional	0000	FFFF FFFF	FFFF FFFF	
Max. unsigned, Integer	0000	0000 0000	FFFF FFFF	

Table 2-6. Valid MR maximum saturation values

You can send the result from MR saturation to either the Register File or back to the same MR register.

Floating-Point Operating Modes

Two mode status bits in the MODE1 register affect multiplier (and ALU) operations:

- Rounding mode (TRUNC)
- Rounding boundary bits (RND32)

Table 2-7. MODE1 ALU and Multiplier operation status bits

Bit	Name	Description							
0	TRUNC	Rounding mode. O= Round-to-nearest 1= Truncate							
1	RND32	Rounding boundary. O= Round to 40 bits 1= Round to 32 bits							

Although the processor supports these two rounding modes for fixed-point multiplier operations on fraction data, the Multiplier performs the round-to-nearest operation only. This is so because the Multiplier has a local result register for fixed-point operations, and it reads only the upper bits of the result and discards the lower bits, implicitly rounding-to-zero.

Rounding Mode

The Multiplier supports two IEEE rounding modes for floating-point operations.

- TRUNC=1 Rounds a floating-point result to 0 (truncation).
- TRUNC=0 Rounds to nearest.

Rounding Boundary

Multiplier floating-point inputs and results can be either 32- or 40-bit floating-point data.

RND32=1 The processor flushes the eight LSBs of each input operand to 0s before multiplication and outputs floating-point results in the 32-bit IEEE format, clearing the lower eight bits of the 40-bit Register File location.

The processor rounds the mantissa of the result to twenty-three bits (not including the hidden bit).

RND32=0 The Multiplier inputs full 40-bit values from the Register File and outputs results in the 40-bit extended IEEE format, rounding the mantissa to thirty-one bits (not including the hidden bit).

Multiplier Status Flags

The Multiplier updates four status flags at the end of each operation. All of these flags appear in the ASTAT register. The states of these flags reflect the result of the most recent multiplier operation, as shown in Table 2-8.

Bit	Name	Description
6	MN	Multiplier result negative
7	MV	Multiplier overflow
8	MU	Multiplier underflow
9	ΜI	Multiplier floating-point invalid operation

Table 2-8. ASTAT multiplier status flags

The Multiplier also updates four sticky status flags in the STKY register, as shown in Table 2-9. Once set, a sticky flag remains high until it is explicitly cleared.

Table 2-9. STCKY multiplier status flags

Bit	Name	Description
6	MOS	Multiplier fixed-point overflow
7	MVS	Multiplier floating-point overflow
8	MUS	Multiplier underflow
9	MIS	Multiplier floating-point invalid operation

The Multiplier updates flags at the end of the cycle in which the status is generated, and results are available on the next cycle. If an application writes the ASTAT register or STKY register explicitly in the same cycle that the Multiplier is performing an operation, the explicit write to ASTAT or STKY supersedes the update that the multiplier operation generates.

Multiplier Negative Flag (MN)

The Multiplier determines the negative flag for all multiplier operations. It sets MN whenever the result of a multiplier operation is negative. Otherwise, it clears MN.

Multiplier Overflow Flags (MV, MVS, MOS)

The Multiplier determines the overflow flag for all fixed-point and floating-point multiplier operations.

For floating-point results, the Multiplier sets MV and MVS whenever the post-rounded result overflows (unbiased exponent > 127).

For fixed-point results, MV and MOS depend on the data format, and the Multiplier sets them when upper bits in the MR register contain certain values, as shown in Table 2-10.

Data Format	MR Bits	Value								
Twos-Complement										
Fractional	Upper 17 bits of MR	All 1s or not all Os								
Integer	Upper 49 bits of MR	All 1s or not all Os								
Unsigned										
Fractional	Upper 16 bits of MR	Not all Os								
Integer	Upper 48 bits of MR	Not all Os								

Table 2-10. MR values that set the MV and MOS flags for fixed-point results

If the processor sends the fixed-point result to an MR register, the overflowed portion of the result is available in MR_1 and MR_2 for integer results, or in MR_2 only for fractional results.

Multiplier Invalid Operation Flag (MI)

The Multiplier determines the MI flag for floating-point multiplication. It sets MI whenever:

- An input operand is a NAN.
- The inputs are Infinity and Zero (0)—treats denormal inputs as 0s

Otherwise, it clears MI.

Multiplier Underflow Flag (MU, MUS)

The Multiplier determines underflow for all fixed-point and floating-point multiplier operations. It sets MU whenever the result of a multiplier operation is smaller than the smallest number the processor can represent in the output format. Otherwise, it clears MU.

For floating-point results, the Multiplier sets MU and MUS whenever the post-rounded result underflows (unbiased exponent < -126). Denormal operands are treated as 0s, so they never cause underflows.

For fixed-point results, MU and MUS depend on the data format and the Multiplier sets them when the upper bits of the result contain certain values, as shown in Table 2-11 on page 2-37.

Data Format	Bits	Value								
Twos-Complement										
Fractional	Upper 48 bits of MR Lower 32 bits	All Os or all 1s Not all Os								
Integer	Not possible	Not Applicable								
	Unsigned									
Fractional	Upper 48 bits Lower 32 bits	All Os Not all Os								
Integer	Not possible	Not Applicable								

Table 2-11. Results that set the MU and MUS flags for fixed-point results

If the processor sends the fixed-point result to an MR register, the underflowed portion of the result is available in MR_0 (fractional result only).

Multiplier Unit

Multiplier Instruction Set Summary

Table 2-12 lists the optional modifiers used in Multiplier fixed-point operations and shows where they appear in instruction syntax in the tables that follow.

T11 0 10	$O \cdot 1$	1.0	C	111	1.	C 1	•	•	•
Table 2-12	Optional	modifiers	tor	Multi	plier	tixed-	-point	insti	inctions.
14010 2 12.	optional	mountero	101	IT I GILI	PILCI	imea	pome	111001	actions

(Х	Y	Data)	S	Signed input
	Input	Input	Format,		U	Unsigned input
			rounding		Ι	Integer input(s)
					F	Fractional input(s)
					FR	Fractional input(s), rounded
						output
					(SF)	Default format for 1-input
						operations
					(SSF)	Default format for 2-input
						operations

Table 2-13 lists the symbols that appear in the multiplier instruction set summary tables that follow.

T11 0 10	77 1 1	1 1 C	11	1 C 1 · 1·	•	•
Table 2-15	Lable sv	mbols to	or all	Multipli	er inst	ructions
10010 2 101	rable of	1110010 1	or an	1,1 areipii	CI 11100	acciono

Symbol	Meaning					
*	Set or cleared, depending on results					
**	Set, but not cleared, depending on results					
_	Not affected					
Rn, Rx, Ry	R15-RO Register File locations, treated as fixed-point					
Fn, Fx, Fy	F15-F0 Register File locations, treated as float- ing-point					

Symbol	Meaning
MRxF	MR2F, MR1F, MROF multiplier result accumulators, foreground
MRxB	MR2B, MR1B, MROB multiplier result accumulators, background

Table 2-13. Table symbols for all Multiplier instructions

Table 2	2-14.	Mul	tiplier	fixed	l-point	instr	ucti	ions
			-		-			

	I	1	AST	AT F	lags	ST	KY F1	ags
			M U	M N N V	1 M / I	M U S	M O S	M M V I S S
Rn = Rx × R MRF MRB	y (S U	S F) U I FR	*	*	* 0		**	
Rn=MRF +Rx × Rn=MRB MRF=MR B MRB=MR B	Ry (SU	S F) U I FR	*	*	* 0		**	
Rn=MRF -Rx × Rn=MRB MRF=MR B MRB=MR B	Ry (S U	S F) U I FR	*	*	* 0	-	**	

Multiplier Unit

		AS	TAT	Flag	S	S	τκγ β	lags	
		M U	M N	M V	M I	M U S	M O S	M V S	M I S
Rn=SAT MRF RN=SAT MRB MRF=SAT MRB MRB=SAT MRB	(SI) (UI) (SF) (UF)	*	*	*	0	_	**	_	_
Rn=RND MRF RN=RND MRB MRF=RND MRB MRB=RND MRB	(SF) (UF)	*	*	*	0	-	**	_	_
MRF = 0 MRB		0	0	0	0	-	_	_	_
MRxF = Rn MRxB		0	0	0	0	-	_	_	_
Rn = MRxF MRxB		0	0	0	0	-	_	_	_

Table 2-15. Multiplier floating-point instruction

Fn = Fx × Fy * * * 0 ** - ** **

For details on each of the Multiplier instructions, see "Multiplier Operations" on page B-50, in *ADSP-21065L SHARC DSP Technical Reference*.

Shifter Unit

The Shifter operates on 32-bit, fixed-point operands. It performs:

- Shifts and rotates from off-scale left to off-scale right.
- Bit manipulations bit set, clear, toggle, and test.
- Bit field manipulations extract and deposit.
- Support operations for conversions between fixed-point and floating-point numbers (exponent extract, number of leading 1s or 0s).

Shifter Operations

The Shifter takes from one to three input operands:

• X-input

This input is operated on.

• Y-input

Specifies shift magnitudes, bit field lengths, or bit positions.

• Z-input

This operand is operated on and updated as, for example:

Rn = Rn OR LSHIFT Rx BY Ry

The Shifter returns one output to the Register File.

During the first half of the cycle, the Shifter fetches input operands from the upper thirty-two bits of a location in the Register File (bits 39:8) or from an immediate value in the instruction. During the second half of the cycle, it transfers results to the upper thirty-two bits of a register, filling the eight LSBs with zeros (0). This enables the Shifter to read and write the same location in the Register File in a single cycle. The X-input and Z-input are always 32-bit, fixed-point values. The Y-input is either a 32-bit, fixed-point value or an 8-bit field (shf8) positioned in the Register File as shown in Figure 2-4.



Figure 2-4. Register File fields for Shifter instructions

Some Shifter operations produce 8-bit or 6-bit results. The Shifter places these results in either the shf8 field or the bit6 field (see Figure 2-5 on page 2-42) and sign-extends them to 32 bits. This procedure ensures that the Shifter always returns a 32-bit result.

Bit Field Deposit and Extract Operations

The Shifter's bit field deposit (FDEP) and bit field extract (FEXT) instructions provide a way to manipulate groups of bits within a 32-bit, fixed-point integer word.

The Y-input for these instructions specifies two 6-bit values, bit6 and len6, positioned in the Ry register as shown in Figure 2-5.



Figure 2-5. Register File fields for FDEP and FEXT instructions

The Shifter interprets bit6 and len6 as positive integers. Bit6 is the starting bit position for the deposit or extract. Len6 is the length, in number of bits, of the field to deposit or extract.

The FDEP (field deposit) instructions take a group of bits from the input register Rx (starting at the LSB of the 32-bit integer field) and deposit them anywhere within the result register Rn (see Figure 2-6). The bit6 value specifies the starting bit position for the deposit.



Figure 2-6. Bit field of the FDEP instruction

The FEXT (field extract) instructions extract a group of bits from anywhere within the input register Rx and place them in the result register Rn (aligned with the LSB of the 32-bit integer field). The bit6 value specifies the starting bit position for the extract.

Shifter Unit

Figure 2-7 illustrates the following field deposit instruction example:



RO=FDEP R1 BY R2;

Figure 2-7. Bit field deposit example

Figure 2-8 on page 2-45 illustrates the following field extract instruction example:

R3=FEXT R4 BY R5;



Figure 2-8. Bit field extract example

Shifter Status Flags

The Shifter returns three status flags at the end of the operation. All of these flags appear in the ASTAT register.

Bit	Name	Description
11	SV	Shifter overflow of bits to left of MSB
12	SZ	Shifter result O
13	SS	Shifter input sign (for exponent extract opera- tions only)

Table 2-16. ASTAT Shifter status bits

The Shifter updates these flags at the end of the cycle in which their status is generated, and the results are available on the next cycle. If an application writes the ASTAT register explicitly in the same cycle that the Shifter is performing an operation, the explicit write to ASTAT supersedes the update that the shift operation generates.

Shifter Overflow Flag (SV)

All shifter operations affect the SV flag. The Shifter sets SV whenever:

- It shifts significant bits to the left of the 32-bit, fixed-point field.
- It tests, sets, or clears a bit outside the 32-bit fixed-point field.
- It extracts a field that is partially or wholly to the left of the 32-bit, fixed-point field.
- A LEFTZ or LEFTO operation returns a result of 32.

Otherwise, it clears SV.

Shifter Zero Flag (SZ)

All shifter operations affect SZ. The Shifter sets SZ whenever:

- The result of a shifter operation is 0.
- A bit test instruction specifies a bit outside the 32-bit, fixed-point field.

Otherwise, it clears SZ.

Shifter Sign Flag (SS)

All shifter operations affect the SS flag.

For the two EXP (exponent extract) operations, the Shifter sets SS if the fixed-point input operand is negative and clears it if the operand is positive.

For all other shifter operations, the Shifter clears SS.

Shifter Instruction Summary

Table 2-17. Shifter instructions

	1	Flags		
Instruction	SZ	SV	SS	
$Rn = LSHIFT Rx BY Ry^{\dagger}$	*	*	0	
Rn = LSHIFT Rx BY <data8>[†]</data8>	*	*	0	
Rn OR LSHIFT Rx BY Ry [†]	*	*	0	
Rn OR LSHIFT Rx BY <data8>[†]</data8>	*	*	0	
$Rn = ASHIFT Rx BY Ry^{\dagger}$	*	*	0	
Rn = ASHIFT Rx BY <data8>[†]</data8>	*	*	0	
Rn OR ASHIFT Rx BY Ry [†]	*	*	0	
Rn OR ASHIFT Rx BY <data8>[†]</data8>	*	*	0	
Rn = ROT Rx BY Ry	*	0	0	
Rn = ROT Rx BY <data8></data8>	*	0	0	
Rn = BCLR Rx BY Ry	*	*	0	
Rn = BCLR Rx BY <data8></data8>	*	*	0	
<pre>t = Compatible with ADSP-21xx instruction * = Data-dependent Rn, Rx, Ry = Any Register File location, bit fields used depend on instruction</pre>				
Fn, Fx = Any Register File location, floatin	g-point	: word		

Table 2-17. Shifter instructions

	I	Flags			
Instruction	SZ	SV	SS		
Rn = BSET Rx BY Ry	*	*	0		
Rn = BSET Rx BY <data8></data8>	*	*	0		
Rn = BTGL Rx BY Ry	*	*	0		
Rn = BTGL Rx BY <data8></data8>	*	*	0		
BTST Rx By BY	*	*	0		
BTST Rx BY <data8></data8>	*	*	0		
Rn = FDEP Rx BY Ry	*	*	0		
Rn = FDEP Rx BY <bit6>:<len6></len6></bit6>	*	*	0		
Rn = Rn OR FDEP Rx BY Ry	*	*	0		
Rn = Rn OR FDEP Rx BY <bit6>:<len6></len6></bit6>	*	*	0		
Rn = FDEP Rx BY Ry(SE)	*	*	0		
Rn = FDEP Rx BY <bit6>:<len6>(SE)</len6></bit6>	*	*	0		
Rn = Rn OR FDEP Rx BY Ry (SE)	*	*	0		
Rn = Rn OR FDEP Rx BY <bit6>:<len6>(SE)</len6></bit6>	*	*	0		
<pre>t = Compatible with ADSP-21xx instruction * = Data-dependent Rn, Rx, Ry = Any Register File location, bit fields used depend</pre>					
on instruction Fn, Fx = Any Register File location, floatin	g-point	word			

	l	Flags			
Instruction	SZ	SV	SS		
Rn = FEXT Rx BY Ry	*	*	0		
Rn = FEXT Rx BY <bit6>:<len6></len6></bit6>	*	*	0		
Rn = FEXT Rx BY Ry(SE)	*	*	0		
Rn = FEXT Rx BY <bit6>:<len6>(SE)</len6></bit6>	*	*	0		
$Rn = EXP Rx(EX)^{\dagger}$	*	0	*		
$Rn = EXP Rx^{\dagger}$	*	0	*		
Rn = LEFTZ Rx	*	*	0		
Rn = LEFTO Rx	*	*	0		
Rn = FPACK Fx	0	*	0		
Rn = FUNPACK Rx	0	0	0		
t = Compatible with ADSP-21xx instruction					
* = Data-dependent					
Rn, Rx, Ry = Any Register File location, bit fields used depend on instruction					
Fn, Fx = Any Register File location, floatin	g-point	word			

Table 2-17. Shifter instructions

For details on each of the Shifter instructions, see "Shifter Operations" on page B-63, in *ADSP-21065L SHARC DSP Technical Reference*.

Multifunction Operations

In addition to the computations performed by each computation unit, the processor provides multifunction operations that combine parallel operation of the Multiplier and the ALU or dual operations in the ALU.

The processor performs multifunction operations the same way it performs the two operations in corresponding single-function computations. It also determines flags for multifunction operations the same way it does for the same single-function computations, except that in the dual add and subtract computation, it ORs together the ALU flags from the two operations.

Each of the four input operands for computations that use both the ALU and Multiplier are constrained to a different set of four locations in the Register File, as summarized in Tables 2-18, 2-19, 2-20, and 2-21 and shown in Figure 2-9 on page 2-52. For example, R8, R9, R10 and R11 are the only valid X-inputs to the ALU. In all other operations, the input operands can be any location in the Register File.

In Tables 2-18, 2-19, 2-20, and 2-21, Ra, Rm, Rs, Rx, and Ry are any fixed-point location in the Register File, and Fa, Fm, Fs, Fx, and Fy are any floating-point location in the Register File. SSF is any signed X or Y fractional input, and SSFR is any signed X or Y fractional input, rounded-to-nearest output.

Table 2-18. Dual add and subtract instructions

```
Ra=Rx+Ry, Rs=Rx-Ry
Fa=Fx+Fy, Fs=Fx-Fy
```

Table 2-19. Fixed-point multiply and accumulate and add, subtract, or average instructions



$Fm = F_{3-0} \star F_{7-4},$	$Fa = F_{11-8} + F_{15-12}$
	$Fa = F_{11-8} - F_{15-12}$
	$Fa = FLOAT R_{11-8} by R_{15-12}$
	Ra = FIX F ₁₁₋₈ by R ₁₅₋₁₂
	$Fa = (F_{11-8} + F_{15-12})/2$
	Fa = ABS F ₁₁₋₈
	Fa = MAX (F ₁₁₋₈ , F ₁₅₋₁₂)
	Fa = MIN (F ₁₁₋₈ , F ₁₅₋₁₂)

Table 2-21. Multiplication and dual add and subtract instructions

For details on each of the multifunction instructions, see "Multifunction Computations" on page B-94, in *ADSP-21065L SHARC DSP Technical Reference*.

Multifunction Operations



Figure 2-9. Input registers for multifunction computations (ALU and Multiplier)

3 PROGRAM SEQUENCING

The processor executes program instructions sequentially, in a linear flow, unless otherwise directed by various program structures:

• Loops

Execute one sequence of instructions several times, incurring zero overhead.

• Subroutines

Temporarily interrupt sequential flow to execute instructions from another part of program memory.

• Jumps

Permanently transfer program flow to another part of program memory.

• Interrupts

A special type of subroutine in which an event that happens at run time, not a program instruction, triggers the execution of the routine.

• Idle

A special instruction that causes the processor to stop operations and hold its current state. When an interrupt occurs, the processor services the interrupt and continues normal execution. Figure 3-1 on page 3-3 illustrates the variations in program flow that these program structures invoke.

To manage these program structures and the sequence of program flow, the core's Program Sequencer:

- Selects the address of the next instruction, generating most of the addresses itself.
- Increments the fetch address.
- Maintains stacks.
- Evaluates conditions.
- Decrements the loop counter.
- Calculates new addresses.
- Maintains an instruction cache.
- Handles interrupts.



Figure 3-1. Variations of program flow

Instruction Cycle

The ADSP-21065L processes instructions in three clock cycles:

• Fetch cycle

The processor reads the instruction from either the on-chip instruction cache or from program memory.

• Decode cycle

The processor decodes the instruction, which generates conditions that control instruction execution.

• Execute cycle

The processor executes the instruction, completing the operations the instruction specified.



When processing instructions, the processor uses its core clock, which runs at 2xCLKIN. Hereafter, in this chapter, all clock cycle references are to 2xCLKIN, unless otherwise noted.

These cycles are overlapping, or pipelined, as shown in Table 3-1 on page 3-5. In sequential program flow, while the core is fetching one instruction, it is decoding the instruction it fetched in the previous cycle

and executing the instruction it fetched in the previous two cycles. Thus, throughput is one instruction per cycle.

Time	Instruction Sequence					
(Cycles)	Fetch	h Decode Execute				
0	0×04					
1	0x05	0×04				
2	0x06	0x05	0×04			
3	0x07	0x06	0x05			
4	0x08	0×07	0x06			

Table 3-1. Pipelined execution cycles

Any nonsequential program flow can potentially decrease the processor's instruction throughput. Nonsequential program operations include:

- Program memory data accesses that conflict with instruction fetches
- Jumps
- Subroutine calls and returns
- Interrupts and returns
- Loops

Program Sequencer Architecture

Figure 3-2 shows the architecture of the Program Sequencer.



Figure 3-2. Block diagram of the Program Sequencer

The Program Sequencer selects the value of the next fetch address from several possible sources.

The fetch address register, decode address register, and program counter (PC) contain the addresses of the instructions the processor's core is currently fetching, decoding, and executing, respectively.

Applications use the PC stack in conjunction with the PC to store return addresses and top-of-loop addresses.
The interrupt controller performs all functions related to interrupt processing, such as determining whether an interrupt is masked and generating the appropriate interrupt vector address.

The instruction cache enables the processor to access data in program memory and fetch an instruction (from the cache) in the same cycle. The DAG2 data address generator outputs program memory data addresses (for details, see Chapter 4, Data Addressing).

Using information from the status registers, the Program Sequencer evaluates conditional instructions and loop termination conditions.

The loop address stack and loop counter stack support nested loops.

The status stack stores status registers that provide support for implementing nested interrupt routines.

Program Sequencer and System Registers

Table 3-2 on page 3-8 lists the registers located in the Program Sequencer.

All registers in the Program Sequencer are universal registers, so they are accessible to other universal registers and to data memory. All registers and the tops of stacks are readable. All registers, except the fetch address, decode address, and PC, are writable.

Applications can write (and read) the PC stack pointer to push and pop the PC stack. Applications must issue explicit instructions to push or pop the loop address stack and the status stack.

Applications can use the *System Register Bit Manipulation* instruction to set, clear, toggle, or test specific bits in the system registers. For details, see Appendix A, Instruction Set Reference, in *ADSP-21065L SHARC DSP Technical Reference*.

Due to pipelining, writes to some of these registers do not take effect on the next cycle. For example, if you write the MODE1 register to enable ALU saturation mode, the change occurs two cycles after the write.

Some registers are not updated on the cycle immediately following a write; that is, an extra cycle occurs before a read of the register yields the new value. Table 3-2 and Table 3-3 on page 3-9 summarize the number of extra cycles that occur before a write takes effect (effect latency) and before a new value appears in the register (read latency) for Program Sequencer and system registers, respectively. A 0 indicates that the write takes effect or appears in the register on the next cycle after the write instruction executes. A 1 indicates one extra cycle.

Register	Contents	Bits	Read Latency	Effect latency
FADDR	fetch address	24	_	_
DADDR	decode address	24	_	_
PC	execute address	24	_	_
PCSTK	top of PC stack	24	0	0
PCSTKP	PC stack pointer	5	1	1
LADDER	top of loop address stack	32	0	0
CURLCNTR	top of loop count stack (current loop count)	32	0	0
LCNTR	loop count for next DO UNTIL loop	32	0	0

T11 2 2	D	C	•	1	1		1 . •
Table 3-2.	Program	Sequencer	registers	read	and	effect	latencies

Register	Contents	Bits	Read Latency	Effect Latency
MODE1	mode control bits	32	0	1
MODE2	mode control bits	32	0	1
IRPTL	interrupt latch	32	0	1
IMASK	interrupt mask	32	0	1
IMASKP	interrupt mask pointer (for nesting)	32	1	1
ASTAT	arithmetic status flags	32	0	1
STKY	sticky status flags	32	0	1
USTAT1	user-defined status flags	32	0	0
USTAT2	user-defined status	32	0	0

Table 3-3. System registers read and effect latencies

Program Sequencer Operation

This section describes how the Program Sequencer operates and defines the various kinds of program flow it supports.

Sequential Program Flow

To determine the next instruction address, the Program Sequencer examines both the instruction currently executing and the current state of the processor. Unless it encounters a program structure that alters program flow, the Program Sequencer simply increments the fetch address to execute instructions from program memory in sequential order.

Program Memory Data Accesses

Usually, the processor's core fetches an instruction from memory on each cycle. When the processor executes an instruction that requires it to read or write data to the same memory block that contains the instruction, the fetch causes a conflict for access to the block. To reduce delays such conflicts cause, the processor uses its instruction cache.

The first time the processor encounters an instruction fetch that conflicts with a program memory data access, it must wait to fetch the instruction on the following cycle, causing a delay. To prevent the same delay from reoccurring, the processor automatically writes the fetched instruction to the instruction cache. The processor checks the instruction cache on every program memory data access. If the needed instruction is in the cache, the fetch from the cache occurs in parallel with the access to program memory data, avoiding a delay.

Branches

A branch occurs when the current fetch address does not follow the previous fetch address sequentially. The processor supports jumps, calls, and returns.

In the Program Sequencer, a jump differs from a call only in that:

- Calls branch to a new location, but upon execution, the Program Sequencer pushes onto the PC stack a return address, which is available when the processor executes a return instruction later.
- Jumps branch to a new location permanently and do not provide for a return.

Loops

The processor supports program loops with the DO UNTIL instruction. The DO UNTIL instruction causes the processor to repeat a sequence of instructions until a specified condition tests true.

Executing Conditional Instructions

The Program Sequencer evaluates conditions to determine whether to execute a conditional instruction and when to terminate a loop. The conditions are based on information from the arithmetic status (ASTAT) register, mode control 1 (MODE1) register, flag inputs, and loop counter. See Chapter 2, Computation Units, for a description of the arithmetic ASTAT bits.

Each condition that the Program Sequencer evaluates has an assembler mnemonic and a unique code, used in a conditional instruction's opcode. For most conditions, the Program Sequencer can test both true and false states (=0 and \neq 0). Table 3-4 on page 3-13 defines the processor's thirty-two condition and termination codes.

After it is set, applications can use the bit test flag (BTF), bit 18 of the ASTAT register, as the condition in a conditional instruction (with the mnemonic TF, see Table 3-4). The results of the BIT TST and BIT XOR forms of the System Register Bit Manipulation instruction, which applications can use to test the contents of the processor's system registers, set and clear this flag. For details, see Appendix A, Instruction Set Reference, in *ADSP-21065L SHARC DSP Technical Reference*.

The two conditions that lack complements are LCE/NOT LCE (loop counter expired/not expired) and TRUE/FOREVER. Context determines the interpretation of these condition codes. You use TRUE and NOT LCE in conditional instructions and FOREVER and LCE in loop termination instructions.

The IF TRUE construct creates an unconditional instruction (the same effect as leaving out the condition entirely). A DO FOREVER instruction executes a loop indefinitely, until an interrupt or reset intervenes.

Applications typically use the LCE condition (loop counter expired) in DO UNTIL instructions. Because the LCE condition checks the value of the loop counter (CURLCNTR), avoid following a write from memory to CURLCNTR with an IF NOT LCE conditional instruction. Otherwise, because the write occurs after the NOT LCE test, the condition is based on the old CURLCNTR value.

The bus master condition (BM) indicates whether the processor is currently bus master in a multiprocessor system. To enable this condition, set both bit 17 and bit 18 of the MODE1 register to 0. Otherwise the condition always evaluates as false.

Number	Mnemonic	Description	True if…
0	EQ	ALU = 0	AZ = 1
1	LT	ALU < zero	footnote ¹
2	LE	ALU ≤ 0	footnote ²
3	AC	ALU carry	AC = 1
4	AV	ALU overflow	AV = 1
5	MV	Multiplier overflow	MV = 1
6	MS	Multiplier sign	MN = 1
7	SV	Shifter overflow	SV = 1
8	SZ	Shifter zero	SZ = 1
9	FLAGO_IN	flag O input	FIO = 1
10	FLAG1_IN	flag 1 input	FI1 = 1
11	FLAG2_IN	flag 2 input	FI2 = 1
12	FLAG3_IN	flag 3 input	FI3 = 1

Table 3-4. Condition and loop termination codes

Number	Mnemonic	Description	True if…
13	TF	bit test flag	BTF = 1
14	ВМ	bus master	
15	LCE	loop counter expired (DO UNTIL term)	CURLCNTR = 1
15	NOT LCE	loop counter not expired (IF condition)	CURLCNTR ≠ 1
Numbers 16 through 30 are the compliments of numbers 0 through			
16	NE	ALU ≠ 0	AZ = 0
17	GE	$ALU \ge 0$	footnote ³
18	GT	ALU > 0	footnote ⁴
19	NOT AC	not ALU carry	AC = 0
20	NOT AV	not ALU overflow	AV = 0
21	NOT MV	not multiplier overflow	MV= 0
22	NOT MS	not multiplier sign	MN = 0
23	NOT SV	not shifter overflow	SV = 0
24	NOT SZ	not shifter zero	SZ = 0
25	NOT FLAGO_IN	not flag O input	FIO = 0
26	NOT FLAG1_IN	not flag 1 input	FI1 = 0
27	NOT FLAG2_IN	not flag 2 input	FI2 = 0
28	NOT FLAG3_IN	not flag 3 input	FI3 = 0

Table 3-4. Condition and loop termination codes (Cont'd)

Number	Mnemonic	Description	True if…
29	NOT TF	not bit test flag	BTF = 0
30	NOT BM	not bus master	
31	FOREVER	always false (DO UNTIL)	always
31	TRUE	always true (IF)	always

Table 3-4. Condition and loop termination codes (Cont'd)

1 $[\overline{AF} \text{ and } (AN \text{ xor } (AV \text{ and } \overline{ALUSAT})) \text{ or } (AF \text{ and } AN \text{ and } \overline{AZ})] = 1$

 $\begin{bmatrix} AF & and (AN xor (AV and ALUSAT)) or (AF and AN)] or \overline{AZ} = 1 \\ \hline AF & and (AN xor (AV and ALUSAT)) or (AF and AN)] or \overline{AZ} = 1 \\ \hline AF & and (AN xor (AV and ALUSAT)) or (AF and AN and AZ)] = 0 \\ \hline AF & and (AN xor (AV and ALUSAT)) or (AF and AN)] or \overline{AZ} = 0 \\ \end{bmatrix}$

Branches (call, jump, rts, rti)

The CALL instruction initiates a subroutine. Both jumps and calls transfer program flow to another memory location, but a call also pushes a return address onto the PC stack, so it is available when a return from subroutine instruction is later executed. Jumps branch to a new location, with no provision for return.

A return causes the processor to branch to the address stored at the top of the PC stack.

Returns are of two types:

- Return from subroutine (RTS)
- Return from interrupt (RTI)

Both instructions pop the return address off the PC stack, but the RTI instruction also:

- Pops the status stack if the ASTAT and MODE1 status registers have been pushed (if the interrupt was IRQ₂₋₀, the timer interrupt, or the VIRPT vector interrupt).
- Clears the appropriate bit in the interrupt latch register (IRPTL) and the interrupt mask pointer (IMASKP).

You can specify a number of parameters for branches:

• Jumps, calls and returns can be conditional.

The Program Sequencer can evaluate any one of several status conditions to determine whether to take the branch. If no condition is specified, it always takes the branch. • Jumps and calls can be indirect, direct, or PC-relative.

An indirect branch goes to an address that DAG2, one of the data address generators, supplies.

Direct branches jump to the 24-bit address that an immediate field in the branch instruction specifies.

PC-relative branches also use a value that the instruction specifies, but the Program Sequencer adds this value to the current PC value to compute the destination address.

• Jumps, calls and returns can be delayed or nondelayed.

In a delayed branch, the processor executes the two instructions that immediately follow the branch instruction.

In a nondelayed branch, the Program Sequencer suppresses the execution of the two immediately following instructions, so the processor executes NOPs instead.

• If it occurs inside a loop, the JUMP (LA) instruction causes an automatic loop abort.

When the loop aborts, the Program Sequencer pops the PC and loop address stacks once, so if the aborted loop was nested, the stacks still contain the correct values for the outer loop.

JUMP (LA) is similar to the C programming language's break instruction, which prematurely terminates execution of a loop.



You cannot use JUMP (LA) in the last three instructions of a loop.

Delayed and Nondelayed Branches

An instruction modifier DB indicates that a branch is delayed; otherwise, it is nondelayed.

If the branch is nondelayed, the processor does not execute the two instructions after the branch, which are in the fetch and decode stages (see Table 3-5 and Table 3-6). For a call, the decode address (the address of the instruction after the call) is the return address. During the two NOP cycles, the processor fetches and decodes the first instruction at the branch address.

Pipeline	CLK1	CLK2	CLK3	CLK4	
Execute	n	NOP	NOP	j	
Decode	n+1→nop	n+2→nop	j	j+1	
Fetch	n+2	j	j+1	j+2	
	n+1 suppressed	n+2 suppressed; for call, n+1 pushed on PC stack			
n = Branch instruction; j = Instruction at jump or call address					

Table 3-5. Nondelayed jump or call

Pipeline	CLK1	CLK2	CLK3	CLK4		
Execute	n	NOP	NOP	r		
Decode	n+1→nop	n+2→nop	r	r+1		
Fetch	n+2	r	r+1	r+2		
n+1 suppressed n+2 suppressed; r popped from PC stack						
n = Branch instruction; r= Instruction at return address						

Table 3-6. Nondelayed return

In a delayed branch, the processor continues to execute two more instructions while the instruction at the branch address is fetched and decoded (see Table 3-7 and Table 3-8). In the case of a call, the return address is the third address after the branch instruction. A delayed branch is more efficient, but it makes the code harder to understand because instructions execute between the branch instruction and the actual branch.

Pipeline	CLK1	CLK2	CLK3	CLK4
Execute	n	n+1	n+2	j
Decode	n+1	n+2	j	j+1
Fetch	n+2	j	j+1	j+2
For call, n+3 pushed on PC stack				
n = Branch instruction; j= Instruction at jump or call address				

Branches (call, jump, rts, rti)

Pipeline	CLK1	CLK2	CLK3	CLK4	
Execute	n	n+1	n+2	r	
Decode	n+1	n+2	r	r+1	
Fetch	n+2	r	r+1	r+2	
r popped from PC stack					
n = Branch instruction; r= Instruction at return address					

Table 3-8. Delayed return

Because of the instruction pipeline, the processor must execute sequentially a delayed branch instruction and the two instructions that follow it. None of the following instructions can occupy the two locations immediately following a delayed branch instruction.

• PUSH and POP of the PC STACK: Push of the PC stack in the delayed branch should be followed by a pop. A value that is pushed in the delay branch of the call should be popped first in the called subroutine. The pop should then be followed by a return to subroutine "rts." Consider the following example.

```
20119 call foo (db);
2011A push PCSTK;
2011B nop;
2011C foo;
PCSTK 2011B - 2nd push due to PCSTK.
2011C -1st push due to call.
```

This example shows that when you push the PCSTK during a delay slot, the PC stack pointer is pushed onto the PCSTK.

Now you have to execute the following instruction before doing an "rts."

```
pop PCSTK;
rts(db);
nop;
nop;
```

If you do a push of a PC stack, you have to do a pop first and then an "rts." If a value is popped inside the delay branch, the return address of the pushed subroutine is popped back and is, therefore, restricted.

• DO UNTIL: A loop that is inside the delay branch does a sequential operation after executing the loop and does not jump to the label. The reason is because running a loop in a delay branch flushes the destination address of the jump address out of the pipeline. Instead of the fetch, decode and execute stages in the pipeline, the loop instructions are in the pipeline and the operation is sequential thereafter. Look at the following example.

```
20118 LCNTR =10;
20119 jump my(db); 2012C my:
2011A do myl until LCE;
2011B myl:r0 =r0 +r1;
2011C r2=r2+r3;
2011D r1 =r1 +r2;
```

This example shows a loop inside a delay branch. Since the loop executes the instructions inside the loop 10 times, the address of the jump (2012C) destination is flushed. Therefore, instead of going to label "my" (2012C), the processor executes the next sequential instruction at address 2011C and then continues the sequential execution. For this reason, the loop is restricted inside the delay branch. • Regarding the jump, call, or return: You cannot have a jump, call, or return after a jump in a delay branch. The reason for this restriction is demonstrated in this example of a jump instruction:

```
Jump foo(db);
Jump my(db);
R0 =R0+R1;
R1 =R1+R2;
```

In this case the delay branch instruction RO = RO+R1; is executed, but the instruction R1 = R1+R2 is not executed. Also, the control jumps to "my" instead of "foo" because Jump foo is a delay branch instruction.

The exception is for a jump done for mutually exclusive conditions (EQ, NE). If the first EQ condition works, the NE conditional jump does not have any meaning and is like a NOP. Code for the exceptional case is shown below:

```
if eq jump label1 (db);
if ne jump label2 (db);
nop;
nop;
```

- IDLE: To come out of the idle instruction, you need an interrupt. If you put an IDLE instruction inside the delayed branch, the processor will be in the idle state infinitely unless an interrupt is generated. Hence, this action is restricted.
- Writes to PC stack or PC stack Pointer: You can write to a PC stack inside the delay branch by writing to a PC stack inside either a jump or a call.

The two instances of writing to a PC stack inside a jump are described as follows.

- a. The PC stack has a value When the PC stack already has a value and you write a value onto the PC stack, the value already in the PC stack is overwritten by the value written onto the PC stack. Since the value in the PC stack is corrupted, this action is restricted.
- b. The PC stack is empty When you write a value onto an empty PC stack, the PC stack will be empty even after you write the value onto the PC stack.

If you write to a PC stack inside a call, the value that is pushed onto the PC stack because of the call is overwritten by the value written onto the PC stack. Hence, when you do an "rts," you return to the address that you had written onto the PC stack, not the address that you had pushed while branching to the subroutine. The explanation is shown in this example:

```
20111 call foo3(db);
20112 PCSTK=0x2011C;
20113 nop;
20114
```

The value 20114 is pushed onto the PC stack. Since you are also writing the value 2011C to the PC stack, the value 20114 is overwritten by 2011C in the PC stack. When you come back by doing a "rts," you return to the address 2011C, not to 20114. Therefore, this action is restricted.

The ADSP-21000 Family assembler checks for these exceptions.

Since the processor must execute a delayed branch instruction and the two following instructions sequentially, it does not process interrupts between execution of these instructions. The processor latches any interrupt that occurs during these instructions but does not process them until it executes the branch. You can read the PC stack or PC stack pointer immediately after a delayed call or return, but the result will indicate that the return address on the PC stack has been pushed or popped, even though the branch has not actually occurred.

PC Stack

The PC stack holds return addresses for subroutines, interrupt service routines, and top-of-loop addresses for loops. The PC stack is thirty locations deep by 24-bits wide.

The Program Sequencer pops the PC stack during returns from interrupts (RTI), returns from subroutines (RTS), and terminations of loops. The stack is full when all entries are occupied; empty when no entries are occupied; and has overflowed if a call occurs when the stack is already full.

The sticky status register (STKY) stores the full and empty flags. The full flag causes a maskable interrupt.

A PC stack interrupt occurs when twenty-nine locations in the PC stack are filled (the *almost full* state). Entering the interrupt service routine then immediately causes a push on the PC stack, making it full. So, the interrupt is a *stack full interrupt*, even though the condition that triggers it is the *almost full* condition. The other stacks in the Program Sequencer, the loop address stack, loop counter stack, and status stack, are provided with overflow interrupts that are activated when a push occurs while the stack is in a *full* state.

The program counter stack pointer (PCSTKP) is a readable and writable register that contains the address of the top of the PC stack. The value of PCSTKP is 0 when the PC stack is empty; 1, 2,..., 30 when the stack contains data; and 31 when the stack has overflowed. A write to PCSTKP takes effect after a one-cycle delay. If the PC stack has overflowed, a write to PCSTKP has no effect.

Loops (DO UNTIL)

The DO UNTIL instruction provides for efficient software loops, without the overhead of additional instructions to branch, test a condition, or decrement a counter.

A simple example of a loop looks like this:

```
LCNTR=30, D0 label UNTIL LCE;
R0=DM(I0,M0), F2=PM(I8,M8);
R1=R0-R15;
label: F4=F2+F3;
```

When the processor executes a DO UNTIL instruction, the Program Sequencer pushes the address of the last loop instruction and the termination condition for exiting the loop (both specified in the instruction) onto the loop address stack. It also pushes the top-of-loop address, which is the address of the instruction following the DO UNTIL instruction, onto the PC stack.

Because of the instruction pipeline—the fetch, decode, and execute cycles—the processor tests the termination condition before the end of the loop, so the next fetch either exits the loop or returns to the top. (If the loop is counter-based, the Program Sequencer decrements the counter.) Specifically, the Program Sequencer tests the condition when the instruction two locations before the last instruction in the loop executes. (The last instruction resides at location e -2, where e is the end-of-loop address.) If the termination condition is false, the processor fetches the instruction from the top-of-loop address stored on the top of the PC stack. If the termination condition is true, the processor fetches the next

Loops (DO UNTIL)

instruction after the end of the loop and pops the loop stack and PC stack. Table 3-9 and Table 3-10 show these loop operations.

Pipeline	CLK1	CLK2	CLK3	CLK4		
Execute	e -2	e -1	е	b		
Decode	e -1	е	b	b+1		
Fetch	е	b	b+1	b+2		
	Termination con- dition tests false	Loop start address is top of PC stack				
e = Loop end instruction; b = Loop start instruction						

Table 3-9. Loop-Back

Table 3-10. Loop termination

Pipeline	CLK1	CLK2	CLK3	CLK4		
Execute	e -2	e -1	е	e+1		
Decode	e -1	е	e+1	e+2		
Fetch	е	e+1	e+2	e+3		
Termination con- dition tests true popped						
e = Loop end instruction; b = Loop start instruction						

Restrictions and Short Loops

This section describes several programming restrictions placed on loops, and it explains restrictions that result from the three-instruction, fetch-decode-execute pipeline and restrictions that apply specifically to short loops of one and two instructions.

General Restrictions

- Nested loops cannot terminate on the same instruction.
- The last three instructions of a loop cannot be a branch (jump, call, or return).

This restriction also applies to one-instruction loops and two-instruction loops with only one iteration.

This rule has one exception—a nondelayed CALL (no DB modifier) paired with an RTS (LR) return from subroutine with loop reentry modifier. You can use the nondelayed CALL as one of the last three instructions of a loop (except in a one-instruction loop or a two-instruction, single-iteration loop.)

The RTS (LR) instruction ensures proper reentry into a loop. In counter-based loops, for example, to check the termination condition, you decrement the current loop counter (CURLCNTR) while the instruction two locations before the end of the loop is executing. You can then use a nondelayed CALL in one of the last two locations, providing you use an RTS (LR) instruction to return from the subroutine.

The loop reentry (LR) modifier assures proper reentry into the loop by preventing the loop counter from being decremented again (that is, twice for the same loop iteration).

Counter-Based Loops

You cannot issue a write to the counter from memory in the third-to-last instruction of a counter-based loop (at e -2, where e is the end-of-loop address).

Short loops terminate in a special way because of the instruction (fetch-decode-execute) pipeline. So, counter-based loops of one or two instructions are not long enough for the Program Sequencer to check the termination condition two instructions from the end of the loop. In these short loops, the Program Sequencer has already looped back when the termination condition is tested. The Program Sequencer provides special handling to avoid overhead (NOP) cycles if the loop is iterated a minimum number of times. Table 3-11 and Table 3-12 show the details of this operation.

Pipeline	CLK1	CLK2	CLK3	CLK4	CLK5
Execute	n	n+1 (pass 1)	n+1 (pass 2)	n+1 (pass 3)	n+2
Decode	n+1	n+1	n+1	l n+2	
Fetch	n+2	n+1	n+2	n+3	n+4
	LCNTR←3	No opcode latch or fetch addr update; count expired tests true	loop-back aborts; PC & loop stacks popped		

Table 3-11. One-instruction loop, three iterations

In both tables, n=D0 UNTIL instruction and n+2=instruction after the loop.

For no overhead, the processor must execute a loop of length one at least three times and a loop of length two at least twice.

Pipeline	CLK1	CLK2	CLK3	CLK4	CLK5	CLK6
Execute	n	n+1 (pass 1)	n+1 (pass 2)	NOP	NOP	n+2
Decode	n+1	n+1	n+1→nop	n+1→nop	n+2	n+3
Fetch	n+2	n+1	n+1	n+2	n+3	n+4
	LCNTR←2	No opcode latch or fetch addr update	Count expired tests true	loop-back aborts; PC & loop stacks popped		

Table 3-12. One-instruction loop, two iterations (overhead = 2 cycles)

Loops of length one that iterate only once or twice and loops of length two that iterate only once incur two cycles of overhead because of the two aborted instructions after the last iteration to clear the instruction pipeline.

Processing of an interrupt that occurs during the last iteration of a one-instruction loop that executes once or twice, a two-instruction loop that executes once, or the cycle following one of these loops (which is a NOP) is delayed one cycle. Similarly, in a one-instruction loop that executes at least three times (three nitrations), processing is delayed one cycle if the interrupt occurs during the third-to-last iteration.

Noncounter-Based Loops

A noncounter-based loop is one in which the loop termination condition is something other than LCE. When a noncounter-based loop is the outer

Loops (DO UNTIL)

loop in a series of nested loops, the end address of the outer loop must be located at least two addresses after the end address of the inner loop.

To abort execution of a loop prematurely, use the JUMP (LA) instruction. When this instruction is located in the inner loop of a series of nested loops, and the outer loop is noncounter-based, the address the program jumps to cannot be the outer loop's last instruction. It can, however, be the next-to-last instruction (or any earlier instruction).

Noncounter-based short loops terminate in a special way because of the instruction pipeline (fetch-decode-execute):

• In a three-instruction loop, the Program Sequencer tests the termination condition when the processor executes the top-of-loop instruction.

When the condition becomes true, the Program Sequencer completes one full pass of the loop before exiting it.

• In a two-instruction loop, the termination condition is checked during the last (second) instruction. See Table 3-13 and Table 3-14 on page 3-31 and page 3-32, respectively.

If the condition becomes true when the first instruction is executed, it tests true during the second, and the Program Sequencer completes one more full pass before exiting the loop.

If the condition becomes true during the second instruction, however, the Program Sequencer completes two more full passes before exiting the loop.

In a one-instruction loop, the termination condition is checked every cycle. When the condition becomes true, the Program Sequencer executes the loop three more times before exiting it.

Pipeline	CLK1	CLK2	CLK3	CLK4	CLK5	CLK6
Execute	n	n+1 (pass1)	n+2 (pass1)	n+1 (pass2)	n+2 (pass2)	n+3
Decode	n+1	n+2	n+1	n+2	n+3	n+4
Fetch	n+2	n+1	n+2	n+3	n+4	n+5
	LCNTR←2	PC stack sup- plies loop start addr	last fetch causes cond. test; tests true	Loop- back- aborts; PC & loop stacks popped		

Table 3-13. Two-instruction loop, two iterations

In both examples, n=DO UNTIL instruction and n+3=instruction after the loop.

Loops (DO UNTIL)

Pipeline	CLK1	CLK2	CLK3	CLK4	CLK5	CLK6
Execute	n	n+1 (pass1)	n+2 (pass1)	NOP	NOP	n+3
Decode	n+1	n+2	n+1→nop	n+2→nop	n+3	n+4
Fetch	n+2	n+1	n+2	n+3	n+4	n +5
	LCNTR←1	PC stack sup- plies loop start addr	last fetched instruc- tion causes cond. test; tests true	loop- back aborts; PC & loop stacks popped		

Table 3-14. Two-instruction loop, one iteration (overhead = 2 cycles)

Loop Address Stack

The loop address stack is six levels deep by 32-bits wide. The 32-bit word of each level consists of a 24-bit loop termination address, a 5-bit termination code, and a 2-bit loop type code.

Table 3-15. Layout of the Loop Address Stack

Bits	Value
0-23	loop termination address
24-28	termination code

Bits	Value
29	reserved (always reads 0)
30-31	loop type code
	00 = arithmetic condition-based (not LCE) 01 = counter-based, length 1
	10 = counter-based, length 2
	11 = counter-based, length > 2

Table 3-15. Layout of the Loop Address Stack (Cont'd)

The processor stacks the loop termination address, termination code, and loop type code when it executes a DO UNTIL or a PUSH LOOP instruction. It pops the stack two instructions before the end of the last loop iteration or when it executes a POP LOOP instruction. A stack overflows if a push occurs when all entries in the loop stack are occupied. The stack is empty when no entries are occupied. The sticky status register (STKY) contains the overflow and empty flags. Overflow causes a maskable interrupt.

The LADDR register contains the top of the loop address stack. It is readable and writable over the DM Data bus. Reading and writing LADDR does not move the loop address stack pointer, but a stack push or pop, performed with explicit instructions, does move the stack pointer. LADDR contains the value 0xFFFF FFFF when the loop address stack is empty.

Because the Program Sequencer checks the termination condition two instructions before the end of the loop, it pops the loop stack before the end of the loop on the final iteration. If LADDR is read at either of these instructions, the value will no longer be the termination address for the loop. A jump out of a loop pops the loop address stack (and the loop count stack if the loop is counter-based) if the Loop Abort (LA) modifier is specified for the jump. This action enables the loop mechanism to continue functioning correctly. Only one pop is performed, however, so you cannot use the loop abort to jump more than one level of nesting.

Loop Counters and Stack

The loop counter stack is six levels deep by 32-bits wide. The loop counter stack works in synchronization with the loop address stack—both stacks always have the same number of locations occupied. So, the same empty and overflow status flags apply to both stacks.

The processor's Program Sequencer operates two separate loop counters:

• The current loop counter (CURLCNTR)

Tracks iterations for an executing loop.

• The loop counter (LCNTR)

Holds the initial count value of the loop before it is executed. While setting up the count for an inner loop, two counters are needed to maintain the count for the outer loop.

The Current Loop Counter (CURLCNTR)

The top entry in the loop counter stack always contains the loop count currently in effect. This entry is the CURLCNTR register, which is readable and writable over the DM Data bus. A read of CURLCNTR when the loop counter stack is empty gives the value <code>0xFFFF FFF.</code>

The Program Sequencer decrements the value of CURLCNTR for each loop iteration. Because it checks the termination condition two instruction cycles before the end of the loop, the Program Sequencer also decrements the loop counter before the end of the loop. So, if you read CURLCNTR at either of the last two loop instructions, the value read is the count for the next iteration.

The processor pops the loop counter stack two instructions before the end of the last loop iteration. When it does so, the new top entry of the stack becomes the CURLCNTR value, the count in effect for the executing loop. If no loop is executing, the value of CURLCNTR is 0xFFFF FFFF after the pop.

Writing CURLCNTR does not cause a stack push. So, if you write a new value to CURLCNTR, you change the count value of the loop currently executing. A write to CURLCNTR when no DO UNTIL LCE loop is executing has no effect.

Because the processor must use CURLCNTR to perform counter-based loops, some restrictions exist that determine when you can write CURL-CNTR. As mentioned earlier, you cannot issue a write to CURLCNTR from memory in the third-to-last instruction of a DO UNTIL LCE loop. You also cannot issue a write to CURLCNTR from memory in the instruction that follows an IF NOT LCE instruction.

The Loop Counter (LCNTR)

LCNTR is the value of the top of the loop counter stack plus one; that is, it is the location on the stack that takes effect on the next push of the loop stack. To set up a count value for a nested loop, without affecting the count value of the loop currently executing, you write the count value to LCNTR. A value of 0 in LCNTR causes a loop to execute 2^{32} times.

The DO UNTIL LCE instruction pushes the value of LCNTR on the loop count stack, so it becomes the new CURLCNTR value. Figure 3-3 on page 3-36 shows this process. The previous CURLCNTR value is preserved one location down in the stack.



Figure 3-3. Pushing the loop counter stack for nested loops

- 1. The processor is not executing a loop, and the loop counter stack is empty. The Program Sequencer loads LCNTR with aaaa aaaa.
- 2. The processor is executing a single loop. The Program Sequencer loads LCNTR with the value bbbb bbbb.

- 3. The processor is executing two nested loops. The Program Sequencer loads LCNTR with the value cccc cccc.
- 4. The processor is executing three nested loops. The Program Sequencer loads LCNTR with the value dddd dddd.
- 5. The processor is executing four nested loops. The Program Sequencer loads LCNTR with the value eeee eeee.
- 6. The processor is executing five nested loops. The Program Sequencer loads LCNTR with the value ffff ffff.
- 7. The processor is executing six nested loops. The loop counter stack (LCNTR) is full.

A read of LCNTR when the loop counter stack is full results in invalid data. When the loop counter stack is full, the processor discards any data written to LCNTR.

If you read LCNTR during the last two instructions of a terminating loop, its value is the last CURLCNTR value for the loop.

Interrupts

A variety of conditions, both internal and external to the processor, cause interrupts. An interrupt forces a subroutine call to a predefined address, the interrupt vector. The processor assigns a unique vector to each type of interrupt.

Externally, the processor supports three prioritized, individually maskable interrupts, each of which can be either level- or edge-triggered (MODE2 register). An external device asserting one of the processor's interrupt inputs (\overline{IRQ}_{2-0}) causes these interrupts.

Arithmetic exceptions, stack overflows, and circular data buffer overflows are some of the internally-generated interrupts.

The processor deems an interrupt request valid if all of the following conditions are true:

- The request is not masked;
- Interrupts are globally enabled (IRPTEN=1);
- No higher-priority request is pending.

Valid requests invoke an interrupt service sequence that branches to the address reserved for that interrupt. Interrupt vectors are spaced at intervals of four instructions, but applications can branch to another region of memory to accommodate longer service routines. Program execution returns to normal sequencing when the processor executes an RTI (return from interrupt) instruction.

The processor cannot service an interrupt unless its core is executing instructions or is in the IDLE state. IDLE and IDLE16 are a special instructions that halt the processor's core until an external interrupt or a timer interrupt occurs.

To process an interrupt, the processor's Program Sequencer performs these actions:

- 1. Outputs the appropriate interrupt vector address.
- 2. Pushes the current PC value (the return address) on the PC stack.

If the interrupt is an external interrupt (\overline{IRQ}_{2-0}), the internal timer interrupt, or the VIRPT multiprocessor vector interrupt, the Program Sequencer pushes the current value of the ASTAT and MODE1 registers onto the status stack.

- 3. Sets the appropriate bit in the interrupt latch register (IRPTL).
- 4. Updates the interrupt mask pointer (IMASKP) to reflect the current interrupt nesting state.

The nesting mode (NESTM) bit in the MODE1 register determines whether all interrupts or only lower priority interrupts are masked during the service routine.

At the end of the interrupt service routine, the RTI instruction causes the Program Sequencer to perform these actions:

- 1. Returns to the address stored at the top of the PC stack.
- 2. Pops this value off of the PC stack.
- 3. Pops the status stack if the ASTAT and MODE1 status registers were pushed (for the \overline{IRQ}_{2-0} external interrupts, timer interrupt, or VIRPT vector interrupt).
- 4. Clears the appropriate bit in the interrupt latch register (IRPTL) and interrupt mask pointer (IMASKP).

Make sure your interrupt service routines, except for reset, end with a return-from-interrupt (RTI) instruction. After reset, the PC stack is empty and no return address exists, so make sure the last instruction of your reset service routine is a jump to the start of your program.

Interrupts

Interrupt Latency

The processor responds to interrupts in three stages:

- Synchronization and latching (1 cycle).
- Recognition (1 cycle).
- Branching to the interrupt vector (2 cycles).

In Table 3-16, n = a single instruction cycle, and v = instruction at the interrupt vector.

Pipeline	CLK1	CLK2	CLK3	CLK4	CLK5
Execute	n-1	n	NOP	NOP	V
Decode	n	n+1→NOP	n+2→NOP	V	v+1
Fetch	n+1	n+2	V	v+1	v+2
	Interrupt occurs	Interrupt recognized	n+1 pushed on PC stack; interrupt vector output		

Table 3-16. Interrupt, single-cycle instruction

If software writes to a bit in IRPTL forcing an interrupt, the processor recognizes the interrupt in the following cycle, and two cycles of branching to the interrupt vector follow the recognition cycle. In Table 3-17, n = an instruction coinciding with a cache miss of a data access of program memory, and v = instruction at the interrupt vector.

Pipeline	CLK1	CLK2	CLK3	CLK4	CLK5	CLK6
Execute	n-1	n	NOP	NOP	NOP	V
Decode	n	n+1→NOP	n+1→NOP	n+2→NOP	V	v+1
Fetch	n+1	_	n+2	V	v+1	v+2
	Inter- rupt occurs	Inter- rupt rec- ognized, but not pro- cessed; program memory data access	Inter- rupt pro- cessed	n+1 pushed onto PC stack; inter- rupt vector output		

Table 3-17. Interrupt, program memory data access with cache miss

In Table 3-18, n = a delayed branch instruction, v = instruction at the interrupt vector, and j = instruction at the branch address.

Interrupts

Pipeline	CLK 1	CLK 2	CLK 3	CLK 4	CLK 5	CLK 6	CLK 7
Execute	n-1	n	n+1	n+2	NOP	NOP	V
Decode	n	n+1	n+2	j→NOP	j+1→NOP	V	v+1
Fetch	n+1	n+2	j	j+1	V	v+1	v+2
	Inter- rupt occurs	Inter- rupt recog- nized, but not pro- cessed		For call, n+3 pushed on PC stack; inter- rupt pro- cessed	j pushed on PC stack; inter- rupt vector output		

Table 3-18. Interrupt, delayed branch

For most interrupts, internal and external, the core executes only one instruction after the interrupt occurs (and before the two instructions abort), while the processor fetches and decodes the first instruction of the service routine. After an arithmetic exception, however, two cycles occur before the processor starts processing an interrupt because of the one-cycle delay between an arithmetic exception and the update of the STKY register.

Table 3-19 on page 3-43 lists and the standard latency associated with the \overline{IRQ}_{2-0} interrupts and the multiprocessor vector interrupt.
Table 3-19. Minimum latency of the \overline{IRQ}_{2-0} and VIRPT interrupts

Interrupt	Minimum Latency
IRQ ₂₋₀	3 cycles
VIRPT	6 cycles

If nesting is enabled and a higher priority interrupt occurs immediately after a lower priority interrupt, the service routine of the higher priority interrupt is delayed one additional cycle. (See "Interrupt Nesting and IMASKP" on page 3-46.) This delay enables execution of the first instruction of the lower priority interrupt routine before that routine is interrupted.

Certain processor operations that span more than one cycle hold off interrupt processing. If an interrupt occurs during one of these operations, the processor synchronizes and latches it, but delays processing it. The operations that delay interrupt processing this way are:

- A branch (call, jump, or return) and the following cycle, whether it is an instruction (in a delayed branch) or a NOP (in a nondelayed branch)
- The first of the two cycles needed to perform a program memory data access and an instruction fetch (when an instruction cache miss occurs).
- The third-to-last iteration of a one-instruction loop.
- The last iteration of a one-instruction loop executed once or twice, or the last iteration of a two-instruction loop executed once and the following cycle (which is a NOP).

- The first of the two cycles needed to fetch and decode the first instruction of an interrupt service routine.
- Wait states for external memory accesses.
- An external memory access when the processor does not have control of the external bus (during a host bus grant or when the processor is a bus slave in a multiprocessing system).

Interrupt Vector Table

The IRPTL and IMASK registers contain all processor interrupts. For a complete list and detailed information, see Appendix F, Interrupt Vector Addresses, in *ADSP-21065L SHARC DSP Technical Reference*.

Interrupt Latch Register (IRPTL)

The interrupt latch (IRPTL) register is a 32-bit register that latches interrupts. It indicates all interrupts the processor is currently servicing and those that are pending. Because this register is readable and writable, software can set or clear any interrupt, except reset. Writing to the reset bit (bit 1) in IRPTL places the processor in an illegal state.

When an interrupt occurs, it sets the corresponding bit in IRPTL. During execution of the interrupt's service routine, this bit remains cleared—the processor clears it during each cycle. This scheme prevents the processor from latching the same interrupt while it executes the interrupt's service routine.

A special method, however, enables applications to reuse an interrupt while the processor is servicing it. The clear interrupt (CI) modifier of the JUMP instruction provides this capability. See "Clearing the Current Interrupt for Reuse" on page 3-49.

IRPTL is cleared by a processor reset. The bits in the IMASK register correspond exactly to those in IRPTL.

Interrupt Priority

The interrupt bits in IRPTL are ordered by priority. The interrupt priority ranks from 0 (highest) to 31 (lowest).

Interrupt priority determines which interrupt the processor services first when more than one occurs in the same cycle and which interrupts are nested when nesting is enabled (see "Interrupt Nesting and IMASKP" on page 3-46).

The arithmetic interrupts—fixed-point overflow and floating-point overflow, underflow, and invalid operation—are determined from flags in the sticky status register (STKY). Reading these flags, the service routine for one of these interrupts determines which condition caused the interrupt. The service routine must clear the appropriate STKY bit, to prevent the interrupt from remaining active after the service routine has finished.

When enabled, both of the programmable timers generate interrupts according to the operation mode in which they are set. You use the INT_HIx bits in the MODE2 register to configure each timer to either bit 4, TMZHI, or to bit 23, TMZLI of the IRPTL register. You can mask both of these interrupts in the IMASK register. (For details on configuring and using the programmable timers, see Chapter 11, Programmable Timers and I/O Ports.)

The programmable timer feature enables you to choose the priority of the timer interrupt. You can configure both timers to latch to the same location or each timer to latch to a separate location. But, only the timer interrupt on the TMZHI bit pushes the status stack.

When both timers latch to the same location, the processor logically ORs both inputs and latches the value in the appropriate bit in the IRPTL register. To determine its source and service the interrupt, you must check its CNT_EXPx or PULSE_CAPx status bit in the STKY register.

Interrupt Masking and Control

To enable and disable all interrupts, except reset, you set the global interrupt enable bit, IRPTEN, bit 12 in the MODE1 register. The processor clears this bit at reset. You must set this bit to enable interrupts.

Interrupt Mask Register (IMASK)

You can mask all interrupts, except reset. Masked means disable. Since the processor still latches (in IRPTL) interrupts that are masked, it processes interrupts that later become unmasked.

The IMASK register controls interrupt masking. The bits in IMASK correspond exactly to the bits in the IRPTL register.

For example, bit 10 in IMASK masks or unmasks the same interrupt that bit 10 in IRPTL latches.

- If a bit in IMASK is set (1), its interrupt is unmasked (enabled).
- If the bit is cleared (0), the interrupt is masked (disabled).

After reset, all interrupts except for reset and the EP0I interrupt for external port DMA channel 8 (bit 16 of IMASK) are masked. The reset interrupt is always nonmaskable. The processor automatically unmasks the EP0I interrupt after reset if an EPROM or a host is booting the processor.

Interrupt Nesting and IMASKP

The processor supports nesting of one interrupt service routine inside another. That is, a higher priority interrupt can interrupt a service routine. The nesting mode bit (NESTM) in the MODE1 register controls this feature.

NESTM=0	Disable interrupt service routine nesting.

The processor services any interrupt that occurs, but only after the routine finishes.

NESTM=1 Enable interrupt service routine nesting.

Higher priority interrupts can interrupt if they are not masked, but lower or equal priority interrupts cannot interrupt.

Make sure to change the NESTM bit outside of an interrupt service routine or during the reset service routine only. Otherwise, interrupt nesting may not work correctly.

If nesting is enabled and a higher priority interrupt occurs immediately after a lower priority interrupt, the service routine of the higher priority interrupt is delayed one cycle. This enables execution of the first instruction of the lower priority interrupt routine before the routine is interrupted.

In nesting mode, the processor uses the interrupt mask pointer (IMASKP) to create a temporary interrupt mask for each level of interrupt nesting the IMASK value is not affected. The bits in IMASKP correspond to the same bits in IRPTL and IMASK and in the same order of priority. When an interrupt occurs, it sets its corresponding bit in IMASKP. The processor changes IMASKP each time a higher priority interrupt interrupts a lower priority service routine. So, the bit in IMASKP that has the highest priority always corresponds to the interrupt the processor is servicing.

To generate a new temporary interrupt mask when nesting is enabled, the Program Sequencer masks all interrupts of equal or lower priority to the highest priority bit set in IMASKP and keeps higher priority interrupts the same as in IMASK. When it executes a return from an interrupt service routine (RTI), the Program Sequencer clears the highest priority bit set in IMASKP and masks all interrupts of equal or lower priority to the new highest priority bit set in IMASKP.

Interrupts

If nesting is disabled, the Program Sequencer masks out all interrupts and does not use IMASKP, although it still updates IMASKP to create a temporary interrupt mask.

The Program Sequencer updates IRPTL, but the processor does not vector to an interrupt that occurs while the processor is executing the interrupt's service routine. The processor waits until the RTI finishes before vectoring to the service routine again.

Status Stack Save and Restore

For low-overhead interrupt servicing, the processor automatically saves and restores the status and mode contexts of the interrupted program. The three external interrupts (\overline{IRQ}_{2-0}), the timer interrupt, and the VIRPT vector interrupt cause an automatic push of ASTAT and MODE1 onto the status stack, which is five levels deep. The return from interrupt instruction RTI (and the JUMP (CI) instruction automatically pops these registers from the status stack. (See "Clearing the Current Interrupt for Reuse" on page 3-49.)

Only \overline{IRQ}_{2-0} , timer, and VIRPT interrupts push the status stack. All other interrupts require an explicit save and restore of the appropriate registers to memory.

Pushing ASTAT and MODE1 preserves the status and control bit settings, so if the service routine alters these bits, the return from interrupt, RTI, automatically restores the original settings.

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Pushes and pops of the status stack do not affect the $FLAG_{3-0}$ bits in ASTAT. The values of these bits carry over from the main program to the service routine and from the service routine back to the main program. The top of the status stack contains the current values of ASTAT and MODE1. Reading and writing these registers does not move the stack pointer. Explicit PUSH and POP instructions, however, do move the stack pointer.

Software Interrupts

The processor provides software interrupts that emulate interrupt behavior but are activated through software instead of hardware.

Setting one of bits 28-31 in IRPTL with either a BIT SET instruction or a write to IRPTL activates a software interrupt. The processor branches to the corresponding interrupt routine if that interrupt is unmasked and interrupts are enabled.

Clearing the Current Interrupt for Reuse

Normally, the processor ignores and does not latch an interrupt that reoccurs while its service routine is executing. When the interrupt initially occurs, it sets its corresponding bit in IRPTL. During execution of the service routine, this bit remains cleared—the processor clears the bit during each cycle, preventing the processor from latching the same interrupt while it is executing the interrupt's service routine.

The clear interrupt (CI) modifier of the JUMP instruction, however, enables an application to reuse an interrupt while it is undergoing servicing. This capability is useful in systems that require fast interrupt response and low interrupt latency. Be sure to place the JUMP (CI) instruction within the interrupt service routine. JUMP (CI) clears the status of the current interrupt without leaving the interrupt service routine. This reduces the interrupt routine to a normal subroutine and enables the interrupt to occur again, as a result of a different event or task in the system.

Interrupts

To reduce an interrupt service routine to a normal subroutine, the JUMP (CI) instruction clears the appropriate bit in the interrupt latch register (IRPTL) and interrupt mask pointer (IMASKP) and pops the status stack. This prevents the processor from clearing the interrupt's latch bit (in IRPTL) in every cycle automatically, so the interrupt can occur again.

When returning from such a subroutine, the application must use the (LR) modifier of the RTS instruction (in case the interrupt occurred during the last two instructions of a loop). For details, see "General Restrictions" on page 3-27.

The following example shows how to use the (CI) modifier to reduce an interrupt service routine to a subroutine:

```
instr1; {interrupt entry from main program}
JUMP(PC,3)(DB,CI); {clear interrupt status}
instr3;
instr4;
instr5;
RTS (LR); {use LR modifier w/return from subrtn}
```

The JUMP(PC,3)(DB,CI) instruction continues linear execution flow only by jumping to the location PC + 3 (instr5), with the processor executing the two intervening instructions (instr3, instr4) because of the delayed branch (DB). This JUMP instruction is only an example—a JUMP (CI) can jump to any location.

External Interrupt Timing and Sensitivity

Each of the processor's three external interrupts, \overline{IRQ}_{2-0} , can be either level- or edge-triggered.

The processor samples interrupts twice every CLKIN cycle. Level-sensitive interrupts are considered valid if sampled active (low). A level-sensitive interrupt must go inactive (high) before the processor returns from the interrupt service routine. If a level-sensitive interrupt is still active when the processor samples it, the processor treats it as a new request, repeating

the same interrupt routine without returning to the main program (assuming no higher priority interrupts are active).

Edge-triggered interrupt requests are considered valid if sampled high in one cycle and low in the next. The interrupt can stay active indefinitely. To request another interrupt, the signal must go high, then low again.

Since they never a need to negate the request, edge-triggered interrupts require less external hardware than level-sensitive requests. However, multiple interrupting devices can share a single level-sensitive request line on a wired-OR basis, which provides for easily expanded systems.

A bit for each interrupt in the MODE2 register indicates the sensitivity mode of each interrupt.

Bit	Name	Definition
0	IRQOE	1 = edge-sensitive; 0 = level-sensitive
1	IRQ1E	1 = edge-sensitive; 0 = level-sensitive
2	IRQ2E	1 = edge-sensitive; 0 = level-sensitive

Table 3-20. MODE2 interrupt mode bits

The processor accepts interrupts that are asynchronous to its clock; that is, an interrupt signal may change at any time. An asynchronous interrupt must be held low at least one CLKIN cycle to guarantee its sampling. Synchronous interrupts need only meet the setup and hold time requirements relative to the rising edge of CLKIN, as specified in the processor's data sheet.

Asynchronous External Interrupts

Vector interrupts are used for interprocessor commands in multiprocessor systems. When an external processor, either another ADSP-21065L or a host, writes an address to the VIRPT register, it causes a vector interrupt.

Interrupts

Multiprocessor Vector Interrupts (VIRPT)

When it services the vector interrupt, the processor automatically pushes the status stack and begins executing the service routine located at the address specified in VIRPT. The lower twenty-four bits of VIRPT contain the address, and applications can use the upper eight bits as data for the interrupt service routine. At reset, the processor initializes VIRPT to the standard address in the its interrupt vector table.

The minimum latency for vector interrupts is six cycles, five of which are NOPs. When the RTI (return from interrupt) instruction is reached in the service routine, the processor automatically pops the status stack.

The VIPD bit in SYSTAT reflects the status of the VIRPT register. If VIRPT is written while a previous vector interrupt is pending, the new vector address replaces the pending one. If VIRPT is written while a previous vector interrupt is undergoing servicing, the processor ignores the new vector address, so no new interrupt is triggered. If the processor writes to its own VIRPT register, the write is ignored.

To use the processor's vector interrupt feature, external processors perform these actions:

- 1. Poll the VIRPT register until it reads a certain token value (0).
- 2. Write the vector interrupt service routine address to VIRPT.

When the service routine has finished, it writes the token back to VIRPT to indicate that it is done and that the processor can initiate another vector interrupt.

Programmable Timers

The processor includes two programmable timers that your application can configure and use in either timer counter mode or in pulse counter/capture mode.

Each timer has one input/output pin—PWM_EVENTx. In timer counter mode (PMWOUT), this pin functions as an output pin, and in pulse counter/capture mode (WIDTH_CNT), this pin functions as an input pin.

Each timer has three registers—TPERIODx, TPWIDTHx, and TCOUNTx—that support timer functions. All timer registers are thirty-two bits wide, and the counters (TCOUNTx) use the system clock (2x CLKIN), which evaluates to a maximum period of 71.5 sec ($(2^{32} - 1) \times 16.67$ ns system clock cycles) for the timer count.

For more details, see Chapter 11, Programmable Timers and I/O Ports.

Stack Flags

As shown in Table 3-21, the STKY status register maintains stack full and stack empty flags for the PC stack as well as overflow and empty flags for the status stack and loop stack. Unlike other bits in STKY, several of these flag bits are not "sticky." They are set by the occurrence of the corresponding condition and are cleared when the condition is changed (by a push, pop, or processor reset).

Bit	Name	Definition	State	Set/Cleared by
21	PCFL	PC stack full	Not sticky	Рор
22	PCEM	PC stack empty	Not sticky	Push
23	SSOV	Status stack over- flow	Sticky	RESET
24	SSEM	Status stack empty	Not sticky	Push
25	LSOV	Loop stacks ¹ over- flow	Sticky	RESET
26	LSEM	Loop stacks ¹ empty	Not sticky	Push

Table 3-21. STKY status register flags

Loop address stack and loop counter stack.

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The status stack flags are read-only. Writes to the STKY register have no effect on these bits.

The overflow and full flags are provided for diagnostic aid only and are not intended to enable recovery from overflow. Status stack or loop stack overflow or PC stack full causes an interrupt. The empty flags facilitate stack saves to memory. You monitor the empty flag when saving a stack to memory to know when all values have been transferred. The empty flags do not cause interrupts because an empty stack is an acceptable condition.

Idle and Idle16

IDLE and IDLE16 are special instructions that halt the processor's core in a low-power state until an external interrupt (\overline{IRQ}_{2-0}), timer interrupt, DMA interrupt, or VIRPT vector interrupt occurs.

When it executes an IDLE instruction, the processor fetches one more instruction at the current fetch address before suspending operation. The IDLE instruction does not affect the processor's I/O processor, so any DMA transfers to or from internal memory continue uninterrupted.

Both the processor's internal clock and the timer (if enabled) continue to run during IDLE. When an external interrupt (\overline{IRQ}_{2-0}), timer interrupt, DMA interrupt, or VIRPT vector interrupt occurs, the processor responds normally. After two cycles incurred in fetching and decoding the first instruction of the interrupt service routine, the processor continues executing instructions normally.

The IDLE16 instruction is a lower power version of the IDLE instruction. It executes a NOP and puts the processor in a low power state. Like the IDLE instruction, IDLE16 halts the processor, but the internal clock continues to run at 1/16th the rate of CLKIN.



While the processor is in IDLE16 mode, do not perform DMA transfers, SPORT transfers, or host transfers.

The processor remains in the low power state until an interrupt occurs.

To exit IDLE16, your application software can:

- Assert the external \overline{IRQx} pin.
- Generate a timer interrupt.

After returning from the interrupt, execution continues at the instruction following the IDLE16 instruction.

During IDLE16, the processor does not support:

• Host accesses

Make sure your application software does not assert HBR.

- Multiprocessor bus arbitration (synchronous accesses)
- External port DMA
- SDRAM accesses
- Serial port transfers

Instruction Cache

The processor's on-chip instruction cache is a two-way, set-associative cache with entries for thirty-two instructions. This cache operates transparently to the programmer.

The processor caches only instructions that conflict with program memory data accesses (over the PMD bus with DAG2 generating the address on the PMA bus). This feature increases the efficiency of the cache considerably, surpassing performance of a cache that loads every instruction since, typically, only a few instructions must access data from a block of program memory.

Because of the three-stage instruction pipeline, if the instruction at address n requires a data access of program memory, it creates a conflict with the instruction fetch at address n+2, assuming sequential execution. The processor stores the fetched instruction (n+2) in the instruction cache, not the instruction that requires the data access of program memory.

If the instruction the processor needs is in the cache, a *cache hit* occurs the cache provides the instruction while the processor performs a data access of program memory.

If the instruction the processor needs is not in the cache, a *cache miss* occurs, and the instruction fetch (from memory) takes place in the cycle following the data access of program memory and incurs one cycle of overhead. The Program Sequencer loads this instruction into the cache if the cache is enabled and not frozen, so the instruction (requiring program memory data) is available the next time the processor executes it.

Cache Architecture

Figure 3-4 on page 3-59 shows a block diagram of the instruction cache. The cache contains thirty-two entries. An entry consists of a register pair

that contains an instruction and its address. Each entry has a *valid* bit, which is set if the entry contains a valid instruction.

The entries are divided into sixteen sets (numbered 15-0) of two entries each, entry 0 and entry 1. Each set has an LRU (Least Recently Used) bit whose value indicates which of the two entries contains the least recently used instruction (1=entry 1, 0=entry 0).

Each possible instruction address is mapped to a set in the cache by its four LSBs. When the processor needs to fetch an instruction from the cache, it uses the four address LSBs as an index to a particular set. Within that set, it checks the addresses of the two entries to see whether either contains the needed instruction. A *cache hit* occurs if the instruction is found, and the LRU bit is updated, if necessary, to indicate the entry that did not contain the needed instruction.



Figure 3-4. Instruction Cache architecture

A *cache miss* occurs if neither entry in the set contains the needed instruction. If so, the processor loads a new instruction and its address into the least recently used entry of the set that matches the four LSBs of the address. It toggles the LRU bit to indicate that the other entry in the set is now the least recently used entry. Because the processor uses the four address LSBs of instructions to map them to sets, it doesn't need to store these bits in the cache. The set in which the instruction has been stored implies the four address LSBs. A cache entry actually stores only bits 23:4.

Cache Efficiency

Usually, cache operation and its efficiency is not a concern. However, some situations can degrade cache efficiency, but your application can easily remedy them.

When a *cache miss* occurs, the Program Sequencer loads the needed instruction into the cache, so if the same instruction is needed again, it is already there (causing a *cache hit*). However, if another instruction whose address is mapped to the same set displaces this instruction, a *cache miss* occurs. The LRU bits reduce cache misses since it takes fetches of at least two other instructions mapped to the same set to displace an instruction. If the processor repeatedly needs all three instructions mapped to the same set, cache efficiency (*hit rate*) can fall to zero (0). To avoid this, move one or more of the instructions to a new address, one that is mapped to a different set.

Listing 3-1 is an example of cache-inefficient code:

Listing 3-1. Cache-inefficient code example

Address		
0x0100		<pre>lcntr=1024, do tight until lce;</pre>
0x0101		r0=dm(i0,m0), pm(i8,m8)=f3;
0x0102		r1=r0-r15;
0x0103		if eq call (sub);
0x0104		f2=float r1;
0x0105		f3=f2*f2;
0x0106	tight:	f3=f3+f4;
0x0107		pm(i8,m8)=f3;

The data access of program memory at address 0x101 in the tight loop causes the Program Sequencer to cache the instruction at 0x103 (in set 3).

Each time the application calls the subroutine sub, the program memory data accesses at 0x201 and 0x211 load the instructions at 0x203 and 0x213 into set 3 and displace this instruction. If the subroutine is called only rarely during the loop execution, the impact will be minimal. If the subroutine is called frequently, the effect will be noticeable.

If the execution of the loop is time-critical, moving the subroutine up one location (starting at 0x201) is advisable, so the two cached instructions end up in set 4 instead of in set 3.

Cache Disable and Cache Freeze

Freezing the cache prevents any changes to its contents—a cache miss does not result in storage of a new instruction in the cache.

Disabling the cache stops its operation completely. The access delays all instruction fetches that conflict with data accesses of program memory.

Instruction Cache

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Bit 4 (CADIS) directs the sequencer to disable the cache (if 1) or enable the cache (if 0). Disabling the cache does not mark the current content of the cache as invalid. If the cache is enabled again, the existing content is used again. To clear the cache, use the FLUSH CACHE instruction.

If you are using self-modifying code (for example, software loader kernel) or software overlays, execute a FLUSH CACHE instruction followed by a NOP before executing the new code. Otherwise, old content from the cache could still be used, even though the code has changed.

The CADIS (cache enable/disable) and CAFRZ (cache freeze) bits in the MODE2 register select the functions shown in Table 3-22.

Table 3-22. MODE2 CADIS and CAFRZ bits

Bit	Name	Function
4	CADIS	Cache Disable
19	CAFRZ	Cache Freeze

After reset, the cache is cleared, so it contains no instructions, but is unfrozen and enabled.

Do not place an instruction that contains a data access of program memory directly after a cache enable or a cache disable instruction—the processor must wait at least one cycle before executing the PM data access. You can insert a NOP instruction to provide this delay.

4 DATA ADDRESSING

Maintaining pointers into memory, the processor's two data address generators (DAGs) simplify the task of organizing data. The DAGs enable the processor to address memory indirectly; that is, an instruction specifies a DAG register that contains the address of a value instead of the value.

Data address generator 1 (DAG1) generates 32-bit addresses on the DM Address Bus. Data address generator 2 (DAG2) generates 24-bit addresses on the PM Address Bus. Figure 4-1 on page 4-3 shows the basic architecture of both DAGs. For details, see "Generating Addresses for the PM and DM Buses" on page 5-11.

The DAGs provide hardware support for some functions commonly used in digital signal processing algorithms. Both DAGs support circular data buffers, which require software to advance a pointer repetitively through a range of memory locations. Both DAGs can also perform a bit-reversing operation, which outputs the bits of an address in reversed order.

DAG Registers

Each DAG has four types of registers: Index (I), Modify (M), Base (B), and Length (L).

An I register acts as a pointer to memory, and an M register contains the value to increment the pointer. To vary the increment as needed, you modify an I register with different M values.

B and L registers work with circular data buffers only. These buffers operate in pairs: B0 with L0, B4 with L4, B12 with L12, and so on. The B register holds the base address (first address) of a circular buffer. The corresponding L register contains the number of locations in the circular buffer, defining its length.

Each DAG contains eight of each register type, as shown in Table 4-1.

DAG1 (32-bit)	DAG2 (24-bit)
B0 - B7	B8-B15
I O - I 7	I8-I15
M0 - M7	M8-M15
L0-L7	L8-L15

Table 4-1. DAG registers



Figure 4-1. Architecture of the data address generators (DAGs)

Alternate DAG Registers

To implement context switching, each DAG register has an alternate register. Figure 4-2 on page 4-4 shows how each DAG is organized into upper and lower halves for activating its alternate registers.



Figure 4-2. Alternate DAG registers

The upper half of DAG1 contains I, M, B and L registers 4 through 7, and the lower half contains I, M, B and L registers 0 through 3.

Likewise, the upper half of DAG2 contains I, M, B and L registers 12 through 15, and the lower half contains I, M, B and L registers 8 through 11.

Table 4-2 shows the control bits in the MODE1 register that determine, for each half, whether the DAG's primary or alternate registers are active.

Bit	Name	Definition
3	SRD1H	DAG1 alternate register select (7-4)
4	SRD1L	DAG1 alternate register select (3-0)
5	SRD2H	DAG2 alternate register select (15–12)
6	SRD2L	DAG2 alternate register select (11-8)
0 = primary registers; 1 = alternate registers		

Table 4-2. MODE1 DAG control bits for

This grouping of alternate registers enables you to pass pointers between contexts in each DAG.

DAG Operation

DAG operations include:

- Address output with premodify or postmodify.
- Modulo addressing (for circular buffers).
- Bit-reversed addressing.

The DAGs right-shift short word addresses (16-bit data) by one bit before outputting them on the DM Address Bus. This enables internal memory to use the address directly. (For details, see "Using 16-Bit Short Word Accesses" on page 5-41.)

Address Output and Modification

The processor can generate addresses in one of two ways:

• Premodify operation

The processor adds an offset (modifier), either an M register or an immediate value, to an I register and outputs the resulting address.

This operation does not update the value of the I register.

Neither the L register nor modulo logic affect a premodified address. Premodify addressing is always linear, never circular.

Restrictions on the use of premodify addressing operations may apply to some older silicon revisions. For details, see "Memory Organization" on page 5-16.

• Postmodify operation

The processor outputs the I register value as is and adds an M register or immediate value to form a new I register value.

The width of an immediate modifier depends on the instruction. It can be as large as the width of the I register.

If you use postmodify addressing without implementing a circular buffer, make sure you set the corresponding L register to 0.

Uninitialized L registers cause unpredictable postmodify behavior.

Figure 4-3 shows a comparison of the pre- and postmodify operations.



Figure 4-3. Comparison of premodify and postmodify operations

DAG Modify Instructions

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In the processor's assembly language, the positions of the index and modifier (M register or immediate value) in the instruction distinguishes the premodify and postmodify operations.

The I register coming before the modifier identifies the postmodify operation. Conversely, the modifier coming before the I register identifies the premodify with no update operation. For example, the following instruction accesses the program memory location with an address equal to the value stored in I15, and the processor writes back the value I15 + M12 to the I15 register:

R6 = PM(I15,M12); Indirect addressing with postmodify

If the order in which the I and M registers appear in the instruction is reversed, the instruction accesses the location in program memory with an address equal to I15 + M12, but without changing the value of I15:

R6 = PM(M12, I15); Indirect addressing with premodify

Any M register can modify any I register within the same DAG (DAG1 or DAG2). So,

DM(MO,I2) = RO;	valid instruction
DM(MO, I14) = RO;	invalid instruction

Immediate Modifiers

The magnitude of an immediate value that can modify an I register depends on the instruction type and whether the I register is in DAG1 or in DAG2.

DAG1 modify values can be up to 32-bits wide. DAG2 modify values can be up to 24-bits wide. Some instructions with parallel operations support modify values up to 6-bits wide only. For example:

• 32-bit modifier

R1=DM(0x00400000,I1); DM address = I1 + $0x0040\ 0000$

• 6-bit modifier:

```
F6=F1+F2, PM(I8, 0xOB)=ASTAT; PM address = I8, I8 = I8 + 0xOB
```

Circular Buffer Addressing

The DAGs provide addressing of locations within a circular data buffer.

A circular buffer consists of a set of memory locations that stores data and an index pointer that steps through the buffer. For each step, the processor postmodifies and updates the buffer's I register by adding the value (positive or negative) specified in the M register to the value in the I register.

If the modified address pointer (M) falls outside the circular buffer, the processor either subtracts or adds, accordingly, the length of the buffer to the value to wrap the index pointer back to the start of the buffer (see Figure 4-4). The value of the base address of a circular buffer carries no restrictions.



Sequence repeats on subsequent passes.

Figure 4-4. Circular data buffers

For circular buffer addressing, you must use M registers to postmodify I registers, not to premodify them.

For example:

```
F1=DM(I0,M0);Use a postmodify operation to
            modify circular buffers, not a premodify
            operation.
```

Circular Buffer Operation

To set up a circular buffer in assembly language, initialize an L register with a positive, nonzero value and load the corresponding B register with the base (starting) address of the buffer. The processor automatically loads the corresponding I register with this same starting address.

On the first postmodify access using the I register, the DAG outputs the I register value on the address bus and then modifies it by adding to it the value specified in the M register or an immediate value.

If the modified value is within the buffer's range, the DAG writes it back to the I register. If the value is outside the buffer's range, the DAG subtracts (or adds if the modify value is negative) the L register value to the modified value before writing the modified value back to the I register.

• If M is positive

$I_{new} = I_{old} + M$	If $I_{old}+M < Buffer base + length$
	(end of buffer)
Inew=Iold + M-L	If $I_{old}+M \ge$ Buffer base + length
	(end of buffer)

• If M is negative

$$\begin{split} I_{new} = I_{old} + M & \quad \text{If } I_{old} + M \geq \text{Buffer base} \\ (\text{start of buffer}) \\ I_{new} = I_{old} + M + L & \quad \text{If } I_{old} + M < \text{Buffer base} \\ (\text{start of buffer}) \end{split}$$

Circular Buffer Registers

A circular buffer uses all four types of DAG registers:

- The I register contains the value the processor outputs on the address bus.
- The M register contains the postmodify value (positive or negative) that the processor adds to the I register at the end of each memory access.

You can use any M register providing it is located in the same DAG as the I register. And you can use noncorresponding M and I register combinations; for example, registers M2 and I4.

You can use an immediate value or an M register value for the modifier. The magnitude of the modify value, whether from an M register or an immediate value, must be less than the length (L register) of the circular buffer.

• The L register sets the size of the circular buffer, defining the address range that the I register steps through.

The value of the L register must be positive and cannot have a value greater than $2^{31}-1$ (for L0 through L7) or $2^{23}-1$ (for L8 through L15). A value of 0 in an L register disables the circular buffer.

- If you use postmodify addressing without implementing a circular buffer, make sure you set the corresponding L register to 0.
- After each access, the processor compares the modified I value to the B register value, or the sum of the B and L registers.

When the processor loads the B register, it also loads the corresponding I register with the same value. When it loads the I register, it does not change the value in the B register. You can read the B and I registers independently.

Circular Buffer Overflow Interrupts

Circular buffer overflow interrupts are useful in implementing, for example, a ping-pong routine that swaps I/O buffer pointers.

One set of registers in each DAG can generate an interrupt when a circular buffer overflows (address wraparound occurs). In DAG1, the registers are B7, I7, and L7, and in DAG2, they are B15, I15, and L15.

A circular buffer addressing operation that uses these registers and causes the processor to increment or decrement the address in the I register past the end or start of the circular buffer generates an interrupt. Which interrupt is generated depends on the register set the operation used, as shown in Table 4-3.

Interrupt	Use DAG	Vector Addr	Symbolic Name ¹
DAG1 circular buffer 7 overflow	B7, I7, L7	0×54	CB7I
DAG2 circular buffer 15 overflow	B15, I15, L15	0x58	CB15I

Table 4-3. Circular buffer overflow interrupts

¹ These symbols are defined in the #include file def21065L.h. For details, see Appendix E, Control and Status Registers, in *ADSP-21065L SHARC DSP Technical Reference*.

Specifically, an instruction generates an interrupt during its address postmodify when:

(for M<O) I + M < B (for M \geq O) I + M \geq B + L

To mask these interrupts, clear the appropriate bit in the IMASK register.

In certain situations, you may want to use I7 or I15 without circular buffering, but with the circular buffer overflow interrupts unmasked. To disable generation of these interrupts, set the B7 and B15 registers in DAG1 and the L7 and L15 registers in DAG2 to values that ensure the conditions that generate interrupts never occur. For example, when accessing the address range 0x1000 to 0x2000, set $B=0\times0000$ and $L=0\timesFFFF$. (Setting the L register to zero (0) will not disable circular buffer interrupts.)

If you are using either of the circular buffer overflow interrupts, avoid using the corresponding I register(s) (I7 and I15) in the rest of your application software, or make sure your software sets the B and L registers accordingly to prevent spurious interrupt branching.

The STKY status register contains two bits that the processor sets when a circular buffer overflow occurs—bit 17 (DAG1 circular buffer 7 overflow) and bit 18 (DAG2 circular buffer 15 overflow). These bits are "sticky" and remain set until explicitly cleared.

Bit Reversal

You can bit-reverse memory addresses two ways:

- Enabling bit-reverse mode on DAG1 or DAG2 and using a specific I register (I0 or I8).
- Using the explicit bit-reverse instruction BITREV.

Using Bit-Reverse Mode

In bit reverse mode, DAG1 bit-reverses 32-bit address values output from I0, and DAG2 bit-reverses 24-bit address values output from I8.

The processor bit reverses the address values from the I0 and I8 registers only.

DAG Operation

This mode affects both premodify and postmodify operations.

The BR0 and BR8 bits in the MODE1 register enable these modes.

Table 4-4. MODE1 bit reversal mode bits

Bit	Name	Description
0	BR8	Bit reverse mode for I8 (DAG2)
1	BRO	Bit reverse mode for IO (DAG1)

Bit reversal occurs at the output of the DAG and does not affect the value in I0 or I8. In postmodify operations, the processor does not bit reverse the update value.

For example:

```
I0=0x80400000;
R1=DM(I0,3); DM address=0x201, I0=0x80400003
```

Using the Bit Reverse Instruction

The BITREV instruction modifies and bit reverses addresses in any DAG index register (I0-I15), without actually accessing memory. This instruction operates independently of bit-reverse mode.

The BITREV instruction:

- Adds a 32-bit immediate value to a DAG1 index register. For a DAG2 index register, you can specify a zero immediate value only.
- Bit-reverses the result.
- Writes the result back to the same index register.

For example:

BITREV(19,0); 19 = Bit-reverse of (19+0)

DAG Register Transfers

DAG registers are part of the universal register set. You can write to them from memory, from another universal register, or from an immediate field in an instruction. Conversely, you can write DAG register contents to memory or to a universal register.

As shown in Figure 4-5, transfers between 32-bit DAG1 registers and the 40-bit Data Memory Data (DMD) bus are aligned to bits 39:8 of the DMD bus.



Figure 4-5. DAG register transfers

When the processor reads 24-bit DAG2 registers over the 40-bit DMD bus, it sign-extends M register values to 32 bits and zero-fills I, L, and B register values to 32 bits. The results are aligned to bits 39:8 of the DMD Bus.

When the processor writes the DAG2 registers from the DMD bus, it transfers bits 31:8 and ignores the rest.

For certain instruction sequences that involve transfers to and from DAG registers, the processor inserts a NOP cycle automatically.

Certain other sequences, which the assembler does not support, cause incorrect results:

• Instructions that generate an extra NOP cycle

The processor automatically inserts a NOP cycle between two consecutive instructions if the first instruction loads a DAG register and the second instruction uses any register in the same DAG for data addressing, modify instructions, or indirect jumps.

The processor inserts the NOP instruction to delay the second operation since both operations need the same bus in the same cycle.

For example:

L2=8; DM(I0,M1)=R1;

Because L2 is in the same DAG as I0 (and M1), the processor inserts an extra cycle after the write to L2.

• Illegal instructions that generate incorrect results

You can execute the following types of instructions on the processor, but they generate incorrect results and are unsupported:

• An instruction that uses indirect addressing from a DAG to store the same DAG register in memory, with or without updating the index register.

This instruction writes the wrong data to memory or updates the wrong index register.

```
For example: DM(M2,I1)=I0;orDM(I1,M2)=I0;
```
• An instruction that uses indirect addressing from a DAG to load the same DAG register from memory and updates the index register.

This instruction either loads the DAG register or updates the index register, but not both.

For example: L2=DM(I1,M0);

DAG Register Transfers

5 MEMORY

The processor's dual-ported SRAM provides 544K bits of on-chip storage for program instructions and data.

The processor's internal bus architecture provides a total memory bandwidth of 900M bytes/sec., enabling the core to access 660M bytes/sec. and the I/O processor to access 264M bytes/sec. of memory

The processor's flexible memory structure enables:

- The processor's core and I/O processor or DMA controller to independently access memory in the same cycle.
- The processor's core to access both memory blocks in parallel using its PM and DM buses.
- Applications to configure memory to store 16-, 32-, 40-, or 48-bit words or combinations of these.

The processor uses 32-bit memory words for single-precision IEEE floating-point data and 48-bit words for instructions. It supports 16-bit short word format for integer or fractional data values.



Figure 5-1. ADSP-21065L block diagram

The following terms are used throughout this chapter:

DAGs Data Address Generators.

Generate indirect addresses for data reads and writes over the PM and DM buses. The DAGs generate addresses simultaneously for dual operand reads and writes if the instruction is available in the Instruction Cache. See also, *Instruction Cache*.

DAG1 generates 32-bit addresses for data transfers over the DM bus. DAG2 generates 24-bit addresses for data transfers over the PM bus.

For more information see, Chapter 4, Data Addressing.

DM bus

Data Memory bus.

Consists of the 32-bit Data Memory Address (DMA) bus and the 40-bit Data Memory Data (DMD) bus.

Controlled by the processor's core, the DM bus provides a connection between SRAM, core (DAGs, PX bus connect, Register File, Programs Sequencer, and Instruction Cache), I/O processor's IOP registers, and the external port.

Used to transfer data between registers and between registers and external memory. Transfers are done within one clock cycle.

See also, PM bus.

External memory space

Memory map area that corresponds to external memory.

See also, Internal memory space, Multiprocessor memory space.

External port

Provides addressing of up to 64M words of additional, off-chip memory and access to other peripherals, a host processor, and the IOP registers of the other ADSP-21065L in a multiprocessing system.

Instruction Cache

One of two sources (PM bus and Instruction Cache) for temporarily storing the next instruction that the processor needs to fetch.

When the Instruction Cache provides instructions, it eliminates PM bus conflicts that can occur when the core uses the PM bus to execute a dual-data access. This way, data accesses over the PM bus incur no extra cycles. The Instruction Cache stores only those instructions that conflict with data accesses over the PM bus.

Internal memory space

Memory map area that corresponds to the processor's internal memory.

See also, External memory space, Multiprocessor memory space.

I/O bus

The input/output bus connecting SRAM with the I/O processor.

Controlled by the I/O processor, the I/O bus enables concurrent data transfers between either memory block and the processor's communications ports (the external port and serial ports).

See also, Memory blocks, External port.

IOP registers

The I/O processor's I/O registers that provide the interface for:

- Accesses into the processor's internal memory made by a host, another ADSP-21065L in a multiprocessor system, or any other peripheral device.
- Accesses into the processor's configuration and status information made by the processor's DMA controller.

For more information, see Chapter 8, Host Interface.

Memory blocks

The two partitions of the processor's on-chip SRAM.

Block 0's 288K bits of 6K x 48 memory is organized into nine columns of 16 x 2k. Block 1's 256K bits of 8K x 32 memory is organized into eight columns of 16 x 2k. The processor's core and the I/O processor can access each block in every cycle. When both access the same block, the accesses incur no extra cycles.

Multiprocessor memory space

Memory map area that corresponds to the IOP registers of another ADSP-21065L in a multiprocessor system.

See also, External memory space, Internal memory space.

PM bus

Program Memory bus.

Consists of the Program Memory Address (PMA) bus, a 24-bit transmission path, and the Program Memory Data (PMD) bus, a 48-bit transmission path.

Controlled by the processor's core, the PM bus provides a connection between SRAM, core (DAGs, PX bus connect, Register File, Program Sequencer, and Instruction Cache), I/O processor's IOP registers, and the external port.

Used to transfer instructions and data.

See also, DM bus.

Program Sequencer

Generates 24-bit PM bus addresses for instruction fetches from memory.

See Chapter 3, Program Sequencing.

PX bus connection

Provides the internal exchange mechanism for passing data between the 48-bit PM bus and the 40-bit DM bus or the 40-bit Register File. Consists of two subregisters, PX1 and PX2, which the processor's core can access as one 48-bit register or as two separate registers, one 16-bit register (PX1) and one 32-bit register (PX2).

Register File

A set of 40-bit, universal registers located in the processor's core in which the processor stores data to feed to or retrieve from the computation units.

See Chapter 2, Computation Units.

SDRAM interface

Part of the external port, the SDRAM interface enables the processor to transfer data to and from off-chip synchronous DRAM at 2x CLKIN.

See Chapter 10, SDRAM Interface.

Transferring Data In and Out of Memory

The processor has three internal buses connected to its dual-ported memory—the PM bus, the DM bus, and the I/O bus. The PM and the DM buses connect to the memory's processor port, and the I/O bus connects to the memory's I/O port as shown in Figure 5-2.



Figure 5-2. Bus connections to on-chip SRAM memory

The processor's core controls the PM and DM buses, and the I/O processor controls the I/O bus. The I/O bus enables concurrent data transfers between either memory block and the processor's communication ports (external and serial ports).

Dual Data Accesses

Figure 5-3 shows addresses that the processor generates for DM bus and PM bus accesses. (See page 5-20 for the processor's address decoding table.) DAG1 generates DM bus addresses, and either the program sequencer or DAG2 generates PM bus addresses for instructions or data, respectively.



Figure 5-3. Memory address bits on the DM and PM buses

Although the processor has two separate internal buses, the Program Memory bus (PM) and the Data Memory bus (DM), memory itself remains undefined as either PM or DM, and applications can store data within program memory space. The processors' modified Harvard architecture enables applications to configure memory to store different combinations of code and data.

The independent PM and DM buses enable the core to simultaneously access instructions and data from the memory blocks. For single instructions, however, core accesses of two words from the same memory block over the same bus incur an extra cycle. The core fetches instructions over the PM bus or from the instruction cache and data over both the DM bus using DAG1 and the PM bus using DAG2. Figure 5-2 on page 5-7 shows the memory bus connections on the processor.

Applications can configure the processor's two memory blocks to store different combinations of 48-bit instruction words and 32-bit data words. However, configuring one block to contain a mix of instructions and PM bus data and the other block to contain DM bus data only achieves maximum efficiency; that is, single-cycle execution of dual-data-access instructions.

This means for instructions that require two data accesses, the processor's core uses the PM bus with DAG2 to access data from the mixed block and the DM bus with DAG1 to access data from the data-only block. The instruction for the core to fetch must be available in the instruction cache. As an alternative, the application can store one operand in external memory space and the other in either block of internal memory space.

Typically, DSP applications, such as digital filters and FFTs, must access two data operands for some instructions. In a digital filter, for example, the filter can store coefficients in 32-bit words in the same memory block that contains the 48-bit instructions and store 32-bit data samples in the other block. This configuration facilitates single-cycle execution of dual-data-access instructions when the core uses DAG2 to access the filter coefficients over the PM bus, and the instruction is available in the instruction cache.

To ensure single-cycle, parallel accesses of two on-chip memory locations, the application must meet these conditions:

- The location of each address must be in a different internal memory block.
- DAG1 must generate one address, and DAG2 the other.
- The DAG1 address must point to a different memory block than the one from which the processor's core is fetching the instructions.

• The instruction takes the form:

compute, Rx=DM(IO -I7,MO -M7), Ry=PM(I8 -I15,M8 -M15);

In these instructions, reads and writes may be intermixed. A cache miss occurs whenever the fetched instruction is invalid during any DAG2 transfer. See "Instruction Cycle" on page 3-4.

Using the Instruction Cache to Access PM Data

Normally, the processor fetches instructions over the 48-bit PM Data bus. Executing a dual-data-access instruction that requires reading or writing data over the PM bus, however, causes a bus conflict. By providing the instruction, the processor's on-chip instruction cache can resolve this conflict. The first time the instruction executes, the instruction cache stores it, making it available on the next fetch.

By providing the instruction, the cache enables the core to access data over the PM bus—the core fetches the instruction from the cache instead of from memory so that it can simultaneously transfer data over the PM bus. The instruction cache stores only those instructions whose fetches conflict with PM bus data accesses.

When the instruction to fetch is already cached—the instruction is executed within a loop—core data accesses over the PM bus incur no extra cycles. However, a cache miss always incurs an extra cycle when the core uses the PM bus to access both instruction and data, even if they are in different memory blocks.

Generating Addresses for the PM and DM Buses

The processor's three internal buses—PM, DM, and I/O—connect to its dual-ported memory, with the PM and DM buses sharing one memory port, and the I/O bus connecting to the other.

The processor's Program Sequencer and data address generators (DAGs) supply memory addresses. The Program Sequencer supplies 24-bit PM bus addresses for instruction fetches, and the DAGs supply addresses for data reads and writes. (See Figure 5-1 on page 5-2.)

Both data address generators enable indirect addressing of data. DAG1 supplies 32-bit addresses over the DM bus. DAG2 supplies 24-bit addresses for data accesses over the PM bus. If the instruction to fetch is available in the instruction cache, the DAGs can generate simultaneous addresses—over the PM bus and DM bus—for dual operand reads and writes.

The 48-bit PM Data bus transfers instructions (and data), and the 40-bit DM Data bus transfers data only. The PM Data bus is 48-bits wide to accommodate the 48-bit instruction width. When this bus transfers 32-bit data (floating- or fixed-point), the data is aligned to the upper 32 bits of the bus.

The 40-bit DM Data bus provides a path for transferring, in a single cycle, the contents of any register in the Register File to any other register or to any external memory location. Data addresses come from either an absolute value specified in the instruction (direct or immediate addressing) or from the output of a DAG (indirect addressing). Thirty-two-bit fixed-point and 32-bit single-precision floating-point data is aligned to the upper 32 bits of the DM Data bus.

The PX bus connect registers pass data between the 48-bit PM Data bus and the 40-bit DM Data bus or the 40-bit Register File. The PX registers contain hardware to handle the 8-bit difference in width. The three memory buses—PM, DM, and I/O—are multiplexed at the processor's external port to create a single off-chip data bus (DATA₃₁₋₀) and address bus (ADDR₂₃₋₀).

Transferring Data Between the PM and DM Buses

The PX register provides an internal bus exchange path for transferring data between the 48-bit PM Data Bus and the 40-bit DM Data Bus. The 48-bit PX register consists of two subregisters, the PX1 and PX2 registers. PX1 is 16-bits wide and PX2 is 32-bits wide. Instructions can use the entire PX register or use PX1 and PX2 separately. Figure 5-4 shows the alignment of PX1 and PX2 within PX.



Figure 5-4. PX register

Instructions use the PX register(s) in universal register-to-register transfers or in memory-to-register (and vice versa) transfers. These transfers use either the PM Data Bus or the DM Data Bus. Instructions can read or write the PX register(s) from or to the PM Data Bus, the DM Data Bus, or the Register File.

Figure 5-5 shows the data alignment in PX register transfers. Transfers between PX2 and the PM Data Bus use the upper 32 bits of the PM Data Bus. On transfers from PX2, the sixteen LSBs of the PM Data Bus are filled with zeros. Transfers between PX1 and the PM Data Bus use the middle sixteen bits of the PM Data Bus. On transfers from PX1, bits PM_{15-0} and PM_{47-32} are filled with zeros (0).



Figure 5-5. PX register transfers

When the combined PX register is used for PM Data Bus transfers, instructions can read or write the entire 48 bits to program memory. PX2 contains the thirty-two MSBs of the 48-bit word, and PX1 contains the sixteen LSBs. (PM Bus data is left-justified in the 48-bit word.)

For example, to write a 48-bit word to the memory location Port1 over the PM Data Bus, the instruction could use this syntax:

```
R0=0x9A00; /* load R0 with 16 LSBs */
R1=0x12345678; /* load R1 with 32 MSBs */
PX1=R0;
PX2=R1;
PM(Port1)=PX; /* write 16 LSBs on PM bus 15-0 and 32 MSBs
on PM bus 47-16 */
```

Data transfers between PX2 and the DM Data Bus or Register File use the upper thirty-two bits of the DM Data Bus or Register File. On transfers from PX2, the eight LSBs are filled with zeros (0). (See Figure 5-5 on page 5-13.) Data transfers between PX1 and the DM Data Bus or Register File use bits DM_{23-8} of the DM Data Bus are used. On transfers from PX1, bits DM_{7-0} and DM_{39-24} are filled with zeros (0).

When using the combined PX register for DM Data Bus transfers, instructions can read or write the upper forty bits of PX. For transfers to or from internal memory, the lower eight bits are filled with zeros. For transfers to or from external memory, the entire forty-eight bits are transferred.

Memory Block Accesses and Conflicts

At any given time, any of the processor's three internal buses, PM, DM, and I/O, may need to access one of the memory blocks. Both the processor's core (over either the PM or DM bus) and the I/O processor (over the I/O bus) can access each block of dual-ported memory in every cycle, without incurring extra cycles when they both access the same block. A conflict occurs, however, when the core attempts two accesses in the same cycle to a single block; for example, an access by DAG1 over the DM bus and either the Program Sequencer or DAG2 over the PM bus. This access incurs an extra cycle—the DM bus access finishes first, and the PM bus access finishes in the following (extra) cycle.

Memory Organization

The processor's SRAM memory is partitioned into two blocks of unequal size, as shown in Figure 5-6.



Figure 5-6. Memory block organization

• Block 0

Contains 288K bits (6K x 48) and is physically organized into nine columns of 16 bits x 2K.

Block 1

Contains 256K bits (8K x 32) and is physically organized into eight columns of 16 bits x 2K.

You can individually configure each memory block to store different combinations of code and data. The physical organization of each memory block determines its storage capacity, as shown in Table 5-1.

Block	Size/Kbits	48b words	32b words	16b words
0	288	6K	8K	18K
1	256	4 K	8K	16K

Table 5-1. SRAM storage capacity in x-bit words

Each memory block is dual-ported to support single-cycle accesses by the core, I/O processor, and DMA controller. This memory structure coupled with the internal buses, enable execution of three data transfers, two by the core and one by the I/O processor or DMA controller, in a single cycle.

The processor has a total address space of 64M words. Table 5-2 details the processor's memory map, which defines this address space.

Table 5-2. Interr	hal memory ma	Р
Start Address	End Address	Contents
0x0000 0000	0x0000 00FF	IOP registers
0x0000 0100	0x0000 01FF	IOP registers of processor ID 001
0x0000 0200	0x0000 02FF	IOP registers of processor ID 002
0x0000 0300	0x0000 7FFF	Reserved (unusable)
0x0000 8000	0x0000 9FFF	Block O normal word address space (48- and 32-bit words)

Reserved

0x0000 BFFF

T 11

0x0000 A000

Memory Organization

Start Address	End Address	Contents
0×0000 C000	0x0000 DFFF	Block 1 normal word address space (48- and 32-bit words)
0x0000 E000	0x0000 FFFF	Reserved
0×0001 0000	0x0001 3FFF	Block O short word address space (16-bit words) ¹
0x0001 4000	0x0001 7FFF	Reserved
0×0001 8000	0x0001 BFFF	Block 1 short word address space (16-bit words)
0x0001 C000	0x0001 FFFF	Reserved
0x0002 0000	0x00FF FFFF	External memory bank O
0x0100 0000	0x01FF FFFF	External memory bank 1
0x0200 0000	0x02FF FFFF	External memory bank 2
0x0300 0000	0x03FF FFFF	External memory bank 3

Table 5-2. Internal memory map (Cont'd)

¹ The structure of Block 0 imposes some restrictions on accessing the addresses within the ninth column. For details, see "Normal Versus Short Word Addressing" on page 5-29.

The processor's memory map is divided into three sections:

• Internal memory space

Corresponds to the processor's IOP registers and normal word and short word addressing space.

The address boundaries for this space are:

0x0000	0000	to	0x0000	00FF	IOP registers
0x0000	8000	to	0x0000	9FFF	Block 0 normal
0x0000	C000	to	0x0000	DFFF	Block 1 normal
0x0001	0000	to	0×0001	3 F F F	Block 0 short
0x0001	8000	to	0x0001	BFFF	Block 1 short

and, with reserved space interspersed between block segments at:

0x0000	A000	to	0x000	BFFF
0x0000	E000	to	0x000	FFFF
0x0001	4000	to	0x001	7 F F F
0x0001	C000	to	0x001	FFFF

• Multiprocessor memory space

Corresponds to the IOP registers of the other processor in a multiprocessor system.

The address boundary for this space is:

0x0000 0100 to 0x0000 02FF

• External memory space

Corresponds to off-chip memory and memory-mapped I/O devices.

The address boundary for this space is:

0x0002 0000 to 0x03FF FFF

Memory Organization

Table 5-3 shows how the processor decodes and routes memory addresses over the DM and PM buses.

DM bit	PM Bit	Field	Description			
31-26	NA	NA	Reserved			
25-24	NA	V	Virtual address.			
			00= Depends on E, S ₁₋₀ , and M bits; address corresponds to local's internal or external (Bank O) memory or to remote processor's IOP space.			
			01= External memory Bank 1, local processor			
			10= External memory Bank 2, local processor			
			11= External memory Bank 3, local processor			
23-17	23-17	E	Memory address.			
			00000[00] = Address in local or remote pro- cessor's internal memory space.			
			<pre>xxxxx[xx] = Based on V bits; address in one of local's four external memory banks.</pre>			

Table 5-3. Address decoding table for memory accesses

Memory

DM bit	PM Bit	Field	Description
16-15	16-15	S ₁	IOP register address (high order bits).
			00= Based on M bits; address in local or remote processor's IOP regis- ter
			01= Normal word address in local's internal memory
			<pre>1x= Short word address in local's internal memory</pre>
14-10	14-10	So	IOP register address (low order bits).
			00000 = Based on M bits; address in local or remote processor's IOP regis- ter
			<pre>xxxxx = Invalid if E or S bits =0s; oth- erwise, address in internal or external memory space (based on V, E, and S₁ bits)</pre>

Table 5-3. Address decoding table for memory accesses (Cont'd)

Memory Organization

DM bit	PM Bit	Field	Description
9 - 8	9 - 8	М	IOP register space.
			00= Address in local's IOP register space
			01= Address in IOP space of processor w/ID1
			10= Address in IOP space of processor w/ID2
			<pre>11= Invalid if E or S bits =0s; oth- erwise, address in internal or external memory space (based on V, E, and S₁ bits)</pre>
7 - 0	7 - 0	Р	IOP register space address.

Table 5-3. Address decoding table for memory accesses (Cont'd)

Internal Memory Space



Figure 5-7. Internal memory space

As shown in Figure 5-7, internal memory has three address regions:

• I/O Processor (IOP) Registers

0x0000 0000 to 0x0000 02FF

The I/O Processor's IOP registers are 256 memory-mapped registers that control system configuration and various I/O operations. The address space between the IOP registers and normal word addresses—locations 0×0000 0300 to 0×0000 7FFF—is unusable memory, and applications should not write to it.

• Normal Word Addresses

 Block 0
 0x0000 8000
 to
 0x0000 9FFF

 Block 1
 0x0000 C000
 to
 0x0000 DFFF

The Interrupt Vector Table is located at the beginning of normal word addresses at:

0×0000	8000	to	0×0000	807F
0.00000	0000	ιo	070000	0071

• Short Word Addresses

Block 0	0×0001	0000	to	0x0001	3FFF
Block 1	0x0001	8000	to	0x0001	BFFF

Multiprocessor Memory Space



Figure 5-8. Multiprocessor memory space

Multiprocessor memory space maps to the IOP registers of the other ADSP-21065L in a multiprocessor system, enabling both processors to access the other's memory-mapped IOP registers. On both processors, the

Memory

address range of the processor with ID1 is 0000 0100 to 0000 01FF, and the address range of the processor with ID2 is 0000 0200 to 0000 02FF.

As shown in Table 5-3 on page 5-20, when the E field of an address is zero and the M field is nonzero, the address falls within multiprocessor memory space. The value of M specifies the processor ID_{1-0} of the processor to access, and only that processor responds to the read or write cycle.

Instead of directly accessing its own internal memory, using its own ID, a processor can also access its memory through multiprocessor memory space. In this case, the core reads or writes to its own internal memory without accessing the external system bus. Only the processor's core, not its DMA controller, can generate addresses for accessing its internal memory through multiprocessor memory space.

If the processor attempts to access an invalid address in multiprocessor memory space, the other processor ignores written data and returns invalid data on a read.

For details on multiprocessor memory accesses, see Chapter 7, Multiprocessing. For details on asynchronous accesses of multiple processors, see Chapter 8, Host Interface.

External Memory Space



Figure 5-9. External memory space

The processor's I/O processor monitors the addresses of all memory accesses and routes accesses to the appropriate memory space. The I/O processor decodes the V, E, M, and S fields as shown in Table 5-3 on page 5-20. If the V and E bit fields contain all zeros, the M and S fields become active, and the I/O processor decodes them.

The processor's core and DMA controller can access external memory over the DM bus, PM bus, and EP (external port) bus, all through the external port. The processor's DAG1, Program Sequencer (and DAG2), and I/O processor control these respective buses.

Generating 32-bit addresses over the DM address bus and the I/O address bus, respectively, DAG1 and the I/O processor provide addressing for the total 16-megaword memory map, 0002 0000 to 03FF FFFF. The Program Sequencer and DAG2 generate 24-bit addresses over the PM address bus, limiting addressing to the low 63.875 megawords.

Memory Space Access Restrictions

Following some basic rules, applications can use the processor's three internal buses, PM, DM, and I/O, to access the processor's memory map:

- The DM bus can access all memory spaces.
- The PM bus can access internal memory space and the lowest 63.875 megawords of external memory space only.
- The I/O bus can access all memory spaces except for the memory-mapped IOP registers in internal memory space.

Word Size and Memory Block Organization

The processor's internal memory accommodates the following word types:

- 48-bit instructions
- 40-bit extended precision, floating-point

These data are accessed in 48-bit words, with the 40 bits left-justified in the 48-bit word (bits 47:8).

- 32-bit floating-point data
- 16-bit short word data

When the processor's core accesses its internal memory, these rules determine the word width of the access:

- Instruction fetches always read 48-bit words.
- Reads and writes using normal word addressing are either 32-or 48-bit words, depending on the memory block's configuration in the SYSCON register.
- Reads and writes using short word addressing are always 16-bit words.
- PM bus (DAG2) reads and writes of the PX register are always 48-bit words, unless they use short word addressing.
- DM bus (DAG1) reads and writes of the PX register are always 40-bit words, unless they use short word addressing.



Use caution when accessing the same physical location in memory with both 32-and 48-bit words. For details, see "Interacting with the Shadow Write FIFO" on page 5-39.

Normal Versus Short Word Addressing

Applications can access the processor's 544K bits of on-chip memory with either normal or short word addressing or with combinations of both.

When each word is 32 bits wide, the range of normal word addresses on each block is 8K words (16K words combined). In this configuration, however, some physical locations at the end of Block 0 become nonexistent. When each word is 48 bits wide, the range of normal word addresses on Block 0 is 6K words and on Block 1, 4K words (10K words combined). In this configuration, however, some physical locations at the end of Block 1 become nonexistent. For details on the physical mapping of 48-and 32-bit words, see "Mixing 32- and 48-Bit Words in One Memory Block" on page 5-32.

When each word is 16 bits wide, the range of short word addresses on Block 0 is 18K words and on Block 1, 16K words (34K words combined). On Block 0, however, the address range of the ninth column is noncontiguous with the address range of the other eight columns. To address the ninth column for short word accesses, you must use the odd addresses between 0×14001 and $0 \times 14FFF$ only. Even addresses between 0×14001 and $0 \times 14FFF$ are undefined.

The PM and DM buses support both normal and short word addressing. Short word addressing increases the amount of 16-bit data that internal memory can store, and it enables MSW (most significant word) and LSW (least significant word) addressing format for 32-bit data words. Short word addressing of 16-bit data words is useful in array signal processing systems. When it reads them from memory, depending on the SSE (short word sign-extension enable) bit in the MODE1 register, the processor either sign- extends or zero-fills 16-bit short words to 32-bit integers.

When configured for booting, the processor's interrupt vector table is located at the start of normal word addressing, $0 \times 0000 8000 - 0 \times 0000 807F$. When configured for "no boot" mode, the interrupt vector table is located in external memory, $0 \times 0002 0000$ to $0 \times 0002 007F$. If the IIVT (internal interrupt vector table) bit of the SYSCON register is set, the interrupt table resides in internal memory, regardless of the booting mode.

Using 32- and 48-Bit Memory Words

Because each memory block is divided into columns that are 16-bits wide, 48-bit instruction words require three columns of contiguous memory, and 32-bit data words require two columns of contiguous memory. Sixteen-bit data words require one column.

Accordingly, the word width of an access determines how columns are grouped and how they are addressed for memory reads and writes.

For 48-bit instruction words, the access selects columns in groups of three. So, depending on the memory block accessed, a memory block consisting entirely of 48-bit instruction words has either three or two groups from which to select:

```
9 columns ÷ 3 columns per group = 3 groups (Block 0)
```

or

8 columns ÷ 3 columns per group = 2 groups (Block 1)

For Block 1, the last two columns are unused. So, a memory block that consists entirely of 48-bit words provides instruction storage for:

```
2K × 3 groups = 6K words (Block 0)
or
2K × 2 groups = 4K words (Block 1)
```

For 32-bit data words, the access selects columns in groups of two. So, a memory block consisting entirely of 32-bit data words has four groups to select from:

9 columns ÷ 2 columns per group = 4 groups (Block 0)

or

8 columns ÷ 2 columns per group = 4 groups (Block 1)

For Block 0, the last column is unused. So, a memory block that consists entirely of 32-bit data words provides instruction storage for:

 $2K \times 4$ groups = 8K words (Block 0 or Block 1)

Figure 5-11 on page 5-33 shows memory block configuration for four basic combinations of 32-bit data and 48-bit instructions.

Because the memory on the processor is arranged in eight and nine 16-bit columns, a similar set of calculations for 16-bit short words yields:

 $2K \times 9$ groups = 18K words of instruction storage

 $2K \times 8$ groups = 16K words of data storage

Figure 5-10 shows the ordering of 16-bit words within both 48-and 32-bit words and the initial addresses for each column of processor memory. All addresses indicate the first location of each column.



Figure 5-10. Memory organization vs. address

Mixing 32- and 48-Bit Words in One Memory Block

Following a few rules, you can store 32-bit data words and 48-bit instruction words in the same memory block. The rules are simplified if you store x32 and x48 words in separate columns. This storage configuration is called column-level granularity.

The rules for using column-level granularity are:

- Storage of instructions must start at the lowest address in the block.
- Storage of data must start on an even-numbered column.
- All data must reside at addresses higher than all instruction addresses.
- Instructions require three contiguous 16-bit columns.
- Data words require two contiguous 16-bit columns.

For using a finer granularity, see "Fine Tuning Mixed Word Accesses" on page 5-35.

Each block of memory is physically organized in columns of 16 bits \times 2K. Figure 5-11 on page 5-33 shows, for both memory blocks, four basic combinations of 48-bit instructions and 32-bit data within a single block.



Figure 5-11. Example using words of mixed-length

A Three columns for instructions, four columns for data, and two unused columns, one between the 48-bit instructions and the 32-bit data and one at the end of the 32-bit data.

This configuration provides 2K of instruction storage and 4K of data storage. Column three is unused because the 32-bit data words must start on an even-numbered column, and column eight is unused because 32-bit data requires two columns.

B Six columns for instructions and two columns for data.

This configuration provides 4K of instruction storage and 2K of data storage.

C Three columns for instructions, four columns for data, and one unused column between the 48-bit instructions and the 32-bit data.

This configuration provides 2K of instruction storage and 4K of data storage. Column three is unused because the 32-bit data words must start on an even column number.

D Six columns for instructions and two columns for data.

This configuration provides 4K of instruction storage and 2K of data storage.

Table 5-4 shows the addressing in Block 0 (beginning address = $0 \times 0000 8000$) and in Block 1 (beginning address = $0 \times 0000 0000$) for each of the instruction and data combinations of Figure 5-11 on page 5-33.

	48-Bit Inst	ructions	32-Bit Data		
	Start	End	Start	End	
А	0×0000 8000	0x0000 87FF	0x0000 9000	0x0000 9FFF	
В	0×0000 8000	0x0000 8FFF	0x0000 9800	0x0000 9FFF	
С	0×0000 C000	0x0000 C7FF	0x0000 D000	0x0000 DFFF	
D	0×0000 C000	0×0000 CFFF	0x0000 D800	0x0000 DFFF	

T 11 C / A 11		C		1	1
Table 5-4. Address	ranges	tor	instructions	and	data
	0				
To determine the starting address of the 32-bit data, use the equations in Table 5-5.

Table 5-5. Equation for determining the starting address of 32-bit data

```
Starting Address
B + m + 2048 + (2048 * i) + 1
B =beginning address of memory block
n =number of 48-bit instruction word locations
i =integer portion of [(n - 1) ÷ 2048]
m =(n - 1) mod 2048
```

Fine Tuning Mixed Word Accesses

If you must mix 48-bit instructions and 32-bit data words with finer granularity than previously described, you need an in-depth understanding of the processor's internal memory. This section details the low-level organization and addressing of the internal memory blocks.

Low-Level Physical Mapping of Memory Blocks

Each block of memory is organized into columns that are 16-bits wide and 2K high, enabling each column to contain 2K 16-bit words. Block 0 contains nine columns, and Block 1 contains eight columns.

For reads or writes of 48-bit and 32-bit words, the thirteen LSBs of the address select a row from each column. The MSBs of the address control which columns are selected. For reads or writes of 16-bit short words, the address is right-shifted one place before it's applied to memory (see Figure 5-12 on page 5-36). This frees bit 0 of the address to select between the MSW and LSW format of 32-bit data.

For any access, the word width of the access determines which columns are selected. For 48-bit words, the columns are selected in groups of three, and address bits 13:15 select the group. For 32-bit words, the columns are selected in groups of two, and address bits 13:15 select the group.

16-bit short word accesses are handled differently to provide easy access to the MSW and LSW of 32-bit data. In the processor's DAGs, a single arithmetic right shift of the short word address provides the physical address of the destination 32-bit word. If the value of the bit shifted out is zero (0), the access is to the LSW, otherwise it is to the MSW. To implement this, first you select columns in groups of two with address bits 13:15 and then select between the two columns in the group with the short word address bit shifted out.



Figure 5-12. Preprocessing 16-bit short word addresses

Restrictions on Storing Mixed Words

Although they are grouped differently within a memory block, 48-bit and 32-bit words attempt to use the same address area. This can cause errors when an application mixes 48-bit instructions and 32-bit data within the same block. (Since 32-bit and 16-bit words use the same grouping structure but different addresses, an application can freely mix them within the

same memory block.) Remember that storing all 48-bit instructions at addresses lower than all 32-bit data prevents one overlapping the other.

Figure 5-13 on page 5-38 shows how 48-bit words fill a memory block and exactly where you can place 32-bit words. If the number of 48-bit word locations to allocate is n and the beginning address of the block is B, Table 5-6 shows the address where contiguous 32-bit data can begin.

(n-1) ÷ 2048	Contiguous 32b Data Start Address		
0	B + 2K m + 1		
1	B + 4K m + 1		
B = Beginning address of memory block n = Number of 32b data word locations m = (n - 1) mod 2048			

Table 5-6. Starting address for contiguous 32-bit data

Figure 5-13 on page 5-38 also shows that when 48-bit and 32-bit data are mixed in the same block with finer than column-level granularity, usable but discontiguous blocks of 32-bit memory are created.



Figure 5-13. Mixing 48- and 32-bit words in a memory block

To use all of the memory block, allocate 48-bit words in 4K word increments (six columns). Even when all memory is used, a range of addresses that does not access any valid word exists between the 48-bit word region and the contiguous 32-bit word region.

To mix 16-bit words with 48-bit words, map the 16-bit words into 32-bit word space, and allocate memory for 32-bit words using the same method described here.

Interacting with the Shadow Write FIFO

Because the processor's internal memory must operate at high speeds, writes to the memory do not go directly into the memory array, but instead into the Shadow Write FIFO.

The Shadow Write FIFO is a cache that temporarily stores the I/O processor's or core's last two data writes before transferring them into internal memory. It stores the data and an address tag that corresponds to the data's location in internal memory. Caching increases the speed at which internal memory operates.

When an internal memory write cycle occurs, the Shadow Write FIFO loads the data at the top (data from the first of two previous reads) into memory and loads the new data into the bottom. This operation is normally transparent since the Shadow Write FIFO intercepts and temporarily stores any reads of the last two locations written. You need be aware of the Shadow Write FIFO only when you mix 48-bit and 32-bit word accesses to the same locations in memory.

The Shadow Write FIFO cannot differentiate between the mapping of 48-bit words and the mapping of 32-bit words. (See Figure 5-10 on page 5-32.) So, if you write a 48-bit word to memory and then try to read the data with a 32-bit word access, the Shadow Write FIFO will not intercept the read and will return incorrect data.

If you must mix 48-bit accesses and 32-bit accesses to the same locations this way, flush the Shadow Write FIFO with two dummy writes before you attempt to read the data.

Configuring Memory for 32- or 40-Bit Data

You can configure each block of internal memory to store either single-precision 32-bit data or extended-precision 40-bit data. To configure data storage, set the IMDWx bits, IMDW0 and IMDW1, in the SYSCON register. If IMDWx = 0, the processor performs 32-bit data accesses. If IMDWx = 1, the processor performs 40-bit data accesses.

If an application attempts to write 40-bit data from a 48-bit word to a memory block configured for 32-bit data, the processor truncates the lower sixteen bits of the 48-bit word. Similarly, on an attempt to read 40-bit data, the processor fills the lower eight bits of the data with zeros. The only exception to these rules occurs in transfers involving the PX register.

For all reads and writes of the PX register, the processor performs 48-bit accesses. If you must store any 40-bit data in a memory block configured for 32-bit words, use the PX register to access the 40-bit data in 48-bit words. For 48-bit writes of 40-bit data from the PX register to 32-bit memory, make sure that the physical memory space of the 48-bit destination does not corrupt any 32-bit data.

You can change the value of the IMDWx bits during system operation, but doing so affects all types of memory access, including processor-toprocessor reads and writes, host-to-processor reads and writes, DMA transfers, and interrupt data areas. The word width of data accesses and the value of the arithmetic precision mode bit RND32 are unrelated. This enables occasional use of 32-bit data in extended-precision, 40-bit systems, without having to toggle the value of RND32.

Because the processor's memory blocks must store either 32-bit or 40-bit data, DMA transfers automatically read or write the proper word width. This simplifies setting up DMA channels for a system. DMA transfers between serial ports and memory are limited to a maximum 32-bit word width.



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You can mix 32-bit words and 16-bit short words in the same memory block with no restrictions.

Using 16-Bit Short Word Accesses

Both 32-bit data accesses and 48-bit instruction fetches must use normal word addressing. But 16-bit data accesses can use short word addressing.

Short word addressing increases the amount of 16-bit data that the processor can store in internal memory, and it enables MSW (most significant word) and LSW (least significant word) addressing of 32-bit words. Bit 0 of the address selects between MSW and LSW addressing of 32-bit words.

Applications can access a single location in memory (that is, the lower 16 bits of a 32-bit word) using normal word addressing or short word addressing. The short word address is a left shift of the corresponding normal word address. This enables easy conversion between short word addresses and normal word addresses for the same physical location.

Word Size and Memory Block Organization

Figure 5-14 shows how short word addresses relate to normal word addresses for 32-bit words. Figure 5-10 on page 5-32 and Figure 5-11 on page 5-33 show how these addresses relate to normal word addresses for 48-bit words.

Arithmetically shifting a short word address to the right by one bit produces the corresponding normal word address. Arithmetically shifting a normal word address to the left produces the short word address of the LSW of the 32-bit normal word. To generate the short word address of the MSW, first perform a left shift and then set bit 0 to 1.



Figure 5-14. Short word addresses

The processor automatically extends into 32-bit integers 16-bit short words read into universal registers. Depending on the value of the SSE bit in MODE1 (0=zero-fill, 1=sign-extend), the processor either zero-fills or sign-extends the upper sixteen bits. When reading a short word into the PX register, the processor always zero-fills the upper sixteen bits, regardless of the value of the SSE bit.

Interfacing with External Memory

The processor provides addressing of up to 16-megawords of off-chip memory through its external port. This external address space includes multiprocessor memory space, the on-chip IOP registers of another ADSP-21065L connected in a multiprocessor system, and external memory space, the region for standard addressing of off-chip memory.

Table 5-7 on page 5-44 defines the processor pins that interface to external memory. Memory control signals enable direct connection to fast static RAM devices and SDRAMs. A user-defined combination of programmable wait states and hardware acknowledge signals provide support for memory-mapped peripherals and slower memories. You can use the suspend bus three-state pin (SBTS) with SDRAM memory.

External memory space can hold both instructions and data. To transfer 32-bit single-precision, floating-point data, the external bus must be 32-bits wide (DATA₃₁₋₀). To transfer instructions, the external bus must be 32-bits wide (DATA₃₁₋₀) and you must follow a precise procedure for packing 32-bit words into 48-bit instructions (see "Executing Program from External Memory" on page 5-49).

If external memory space contains only data or packed instructions for DMA transfer, the external data bus width can be either 8, 16, or 32 bits. In this type of system, the processor's on-chip I/O processor handles unpacking operations on incoming data and packing operations on outgoing data. Figure 5-15 on page 5-44 shows how the external port handles transfers of different data word sizes.



Figure 5-15. Alignment of external port data

The internal 32-bit DMA bus, PMA bus, and the I/O processor can access the entire 63.875-megaword external memory space.

Table 5-7. External memory interface signals

Pin	Туре	Function		
ADDR 23-0	I/0/Z	External Bus Address.		
		Processor outputs addresses for external mem- ory and peripherals on these pins.		
		In a multiprocessor system, the bus master outputs addresses for read/writes on IOP reg- isters of other ADSP-21065L. Processor inputs addresses when a host processor or multi pro- cessing bus master is reading or writing its IOP registers.		
$I = Input; 0 = Output; S = Synchronous; Z = Hi-Z (when \overline{SBTS} or \overline{HBR} is asserted, or when processor is a bus slave)$				

Pin	Туре	Function
DATA 31-0	I/0/Z	External Bus Data.
		Processor inputs and outputs data and instructions on these pins. Thirty-two bit, single-precision, floating point data is transferred over bits 31-0 of the bus. Six- teen-bit short word data is transferred over bits 15-0 of the bus.
		Pull-up resistors on unused DATA pins are unnecessary.
MS ₃₋₀	0/Z	Memory Select Lines.
		These lines are asserted as chip selects for the corresponding banks of external memory. These lines are decoded memory address lines that change at the same time as the other address lines. These lines remain inactive as long as no attempt to access external memory occurs. They are active, however, whenever a conditional memory access instruction exe- cutes, whether or not the condition is true. In a multiprocessing system, the bus master outputs the $\overline{MS}_{3,0}$ lines.
	I/0/7	Memory Read Strobe
		Asserted when the processor reads from exter- nal memory devices or from the IOP registers of another ADSP-21065L. External devices (including another ADSP-21065L) must assert RD to read from the processor's IOP registers. In a multiprocessor system, the bus master outputs RD, and the other ADSP-21065L inputs
		RD.
<u>I =</u> Input HBR is as	t; Ο = Οι serted,	tput; S = Synchronous; Z = Hi-Z (when <u>SBTS</u> or or when processor is a bus slave)

Table 5-7. External memory interface signals (Cont'd)

Interfacing with External Memory

Pin	Туре	Function
WR	I/0/Z	Memory Write Strobe.
		Asserted when processor writes to external memory devices or to the IOP registers of another ADSP-21065L. External devices must assert WR to write to the processor's IOP reg- ister.
		In a multiprocessing system, the bus master outputs WR, and the other ADSP-21065L inputs WR.
SW	I/0/Z	Synchronous Write Select.
		Provides the interface to synchronous memory devices (including another ADSP-21065L). Processor asserts \overline{SW} to provide an early indication of an impending write cycle, which can be aborted if \overline{WR} is not asserted later in a conditional write instruction.
		In a multiprocessing system, the bus master outputs SW, and the other ADSP-21065L inputs SW to determine whether the access to multi- processor memory is a read or a write. SW assertion and address output occur at the same time.
<u>I =</u> Input HBR is as	t; 0 = Ou sserted,	utput; S = Synchronous; Z = Hi-Z (when SBTS or or when processor is a bus slave)

Table 5-7. External memory interface signals (Cont'd)

Pin	Туре	Function	
АСК	I/0/S	Memory Acknowledge.	
		External devices can deassert ACK to add wait states to an external memory access. I/O devices, memory controllers, or other periph- erals use ACK to hold off completion of an access to external memory.	
		In a multiprocessing system, the slave pro- cessor deasserts the bus master's ACK input to add wait states to an access of its internal memory. The bus master has a keeper latch on its ACK pin, which maintains the input at the level it was driven to last.	
$I = Input; 0 = Output; S = Synchronous; Z = Hi-Z (when \overline{SBTS} or \overline{HBR} is asserted, or when processor is a bus slave)$			

Table 5-7. External memory interface signals (Cont'd)

External Memory Banks

External memory is divided into four banks of fixed size. All banks, except bank 0, can address all 16M words of external memory. Because part of the first 16M words of external memory is in internal memory, bank 0 is limited to 15.875M words of address space.

Because of its size, bank 0 imposes limitations on some applications but not on others. For example, you wouldn't want to use a $16M \ge 32$ memory in bank 0 because part of that address space is inaccessible. However, if you want to run code from external memory, you must do so from bank 0.

External memory's extremely flexible architecture enables you to use any kind of memory in any bank. If you use SDRAM, you can map it to only one bank.

Because the size of the external memory banks is fixed, any address generated within any external memory bank address space causes assertion of the corresponding $\overline{\text{MS}}x$ line. So, code your application to avoid generating addresses that do not map to physical devices.

Since all external memory space is banked, when you configure the blocks with bus idle, only transitions from reading one bank to reading another or to writing to the same bank generates an inactive bus cycle. Therefore, if you use several external devices, we recommend that you map each one to a different bank.

Each bank is associated with its own wait-state generator, enabling you to memory map slower peripheral devices into a bank that you have configured with a specific number of wait states. By mapping peripherals into different banks, you can accommodate I/O devices with different timing requirements. When you map SDRAM to a bank, make sure you program that bank with zero (0) wait states, so the SDRAM device operates properly. Bank 0 starts at address $0 \times 0002 \ 0000$ in external memory, followed by bank 1 at $0 \times 0100 \ 0000$, bank 2 at $0 \times 0200 \ 0000$, and bank 3 at $0 \times 0300 \ 0000$. Whenever the processor generates an address located within one of the four banks, it asserts the corresponding memory select line, $\overline{\text{MS}}_{3-0}$.

You can use the $\overline{\text{MS}}_{3-0}$ outputs as chip selects for memories or for other external devices and eliminate the need for external decoding logic.

The $\overline{\text{MS}}_{3-0}$ lines are decoded memory address lines that change at the same time as the other address lines. While no external memory access is occurring, the $\overline{\text{MS}}_{3-0}$ lines are inactive. However, they are active during execution of a conditional memory access instruction, whether or not the condition is true. To ensure proper operation on systems that use the $\overline{\text{SW}}$ signal but are unable to abort such accesses, avoid using conditional memory write instructions.



The processor's internal memory is divided into two blocks, but the external memory space is divided into four banks.

Executing Program from External Memory

To execute 48-bit instructions from external memory, the processor packs 32-bit words in external memory into internal 48-bit instructions and vice versa. This kind of packing differs from the packing modes DMA controller accesses or host accesses use, and it is performed in these two cases only:

- The Program Sequencer initiates an external access to fetch an instruction.
- The processor loads data from external memory into the PX register.



The processor supports program execution from external memory bank 0 only.

Table 5-8 shows an example of the packing scheme the processor uses to store 48-bit instructions in external memory.

Address/bits	31	bits	16	15	bits	0
0×20010	INSTRO[15:0]					
0x20011	INSTR0[47:16]					
0x20012	INSTR1[15:0]					
0x20013	INSTR1[47:16]					

Table 5-8. Example addresses for external program execution

The processor stores an instruction in two consecutive internal memory locations, with the first sixteen of the forty-eight bit instruction in an even address, and the remaining thirty-two bits in the next location.

To generate a corresponding address in external memory for the first part of the instruction, the processor left-shifts bits 15:0 to generate bits 16:1 (ADDR₁₆₋₀) in external memory. The processor leaves bits 23:17 unaltered. Each access of external memory to fetch an instruction or to load the PX register translates into two accesses to successive locations. ADDR₀ is 0 for the first access and 1 for the second. In this way, internal address 0x20000 on the PMA bus aligns with the beginning of external memory at 0x20000. To generate a corresponding address in external memory for the second part of the instruction, the processor increments the address of the previous access by one.

Table 5-9 shows the address generation scheme. This scheme limits the size of the internal contiguous program segments to 64K.

On the PMA bus, 64K memory space maps to 128K memory space in x32 external memory. A program segment can start on any 128K boundary of external memory. Although the PMA bus provides only 64K of contiguous program memory space, to use multiple segments, programs can incorporate JUMP instructions towards the end of individual 64K segments.

As shown in Table 5-9, ranges of segmented addresses on the PMA bus give rise to continuous addresses in external memory. It is possible to entirely use up bank 0 (0x20000-0xFFFFF) storing program.

Segment	PMA		ADDR	
1	0x20000	6	0x20000/1	1
	0x20001	4	0x20002/3	2
	\$	К	\$	8
	0x2FFFF		0x3FFFE/F	К
2	0×40000	6	0x40000/1	1
	\$	4	\$	2
	0x4FFFF	К	0x5FFFE/F	8
				К

Table 5-9. External memory address generation scheme

Segment	РМА		ADDR	
3	0x60000	6	0x60000/1	1
	\$	4	\$	2
	0x6FFFF	К	0x7FFFE/F	8
				К
	•	•	•	
		•		•
•	•	•	•	•

Table 5-9. External memory address generation scheme (Cont'd)

Program addresses in certain ranges are unavailable for program segments (for example, $0 \times 30000 - 0 \times 3FFFF$), and some of these address regions may be unavailable for data segments too. This is so because any data access to a location (for example, 0×30000) occurs to a physical location where part of an instruction (0×28000 in this case) may be stored. Make sure you select data segments carefully to avoid corrupting program memory in external memory.

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The value in the bit position that corresponds to PM_{19-16} must be an even number. An odd numbered value in this position conflicts with valid segments.

The processor drives the address for any data access as is on the ADDR pins, performing no packing. It does not support 40-bit data accesses from external memory. Programs must store 40-bit data in internal memory only.

Boot Memory Select (BSEL and BMS)

When BSEL is connected to V_{DD} , \overline{BMS} becomes an output pin, and the processor starts up in EPROM boot mode. The processor assumes that the EPROM's data bus is 8-bits wide. For EPROM booting, make sure you connect \overline{BMS} to the EPROM's chip select pin and the EPROM and processor data buses together LSB to LSB. This configuration enables applications to access a separate external memory space for booting.

In EPROM boot mode, when the processor generates EPROM addresses, it:

- Uses the EBxWM and EBxWS bits in the WAIT register to configure wait states.
- Drives the $\overline{\text{MS}}x$ pins high.

Only the master processor drives \overline{BMS} output. For details on EPROM booting, see Chapter 12, System Design.

Wait States and Acknowledge

You use the processor's WAIT register, an IOP control register, to configure external memory wait states and the processor's response to the ACK signal.

To simplify the interface between the processor and slow external memories and peripherals, the processor provides a variety of methods for extending off-chip memory accesses:

• External

The processor samples its acknowledge input (ACK) during each clock cycle.

If it latches a low value, the processor inserts a wait state by holding the address and strobes valid for an additional cycle. If the value of ACK is high, the processor completes the cycle.

• Internal

The processor ignores the ACK input.

Control bits in the WAIT register specify the number of wait states for the access. You can specify a different number of wait states for each bank of external memory. The processor uses the 1x CLKIN to count the number of wait state cycles.

• Both

The processor samples its ACK input in each clock cycle.

If it latches a low value, the processor inserts a wait state. If the value of ACK is high, the processor completes the cycle only if the number of wait states (specified in WAIT) have expired.

In this mode, the WAIT-programmed wait states specify a minimum number of cycles per access, and an external device can use the ACK pin to extend the access as necessary. The ACK signal may be transitioning (be undefined) until the internally programmed wait states have finished; that is, the processor does not sample ACK until the programmed wait states have finished. No metastability problems will occur.

• Either

The processor completes the cycle as soon as it samples the ACK input as high or when the WAIT-programmed number of wait states have expired, whichever occurs first.

In this mode, a system with two different types of peripherals could use ACK to shorten the access for the faster peripheral and use the programmed wait states for the slower peripheral. The method selected for one memory bank is independent of the method selected for any other bank. So, you can map devices of different speeds into different memory banks to maintain the appropriate wait state control.

The WAIT Register

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The bits in the WAIT register enable you to configure:

- For each bank of external memory, the wait state mode.
- For each bank of external memory, the number of wait states.
- A single wait state for multiprocessor memory space.
- A single idle cycle for DMA Handshaking.

The WAIT register initializes to 0x21AD 6B5A after processor reset. This configures the processor for:

- Six internal wait states.
- Dependence on both software-programmed wait states and external acknowledge for all memory banks.
- Multiprocessor memory space wait state enabled. (For details, see "Multiprocessor Memory Space Wait States and Acknowledge" on page 5-61).
- For proper SDRAM operation, make sure your application programs a zero (EBXWS=000) wait state for the external memory bank to which it maps.

Table 5-10 and Figure 5-16 on page 5-58 show the architecture of the WAIT register.

Table 5-	10. V	VAIT	register	bit	defin	itions
			0			

Bit	Name	Function
0 - 1	EBOWM	External bank O wait state mode. See Table 5-12 on page 5-61 for mode definitions.
2 - 4	EBOWS	External bank O number of wait states. See Table 5-11 on page 5-60 for number of wait states.
5 - 6	EB1WM	External bank 1 wait state mode. See Table 5-12 on page 5-61 for mode definitions.
7 - 9	EB1WS	External bank 1 number of wait states. See Table 5-11 on page 5-60 for number of wait states.
10-11	EB2WM	External bank 2 wait state mode. See Table 5-12 on page 5-61 for mode definitions.
12-14	EB2WS	External bank 2 number of wait states. See Table 5-11 on page 5-60 for number of wait states.
15-16	EB3WM	External bank 3 wait state mode. See Table 5-12 on page 5-61 for mode definitions.
17-19	EB3WS	External bank 3 number of wait states. See Table 5-11 on page 5-60 for number of wait states.
20-21	RBWM	ROM boot wait mode. See Table 5-11 on page 5-60 for number of wait states. Use the same values given for EBxWS.

Bit	Name	Function		
22-24	RBWS	ROM boot wait state. See Table 5-12 on page 5-61 for mode definitions. Use the same values given for EBxWM.		
25-28	Reserved	eserved		
29	MMSWS	Single wait state for multiprocessor memory space access		
30	HIDMA	Single idle cycle for DMA handshake ¹		
31	Reserved			

Table 5-10. WAIT register bit definitions (Cont'd)

¹ Setting the HIDMA bit to 1 also inserts an idle cycle after every read (with DMAGx asserted) from an external DMA latch. This enables a device with a slow Hi-Z time to get off the bus before another ADSP-21065L begins the next access. An idle cycle is inserted after every read from the DMA latch, not just for a change over. For details, see Chapter 6, DMA.

Figure 5-16 on page 5-58 shows the default bit values at initialization, after a processor reset.



Figure 5-16. Wait register bit values

A *bus idle cycle* is an inactive bus cycle that the processor automatically generates to avoid bus driver conflicts. Such conflicts can occur when, in the following cycle after it deasserts $\overline{\text{RD}}$, a device with a long output disable time continues to drive the bus when another device begins to drive it.

To avoid this conflict, the processor generates bus idle cycle only on transitions from reading one bank to reading another or to writing to the same bank. In other words, a bus idle cycle is generated after a read, except in the case of consecutive reads of the same bank. Normally, the processor's bus idle cycle period is one full CLKIN cycle. When an SDRAM access occurs after an access that causes a bus idle cycle, however, the bus idle cycle period is only half of one CLKIN cycle.

Figure 5-17 shows the effects of the bus idle cycle option.



Figure 5-17. Bus idle cycle

For a device with a slow disable time, make sure your application enables bus idle cycle for the bank it uses. To do so, in the WAIT register, set the EBxWS bits for the particular bank as shown in Table 5-11 on page 5-60.

Wait States	EBxWS	Bus Idle Cycle?	Hold Time Cycle?	
0	000	No	No	
1	001	Yes	No	
2	010	Yes	No	
3	011	Yes	No	
4	100	No	Yes	
5	101	No	Yes	
6	110	No	Yes	
0	111	Yes	No	
Bus idle cycles and hold time cycles occur if programmed, regardless of the wait state mode.				

Table 5-11. EBxWS bit values for bus idle cycles

A *bus hold time cycle* is an inactive bus cycle that the processor automatically generates at the end of a read or write to provide a longer hold time for address and data. The address and data remains unchanged and driven for $\frac{1}{2}$ the CLKIN cycle after the device deasserts the read or write strobes.

Figure 5-18 shows the effects of the bus hold time cycle option.



Figure 5-18. Bus hold time cycle

Table 5-12. Wait state modes

EB×WM	Mode
00	External acknowledge only (ACK)
01	Internal wait states only
10	Requires both internal and external acknowledge
11	Requires either internal or external acknowledge

Multiprocessor Memory Space Wait States and Acknowledge

Completion of reads and writes to multiprocessor memory space depends on the ACK signal only.

You can use the \overline{SW} signal to obtain an early indication of whether the access is a write or a read (see Figure 5-20 on page 5-68) and if the auto-

matic wait state option is enabled, adding a single wait state to all accesses of multiprocessor memory space.

To use the automatic wait state option, you set the MMSWS (multiprocessor memory space wait state) bit in the WAIT register.

Use the automatic wait state option whenever the external system bus is heavily loaded—under conditions that prevent the system from meeting the synchronous timing requirements for interprocessor communications. See the processor's data sheet for these specifications.

In this mode, the processors follow this procedure:

- 1. The master processor inserts the wait state.
- 2. In response, the slave processor drives ACK low in the first cycle, even if it has MMSWS=1.

If the master processor has MMSWS=1, it ignores ACK in the first cycle and responds to it in the second cycle. This setting provides longer set up times for the slave's signals ADDR, $\overline{\text{RD}}$, $\overline{\text{WR}}$, and DATA (written to the slave). And it provides a longer set up time for the bus master's ACK signal.

MMSWS=1 does not affect other set up and hold times. For example, it does not change hold times for the slave's \overline{RD} , \overline{WR} , or DATA (written to the slave) or set up and hold times for the bus master's DATA (read from the slave).

In a multiprocessor system, the value of the MMSWS bit must be the same on both processors.

External SDRAM Memory

Applications with large amounts of data can use off-chip SDRAM memory for bulk storage. The processor's SDRAM controller provides a glueless interface to standard 16M, 64M, and 128M SDRAMs. For details, see Chapter 10, SDRAM Interface.

Suspending Bus Three-state (\overline{SBTS})

External devices can assert the processor's <u>SBTS</u> input to place the external bus address, data, selects, and strobes in a high-impedance state for the following cycle.

If the processor attempts to access external memory while $\overline{\text{SBTS}}$ is asserted, the processor halts, and the access to memory is delayed until the external device deasserts $\overline{\text{SBTS}}$.

Use <u>SBTS</u> only to recover from deadlock with a host processor. (For details, see <u>Chapter 8</u>, Host Interface.)

<u>SBTS</u> causes the processor to place these pins in a high-impedance state.

- ADDR₂₃₋₀ BMS DATA₃₁₋₀
- $\overline{\text{DMAG}}_{2-1}$ $\overline{\text{MS}}_{3-0}$ $\overline{\text{RD}}$
- <u>SW</u> <u>WR</u>

Normal SBTS Operation: HBR not Asserted

Asserting <u>SBTS</u> places the external bus address, data, selects, and strobes in a high-impedance state for the following cycle.

If $\overline{\text{SBTS}}$ is asserted while an external access is in progress, the processor aborts the access (as if ACK were deasserted) and restarts the access after $\overline{\text{SBTS}}$ is deasserted.

If $\overline{\text{SBTS}}$ is asserted while no external access is in progress, the processor puts the external bus pins in a high impedance state and continues running until it initiates an external access (at which time the processor halts). In this case, the memory access begins in the cycle after the deassertion of $\overline{\text{SBTS}}$.

When $\overline{\text{SBTS}}$ is deasserted, the processor reasserts the $\overline{\text{RD}}$, $\overline{\text{WR}}$, and $\overline{\text{DMAGx}}$ strobes (if they were asserted before) after the external address becomes valid (at normal timing within the cycle). The processor also resets the wait state counter, even if the processor is held in reset ($\overline{\text{RESET}}$ asserted).

<u>SBTS</u> differs from <u>HBR</u> since it takes effect in the next cycle, even if an external access is in progress (but not finished). Use <u>SBTS</u> only when accessing an external device, such as an SDRAM or cache memory, where the access must be held off to prepare for it. Using <u>SBTS</u> at other times—such as during ADSP-21065L-to-ADSP-21065L accesses or during assertion of <u>DMAGx</u>—results in incorrect operation.

External Memory Access Timing

This section describes memory access timing for both the external and multiprocessor memory spaces. For exact timing specifications, see the processor's data sheet.

External Memory

The processor can interface asynchronously, without reference to CLKIN, to external memories and to memory-mapped peripherals. In a multiprocessing system, to access external memory, the processor must be bus master.

Figure 5-19 shows representative timing for an asynchronous read or write of external memory. The clock signal is shown only to indicate that the access occurs within a single cycle.



Figure 5-19. External memory access timing

Bus Master Reads of External Memory

External memory reads follow this sequence (see Figure 5-19):

1. The processor drives the read address and asserts a memory select signal (\overline{MS}_{3-0}) to indicate the selected bank.

The processor does not deassert the memory select signal between successive accesses of the same memory bank.

- 2. The processor asserts the read strobe (unless the access is aborted due to a conditional instruction).
- 3. The processor determines whether it needs to insert wait states.

If so, the memory select and read strobe remain active for one or more additional cycles. The state of the external acknowledge signal (ACK), the internally programmed wait state count, or a combination of the two determine the wait states.

- 4. The processor latches in the data.
- 5. The processor deasserts the read strobe.
- 6. If initiating another memory access, the processor drives the address and memory select lines for the next cycle.

If a memory read is part of a conditional instruction that remains unexecuted because the condition is false, the processor still drives the address and memory select lines for the read, but it does not assert the read strobe or read any data.

Bus Master Writes of External Memory

External memory writes follow this sequence (see Figure 5-19 on page 5-65):

1. The processor drives the write address and asserts a memory select signal to indicate the selected bank.

The processor does not deassert the memory select signal between successive accesses of the same memory bank.

- 2. The processor asserts the write strobe and drives the data (unless the memory access is aborted due to a conditional instruction).
- 3. The processor determines whether it needs to insert wait states.

If so, the memory select and write strobe remain active for one or more additional cycles. The state of the external acknowledge signal, the internally programmed wait state count, or a combination of the two determine the wait states.

- 4. The processor deasserts the write strobe near the end of the cycle.
- 5. The processor puts its data outputs in a high impedance state.
- 6. If initiating another memory access, the processor drives the address and memory select lines for the next cycle.

If a memory write is part of a conditional instruction that remains unexecuted because the condition is false, the processor still drives the address and memory select lines for the write, but it does not assert the write strobe or drive any data.

Multiprocessor Memory

Figure 5-20 on page 5-68 shows timing for multiprocessor memory accesses. For details on multiprocessor memory accesses, see Chapter 7, Multiprocessing.



Figure 5-20. Multiprocessor memory access timing

6 DMA

Direct Memory Access (DMA) provides a mechanism for transferring an entire block of data.

The processor's on-chip DMA controller relieves the core processor of moving data between internal memory and an external data source or external memory. Fully integrated, the DMA controller enables the processor's core or an external device to specify data transfer operations and return to normal processing while the DMA controller carries out data transfers independently and transparently.

The DMA controller can transfer blocks of data between:

- Internal memory and external memory or memory-mapped peripherals
- Internal memory and the IOP registers of another ADSP-21065L
- Internal memory and a host
- Internal memory and serial port I/O
- External memory and external peripherals

To ensure compatibility between its internal 32- and 48-bit structure and 16- and 32-bit peripheral devices, the processor packs and unpacks external bus words.

Each of the processor's two external port DMA control registers (\overline{DMAC}_{1-0}) provide control for external word packing.



Figure 6-1. ADSP-21065L block diagram


Figure 6-2. DMA control and data paths

As shown in Figure 6-2, the processor's DMA request inputs $\overline{\text{DMAR}}_{2-1}$ and DMA grant outputs $\overline{\text{DMAG}}_{2-1}$ respond to external DMA requests to transfer blocks of data to and from external asynchronous peripheral devices.

To transfer data to the processor's internal or external memory, I/O devices simply pull a $\overline{\text{DMAR}}x$ line low and wait for the processor to return the appropriate $\overline{\text{DMAG}}x$ signal.

For each of the processor's ten DMA channels, Table 6-1 shows the corresponding data buffer.

Chn	Data Buffer	Description
0	RxOA	Serial port O receive; A data
1	Rx1A	Serial port 1 receive; A data
2	RxOB	Serial port O receive; B data
3	Rx1B	Serial port 1 receive; B data
4	TxOA	Serial port O transmit; A data
5	Tx1A	Serial port 1 transmit; A data
6	TxOB	Serial port O transmit; B data
7	Tx1B	Serial port 1 transmit; B data
81	EPBO	External port FIFO buffer O
9 ²	EPB1	External port FIFO buffer 1

Table 6-1. DMA channels and data buffers

DMAR₂ and DMAG₂ are handshake controls for DMA Channel 8
 DMAR₁ and DMAG₁ are handshake controls for DMA Channel 9

The following terms are used throughout this chapter:

External port FIFO buffers

 EPB_{1-0} . The IOP registers used for external port DMA transfers and single-word data transfers from another ADSP-21065L or from a host. These buffers are 6-deep FIFOs.

DMACx control registers

The DMA control registers for the EPBx external port buffers $DMAC_{1-0}$. These correspond to EPB_{1-0} , respectively.

DMA parameter registers

The registers used to set up a DMA transfer. These registers include: address (IIx), modifier (IMx), count (Cx), chain pointer (CPx), and so on.

SPORT

Serial port.

Transfer control block (TCB)

A set of DMA parameter register values stored in internal memory that the processor's DMA controller downloads for chained DMA operations.

TCB chain loading

The process by which the processor's DMA controller downloads a transmit control block from memory and autoinitializes the DMA parameter registers.

The following conventions of notation are used throughout this chapter:

In register names,

- x = SPORT number (0/1)
- y = transmit or receive (T/R)
- z = data channel (A/B).

For example, in the notation DMACx for a DMA control register, x = SPORT number.

In the notation TXx_z for a DMA data buffer:

- TX = Transmit data buffer
- x = 0 or 1 (SPORT)
- z = A or B (data channel)

In the notation IIyx_z for a DMA parameter register:

- II = Index register
- y = R or T (Receive or Transmit)
- x = 0 or 1 (SPORT)
- z = A or B (data channel)

DMA Controller Operation

The processor's DMA controller performs four basic types of DMA transfer operations:

• External port block data transfers

This type of transfer moves data between the processor's internal memory and external memory, a host, another processor, or a memory-mapped device.

The application must program the DMA controller with the size and address of the internal memory buffer, the address increment, and the direction of transfer. The application may need to supply an external address also.

Once programmed, the DMA controller automatically begins transfers and continues until it has transferred the entire buffer to or from internal memory.

The processor supports four external port DMA transfer modes: master mode, handshake mode, external handshake mode, and paced master mode. For details, see "External Port DMA Modes" on page 6-55.

• Serial port I/O data transfers

This type of transfer handles data transmitted and received through the processor's serial ports.

As with external port transfers, the application must configure an internal memory buffer, but the DMA controller accesses the Tx or Rx serial port buffer instead of the EPBx buffer.

The direction of the serial port determines the direction of the data transfer. When the port receives data, the DMA controller automatically transfers it to internal memory. Likewise, when the port must transmit a word, the DMA controller automatically fetches the word from internal memory.

• Transfers between external devices and external memory.

The processor also supports data transfers between an external device and external memory. This type of transfer does not interfere with internal operations that do not use the external port.

External devices participate in DMA transfers in one of two ways:

- They read or write to one of the processor's DMA buffers.
- They assert a DMA request input (DMARx) to request service.
- DMA chaining

Applications can program one DMA transfer operation, upon finishing, to autoinitialize another one on the same channel.

Setting Up DMA Transfers

The master processor or a host can program DMA operations. To do so, the application must write to the processor's memory-mapped DMA control and parameter registers. This includes writing a set of memory buffer parameters to the DMA parameter registers and loading:

- The IIyx_z register with the starting address of the buffer.
- The IMyx_z register with an address modifier.
- The Cyx_z register with a word count.

Each external port and each serial port has a DMA enable bit (DEN) in its main control register (DMACx) that enables DMA operation. Once set up and enabled, DMA channels automatically transfer data words they receive to the buffer in internal memory. Likewise, when the processor is ready to transmit data, DMA channels automatically transfer data from internal memory to the DMA buffer register. Transfer continues until the entire data buffer has been received or transmitted.

The processor generates a DMA interrupt when it completes the transfer of an entire block of data. An interrupt occurs when the DMA channel's count register Cyx_z (and ECEPx register in master mode only) decrements to zero (0). The processor latches and masks DMA interrupts in the IRPTL and IMASK registers, respectively. These registers are located in the processor's core, not in its memory-mapped IOP register space.

To start a new DMA sequence after the current one finishes, applications must follow these steps:

- 1. Clear the DEN bit;
- 2. Write new parameters to the II, IM, and C registers;

Setting Up DMA Transfers

3. Set the DEN bit to re-enable DMA.

For chained DMA operations, this is not necessary. For details, see "DMA Chaining" on page 6-39.

DMA Control Registers

The registers that control and configure DMA operations are part of the memory-mapped IOP register set. To access these registers, applications write to or read from the appropriate address in memory.

This section describes the various operating modes of the DMA controller and associated control registers and bits. For details on the IOP registers, see Appendix E, Control and Status Registers, in *ADSP-21065L SHARC DSP Technical Reference*.

Table 6-2 lists the DMA control registers and data buffer registers. Because the serial port DMA control bits are located in the SPORT control registers, they do not appear in this table. For details, see "Serial Port DMA Control Registers" on page 6-22.

Register	Width	Description
EPBO	48	External port DMA FIFO buffer O
EPB1	48	External port DMA FIFO buffer 1
DMACO	16	DMA channel 8 control register for Ext. port buffer 0 (EPB ₀)
DMAC1	16	DMA channel 9 control register for Ext. port buffer 1 (EPB ₁)
DMASTAT	32	DMA channel status register
IIROA, IMROA, CROA, CPROA, GPROA	16-18	DMA channel O parameter registers (SPORTO receive, A data)
IIROB, IMROB, CROB, CPROB, GPROB	16-18	DMA channel 1 parameter registers (SPORTO receive, B data)

Table 6-2. DMA control, buffer, and parameter registers

Register	Width	Description
IIR1A, IMR1A, CR1A, CPR1A, GPR1A	16-18	DMA channel 2 parameter registers (SPORT1 receive, A data)
IIR1B, IMR1B, CR1B, CPR1B, GPR1B	16-18	DMA channel 3 parameter registers (SPORT1 receive, B data)
IITOA, IMTOA, CTOA, CPTOA, GPTOA	16-18	DMA channel 4 parameter registers (SPORTO transmit, A data)
IITOB, IMTOB, CTOB, CPTOB, GPTOB	16-18	DMA channel 5 parameter registers (SPORTO transmit, B data)
IIT1A, IMT1A, CT1A, CPT1A, GPT1A	16-32	DMA channel 6 parameter registers (SPORT1 transmit, A data)
IIT1B, IMT1B, CT1B, CPT1B, GPT1B	16-32	DMA channel 7 parameter registers (SPORT1 transmit, B data)
IIEPO, IMEPO, CEPO, CPEPO, GPEPO, EIEPO, EMEPO, ECEPO	16-32	DMA channel 8 parameter registers (External port FIFO buffer O)
IIEP1, IMEP1, CEP1, CPEP1, GPEP1, EIEP1, EMEP1, ECEP1	16-32	DMA channel 9 parameter registers (External port FIFO buffer 1)

Table 6-2. DMA control, buffer, and parameter registers (Cont'd)

External Port DMA Registers

Each external port DMA channel has its own control register, DMACx (see Figure 6-3), that corresponds to either DMA channel 8 or 9.

All bits are active high unless otherwise noted.



Figure 6-3. DMACx registers

Table 6-3 lists the contents of the DMACx registers. All control bits in the DMACx registers, except FLSH, take effect during the second cycle after the write to the register has finished. The FLSH bit takes effect in the third cycle after the write.

Bits	Register	Description
0	DEN	DMA enable for external ports.
1	CHEN	DMA chaining enable for external ports.
2	TRAN	Transmit/receive.
3 - 4	PS	Pack status (read-only).
5	DTYPE	Data type.
6 - 7	PMODE	Packing mode.
8	MSWF	Most significant word first during packing.
9	MASTER	Master mode enable.
10	HSHAKE	Hand shake mode enable (DMARx, DMAGx).
11	INTIO	Single-word interrupt enable for external port buffers.
12	EXTERN	External handshake mode enable.
13	FLSH	Flush DMA buffers and status.
14-15	FS	External port buffer status.
16-31	Reserved	

Table 6-3. External port control registers (DMACx)

DEN Enables DMA for the external port buffers.

CHEN

Enables chained DMA transfers.

Setting CHEN=1 and DEN=0 places the DMA channel in chain insertion mode. In this mode, the application can insert a new DMA chain into the current chain without affecting the current DMA transfer. This mode is similar to setting CHEN=1 and DEN=1, except it disables automatic chaining when the current DMA transfer ends.

Table 6-4 lists the modes selected by the CHEN and DEN bits.

CHEN	DEN	Mode
0	0	Chaining disabled, DMA disabled
0	1	Chaining disabled, DMA enabled
1	0	Chaining enabled, DMA enabled, autochain- ing disabled (chain insertion mode)
1	1	Chaining enabled, DMA enabled, autochain- ing enabled

TRANSpecifies the direction of data transfer.

- TRAN = 1 Transmit; read from internal memory to EPBx (slave mode) or to the external bus through the EPBx buffers (master mode).
- TRAN = 0 Receive; write to internal memory from the external bus through the EPBx buffers.

When set to 1, the direction of data transfer is internal-to-external. When EXTERN=1, setting TRAN=1 specifies a read from external memory, and setting TRAN=0 specifies a write to external memory.

PS A two-bit status field that indicates whether the packing buffer is on its first, second, or last pack, as shown in Table 6-5.

Value	Status
00	Pack finished.
01	First stage of all pack and unpack modes.
10	Second stage of 16- to 48-bit pack or unpack modes, or second stage of 32- to 48-bit pack or unpack modes.
11	Reserved.

Table 6-5. PS values for EPBx packing status

DTYPE

Specifies the type of data to transfer.

Internal memory uses this information to determine the word width.

DTYPE=1	Overrides the IMDW bits and forces a 48-bit (3-col-
	umn) memory transfer.

DTYPE=0 Uses the data word setting of the IMDW bits in the SYSCON register.

The data word may be 32 or 40 bits, as determined by the IMDW bits in the SYSCON register.

PMODE

A two-bit value that specifies the EPBx buffer packing mode.

For host accesses of the EPBx buffers, the application must set the HBW bits in the SYSCON register to correspond to the external bus width specified by PMODE, as shown in Table 6-6.

ValueMode00No packing or unpacking01Packing 16-bit external bus words to/from
32-bit internal words10Packing 16-bit external bus words to/from
48-bit internal words11Packing 32-bit external bus words to/from
48-bit internal words

Table 6-6. PMODE values for EPBx buffer packing modes

MSWF

Specifies the packing order for 16-to-32 bit packing and 16-to-48 bit packing.

For 32-to-48 bit packing, the DMA controller ignores MSWF.

- MSWF=1 Packing order is MSW (most significant 16-bit word first)
- MSWF=0 Packing order is LSW (least significant 16-bit word first)

INTIO

Enables external port DMA interrupts to occur when the external ports receive or transmit individual words.

Used only when DEN=0

Generating DMA interrupts this way is useful for implementing interrupt-driven, single-word transfers that are under control of the processor's core.

Setting INTIO=1 and:

TRAN=0	Causes the interrupts to occur when the EPBx input
	buffer is "not empty."

- TRAN=1 Causes the interrupts to occur when an output buffer is "not full."
- FLSH Reinitializes the state of the DMA channel, clearing the FS and PS status bits (setting them to 0).

This procedure flushes the external port FIFO buffer, the DMA request counter, and any partially packed data words. It also resets any internal DMA states. The entire procedure has a two-cycle latency.

FLSH is a self-clearing control bit, which is not latched and always reads as 0.

To avoid unexpected results, use the FLSH bit to clear the DMA channel only when the channel is inactive. To determine if the channel is active, read the DMASTAT register. (For any channel, the processor sets the channel active status bit in DMASTAT if DMA is enabled for the channel and the current DMA sequence is still in progress.)

Set the FLSH bit to 1 only when the DEN bit is 0 or at the same time you clear the DEN bit. Do not set FLSH to 1 in the same write that you set DEN to 1.

FS A two-bit status field that indicates whether data is present in the EPBx FIFO buffer.

When the processor is transmitting data to an external device, these status bits indicate whether the buffer has room for more data.

As shown in Table 6-7, when the processor is receiving data, these status bits indicate whether the buffer has new (unread) data.

Value	Status
00	Empty
01	Undefined
10	Partially full
11	Full

Table 6-7. FS EPBx FIFO buffer status values

MASTER

Master Mode DMA Enable.

The MASTER, HSHAKE, and EXTERN bits are used in combination, as described Table 6-8.

HSHAKE

DMA Handshake Mode Enable.

The MASTER, HSHAKE, and EXTERN bits are used in combination, as described in Table 6-8.

EXTERN

Specifies an external memory to external device DMA transfer.

In this mode, HSHAKE must equal 1, and MASTER must equal 0.

The MASTER, HSHAKE, and EXTERN bits configure the DMA mode this way.

М	Н	E	Mode
0	0	0	Slave Mode.
			Data in the receive buffer or available space in the transmit buffer generates an internal DMA request.
			Data transfer occurs between internal mem- ory and EPBx.
			If TRAN=1 (internal to external), the DMA controller fills the EPBx buffer as soon as the application sets DEN=1.
0	0	1	Reserved
0	1	0	Handshake Mode.
			Asserting the $\overline{\text{DMAR}}x$ line generates a DMA request. The transfer occurs when $\overline{\text{DMAG}}x$ is asserted*.
			Applies to EPBO, EPB1 buffers, DMA chan- nels 8 and 9 only.
0	1	1	External Handshake Mode.
			Identical to Handshake Mode, but with data transferred between external memory and an external device
			Applies to EPBO, EPBO buffers, DMA chan- nels 8 and 9 only.

Table 6-8. DMA mode configurations

Table 6-8. DMA mode configurations (Cont'd)

М	Н	E	Mode
1	0	0	Master Mode. The DMA controller attempts a transfer whenever the DMA counter is nonzero and the receive buffer has data or the trans- mit buffer has space.* Data transfer occurs between internal mem- ory and an external device. Keep DMAR2 high if DMA channel 8 is in mas- ter mode.
1	0	1	Reserved
1	1	0	Paced Master Mode. In this mode, the DMARx signal paces trans- fers. Applies to EPBO and EPB1 buffers and channels 8 and 9 only. Asserting DMARx generates a DMA request. DMARx requests operate the same as in hand- shake mode, except that DMAGx isn't used. Bus transfer occurs when either RD or WR is asserted. The address is driven as in nor- mal master mode. Since ORing the RD-DMAGx and WR-DMAGx pairs requires no external gates, buffer access can be zero-wait state with no idle states.
			Wait states and acknowledge (ACK) apply to Paced Master Mode transfers; see "Wait States and Acknowledge" on page 5-53.
1	1	1	Reserved

Serial Port DMA Control Registers

The processor's two serial ports, SPORT0 and SPORT1, can use DMA transfers to handle transmit and receive data. As shown in Table 6-9, DMA channels 0-7 are assigned to the serial ports.

The direction of SPORT DMA transfers is hardwired:

- Receive channels transfer data to internal memory.
- Transmit channels transfer data from internal memory.

DMA Chn	Data Buffer	Description
0	RXO_A	Serial port O; receive A data
1	RXO_B	Serial port O; receive B data
2	RX1_A	Serial port 1; receive A data
3	RX1_B	Serial port 1; receive B data
4	TXO_A	Serial port O; transmit A data
5	ТХО_В	Serial port O; transmit B data
6	TX1_A	Serial port 1; transmit A data
7	TX1_B	Serial port 1; transmit B data

Table 6-9. Serial port DMA channel assignments

The processor transmits 32-bit words internally between the RX and TX buffers and memory. Using the SPORTs' packing capability, you can configure the processor to receive and transmit 16-bit serial words, two at a time. For details, see Chapter 10, Serial Ports.

You must set up serial port DMA transfers in the DMA parameter registers for channels 0 through 7. Table 6-2 on page 6-11 lists these registers.

The serial port DMA enable bits are located in the SPORT transmit and receive control registers, STCTL0 and STCTL1. For details, see Chapter 10, Serial Ports.

Table 6-10 shows the control bits related to serial port DMA. These bits are active high: 0=disabled, 1=enabled.

Table 6-10. STCTLx/SRTCTLx serial port DMA control bits

Bit	Function	
SDENz	SPORT DMA enable	
SCHENz	SPORT DMA chaining enable	

Each serial port has a transmit DMA interrupt and a receive DMA interrupt, as shown in Table 6-11. When serial port DMA is disabled, a TX interrupt occurs when the TX buffer is not full, and a RX interrupt occurs when the RX buffer is not empty.

Table 6-11. SPORT DMA interrupts

Interrupt	Description	Priority
SPROI	DMA channels O, 1; SPORT O receive	Highest
SPR1I	DMA channels 2, 3; SPORT 1 receive	
SPTOI	DMA channels 4, 5; SPORT O transmit	
SPT1I	DMA channels 6, 7; SPORT 1 transmit	
EPOI	DMA channel 8; Ext. port buffer 0	
EP1I	DMA channel 9; Ext. port buffer 1	Lowest

DMA Channel Status Register

The DMA controller maintains a 32-bit, read-only status register, DMASTAT, that provides information on the state of each of the processor's DMA channels.

Table 6-12 lists the bits and their definitions. Bits 0 through 9 indicate which DMA channels are active, with bit 0 corresponding to channel 0, and so on. Bits 10 through 19 indicate the DMA chaining status for each channel.

- Channel active status
 - 1 = Active; transferring data or waiting to transfer the current block, not transferring TCB.
 - 0 = Inactive; DMA disabled, transfer complete or transferring TCB.
- Channel chaining status
 - 1 = Transferring TCB or waiting to transfer TCB.

Often, a DMA channel must wait to get control of the processor's internal I/O bus before it can transfer the TCB. The length of the wait depends on the number of DMA channels active at the same time.

0 = Chaining disabled or not transferring TCB

Table 6-12. Bit definitions of the DMASTATx registers

Bit	DMA Channel	Status for…
0	0	Rx0_A
1	2	Rx1_A
2	4	Tx0_A

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Bit	DMA Channel	Status for…
3	6	Tx1_A
4	1	Rx0_B
5	3	Rx1_B
6	8	EPBO
7	9	EPB1
8	5	Tx0_B
9	7	Tx1_B
10	0	Chaining on RxO_A
11	2	Chaining on Rx1_A
12	4	Chaining on TxO_A
13	6	Chaining on Tx1_A
14	1	Chaining on RxO_B
15	3	Chaining on Rx1_B
16	8	Chaining on EPBO
17	9	Chaining on EPB1
18	5	Chaining on TxO_B
19	7	Chaining on Tx1_B
20-31	Reserved	

Table 6-12. Bit definitions of the DMASTATx registers (Cont'd)

For a particular channel, the processor sets the channel active status bit if DMA is enabled and the current DMA transfer has not finished. It sets the chaining status bit if the channel is currently loading a TCB or if it is preparing to load a TCB. A single cycle of latency occurs between the time the processor changes the internal status and the time it updates the DMASTAT register.

As an alternative to interrupt-driven DMA, your application can poll DMASTAT to determine when a single DMA transfer has finished. To do so, the application reads DMASTAT to see if both status bits for the channel are inactive. If so, the DMA sequence has finished.



Polling DMASTAT while the DMA controller is transferring data through an EPBx buffer may cause the processor to deassert its \overline{BRx} line for one cycle. During this cycle, the host or another processor can take control of the bus, stalling the DMA transfer until the processor regains bus mastership.

Do not use polling if chaining is enabled because the next DMA sequence may have started by the time the processor returns the polled status.

DMA Controller Operation

DMA controller operations occur over the internal I/O bus. The serial ports and external port connect to internal memory over the I/O Data bus (IOD), and the DMA controller generates internal memory addresses on the I/O Address bus (IOA).

The DMA controller maintains two DMA channels used by the external port and eight DMA channels used by the serial ports. Each DMA channel consists of a set of parameter registers that specify a data buffer in internal memory and hardware that an I/O port uses to request DMA service.

To transfer data, the DMA controller accepts internal requests from I/O ports and sends back an internal grant when it services the ports. The DMA controller contains priority logic that determines which channel can drive the bus in any given cycle. Because internal memory has separate ports for core and I/O accesses, DMA transfers never conflict with the core over access of internal memory.

Each external port DMA channel has a control and a status register (read-only) that set the channel's operating mode and return its status information, respectively. External devices have access to all of the DMA control and parameter registers, which enables a host or other ADSP-21065L to set up a DMA channel and initiate transfers, without involving the local ADSP-21065L. To set up a DMA channel on itself, the processor writes to its own DMA control and parameter registers.

You can configure the external port DMA channels to transmit or receive data from internal memory, but since they are unidirectional, external port DMA channels either transmit or receive data only.

DMA Channel Parameter Registers

The processor's DMA channels and Data Address Generators (DAGs) operate similarly. Each channel has a set of parameter registers that includes an index register (IIyx_z), a modify register (IMyx_z), and a count register (Cyx_z). (For a complete list of these parameter registers, see Table 6-13 on page 6-31.) You use the index and modify registers to set up a data buffer in internal memory. You use the count register to determine when the processor generates an interrupt for the channel.

The application must initialize the index register with a starting address for the data buffer. The processor drives the address in the index register on its IOA (I/O Address) bus and applies it to internal memory during each DMA cycle. A DMA cycle is a clock cycle in which a DMA transfer is proceeding.

All addresses in the 17-bit index registers are offset by 0x0000 8000, the first internal RAM location, before the DMA controller uses them. The DMA controller cannot perform transfers to short word address space. (Using the processor's external port and serial port packing capability, however, you can transfer 16-bit short word data within 32-bit words.)

After transferring each data word to or from internal memory, the DMA controller adds the modify value to the index register to generate the address for the next DMA transfer. (It adds the modify value to the index value and writes the new value back to the index register.)



To enable both incrementing and decrementing, the modify value in the IM register is a signed integer. The modify value is fixed to 1 for DMA channels 0 through 7.



If the index register (II) is modified past its maximum 17-bit value (the value falls outside the normal word address range of internal memory), the register wraps around to the beginning address of the particular block, where DMA transfers continue.

For block 0, the maximum bit value is x0000 9FFF, and the starting address is x0000 8000. For block 1, the maximum bit value is x0000 DFFF, and the starting address is x0000 C000. For details, see "Memory Organization" on page 5-16.

Each DMA channel has a count register (Cyx_z), which the application must initialize with the word count of the data to transfer. The count register decrements at the end of each DMA transfer. When the count register value reaches 0, the processor can generate an interrupt for the channel.

Initializing a channel's count register with 0 does not disable
 DMA transfers on the channel. Instead, the channel performs
 2¹⁶ transfers because the first transfer starts before the controller tests the count value.

To disable a DMA channel, you clear the DMA enable bit in the channel's control register.

To start a new DMA sequence after the current one has finished:

- 1. Clear the DEN enable bit DMA interrupts.
- 2. Write new parameters to the II, IM, and C registers.
- 3. Set the DEN bit to re-enable DMA.

For chained DMA operations, this step is unnecessary.

Each DMA channel also has a chain pointer register (CPyx_z) and a general-purpose register (GPyx_z). You use the CP register to set up chained DMA operations and the GP register for any general purpose, such as storing the address of the previously used buffer.

The external port DMA channels (EPBx) each contain three additional parameter registers:

- External index register (EIEPx)
- External modify register (EMEPx)
- External count register (ECEPx)

(Serial port DMA channels do not have these registers.)

You use the EIEP, EMEP, and ECEP registers to generate 32-bit addresses that are driven out of the external port for master mode DMA transfers between internal memory and external memory or devices.

If the index register (EIEPx) is modified past its maximum 32-bit value (the value falls outside the external memory bank address range of internal memory), the processor continues to drive the ADDRx, RD, WR, and DATAx lines, but it does not drive any of the MSx lines. So, when the index register overflows, the processor gives no indication that it has, and no memory reads or writes occur.

You can use the upper bits of ADDRx to generate addresses outside the external memory bank address range.

The MASTER bit of each DMACx control register configures Master Mode. In Master Mode only, you must load the ECEP register with the number of external bus transfers to perform. (This count differs from the number of words the DMA controller transfers when you use word packing.) EIEPx cannot index internal memory.

DMA

Table 6-13 defines the DMA parameter registers. The parameter registers are uninitialized following a processor reset.

Register	Width	Function
II	17	Internal index. Starting address for data buffer is 0x0000 8000. (IIyx_z for SPORT DMA channels and IIEPx
IM	16	<pre>for external port DMA channels) Internal modifier. Address increment.¹ (IMyx_z for SPORT DMA channels and IMEPx for external port DMA channels)</pre>
С	16	Internal count. Number of words to transfer. (Cyx_z for SPORT DMA channels and CEPx for external port DMA channels)
СР	18	Chain pointer. Address of next set of buffer parameters. ² (CPyx_z for SPORT DMA channels and CPEPx for external port DMA channels)
GP	17	General purpose DMA. (GPyx_z for SPORT DMA channels and GPEPx for external port DMA channels)
EIEPx	32	External index. External port DMA channels only.

Table 6-13. DMA parameter registers

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Register	Width	Function
EMEPx	32	External modifier. External port DMA channels only.
ECEPx	32	External count. External port DMA channels only.

Table 6-13. DMA parameter reg	gisters (Cont'd)
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¹ The modify value of DMA channels 0-7 is fixed to 1.

² Lower 17 bits (bits 16-0) contain the memory address of the next set of parameters for chained DMA operations. Most significant bit (bit 17) is the PCI bit (Program-Controlled Interrupts), which determines whether the DMA interrupts occur at the completion of each DMA sequence.

Table 6-14 lists the parameter registers for each DMA channel.

DMA Chn	Registers	Description	
0	IIROA, IMROA ¹ , CROA, CPROA, GPROA	SPORT O receive; A data	
1	IIROB, IMROB, CROB, CPROB, GPROB	SPORT O receive; B data	
2	IIR1A, IMR1A, CR1A, CPR1A, GPROA	SPORT 1 receive; A data	
3	IIR1B, IMR1B, CR1B, CPR1B, GPR1B	SPORT 1 receive; B data	
4	IITOA, IMTOA, CTOA, CTROA, GPTOA	SPORTO Transmit; A data	
5	IITOB, IMTOB, CTOB, CPTOB, GPTOB	SPORTO Transmit; B data	

Table 6-14. Parameter re	egisters o	of each	DMA	channel
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DMA Chn	Registers	Description	
6	IIT1A, IMT1A, CT1A, CTR1A, GPT1A	SPORT 1 Transmit; A data	
7	IIT1B, IMT1B, CT1B, CPT1B, GPT1B	SPORT 1 Transmit; B data	
8	IIEPO, IMEPO, CEPO, CPEPO, GPEPO, EIEPO, EMEPO, ECEPO	External Port Buffer O	
9	IIEP1, IMEP1, CEP1, CPEP1, GPEP1, EIEP1, EMEP1, ECEP1	External Port Buffer 1	

Table 6-14. Parameter registers of each DMA channel (Cont'd)

¹ The values in the IMyx_z registers are fixed to 1.

Figure 6-4 on page 6-34 shows a block diagram of the DMA controller's address generator.









Figure 6-4. DMA address generation

Internal Request and Grant

The processor's I/O ports use internal DMA request and grant handshake hardware and protocol to communicate with the DMA controller.

Each serial port and external port DMA channel has one request and one grant line. When an I/O port needs to write data to internal memory, it asserts its request line. The DMA controller prioritizes this request with all other valid DMA requests. See Figure 6-2 on page 6-3.

When a channel's request takes highest priority, the DMA controller asserts that channel's internal grant line and starts the transfer in the next cycle. The DMA controller follows the same sequence when an I/O port requests read data from internal memory.

If a DMA channel is disabled, the DMA controller does not assert the channel's grant line, even if the channel has data to transfer.

Setting DMA Channel Prioritization

Since more than one DMA channel can have a request active in any cycle, the DMA controller uses a prioritization scheme to select which channel to service.

Prioritization enables the DMA controller to determine which channel can use the IOD bus to access memory. Except for the external port DMA channels, the processor always uses a fixed prioritization scheme. For external port DMA prioritization, see Table 6-15 on page 6-36, which lists, in descending order, the prioritization of I/O bus accesses, including DMA channels.

	Core Access to I/O Registers	
Priority	DMA Chn	Port/Buffer
Highest	0	Serial port O receive; RxO_A
	1	Serial port O receive; RxO_B
	2	Serial port 1 receive; Rx1_A
	3	Serial port 1 receive; Rx1_B
	4	Serial port O transmit; TxO_A
	5	Serial port O transmit; TxO_B
	6	Serial port 1 transmit; Tx1_A
	7	Serial port 1 transmit; Tx1_B
	NA	TCB loading requests ¹
	8	External port buffer O
Lowest	9	External port buffer 1

Table 6-15. Priority of internal memory I/O bus accesses

¹ Since TCB chain loading uses the I/O bus, these transfers require prioritization. See "DMA Chaining" on page 6-39.

Between each individual data transfer, the DMA controller determines which requesting channel has the highest priority during the next cycle. Prioritization of bus requests between master and slave processors, however, occurs only when the master processor gives up control of the external bus, which occurs only after the DMA controller has completed the transfer of an entire DMA data block. The processor prioritizes external direct accesses of internal memory and TCB chain loading with the DMA channels.

It does so to prevent contention over the internal I/O bus since these accesses occur over it. TCB chain loading has higher priority than external port accesses to enable chaining of serial port DMA transfers, which cannot be held off, even when the external port is attempting an access in every cycle. (For details, see "Transfer Control Blocks and Chain Loading" on page 6-41.)

Rotating Priority for External Port Channels

You can program the DMA controller to use a rotating priority scheme for the two external port channels. To do so, you set the DCPR bit in the SYSCON register.

The DCPR bit enables rotating priority for external port DMA channels 8 and 9.

DCPR = 0 disable DCPR = 1 enable

and

When rotating priority is enabled, high priority shifts back and forth between DMA channels 8 and 9 after each single-word transfer.

For example, rotation proceeds this way:

- 1. After reset, the default priority ordering, from high to low, is channel 8 to channel 9.
- 2. A single transfer is performed on channel 8.

3. With rotating priority enabled (DCPR=1), priority shifts to channel 9.

The external port channel priorities do not change relative to the serial port channel priorities. At reset, the processor clears the DCPR bit, disabling rotating priority.

When using fixed priority for the external port DMA channels, the highest priority is assigned to channel 8, and the lowest priority is assigned to channel 9. To redefine this priority, you assign channel 9 the highest priority.

To do so:

- 1. Disable external port DMA channel 8 only.
- 2. Select rotating priority, set DCPR = 1.
- 3. Generate at least one transfer on channel 9.
- 4. Disable rotating priority (DCPR = 0), and re-enable both external port DMA channels.

Table 6-16 illustrates this procedure.

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				1		0	Ο.	F		0	

Priority @	Highest	Lowest				
Reset	DMA 8	DMA 9				
Follow steps 1-4 above to make DMA 8 lowest priority.						
Reorder	DMA 9	DMA 8				
DMA Chaining

DMA chaining enables the processor's DMA controller to autoinitialize itself between multiple DMA transfers. Using chaining, you can set up multiple DMA operations in which each operation has different attributes.

In chained DMA operations, the processor automatically sets up another DMA transfer when its DMA controller has transmitted or received the entire contents of the current buffer. The processor supports DMA chaining on the same channel only. It does not support cross-channel chaining.

You use the chain pointer register (CP) to point to the next set of DMA parameters stored in internal memory. This new set of parameters is called a *transfer control block (TCB*). To set up the next DMA sequence, the processor's DMA controller automatically reads the TCB from internal memory and loads the parameter values into the channel parameter registers. This procedure is called *TCB chain loading*.

A *DMA sequence* is the sum of the DMA transfers for a single channel, starting with the initialization of the parameter registers and ending with the point at which the decrementing count register reaches zero (0).

Each DMA channel has a chaining enable bit (CHEN) in its corresponding control register. To enable chaining, you set this bit to 1, and to disable chaining, you write all zeros (0s) to the address field of the chain pointer register (CP).

With chaining enabled, to initiate DMA transfers, you write a memory address to the CP register. This is also an easy way to start a single DMA sequence, which includes no subsequent chained DMA transfers. Since you can load the CP register any time during the DMA sequence, you can disable chaining on a DMA channel (CP register address field = 0×0000) until an event occurs that loads the CP register with a non-zero value.

The lower seventeen bits of the 18-bit wide CP register is the memory address field, which is offset by 0×0000 8000 before the DMA controller

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uses it. Bit 17, the PCI (Program-Controlled Interrupts) bit, is a control bit and the most significant bit of the CP register.

Used in conjunction with the interrupt's mask bit in IMASK, the PCI bit selects whether or not an interrupt occurs at the completion of the current DMA sequence, but only on DMA channels with chaining enabled (CHEN=1).

- PCI=1 Enables the corresponding DMA channel interrupt, which occurs when the count register reaches 0.
- PCI=0 Disables the DMA channel's interrupt.

For nonchained DMA operations, you must use the IMASK register to disable the interrupt. But you can still mask out (disable), in the IMASK register, interrupt requests enabled by the PCI bit. Figure 6-5 shows the CP register and PCI bit.

Because the PCI bit is not part of the memory address in the CP register, take care when writing and reading addresses to and from the register. To prevent errors, mask out the PCI bit (bit 17) when you copy the address in CP to another address register.



Figure 6-5. Chain pointer register and PCI bit

The processor loads the general-purpose (GP) register from memory with the other parameter registers. You can use it during chained DMA sequences to point to the last DMA sequence that the DMA controller finished transferring. This procedure enables an application to determine the location of the last full (or empty) data buffer. Since a general-purpose register has no dedicated functionality, you can use it for any purpose.

Transfer Control Blocks and Chain Loading

During TCB chain loading, the processor loads the DMA channel parameter registers with values retrieved from internal memory. The CP register contains the chain pointer, which is the highest address of the TCB. The TCB is stored in consecutive locations.

Table 6-17 shows the TCB-to-register loading sequence for the external port and serial port DMA channels. The loading sequence is the order in which the DMA controller reads and loads each word of the TCB into its corresponding register.

Figure 6-6 on page 6-43 shows how to set up in memory the TCB for an external port DMA chain, which is referenced to the address pointer contained in the CP register of the previous DMA operation in the chain.

Address	+ Offset	Ext. Port Buffers	Serial Ports
CPyx_z	+ 0x0000 8000	IIEPx	IIyx_z
CPyx_z - 1	+ 0x0000 8000	IMEPx	IMyx_z
CPyx_z - 2	+ 0x0000 8000	CEPx	Cyx_z
CPyx_z - 3	+ 0x0000 8000	CPEPx	CPyx_z

Table 6-17. TCB chain loading sequence

Address	+ Offset		Ext. Port Buffers	Serial Ports
CPyx_z - 4	+ 0x0000	8000	GPEPx	GPyx_z
CPyx_z - 5	+ 0x0000	8000	EIEPx	
CPyx_z - 6	+ 0x0000	8000	EMEPx	
CPyx_z - 7	+ 0x0000	8000	ECEPx	
CPyx_z - 8	+ 0x0000	8000	_	

Table 6-17. TCB chain loading sequence (Cont'd)

TCB chain loading is requested the same way as all other DMA operations. The processor latches and holds a TCB loading request in the DMA controller until the TCB becomes the request with highest priority. As in normal DMA operation, the I/O Processor prioritizes and transfers the TCB registers individually. If multiple chaining requests are present, the DMA controller transfers the TCB registers for the highest priority DMA channel first. A channel with higher priority cannot interrupt a channel that is currently chain loading. See Table 6-15 on page 6-36 for DMA channel request priorities.



Figure 6-6. TCB memory setup for external port DMA channels

Setting Up and Starting a Chain

To setup and initiate a chain of DMA transfers:

- 1. Set up all TCBs in internal memory.
- 2. Write to the appropriate DMA control register, and set DEN=1 and CHEN=1.
- 3. To start the chain, write to the channel's CP register the last address (the address of the II register value) of the first TCB.

Before starting the first transfer, the DMA controller autoinitializes itself with the first TCB. On completion of this transfer, the DMA controller starts the next transfer if the current chain pointer address is nonzero. The DMA controller uses this address as the pointer to the next TCB. The address field of the CP registers is only seventeen bits wide. A symbolic address written directly to the CP register can cause a conflict between bit 17 and the PCI bit. Be sure to clear the upper bits of the address first, before you AND in the PCI bit separately (if necessary).

Inserting a Chain

You can insert a high priority DMA operation or chain into an active DMA chain.

Setting CHEN=1 and DEN=0 places the DMA channel in chain insertion mode. In this mode, a new DMA chain inserted into the current chain does not affect the current DMA operation. The processor's core writes a TCB into the channel parameter registers to insert the new chain.

In this mode, the DMA channel operates normally (as with CHEN=1 and DEN=1), except that at the end of the current DMA transfer, automatic chaining is disabled, and an interrupt request occurs. This interrupt request is independent of the PCI bit state.

Use this sequence to insert a DMA subchain while another chain is active:

1. To enter chain insertion mode, set CHEN=1 and DEN=0 in the appropriate DMA control register.

The DMA interrupt occurs to indicate when the current DMA sequence has finished.

2. Write the CP register value into the CP position of the last TCB in the new chain.

- 3. Set DEN=1 and CHEN=1.
- 4. Write the start address of the first TCB of the new chain into the appropriate CP register.

Do not use chain insertion for normal operations. Use it only to insert a high priority operation when another DMA operation is active.

DMA Interrupts

When the count register (C) of an active DMA channel decrements to zero (0), it generates an interrupt. For the external port DMA channels, when the processor is in MASTER mode, both the C and ECEP (external count) registers must equal zero (0) to generate the interrupt. Moreover, to generate a DMA interrupt, the count registers must decrement to zero (0) as a result of actual DMA transfers. Writing 0 to a count register does not generate this interrupt.

Each DMA channel has its own interrupt, which is latched in the IRPTL register and enabled in the IMASK register. Table 6-18 shows, in order of priority, the IRPTL and IMASK bits of the ten DMA channel interrupts. The interrupt priorities of all DMA channels are fixed.

Bit	Address ¹	Interrupt	DMA Chn	I/O port	Priority
10	0x28	SPROI	0/1	SPORT 0 rcv	Highest
11	0x2C	SPR1I	2/3	SPORT 1 rcv	
12	0x30	SPTOI	4/5	SPORT O xmit	
13	0x34	SPT1I	6/7	SPORT 1 xmit	
14-15	0x38-0x3C	Reserved			

Table 6-18. DMA interrupt vectors and priority

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1

Bit	Address ¹	Interrupt	DMA Chn	I/O port	Priority
16	0×40	EPOI	8	EPBO	
17	0×44	EP1I	9	EPB1	Lowest

Table 6-18. DMA interrupt vectors and priority (Cont'd)

Offset from base address: 0x0000 8000 for interrupt vector table in internal memory, 0x0002 0000 for interrupt vector table in external memory.

When DMA chaining is enabled, you can use the PCI bit in the CP register, instead of IMASK, to enable and disable DMA interrupts for each channel configured for chaining.

- PCI=1 DMA interrupt requests occur when the count register reaches zero (0).
- PCI=0 DMA interrupts disabled.

The PCI bit is valid only when DMA chaining is enabled. If chaining is disabled, you must use the IMASK register to disable interrupts. You can still mask out (disable) interrupt requests enabled by PCI in the IMASK register.

The processor's I/O ports can generate DMA interrupts without using DMA. In this case, two conditions generate an interrupt:

- The receive buffer contains data.
- The transmit buffer has space.

Generating DMA interrupts this way is useful for implementing interrupt-driven I/O controlled by the processor's core. Multiple interrupts can occur if several I/O ports transmit or receive data in the same cycle. To perform single-word, non-DMA interrupt-driven transfers on the external port, you must set the INTIO bit in the appropriate DMACx control register. Table 6-19 lists the conditions for which a DMA channel or its corresponding I/O port generate an interrupt.

Table 6-19. Conditions that generate DMA and I/O interrupts

Condition	Interrupt Mask
Chaining disabled; current DMA sequence ends	IMASK
Chaining enabled; current DMA sequence ends	IMASK and PCI
Chain insertion mode; current DMA sequence ends	IMASK
DMA disabled and I/O port accesses a buffer 1	IMASK

INTIO bit must be set in DMACx control register for external port.

1

When the interrupt mask is 1 (unmasked), the interrupt is enabled and will be acknowledged.

Because it is a universal register located in the processor's core, and not memory-mapped like the IOP registers, external devices cannot directly access the IMASK register over the external port. Applications can, however, use an interrupt vector to a routine that reads and writes IMASK through the external port. To do so, you use the VIRPT vector interrupt register.

Polling the DMASTAT register provides an alternative to interrupts for determining when a single DMA sequence has finished. To do so, you read the DMASTAT register, and, if both status bits for the channel are inactive, you know that the DMA sequence has finished.



Polling DMASTAT while the DMA controller is transferring data through an EPBx buffer may cause the processor to deassert its \overline{BRx} line for one cycle. During this cycle, the host or another processor can take control of the bus, stalling the DMA transfer until the processor regains bus mastership.

Do not use polling if chaining is enabled because the next DMA sequence may have started by the time the processor returns the polled status.

Starting and Stopping DMA Sequences

The way DMA sequences start depends on whether DMA chaining is enabled. When chaining is disabled, only the DMA enable bit (DEN) enables or disables DMA transfers.

A DMA sequence starts when one of the following occurs:

- Chaining is disabled, and the DMA enable bit (DEN) transitions from low to high.
- Chaining is enabled, DMA is enabled (DEN=1), and the application writes a nonzero value to the CP register address field.

In this case, TCB chain loading of the channel parameter registers occurs first.

• Chaining is enabled, the CP register address field is nonzero, and the current DMA sequence finishes.

In this case, TCB chain loading occurs.

A DMA sequence ends when one of the following occurs:

- The count register decrements to 0 (for external port channels, both C and ECEP).
- Chaining is disabled, and the channel's DEN bit transitions from high to low.

If the DEN bit goes low and chaining is enabled, the channel enters chain insertion mode, and the DMA sequence continues. (For details, see "Inserting a Chain" on page 6-44.)

When the DEN bit goes high again, the DMA sequence continues from where it stopped (for nonchained operations only).

To start a new DMA sequence after the current one has finished:

- 1. Clear the DEN bit.
- 2. Write new parameters to the II, IM, and C registers.
- 3. Set the DEN bit to re-enable DMA.

(For chained DMA operations, however, this is not necessary. See "DMA Chaining" on page 6-39.)

External Port DMA

Channels 8 and 9 are the external port DMA channels.

These DMA channels enable efficient data transfers between the processor's internal memory and external memory or devices. DMA transfers between the processor and any external device that lacks bus master capability use these channels.

External Port FIFO Buffers (EPBx)

DMA Channels 8 and 9 are associated with the external port FIFO data buffers, EPB_0 and EPB_1 .

Each buffer acts as a six-location FIFO, and each has two ports—a read port and a write port. Each port can connect to either the EPD (External Port Data) bus or to the IOD (I/O Data) bus, the PM Data bus, or the DM Data bus. (See Figure 6-2 on page 6-3.)

The FIFO structure enables DMA transfers at full processor clock frequency since reads and writes of the same data can occur at the same time through the FIFO's separate read and write ports.

You can use the external port FIFO buffers for non-DMA, single-word data transfers too. For details, see Chapter 8, Host Interface.



Do not attempt core reads or writes of an EPBx buffer when a DMA operation using that buffer is in progress. Doing so corrupts the DMA data.

To flush (clear) an external port buffer, write 1 to the FLSH bit in the appropriate DMACx control register. Do so only when DMA for the channel is disabled.

The FLSH bit is not latched internally and always reads as 0. Status can change in the following cycle.

Do not enable and flush an external port buffer in the same cycle.

External Port DMA Data Packing

Each external port buffer contains data packing logic to pack 8-, 16-, or 32-bit external bus words into 32- or 48-bit internal words. The packing logic is reversible to unpack 32-bit or 48-bit internal data into 8-, 16-, or 32-bit external data.

The PMODE bits in the DMACx control registers determine the packing mode for internal bus words, and the HBW bits in the SYSCON register determine the packing mode for external bus words. The type of access, host or processor-to-processor or processor-to-memory, determines which packing bits you need to set to select a packing mode.

For processor accesses of another ADSP-21065L or of memory while using master mode, paced master mode, or handshake mode DMA, to pack and unpack individual data words, you must set the PMODE bits only (HBW bits have no effect), as shown in Table 6-20.

Value	Mode
00	No packing or unpacking
01	Packing 16-bit external bus words to/from 32-bit internal words
10	Packing 16-bit external bus words to/from 48-bit internal words
11	Packing 32-bit external bus words to/from 48-bit internal words

Table 6-20. PMODE values for EPBx buffer packing modes

For host accesses, to pack and unpack individual data words, you must set both the PMODE bits in the appropriate DMACx control register and the HBW bits in the SYSCON register, as shown in Table 6-21.

DMA P	acking Mode	Host Bus Width				
PMODE	Internal bits	00 (32b)	01 (16b)	10 (8b)		
00	Invalid for host DMA transfers through the EPBx buffers. Valid only for nonhost-based DMA transfers.					
01	32	No pack	16 ↔ 32	8 ↔ 32		
10	48	32 ↔ 48	16 ↔ 48	8 ↔ 48		
11	Identical to PMODE = 10					

Table 6-21. Packing modes using PMODE and HBW bits

The external port buffer can pack data in most significant word first (MSWF) order or in least significant word first (LSWF) order. Setting the MSWF bit to 1 in the DMACx control register selects MSW mode for both packing and unpacking operations. The MSWF bit has no effect when PMODE=11 or PMODE=00.

The packing sequence for downloading processor instructions from a 32-bit bus (PMODE=11, HBW=00) takes three cycles for every two words, as Table 6-22 shows.

Table 6-22. Packing sequence for downloading instructions from a 32-bit bus

Transfer	Data bus lines 31-16	Data Bus Lines 15-0
First	Word 1; bits 47-32	Word 1; bits 31-16

Tabl	e 6-22.	Packing	sequence	for	downlo	bading	instru	ctions	from a	a 32-bit
bus	(Cont'o	ł)								

Transfer	Data bus lines 31-16	Data Bus Lines 15-0
Second	Word 2; bits 15-0	Word 1; bits 15-0
Third	Word 2; bits 47-32	Word 2; bits 31-16

For host transfers to or from the EPBx buffers, you must set the HBW bits in the SYSCON register to correspond to the external bus width. For details, see Chapter 8, Host Interface.

The processor transfers 32-bit data on data bus lines 31-0. To transfer an odd number of instruction words, you must write a dummy access to flush the packing buffer and remove the unused word.

For 32- to 48-bit packing, the processor ignores the HMSWF bit in the SYSCON register and the MSWF bit in the DMACx control register.

Table 6-23 shows the packing sequence for downloading processor instructions from a 16-bit bus (PMODE=10, HBW=01).

Table 6-23.	Packing	sequence	for	download	ling	instruc	tions	from a	a	16-bit
bus										

Transfer	Data Bus Pins 15-0
First	Word 1; bits 47-32
Second	Word 1; bits 31-16
Third	Word 1; bits 15-0
HMSWF = 1 (pack	ing order for host accesses is MSW)

The HMSWF bit determines whether the I/O processor packs the most significant 16-bit word or the least significant 16-bit word first. See Chapter 5, Memory, for details on allocating memory for different word widths.

The packing sequence for downloading processor instructions from an 8-bit bus (PMODE=10, HBW=10) takes six cycles for each word, as Table 6-24 shows.

Transfer	Data Bus Pins 7-0			
First	Word 1; bits 47-40			
Second	Word 1; bits 39-32			
Third	Word 1; bits 31-24			
Fourth	Word 1; bits 23-16			
Fifth	Word 1; bits 15-8			
Sixth	Word 1; bits7-0			
HMSWF = 1 (packing order for host accesses is MSW)				

Table 6-24. Host to processor, 8- to 48-bit word packing

The HMSWF bit in SYSCON determines whether the I/O processor packs the most significant or least significant 8-bit word first.

Packing Status

Each external port DMA control register contains a 2-bit PS field, which indicates the number of short words currently packed in the EPBx buffer. The PS status field behaves the same way during packing and unpacking operations. All packing functions are available for all types of DMA transfer.

Generating Internal and External Addresses

For DMA transfers between the processor's internal memory and external memory, the DMA controller must generate addresses in both memories. The external port DMA channels contain both EIEP (External Index) and EMEP (External Modifier) registers to generate external addresses. The EIEP register provides the external port address for the current DMA cycle, and it is updated with the modifier value in EMEP for the next external memory access.

To support the wide range of data packing options provided for external DMA transfers, the EIEP and EMEP registers can generate addresses at a different rate than the internal address generating registers IIEP and IMEP. For this reason, the internal and external address generators operate independently, and the ECEP (External Count) register serves as the external DMA word counter.

When, for example, a 16-bit DMA device reads data from the processor's internal memory, two external 16-bit transfers occur for each 32-bit internal memory word, and the ECEP (external) word count is twice the value of the CEP (internal) word count.

External Port DMA Modes

The MASTER, HSHAKE, and EXTERN bits of each DMACx control register select the DMA operation mode for the channel. You can set up each external port DMA channel to operate in one of five DMA modes as shown in Table 6-25 on page 6-56.

Only master mode initiates transfers, and all other modes act as *slave*, requiring an external device to initiate each transfer.

External Port DMA

Table 6-25 shows how the MASTER, HSHAKE, and EXTERN bits in combination configure the DMA mode.

Table 6-25. DMACx register DMA mode configuration bit combinations

М	Н	E	Mode ¹		
0	0	0	Slave Mode.		
			an Rx buffer is not empty or a Tx buffer is not full. ²		
0	0	1	Reserved.		
0	1	0	Handshake Mode.		
			Applies to the EPBx buffers (channels 8 and 9) only.		
			The DMA controller generates a DMA request when the DMARx line is asserted and begins transferring the data when the processor asserts the DMAGx line.		
0	1	1	External Handshake Mode.		
			Applies to the EPBx buffers (channels 8 and 9) only.		
			Identical to Handshake Mode, except the DMA con- troller transfers the data between external memory and an external device.		
			The processor does not support this mode on an external memory bank mapped to SDRAM.		

Table 6-25. DMACx register DMA mode configuration bit combinations (Cont'd)

М	Н	E	Mode ¹
1	0	0	Master Mode. The DMA controller attempts to transfer data when- ever the DMA counter is nonzero and either the Rx buffer is not empty or the Tx buffer is not full. Keep DMAR2 high (inactive) if channel 8 is in master mode. Keep DMAR1 high (inactive) if channel 9 is in master mode.
1	1	0	Paced Master Mode. Applies to the EPBx buffers (channels 8 and 9) only. The DMARx signal paces transfers. The DAM controller generates a DMA request when the DMARx line is asserted. DMARx requests operate the same as in Handshake Mode, and the DMA controller transfers the data when RD or WR is asserted. The address is driven as in normal master mode. ORing the RD-DMAGx and WR-DMAGx pairs requires no external gates, enabling buffer access with zero-wait states and no idle states. Wait states and Acknowledge (ACK) apply to paced master mode transfers. For details, see <i>Chapter 5</i> , <i>Memory</i> .
1	1	1	Reserved.

¹ When an external port DMA channel is configured for output (TRAN=1), the EPBx buffer starts to fill as soon as the DMA channel is enabled, even if no DMARx assertions or slave mode DMA buffer reads have been made.

² For data reads from the processor (TRAN=1), the EPBx buffer is filled as soon as the DEN enable bit is set to 1.

External Port DMA

Master Mode

For a channel configured for master mode, the DMA controller generates internal DMA requests for the channel until the DMA sequence has finished.

While in master mode, the processor drives the external bus control signals.

Setting DMACx bits,

MASTER=1 HANDSHAKF=0 FXTFRN=0

places the corresponding DMA channel in master mode. You can specify master mode independently for each external port DMA channel.

Examples of DMA master mode operations include:

- Transfers between internal memory and external memory.
- Transfers from internal memory to external devices.

In both cases, the data is set up in memory, so the processor can run the complete sequence without having to interact with other devices.



Serial port DMA channels do not have the MASTER control bit and do not operate in master mode.

Paced Master Mode

In paced master mode, $\overline{\text{DMAR}}x$ requests operate the same way as in handshake mode, but $\overline{\text{DMAR}}x$ is inactive. The slave processor asserts $\overline{\text{DMAR}}x$ to initiate each transfer. The processor responds to requests with the \overline{RD} or \overline{WR} strobe only. This method enables both the DMA controller and core I/O to share the same buffer without external gating.

To extend paced master mode accesses, you can:

- Use the ACK pin.
- Use wait states programmed in the WAIT register.
- Hold the $\overline{\text{DMAR}}x$ pin low.

Slave Mode

Clearing the DMACx bits MASTER, HANDSHAKE, and EXTERN configures the corresponding DMA channel for slave mode. In slave mode, the processor does not drive the external bus control signals.

In slave mode, the DMA channel cannot initiate external memory transfers independently, regardless of the programmed direction of data transfer. To initiate a DMA transfer to or from the processor configured for slave mode, an external device must read or write to the appropriate EPBx buffer.

The direction of date transfer through the EPBx buffers determines the behavior of the DMA channels:

• Internal to external

Transfers occur between internal memory and the EPBx buffers. The DMA channel automatically performs enough transfers to keep the EPBx buffer full. (Each EPBx buffer is a six-location FIFO.)

• External to internal

Transfers occur between external devices and the EPBx buffers. The DMA channel does not initiate any internal DMA transfers until the EPBx buffer contains valid data.

Slave mode does not use the EIEP, EMEP, or ECEP registers.

External to Internal. In slave mode, block transfers of data from an external device into the processor's internal memory follow this sequence:

- 1. To initialize the channel, the external device writes to the DMA channel parameter registers, II, IM, and C, and to the DMACx control register.
- 2. The external device begins writing data to the EPBx buffer.
- 3. When the EPBx buffer contains a valid data word, it signals the DMA controller to request an internal DMA cycle.

Depending on the packing mode selected, the EPBx buffer may require one or more external memory cycles to acquire a valid data word.

4. When $\overline{\text{DMAG}}x$ is asserted, the DMA controller performs the internal transfer and empties the EPBx FIFO buffer.

Even if the internal DMA transfer is held off, the external device can still write to the EPBx buffer again since the buffer is a six-deep FIFO.

- 5. When the EPBx FIFO fills up, the processor deasserts the REDY signal to hold off the external device.
- 6. The processor continues to deassert REDY until the internal DMA transfer has finished, freeing space in the EPBx buffer. To configure the buffer to operate this way, clear the BHD (Buffer Hang Disable) bit in the SYSCON register.

Internal to External. In slave mode, block transfers of data from the processor's internal memory to an external device through the external port follow this sequence:

- 1. Immediately after it is enabled, the DMA controller requests internal DMA transfers to fill up the EPBx FIFO buffer.
- 2. When the buffer fills up, the DMA controller deasserts the request.
- 3. The external device reads the buffer, causing the EPBx buffer to become "partially empty."

Depending on the packing mode selected, the external device may require one or more external memory cycles to read the EPBx buffer.

- 4. The DMA controller asserts the internal DMA request again.
- 5. If, because of internal bus conflicts, the internal DMA transfers do not fill the EPBx FIFO buffer at the same rate the external device empties it, the processor deasserts the REDY signal to hold off the external device until the EPBx buffer contains valid data.

To configure the buffer to operate this way, clear the BHD (Buffer Hang Disable) bit in the SYSCON register.

The processor deasserts REDY during a write only when the EPBx FIFO buffer is full. REDY remains asserted at the end of a block transfer if the EPBx buffer is empty or partially full. For reads, the buffer is empty at the end of the block transfer, and the processor deasserts REDY if an additional read is attempted.

System-Level Considerations. Slave mode DMA is useful in systems with a host processor because it enables the host to access any internal memory location in the processor while limiting the address space the host must

recognize—only the address space of the processor's IOP registers. Slave mode DMA is also useful for interprocessor DMA transfers.

Handshake Mode

Slave mode DMA has one drawback that occurs when the processor interfaces with a slow host. Regardless of who initiates the transfer, a slow host holds up the external bus during a transfer and prevents any other transactions from proceeding. To avoid this delay, use the DMA handshake mode.

In handshake mode:

- The host can make a DMA request without mastering the bus.
- The processor in master mode can use the bus without waiting for the transfer to finish.

In this scenario, the host asserts the $\overline{\text{DMARx}}$ pin. When the processor is ready to do the transfer, it can complete it in one bus cycle.

DMA channels 8 and 9, for external port buffers EPB_0 and EPB_1 , each have a set of external handshake controls, \overline{DMARx} and \overline{DMAGx} . $\overline{DMAR_2}$ is the request signal, and $\overline{DMAG_2}$ is the grant signal for EPB_0 and channel 8. Likewise, $\overline{DMAR_1}$ is the request signal, and $\overline{DMAG_1}$ is the grant signal for EPB_1 and channel 9.

These signals provide the hardware handshake for DMA transfers between the processor and an external device that does not have bus mastership capability.

If you enable an external port DMA channel, but do not intend to use the handshake signals, be sure to keep the corresponding DMARx signal high. Setting the HSHAKE bit to 1 in a channel's DMACx register enables handshake mode DMA for the channel:

MASTER=0 The processor handshakes, returning the \overline{DMAGx} signal.

MASTER=1 The DMA channel operates in paced master mode.

DMA handshaking occurs asynchronously up to the processor's full clock speed. For the source and destination of the data, you can select either the processor's internal memory or its external memory. Make sure your application loads the ECEP external count register whenever it performs external DMA transfers.

During DMA transfers between itself and an external device, the processor keeps its $\overline{\text{MS}}_{3-0}$ memory select lines deasserted because the transfer does not access external memory space. In external handshake mode, however, the processor asserts its $\overline{\text{MS}}_{3-0}$ lines to provide the address and strobes for transfers between an external DMA device and external memory.

The DMA handshake uses the rising and falling edges of $\overline{\text{DMARx}}$. The processor interprets a falling edge as "begin a DMA access," and it interprets the rising edge as "complete the DMA access." See Figure 6-7 on page 6-66.

To request access of the EPBx buffer, the external device pulls $\overline{\text{DMARx}}$ low. The processor detects and synchronizes the falling edge of $\overline{\text{DMARx}}$ to its system clock. For the processor to recognize the $\overline{\text{DMARx}}$ line's transition to low in a particular cycle, the transition must meet the setup time specified in the processor's data sheet. Otherwise, the processor may not recognize the transition until the following cycle.

When it recognizes the request, the processor, if it is not already bus master or if the buffer is not blocked, begins arbitrating for the external bus. When the processor becomes the bus master, it drives \overline{DMAGx} low until it detects \overline{DMARx} deasserted. This enables the external device, until it is ready to proceed, to hold off the processor. If no pipelined requests

occurred, the processor deasserts $\overline{\text{DMAG}}x$ in the cycle after the external device deasserts $\overline{\text{DMAR}}x$.

If the external device does not need to extend the grant cycle, it can deassert $\overline{\text{DMARx}}$ immediately after asserting it, provided this procedure meets the minimum pulse width timing requirements specified in the processor's data sheet. In this scenario, $\overline{\text{DMAGx}}$ is a short pulse, and the external bus is used for one cycle only.

The DMA controller has a three-cycle pipeline similar to the Program Sequencer's fetch-decode-execute pipeline:

- DMA request and arbitration occur in the fetch cycle.
- DMA address generation and bus arbitration occur in the decode cycle
- The data transfer occurs in the execute cycle.

Using the rising and falling edges of $\overline{\text{DMARx}}$ makes better use of the pipeline and, if appropriate, enables data transfers up to the processor's full clock rate.

The external device need not wait for the $\overline{\text{DMAG}}x$ grant signal before making another request. The processor stores and maintains requests in an internal working counter. The counter holds a maximum of six requests, so the external device can make up to six requests before the processor services the first one.



More than six requests without a grant can cause unpredictable results.

The processor asserts DMAGx in response to DMARx only for the number of transfers specified in the counter. DMAGx remains deasserted if requests exceed this number. You use the flush bit (FLSH) in the DMACx control register to clear any extra requests. When the $\overline{\text{DMAG}}x$ grant signal arrives, the external device must make sure that:

- It is able to accept each word for a read.
- The data for each write request is immediately available.

To ensure immediate availability of data, place it in an external FIFO.

When transferring DMA data at the processor's full clock speed, you may need a two- or three-deep data pipeline to handle the latency between request and grant. For example, the external device might issue three consecutive requests rapidly and condition a fourth request on whether the processor issued a grant in response to the requests. Baring this caveat, DMA transfers can occur at up to the processor's full clock rate for both reads and writes. The processor clears the stored requests when the application writes a 1 to the flush bit (FLSH) in the channel's DMACx control register.

Because the external device can control completion of a request, it does not need data available before making a request. If, however, the data remains unavailable for two cycles and DMARx remains low for that time, the processor and the external bus may be held inactive. Each DMA transfer occupies the external bus for only one cycle if the request is deasserted before the grant has been asserted. Otherwise, the external bus is held for the time $\overline{\text{DMARx}}$ is asserted.



Figure 6-7. DMA handshake timing with asynchronous requests

For asynchronous DMA DMARx requests, as shown in Figure 6-7:

• The falling edge of DMARx initiates a DMA request on the processor. When writing, the device must provide data before the processor deasserts DMAGx. If the data is unavailable, the device can continue to assert DMARx (hold it low) until the data becomes available. When this occurs, the processor attempts to service the request, but it is delayed until the rising edge of DMARx.

• After DMARx, a minimum delay of three cycles occurs before the processor asserts DMAGx and the external DMA device transfers the data to the processor or to external memory.

If, however, a higher priority DMA operation is requesting service or another ADSP-21065L is currently using the bus, the processor may not be able to issue a $\overline{\text{DMAGx}}$ grant for several cycles after a DMA request. So, the external device must not assume that the grant will arrive within two cycles, unless higher priority DMA operations are disabled and the external bus is available.

• DMA requests are pipelined in the processor.

The processor keeps track of a maximum of six requests when it is unable to service them immediately and services them based on priority. Tracking enables DMA transfers to occur at up to the processor's full clock rate.

The external device is responsible for keeping track of requests, monitoring grants, and pipelining the data when operation is at full clock rate.

An EPBx buffer that is full during a write or empty during a read creates a blocked condition and prevents the processor from beginning arbitration for the external bus in response to \overline{DMARx} . Arbitration begins again when the DMA controller services the EPBx buffer, changing its state and clearing the block.

Disabling an external port DMA channel disables its corresponding $\overline{\text{DMARx}}$ and $\overline{\text{DMAGx}}$ pins. When re-enabling DMA, the processor ignores $\overline{\text{DMARx}}$ assertions for a maximum of two cycles after the instruction that enables DMA (DEN=1) in handshake mode as shown in Figure 6-8 on page 6-68. The processor holds $\overline{\text{DMAGx}}$ high.

The application must keep the $\overline{\text{DMARx}}$ input high (not low or transitioning) during the instruction that enables DMA in handshake mode as shown in Figure 6-8.



Figure 6-8. DMARx delay after enabling handshake DMA

Two processors in a multiprocessing system can share the same \overline{DMAGx} signal, but only the processor that is bus master drives \overline{DMAGx} . The processor disables \overline{DMAGx} when it is bus slave or whenever the host asserts \overline{HBG} . This scheme eliminates the need for external gating when both processors or the host needs to drive the DMA buffer.

 $\overline{\text{DMAGx}}$ needs a pullup resistor when the pin does not connect to a host that drives it to acquire the bus. $\overline{\text{DMAGx}}$ has the same timing and transitions as the $\overline{\text{RD}}$ and $\overline{\text{WR}}$ strobes and responds to the $\overline{\text{SBTS}}$ and $\overline{\text{HBR}}$ signals the same way as do $\overline{\text{RD}}$ and $\overline{\text{WR}}$.

External Handshake Mode

External devices can also use the DMARx and DMAGx handshake signals to control DMA transfers between an external device (except SDRAM) and external memory. In this mode, the processor operates as an independent DMA controller.

To configure a channel for external handshake mode, you set the following bits in the DMACx control register:

```
EXTERN =1
HSHAKE =1
MASTER =0
```

These transfers are similar to standard DMA transfers, but with a few differences:

- In external handshake mode, transfers require the DMA controller to generate external memory access cycles.
- DMARx and DMAGx retain the same functionality, but instead of simply generating DMAGx, the processor also outputs addresses, MS₃₋₀ memory selects, and the RD and WR strobes, and it responds to ACK.

The processor holds $\overline{\text{DMAG}}x$ low until the ACK line is released or any wait states finish.

• The access to external memory behaves exactly as if the processor's core requested it.

The processor's EPBx buffers do not latch or drive any data, however, and the processor's DMA controller performs no internal memory DMA transfer.

- To generate the external memory addresses and word count, you must preload the DMA channel's EIEP, EMEP, and ECEP parameter registers.
- Since internal DMA transfers do not occur in this mode, you cannot use the PCI bit of the CPEP register to disable the DMA interrupt. Instead, you must use the IMASK register.

Unless you mask it out in IMASK, the DMA interrupt remains enabled and is always generated.

Since data does not pass through the processor in external hand-• shake mode, you cannot pack or unpack it into different word widths.

System Configurations for Interprocessor DMA

Table 6-26 shows the different ways you can set up external port DMA transfers between two processors in a multiprocessor system. We recommend that you consider the advantages and disadvantages of each configuration when designing your system.

Source	Destination	Throughput	Advantages/ Disadvantages		
Bus Master MASTER=1 TRAN=1 EIx=Addr. of destination EPBx buffer EMx=0	Bus Slave MASTER=0 TRAN=0	1 cycle/ transfer	Advantage Destination automat- ically generates interrupt upon fin- ishing. Disadvantage Must program DMA on both source and des- tination.		
MMS = Multiprocessor Memory Space					

Table 6-26. Processor configurations for interprocessor DMA transfers

Throughput rate assumes no MMS wait states configured in WAIT register. For selection of a single MMS wait state, add 1 to value in Throughput column.

Source	Destination	Throughput	Advantages/ Disadvantages				
Bus Slave MASTER=0 TRAN=1	Bus Master MASTER=1 TRAN=0 EIx=Addr.of source EPBx buffer EMx=0	2 cycles/ transfer	Advantage Source automati- cally generates interrupt upon fin- ishing. Disadvantage Slower throughput. Must program on both source and destina- tion.				
MMS = Multiprocessor Memory Space Throughput rate assumes no MMS wait states configured in WAIT reg- ister. For selection of a single MMS wait state, add 1 to value in Throughput column.							

Table 6-26. Processor configurations for interprocessor DMA transfers (Cont'd)

External Port DMA

Interfacing with DMA Hardware

Figure 6-9 shows a typical DMA interface between two multiprocessing ADSP-21065Ls and an external device.



Figure 6-9. Example DMA hardware interface

In this example, both processors are configured for handshake mode operation.

Both external latches act as a mailbox between the external device and the processors. The latches enable DMA transfers to take only one processor

bus cycle, even when the external device is slow. The $\overline{\text{DMAR}}x$ and $\overline{\text{DMAG}}x$ signals control the latches directly.

When the external device is writing data to a latch, it uses the \overline{DMAGx} signal as the output enable signal for the latch. When the external device is reading from a latch, it uses the \overline{DMAGx} signal to clock the data on its rising edge.

Figure 6-10 shows the timing relationships between $\overline{\text{DMARx}}$, $\overline{\text{DMAGx}}$, and the data transfer. See the processor's data sheet for exact specifications.



Figure 6-10. $\overline{\text{DMAR}}x$ and $\overline{\text{DMAG}}x$ timing

Overall DMA Throughput

This section describes the overall DMA throughput when several DMA channels try to access internal or external memory at the same time.

Concurrent Accesses to Internal Memory

The DMA channels arbitrate for access to the processor's internal memory.

The DMA controller determines, on a cycle-by-cycle basis, which channel gains access to the internal I/O bus and, consequently, which channel gets to read or write to internal memory. Table 6-15 on page 6-36 shows the priority of the DMA channels.

Each DMA transfer takes only one clock cycle, even when the DMA controller grants different DMA channels access on sequential cycles. That is, switching between channels incurs no loss in overall throughput. So, four serial port DMA channels, each transferring one byte per cycle, would have the same I/O transfer rate as one external port DMA channel transferring data to internal memory on every cycle. Any combination of serial port and external port transfers has the same maximum transfer rate.

Concurrent Accesses to External Memory

When the DMA transfer is between the processor's internal and external memory, the transfer to external memory may incur one or more wait states.

External memory wait states, however, do not reduce the overall internal DMA transfer rate if other channels have data available to transfer. That is, uncompleted external transfers do not hold up the processor's internal I/O data bus.
For data transfers from internal memory to external memory, the DMA controller places the data in the external port's EPBx buffer first and then begins the access to external memory independently. (Likewise, for external-to-internal DMA, the DMA controller does not make the internal DMA request until the data from external memory is in the EPBx buffer.)

In both cases, the external DMA address generator—the EIEP and EMEP parameter registers—maintains the external address until the data transfer has finished. The internal and external address generators of each DMA channel operate independently.

Since EXTERN mode DMA transfers between an external device and external memory do not use the processor's internal resources, they do not affect internal DMA throughput.

Overall DMA Throughput

7 MULTIPROCESSING

The processor includes functionality and features that enable users to design multiprocessing DSP systems. These features include

• Distributed on-chip bus arbitration logic for bus mastership.

This feature enables the processor to access external memory and the IOP registers of another ADSP-21065L in the system.

• Bus locking capability.

This feature enables the processor to perform indivisible read-modify-write sequences for semaphores.

In a multiprocessor system with two processors sharing the external bus (see Figure 7-1 on page 7-2), either of the processors can become the bus master. Unless it relinquishes control to the host, the bus master controls the external bus, which consists of the DATA₃₁₋₀, ADDR₂₃₋₀, and associated control lines. The bus master always retains control of the SDRAM control pins— \overline{CAS} , DQM, \overline{MSx} , \overline{RAS} , SDA10, SDCKE, SDCLKx, and \overline{SDWE} .



Figure 7-1. A basic multiprocessing system

Table 7-1 shows how to connect the IDx pins on both processors in a multiprocessing system.

ID1	IDO	$\overline{\mathrm{BR}}_1$	BR ₂	Status
GND	GND	Input	Input	Uniprocessor configuration
GND	VDD	Output	Input	Processor ID #1
VDD	GND	Input	Output	Processor ID #2
VDD	VDD	Illegal		

Table 7-1. IDx pin connections

Connecting both IDx pins to VDD is illegal. In a uniprocessor system, you connect both IDx pins to ground.

The two bus request pins (\overline{BRx}) on each processor become an input and output pair. The \overline{BRx} input pin on one processor connects to the \overline{BRx} output pin on the other. To make these connections, you short the $\overline{BR_1}$ pins on both processors together and the $\overline{BR_2}$ pins on both processors together.

Table 7-2 shows which pins you must connect between two processors for particular environments.

Connect…	Pins
Always	ADDR ₂₃₋₀ , DATA ₃₁₋₀ , MS ₃₋₀ , RD,WR, ACK, SBTS, SW, BMS, BR ₂₋₁ , RESET, CLKIN
For Host Interface	REDY, HBG, HBR

Table 7-2. Pin connections between two processors

Table 7-2. Pin connections between two processors (Cont'd)

Connect…	Pins…		
For SDRAM systems	CAS, DQM, RAS, SDA10, SDCKE, SDCLK ₀₋₁ , SDWE		
For Core Priority Access Functions	CPA		

The IOP registers of the system's processors collectively are called multiprocessor memory space. Multiprocessor memory space is mapped into the unified address space of each processor. For details, see Chapter 5, Memory.

Once a processor becomes the bus master, it can directly read and write any of the slave's IOP registers, including its external port FIFO data buffers. For example, the master processor can write to a slave's IOP registers to set up DMA transfers or to send a vector interrupt.

The following terms are used throughout this chapter:

DMACx control registers

The DMA control registers for the EPBx external port buffers $DMAC_{0-1}$, which correspond to EPB_{0-1} , respectively. For details, see Chapter 6, DMA and Appendix E, Control and Status Registers in *ADSP-21065L SHARC DSP Technical Reference*.

External bus

ACK, ADDR₂₃₋₀, \overline{BMS} , \overline{CAS} DATA₃₁₋₀, DQM, \overline{MS}_{3-0} , \overline{RAS} , \overline{RD} , SDA10, \overline{SBTS} , SDCKE, SDCLK₁₋₀, \overline{SDWE} , \overline{SW} , and \overline{WR} signals.

External port FIFO buffers

 EPB_{1-0} , the IOP registers used for external port DMA transfers and single-word data transfers from another processor or from a host. The EPBx buffers are 6-deep FIFOs.

IOP register

One of the control, status, or data buffer registers of the processor's on-chip I/O processor.

Master processor

The processor that has gained control of the bus from the other ADSP-21065L or from a host.

Multiprocessor memory space

Memory map area that corresponds to the IOP registers of the other processor in a multiprocessing system. This address space is mapped into the processor's unified address space.

Multiprocessor system

A system with two processors and with or without a host. The external bus connects both processors.

Single-word data transfers

Reads and writes to the EPBx external port buffers, performed externally by the master processor or internally by the slave processor's core. These accesses occur only when DMA has been disabled in the DMACx control register.

Slave processor

The processor that has relinquished control of the bus to the other ADSP-21065L or to a host.

For multiprocessing operations, the processor uses the system clock which runs at 1xCLKIN. Hereafter, in this chapter, all clock cycle references are to 1xCLKIN, unless otherwise noted.

For details on clock cycles and data throughput, see Table 12-11 on page 12-30.

Multiprocessing System Architecture

The nodes in a multiprocessor system communicate through a single, shared global memory over a parallel bus.

Multiprocessing systems must overcome two problems—interprocessor communication overhead and data bandwidth bottlenecks. The processor's architecture supports two basic multiprocessing topologies that address these problems:

- Data flow multiprocessing
- Cluster multiprocessing

Data Flow Multiprocessing

For applications that require high computational bandwidth, but only limited flexibility, data flow multiprocessing is the best solution.

In this scenario, you partition your algorithm sequentially across both processors and pass data linearly across them, as shown in Figure 7-2.



Figure 7-2. Data flow multiprocessing

The processor is ideally suited for data flow multiprocessing applications because it eliminates the need to use interprocessor data FIFOs and external memory. For most applications using this topology, the processor's internal memory is usually sufficient to contain both code and data. A data flow system requires only two processors with connected point-to-point signals. This configuration yields a substantial savings in complexity, board real estate, and system cost.

Cluster Multiprocessing

For applications that require a fair amount of flexibility, cluster multiprocessing (Figure 7-3) is the best solution. This is especially true when a system must support a variety of different tasks, some of which may run concurrently.



Figure 7-3. Cluster multiprocessing

The processor also has an on-chip host interface that provides an interface between the cluster and a host.

Cluster multiprocessing systems include two processors connected by a parallel bus that enables interprocessor access of multiprocessor memory space and to shared global memory.

In a typical cluster, two processors and a host can arbitrate for the bus. The on-chip bus arbitration logic enables these processors to share the parallel bus. The processor's on-chip features help reduce the need for extra hardware in the cluster configuration. This configuration often eliminates the need for external memory, both local and global.

The processor supports a fixed priority scheme, bus locking, timed release, and core access preemption of background DMA transfers. The on-chip bus arbitration logic ensures that bus mastership transitions incur only one cycle of overhead. Processor accesses of an external address automatically generate a bus request. These extensive bus sharing features free designers from the time and risk involved in developing their own shared-bus logic and timing.

Once a processor gains bus mastership, it can access external memory or the IOP registers of the other processor. To transfer data to the other processor, the bus master sets up a DMA channel for the transfer.

Both processors are mapped into a common memory map. Each has a unique ID, which identifies its address space within the unified memory map of the system cluster. Both processor's IOP registers and external memory are part of this unified address space. Memory mapping eliminates the need for external memory to pass messages between processors, and it simplifies software communications. Since processors can write directly into each other's IOP registers, it saves an extra transfer step.

The processor's on-chip SRAM helps to eliminate the need for local memory. Larger applications, however, may require storing blocks of data and code in shared bulk memory and swapping them in and out of a processor's internal memory transparently.

The cluster configuration enables a very fast node-to-node data transfer rate. It also enables a simple and efficient software communications model. For example, one processor can perform all of the required setup operations for a DMA transfer, insuring that the other processor completes the DMA transfer uninterrupted. The architecture of the processor's internal memory supports the I/O needs of multiprocessor systems (for details, see Chapter 5, Memory). The on-chip, dual-ported RAM enables full-speed interprocessor transfers concurrent with dual accesses by the processor's computational core. These transfers steal no cycles from the core, and the processor continues to execute at 2xCLKIN.

Multiprocessor Bus Arbitration

Two processors share the external bus with no additional arbitration circuitry. The processor's on-chip bus arbitration logic enables connection of two processors and a host.

The \overline{BR}_{2-1} , \overline{HBR} , and \overline{HBG} signals provide bus arbitration. \overline{BR}_{2-1} arbitrate between the processors, and \overline{HBR} and \overline{HBG} pass control of the bus between the master processor and the host. Table 7-3 lists and describes the pins the processor uses in a multiprocessing system.

Signal	Туре	Definition
BR ₂₋₁	I/0/S	Multiprocessing Bus Requests.
		Used by multiprocessing processors to arbitrate for bus mastership. A processor drives its own BRx line only (corresponding to the value of its ID_{1-0} inputs) and monitors all others.
ID ₁₋₀	Ι	Multiprocessing ID.
		Determines which multiprocessing bus request $(\overline{\text{BR}}_{2-1})$ the processor uses. ID=01 corresponds to $\overline{\text{BR}}_1$, ID=10 corresponds to $\overline{\text{BR}}_2$. ID=00 used in single-processor systems.
		These lines are a system configuration selection and are hardwired or changed at reset only.

Table 7-3. Multiprocessing signals

Signal	Туре	Definition
CPA (o/d)	I/0	Core Priority Access.
		Asserting its CPA pin enables the slave's core to interrupt background DMA transfers of the other processor and access the exter- nal bus.
		$\overline{ ext{CPA}}$ is an open drain output that connects to both processors in the system. The $\overline{ ext{CPA}}$ pin has an internal 5 K Ω pull-up resistor.
		If not required in the system, leave the CPA pin unconnected.
A=Asynchro (o/d)=Open	nous;(a/ Drain;	d)=Active Drives; I=Input; O=Output; S = synchronous

Table 7-3. Multiprocessing signals (Cont'd)

The ID_{1-0} pins provide a unique identity for each processor in a multiprocessing system. Assign one processor ID= 01 and the other ID=10. (For the bus synchronization scheme to function properly, you must assign one processor ID= 01.) Processor 01 holds the external bus control lines stable during reset.

When the ID_{1-0} inputs of a processor are equal to 01 or 10, the processor configures itself for a multiprocessor system and maps its internal memory and IOP registers into the multiprocessor memory space. ID=00 configures the processor for a single-processor system. ID=11 is reserved, so do not use it.

Reading the CRBM (2:0) bits of the SYSTAT register, both processors in a multiprocessor system can determine which processor is the current bus master. These bits contain the value of the ID_{1-0} inputs of the current bus master.

You can write conditional instructions that are based on whether the processor is the current bus master in a multiprocessor system. The assembly language mnemonic for this condition code is BM (Bus Master), and its complement is NOT BM (Not Bus Master). To enable the bus master condition, set bits 17 and 18 of the MODE1 register to zero (0); otherwise the processor always evaluates the condition to false. For a complete list of condition codes, see Chapter 3, Program Sequencing.

Bus Arbitration Protocol

You connect the \overline{BR}_{2-1} pins between the two processors in a multiprocessing system. Each processor drives the $\overline{BR}x$ pin that corresponds to its ID_{1-0} inputs and monitors the other.

When the slave processor requires bus mastership, it asserts its \overline{BRx} line at the beginning of the cycle to automatically initiate the bus arbitration process. Later in the same cycle, it samples the value of the other \overline{BRx} line.

The cycle in which mastership of the bus passes from one processor to another is called a *bus transition cycle*. A bus transition cycle occurs only when these two events occur in the same cycle:

- The current bus master deasserts its BRx pin
- The slave processor asserts its BRx pin

By keeping its \overline{BRx} pin asserted, the master processor retains bus mastership. The master processor does not lose bus cycles when both processors deassert their \overline{BRx} lines at the same time.

By monitoring the \overline{BRx} lines, each processor can detect when a bus transition cycle occurs and which processor has become the new bus master. Transference of bus mastership occurs only during a bus transition cycle.

Figure 7-4 on page 7-13 shows typical timing for bus arbitration.



Figure 7-4. Bus arbitration timing

The actual transfer occurs when the current bus master places the external bus—DATA₃₁₋₀, ADDR₂₃₋₀, $\overline{\text{RD}}$, $\overline{\text{WR}}$, $\overline{\text{MS}}_{3-0}$, $\overline{\text{HBG}}$, and $\overline{\text{DMAG}}_{2-1}$ —in a high impedance state at the end of the bus transition cycle, and the new bus master begins driving these signals at the beginning of the next cycle.

Before placing the external bus in a high impedance state at the beginning of the transfer, the bus master drives high \overline{MSx} (except for the SDRAM bank select line), inactivating it as shown in Figure 7-5 on page 7-15.

Multiprocessor Bus Arbitration

Execution of external accesses are delayed during bus transition cycles. For example, when the slave processor needs to perform an external read or write, and it asserts its BRx line to automatically initiate the bus arbitration process, the read or write is delayed until the processor receives bus mastership.

If the processor's core, not the DMA controller, generates the read or write, program execution stops until the instruction finishes.



Figure 7-5. Bus request and Read/Write timing. (The processor continues to drive the $\overline{\text{MS}}x$ line connected to SDRAM.)

To acquire bus mastership and perform an external read or write over the bus, the slave processor:

- 1. Determines if the instruction that it is executing requires an off-chip access.
- 2. Asserts its \overline{BRx} line at the beginning of the cycle.

Until the slave acquires bus mastership, the processor's core or DMA controller generates extra cycles.

3. Waits for the current bus master to deassert its \overline{BRx} line and initiate a bus transition cycle.

At the end of the bus transition cycle, the current bus master releases the bus, and the new bus master starts driving it.

Whenever the bus master stops using the bus, it deasserts its \overline{BRx} line, enabling the other processor to gain mastership if needed. If the slave processor does not assert its \overline{BRx} line when the master deasserts its, the master processor retains control of the bus and continues to drive the memory control signals until:

• It needs to use the bus again.

or

• The slave processor asserts its BRx line.



Whenever it executes a conditional external access, the processor attempts to become bus master, even if the access aborts.

In SDRAM systems, the current master processor asserts its \overline{BRx} line if the SDRAM controller needs to perform a refresh operation, or the application sets the self-refresh bit in the IOCTL register. It continues to assert its \overline{BRx} line until the SDRAM device enters into self-refresh mode.

For SDRAM accesses, the current master processor continues to assert its \overline{BRx} line if the SDRAM device is still bursting data. In this case, the current master processor deasserts its \overline{BRx} line such that the SDRAM device stops its data burst before the end of the bus transition cycle.

While waiting to acquire bus mastership and perform a DMA transfer, the slave processor asserts its \overline{BRx} line. If the slave's core accesses the DMA address (DA) group of IOP registers, the processor deasserts its \overline{BRx} line until the core completes its access. For a list of the registers in the DA group, see Table E-11 on page E-33, and, for a list of all IOP register groups, see Table E-15 on page E-43, in *ADSP-21065L SHARC DSP Technical Reference*.

Bus Mastership Timeout

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You may want to limit how long a bus master can own the bus. To do so, you force the bus master to deassert its \overline{BRx} line after a specified number of cycles, giving the slave processor a chance to acquire bus mastership.

To set up a bus master timeout, load the BMAX register as follows.

BMAX = (2 ★ maximum # of CLKIN cycles) - 2

As an example to ensure that any processor retains the bus for a maximum of 10 CLKIN cycles when another slave is requesting the bus, BMAX can be calculated as follows.

BMAX = (2 * 10) - 2 = 18

The minimum value for BMAX is 2, which enables the processor to retain bus mastership for 4 CLKIN cycles.

Each time the processor acquires bus mastership, it loads the value in BMAX into its BCNT register. The processor decrements BCNT each 2xCLKIN cycle in which it performs a read or write over the bus and the slave processor requests the bus. Any time the master processor deasserts its BRx line, it reloads BCNT from BMAX.

When BCNT decrements to zero (0), the bus master:

- 1. Completes its off-chip read or write.
- 2. Deasserts its own \overline{BRx} line, delaying any new off-chip accesses.

This procedure initiates the transfer of bus mastership. If the slave processor is deasserting its \overline{BRx} request line when the master's BCNT reaches 0, the master processor keeps asserting its \overline{BRx} line and does not reload BNCT from BMAX. If the ACK signal is holding off an access when BCNT reaches 0, the master processor retains bus mastership until that access finishes.

If BCNT reaches 0 while bus lock is active, the master processor deasserts its \overline{BRx} line only after the bus lock is removed. (The BUSLK bit in the MODE2 register enables bus lock. See "Bus Lock and Semaphores" on page 7-34.)

While the master processor is servicing $\overline{\text{HBR}}$, it stops decrementing BCNT until the host deasserts $\overline{\text{HBR}}$.

Core Priority Access

As shown in Figure 7-6 on page 7-19, the Core Priority Access signal, \overline{CPA} , enables the slave's core to access the external bus and take priority over ongoing DMA transfers.



Figure 7-6. Core priority access timing

Normally, during external port DMA transfers, the slave's core cannot use the external bus until the DMA transfer has finished. By asserting its CPA pin, however, the slave processor's core can acquire the bus without waiting for the DMA operation to finish.

If the $\overline{\text{CPA}}$ signal isn't used in a multiprocessor system, the master processor relinquishes the bus to the slave processor only when one of the following occurs:

- A cycle in which the master processor does not perform an external bus access
- A bus timeout

If a slave processor needs to send a high priority message or perform an important data transfer, usually, it must wait until any DMA operation finishes. But the \overline{CPA} signal enables the slave to perform its higher priority bus access with less delay.

When the slave processor has a pending core access of the bus, it asserts both its \overline{CPA} pin and its bus request (\overline{BRx}) pin. \overline{CPA} is an open-drain output and connects both processors in a system. Both processors have a 5 K Ω pull-up resistor on this pin, enabling them to share it. Either processor can assert \overline{CPA} , and the internal resistors (or an additional external resistor for quicker pull-up) pull it high when it's released. Both processors can assert this line at the same time.

When \overline{CPA} is active, the current master processor deasserts its \overline{BRx} line and relinquishes the bus, providing its core does not have an external access pending. The current bus master never asserts \overline{CPA} because it already has control of the bus.

In the cycle (≥ 1 cycle for SDRAM systems, see page 7-19) after the slave asserts \overline{CPA} , only the processor's core with a pending external access asserts its bus request. Bus arbitration now proceeds as usual when the previous bus master releases its \overline{BRx} line.

The processor that becomes bus master releases \overline{CPA} immediately, the pull-up resistors pull the \overline{CPA} signal high, and arbitration proceeds normally. The previous bus master, having deasserted its \overline{BRx} line in response to \overline{CPA} , reasserts \overline{BRx} in the cycle after it samples \overline{CPA} high.

In summary, when a slave processor uses its \overline{CPA} signal, the following sequence occurs: (see Figure 7-6 on page 7-19)

- 1. The slave processor asserts both its \overline{CPA} pin and its \overline{BRx} pin when its core has an external bus access pending.
- When the common CPA line is asserted, the master processor, if its core has no external accesses pending, deasserts its BRx line in the next cycle and relinquishes the bus after completing its current access. (≥1 cycle for SDRAM systems, see page 7-19)

- 3. In the cycle after the slave asserts \overline{CPA} , arbitration occurs normally between the processors when both assert their respective \overline{BRx} lines.
- 4. The new master processor releases CPA immediately after acquiring the bus.

Both processors arbitrate as usual while \overline{CPA} is asserted, but each asserts its \overline{BRx} line only if its core needs to make an access over the external bus.

When \overline{CPA} is released, both processors resume normal \overline{BRx} operation one cycle after sampling \overline{CPA} high. After releasing its \overline{CPA} , the new bus master ignores the \overline{CPA} pin for two cycles. This reduces the possibility of losing bus mastership unnecessarily while the common pull-up resistors pull the \overline{CPA} signal high. Because a resistor, which may have a time constant greater than one cycle, pulls up \overline{CPA} , both processors may not detect \overline{CPA} high in the same cycle.

In systems that do not require core access priority, leave the \overline{CPA} pin unconnected. The processors will arbitrate normally.

Bus Arbitration Synchronization After Reset

When you use the $\overline{\text{RESET}}$ pin to reset a multiprocessing system, the bus arbitration logic on each processor must resynchronize to insure that only one processor drives the external bus.

During synchronization, one processor becomes the bus master, and the other processor acknowledges it. Synchronization must occur before the processors can actively arbitrate for the bus. The bus synchronization scheme also enables the system to safely bring each processor in and out of reset.

A soft reset (SRST) also resynchronizes the processor.

For the bus synchronization scheme to function properly, you must assign one processor in the system ID=01. The processor with ID1 holds the external bus control lines stable during reset. When the processor is assigned ID=00 (single-processor mode), it disables bus arbitration synchronization.

After reset, both processors follow this procedure to resynchronize their bus arbitration logic and define the bus master:

1. The processor with ID=10 deasserts its \overline{BR}_2 line during reset and for at least two cycles after, until its bus arbitration logic is synchronized.

After reset, a processor considers itself synchronized in the cycle in which it detects only one \overline{BRx} line asserted.

The \overline{BRx} line that is asserted identifies the bus master, and both processors update their internal records (CRBM bits in the SYS-TAT register) accordingly.

2. The processor with ID= 01 asserts its \overline{BR}_1 line during and at least one cycle after reset.

If its \overline{BR}_1 line remains the only one asserted during reset and the following cycle, this processor drives the memory control lines to prevent glitches in their signals. (This processor does not perform reads or writes over the bus.)

If this processor is synchronized by the end of the two cycles following reset, it becomes the bus master. If not, it deasserts \overline{BR}_1 and waits until it is.

When a processor has synchronized itself, it sets the BSYN bit in the SYSTAT register.

The processor with ID=01 maintains correct logic levels on the $\overline{\text{RD}}$, $\overline{\text{WR}}$, $\overline{\text{MS}}_{3-0}$, $\overline{\text{HBG}}$, and the SDRAM signals— $\overline{\text{CAS}}$, DQM, $\overline{\text{RAS}}$, SDA10, SCCLK, SDCKE, and $\overline{\text{SDWE}}$ —during reset.

Because an erroneous write to the soft reset bit (SRST) in the SYSCON register can reset the processor with ID=01, that processor behaves this way during reset:

- 1. It asserts \overline{BR}_1 to gain control of the bus.
- 2. It drives the RD, WR, MS₃₋₀, DMAG₁, DMAG₂, HBG, and the SDRAM signals—CAS, DQM, RAS, SDA10, SCCLK, SDCKE, and SDWE—only if it determines it has control of the bus.

Two conditions determine whether the processor has control of the bus:

- In the previous cycle, \overline{BR}_1 was asserted and \overline{BR}_2 was deasserted, and
- In the previous cycle, HBG was deasserted.

The processor with ID=01 continues to drive the \overline{RD} , \overline{WR} , \overline{MS}_{3-0} , \overline{DMAG}_1 , \overline{DMAG}_2 , and \overline{HBG} and the SDRAM signals— \overline{CAS} , DQM, \overline{RAS} , SDA10, SCCLK, SDCKE, and \overline{SDWE} —for two cycles after reset, as long as neither \overline{HBG} nor \overline{BR}_2 are asserted. At the end of the second cycle, the processor assumes bus mastership if it is synchronized, and normal bus arbitration begins in the following cycle. If it remains unsynchronized, the processor deasserts \overline{BR}_1 , stops driving the memory control signals, and does not arbitrate for the bus until it becomes synchronized.

Although the bus synchronization scheme supports reset of individual processors, the processor with ID=01 may fail to drive the memory control signals if it is in reset while the processor with ID=10 asserts its \overline{BR}_2 line.

If the processor with ID= 01 has asserted $\overline{\text{HBG}}$ while it is in reset, it becomes synchronized when the host or external RESET circuitry deasserts $\overline{\text{RESET}}$. This protocol enables the host to use the bus while the processors are in reset.

Multiprocessor Bus Arbitration

If a host attempts to reset the master processor (which is driving the $\overline{\text{HBG}}$ output), the host immediately loses control of the bus.

During reset, the master processor pulls the ACK line high with an internal 2 $k\Omega$ equivalent resistor.

Data Transfers

The master processor can read and write all of the slave processor's IOP registers to:

- Control and configure the slave's operation (SYSCON and SYS-TAT registers).
- Communicate with the slave's core (MSGRx).
- Send a vector interrupt (VIRPT).
- Set up DMA transfers (DMACx).
- Transfer data.

To do so, the master processor reads or writes the address of the appropriate IOP register in multiprocessor memory space.

The slave processor monitors the address lines driven on the external bus and responds to any address that falls within its region of multiprocessor memory space.

These accesses are invisible to the slave's core because they are performed through the external port, over the on-chip I/O bus—not the DM bus or PM bus. This is an important distinction, because it enables the slave's core to continue executing program uninterrupted. (See Figure 8-1 on page 8-2.)

For heavily loaded buses, or when using external data buffers, you can add a single wait state to all multiprocessor memory accesses. To do so, you set the MMSWS bit in the WAIT register. (For details, see "Multiprocessor Memory Space Wait States and Acknowledge" on page 5-61.)

Data Transfers

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Writing the IOP Registers

Because the external port buffers (EPBx), which are also IOP registers, are six-deep FIFO buffers, writes to them execute slightly differently than writes to the other IOP registers. And, the master processor uses them to perform DMA transfers. For details, see "Transfers Through the EPBx Buffers" on page 7-27.

When the master processor writes to a slave processor, the slave's I/O processor latches the address and data on-chip, buffering the address and data in a special set of FIFO buffers, the *slave write FIFO*, at the external port pins (see Figure 8-1 on page 8-2). If the master processor attempts additional writes when this FIFO buffer is full, the slave processor deasserts ACK until the buffer is no longer full.

In the next cycle after the slave's I/O processor latches the address and data, the slave write FIFO attempts to complete the write internally to the target IOP register. This enables the master processor to perform writes at the full clock rate.

Writes to the IOP registers usually occur in the following one or two cycles. Writes take more than two cycles only when a full buffer delayed a write in the previous cycle.

If the EPBx buffer and the slave write FIFO are full when the master processor attempts a write, the slave deasserts ACK until buffer space is available. The EPBx buffer usually empties within one cycle, creating a *write latency*, unless higher priority, on-chip DMA transfers are in progress.

Data in the slave write FIFO delays a master processor read. This delay prevents the master processor from reading invalid data and from performing operations out of sequence.

Reading the IOP Registers

When the master processor reads a slave processor, the slave's I/O processor latches the address on-chip, and the slave asserts ACK. When the slave processor reads the corresponding IOP register location, it drives the data off-chip and asserts ACK. Unlike writes, the processor cannot pipeline reads. Reads occur one at a time only.

Writes have a maximum pipelined throughput of one per cycle, and reads have a maximum throughput of one every one 1xCLKIN cycle. See Chapter 12, System Design. Because of this low bandwidth, direct reads are not the most efficient method of transferring data out of a slave processor.

Transfers Through the EPBx Buffers

In addition to reads and writes of the other IOP registers, the master processor can transfer data to and from the slave processor's internal memory space through its external port FIFO buffers, EPB_0 and EPB_1 .

Through the EPBx buffers, the master processor can perform:

• Single-word transfers

The processor's core handles internal single-word transfers.

• DMA block transfers

The processor's DMA controller handles internal DMA transfers.

Each EPBx buffer has a read port and a write port. Both ports can connect internally to the EPD (External Port Data) bus, the IOD (I/O Data) bus, the PM Data bus, or the DM Data bus as shown in Figure 7-1 on page 7-2.

When the master processor writes to the slave processor's EPBx buffers, the slave's I/O processor latches and buffers the address and data on-chip,

just as it does for writes to the other IOP registers. And, if additional writes occur when the slave write FIFO buffer is full, the slave deasserts ACK and waits for space to become available in the buffer.

But, because both of the EPBx buffers, which are part of the IOP register set, are six-location FIFOs, the master processor can perform up to six writes before encountering a delay, or *write latency*. (The external port FIFO buffers can be delayed up to four cycles if all of the serial port DMA channels are active or up to nine cycles per chain during a DMA chaining operation.)

Single-Word Transfers

When the master processor writes a single data word to a slave's EPBx buffers, the slave's core must read the data. Conversely, when the slave's core writes a single piece of data to one of its EPBx buffers, the master processor must perform an external bus read cycle to obtain it. Because the EPBx buffers are six-deep, bidirectional FIFOs, the cores of both processors have extra time to read the data. This functionality enables efficient, continuous, single-word transfers to occur in real-time, with low latency and no DMA.

If the master processor attempts to read from an empty EPBx buffer on the slave, the slave holds off the access with the ACK signal until the buffer receives data from the core. If the slave's core attempts to write to a full EPBx buffer, the slave processor delays the access, and its core hangs until the master processor reads the buffer. To prevent the slave's core from hanging, set the Buffer Hang Disable bit (BHD=1) in the SYSCON register. To determine the status of a particular EPBx buffer, read the appropriate DMACx register.

Similarly, if the master processor attempts to write to a full EPBx buffer on the slave processor, the slave delays the access with ACK until its core reads the buffer. If the slave's core attempts to read from an empty buffer, the slave processor delays the access, and its core hangs until the master processor writes the buffer. To prevent this hang condition, set ${\tt BHD=1}$ in the SYSCON register.

To flush (clear) either EPBx buffer, write 1 to the FLSH bit in the corresponding DMACx control register. The processor does not latch this bit internally, and this bit always reads as 0.

Status can change in the following cycle.

Do not enable and flush an EPBx buffer in the same cycle.



To perform single-word, non-DMA transfers through the EPBx buffers, you must clear the DMA enable bit (DEN) in the appropriate DMACx control register.

Interrupts for Single-Word Transfers. You can use the interrupts for the two external port DMA channels to control single-word data transfers between the master processor and the slave.

To do so, set two bits in the DMACx control register:

DEN=0	Disables DMA
INTIO=1	Enables interrupt-driven I/O DMA interrupts

For details, see Chapter 6, DMA and Appendix E, Control and Status Registers in *ADSP-21065L SHARC DSP Technical Reference*.

With this configuration, the interrupt is generated whenever data becomes available in the read port of the EPBx buffer or whenever the write port has no new data to transmit. Then, either the slave's core or an external device, such as the master processor or host, can read or write the EPBx buffer. Generating interrupts this way is useful for implementing interrupt-driven I/O that the slave's core controls.

You can mask out (disable) this interrupt in the IMASK register. If you re-enable it later in IMASK, make sure you clear the corresponding

Data Transfers

IRPTL latch bit to clear any interrupt request that might have occurred in the interim, before you re-enabled the interrupt.

DMA Transfers

The master processor can also set up DMA transfers to and from a slave's internal memory space. The master processor writes to the slave's DMA control and parameter registers to set up an external port DMA operation. This is the most efficient way to transfer blocks of data between two processors.

• DMA transfers to internal memory space.

The master processor sets up external port DMA channels to transfer data to and from the slave's internal memory space, or it can use the DMA request and grant lines (DMARx and DMAGx) to transfer data directly to or from the slave's internal memory space.

• DMA transfers to external memory space.

Using the DMA request and grant lines (\overline{DMARx} and \overline{DMAGx}), the master processor sets up an external port DMA channel to transfer data directly to the slave's external memory space.

See Chapter 6, DMA for details on setting up DMA operations.

Transfers to Internal Memory Space. To set up DMA channels to transfer data to and from the slave's internal memory space, the master processor initializes the slave's DMA control and parameter registers for the particular channel. Once the DMA channel is set up, the master processor reads from or writes to the corresponding EPBx buffer on the slave.

If the slave's EPBx buffer is empty (or full), the access is extended until data is available (or stored). This method enables fast and efficient data transfers.

The master processor sets up a channel for either slave mode DMA or for handshake mode DMA. To do so, the it sets the MASTER, HSHAKE, and EXTRERN bits in the channel's DMACx register appropriately.

For slave mode DMA, it sets:

```
MASTER = 0
HSHAKE = 0
EXTERN = 0
```

In slave mode DMA, if the buffer is empty (or full), the slave's DMA controller extends the access until data is available (or stored). This method enables fast and efficient data transfers.

To pack and unpack DMA data, you select the packing mode in the PMODE bits of the external port DMA control registers (DMAC0 and DMAC1).You can select 16-bit to 32- or 48-bit and 32-to-48-bit packing and unpacking. For details, see "External Port DMA Data Packing" on page 6-51.

For handshake mode DMA, it sets:

```
MASTER = 0
HSHAKE = 1
EXTERN = 0
```

In handshake mode DMA, the master processor can also use the $\overline{\text{DMAR}}x$ and $\overline{\text{DMAG}}x$ handshake signals for a DMA transfer.

DMA Transfers to External Memory Space. To use the slave's DMA controller to transfer data directly to external memory space, you must use the *external handshake mode* for external port DMA channel 8 or 9.

Data Transfers

For external handshake mode DMA, set:

```
MASTER =0
HSHAKE = 1
EXTERN = 1
```

This mode provides the $\overline{\text{DMAR}}x$ and $\overline{\text{DMAG}}x$ handshaking for this type of transfer.

Since the data passes through the DMA controller and not the processor, you cannot pack the data.

For details on using DMA, see Chapter 6, DMA.

Interacting with the Shadow Write FIFO

Because the processor's internal memory must operate at high speeds, writes to the memory do not go directly into the memory array, but into a two-deep FIFO called the *Shadow Write FIFO*.

When an internal memory write cycle occurs, the processor loads into memory the data in the Shadow Write FIFO and loads the new data into the Shadow Write FIFO. Normally, this operation is transparent since the processor intercepts and routes to the FIFO any reads of the last two locations written. You need be aware of the Shadow Write FIFO only when you mix 48- and 32-bit word accesses to the same locations in memory.

The Shadow Write FIFO cannot differentiate between the mapping of 48-bit words and the mapping of 32-bit words. (See Figure 5-10 on page 5-32.) So, if you write a 48-bit word to memory and try to read the data with a 32-bit word access, the Shadow Write FIFO will not intercept the read, and the processor will return incorrect data.

If you must mix 48- and 32-bit accesses to the same locations, flush out the Shadow Write FIFO with two dummy writes before you attempt to read the data.

Bus Lock and Semaphores

You can use semaphores in multiprocessor systems to enable both processors to share resources, such as memory or I/O.

A semaphore is a flag that either processor sharing the resource can read and write. The value of the semaphore indicates when the processor can access the resource. Semaphores are also useful for synchronizing the tasks each processor is performing separately.

The bus lock feature enables the processor to read and modify a semaphore in a single indivisible operation—a key requirement of multiprocessing systems.

Semaphores can reside in external memory or in an IOP register, such as a message register (MSGRx). When attempting a read-modify-write operation on a semaphore, a processor must have bus mastership for the duration of the operation. If both processors obey this rule, both can perform read-modify-write operations on semaphores.

A processor adheres to this rule when it uses its bus lock feature to lock in its mastership of the bus. Doing so, it prevents the other processor from simultaneously accessing the semaphore.

To request bus lock, you set the BUSLK bit in the MODE2 register. Then, the processor initiates the bus arbitration process, asserting its \overline{BRx} line. When it becomes bus master, the processor locks the bus, keeping its \overline{BRx} line asserted, even when not performing an external read or write, to maintain its bus mastership. The processor ignores \overline{HBR} during a bus lock. When the BUSLK bit is cleared, the processor deasserts its \overline{BRx} line to relinquish control of the bus.

While the BUSLK bit is set, the processor can execute a conditional instruction using the BM or NOT BM condition codes to determine who is current bus master. For example:

IF NOT BM JUMP(PC,O);/* wait for bus mastership */
If it is not the current bus master, the processor can either wait until it gains control of the bus, or it can clear its BUSLK bit and try again later. If it is the current bus master and the semaphore resides in external memory space, the processor can proceed with reading or writing the semaphore. If it is the current bus master and the semaphore resides in IOP register space, the processor must test the status of the SWPD bit (SYSTAT register) before proceeding to read or write the semaphore.

In summary, to perform a read-modify-write operation, write code that follows these steps:

- 1. Set the BUSLK bit in MODE2 to request a bus lock.
- 2. Wait to acquire bus mastership.

If the semaphore resides in IOP register space, wait until SWPD=0.

3. Read the semaphore, test it, then write to it.

Interprocessor Messages

To communicate with the slave processor, the master processor writes messages to the slave's IOP registers.

The MSGR₇₋₀ registers are general-purpose registers, which applications can use to pass messages or to implement semaphores and resource sharing between two processors.

You can use the MSGRx and VIRPT registers for interprocessor communications in the following ways:

• Message Passing

The master processor can read or write any of the slave's eight message registers, MSGR₇₋₀, to pass messages.

• Vector Interrupts

The master processor can write the address of an interrupt service routine to the slave's VIRPT register to generate a vector interrupt.

Doing so causes an immediate, high-priority interrupt on the slave that, when serviced, causes the slave processor to branch to the specified service routine.

The MSGRx and VIRPT registers also support the host interface. Since these registers can be shared resources within a single processor, conflicts can occur. Your system software is responsible for preventing such conflicts. For details, see Appendix E, Control and Status Registers, in *ADSP-21065L SHARC DSP Technical Reference*.

Message Passing (MSGRx)

The master processor has three software protocols available to it for communicating with a slave through the slave's MSGRx message registers:

• Vector-interrupt-driven

The master fills predetermined MSGRx registers on the slave with data and writes the address of the service routine to the slave's VIRPT register to trigger a vector interrupt.

After the slave's service routine reads the data from the MSGRx registers, it must write 0 to VIRPT to tell the master it has completed the read.

The service routine can also use one of the slave's $FLAG_{11-0}$ pins to tell the master it has finished.

• Register handshake

You designate four of the MSGRx registers as follows:

- A receive register (R)
- A receive handshake register (RH)
- A transmit register (T)
- A transmit handshake register (TH).

Register handshaking follows this sequence:

- 1. To pass data to the slave processor, the master processor writes data into T and then writes 1 into TH.
- 2. When the slave processor sees 1 in TH, it reads the data from T and then writes 0 back into TH.

- 3. When the master processor sees 0 in TH, it knows that the transfer has finished.
- 4. The slave processor follows a similar sequence when it passes data to the master processor through R and RH.
- Register write-back

This method is similar to the register handshake method, but uses only the T and R data registers.

Register write-back follows this sequence:

- 1. The master processor writes data to T.
- 2. When the slave processor sees a nonzero value in T, it retrieves it and writes 0 back into T.
- 3. The master processor uses a similar sequence to receive data.

This method is simpler and works well as long as the data to pass does not include 0.

Vector Interrupts (VIRPT)

The processor uses vector interrupts to respond to interprocessor commands from the other processor or from a host. When the other processor or an external device writes an address to the processor's VIRPT register, it generates a vector interrupt.

Servicing a Vector Interrupt

When it services a vector interrupt, the processor automatically pushes the status stack and begins executing the service routine located at the address specified in VIRPT. The lower twenty-four bits of VIRPT contain the address. Optionally, you can use the upper eight bits to pass data for the

interrupt service routine to read. At reset, the processor reinitializes VIRPT to its standard address in the interrupt vector table.

The minimum latency for vector interrupts is six cycles, five of which are NOPs. When the interrupt service routine reaches the RTI (return from interrupt) instruction, the processor automatically pops the status stack.

Make sure your interrupt service routine checks the VIPD bit in the SYS-TAT register. This bit indicates the status of the VIRPT register:

- If the master processor writes the slave's VIRPT while a previous vector interrupt is pending, the new vector address replaces the pending one.
- If the master processor writes the slave's VIRPT while the slave is servicing a previous occurrence of the vector interrupt, the slave ignores the new vector address, so the write doesn't generate a new interrupt.
- If the processor writes to its own VIRPT register, the write doesn't generate an interrupt.

To use the slave processor's vector interrupt feature, the master processor performs this procedure:

- 1. Polls the slave's VIRPT register until it reads a certain token value (for example, 0).
- 2. Writes the vector interrupt service routine address to VIRPT.

When the service routine is finished, the slave processor writes the token back into VIRPT to indicate that it has finished and that it is ready to accept another vector interrupt.

SYSTAT Register Status Bits

The SYSTAT register provides status information, primarily for multiprocessor systems. Table 7.4 shows the status bits in this register, and Figure 7-7 on page 7-41 shows the default bit values.

Bit	Name	Definition		
0	HSTM	Host mastership		
1	BYSN	Bus synchronization		
2 - 3	Reserve	d		
4 - 5	CRBM	Current bus master (ID $_{\rm 1-0}$ of processor bus master)		
6 - 7	Reserved			
8 - 9	IDC	ID code (ID $_{1-0}$ of this processor)		
10-11	Reserved			
12	SWPD	Slave write data pending (at slave write FIFO)		
13	VIPD	Vector interrupt pending		
14	HPS	Host packing status		
15-31	Reserved			

Table 7-4. SYSTAT status bits



Figure 7-7. SYSTAT register

HSTM

Host Mastership.

Indicates whether the host has been granted control of the bus.

1=Host is bus master

0=Host is not bus master

BSYN Bus Synchronization.

Indicates when the processor's bus arbitration logic is synchronized after reset. (See "Bus Arbitration Synchronization After Reset" on page 7-21.)

1=Synchronized

0=Not synchronized

CRBM

Current Bus Master.

Indicates the ID code of the processor that is the current bus master. If CRBM is equal to the ID of this processor then it is the current bus master. CRBM is only valid for $ID_{2-0} > 0$ (greater than zero). When $ID_{2-0}=00$, CRBM is always 1.

IDC ID Code.

Indicates the ID_{2-0} inputs of this processor.

SWPD

Slave write pending data.

Indicates valid data is pending in the slave write FIFO.

1=Data pending

0=No data pending

VIPD Vector Interrupt Pending.

Indicates that a pending vector interrupt has not yet been serviced.

The VIPD bit is set when the VIRPT register is written to and is cleared upon return from the interrupt service routine.

The master processor (or host) that issued the vector interrupt should monitor this bit to determine when the service routine has finished, and when a new vector interrupt can be issued.

1=Vector interrupt pending

0=No vector interrupt pending

HPS Host Packing Status.

Indicates when host word packing is completed or, if not, what stage of the process is taking place.

0=Partially packed

1=Fully packed

SYSTAT Register Status Bits

8 HOST INTERFACE

The host interface provides an asynchronous connection to standard 8-, 16-, and 32-bit microprocessor buses and supports asynchronous transfers at speeds up to 1xCLKIN.

The host interface enables a host to:

• Gain control of the processor and its external bus.

Once in control the host can access any of the processor's resources.

• Read and write any of the processor's IOP registers, including the EPBx FIFO buffers.

All of the internal IOP registers and resources of any processor's I/O processor are available to the host. The host uses specific IOP control and status registers to control and configure the processor and to set up DMA transfers. Once set up, the processor's on-chip DMA controller controls DMA transfers.

• Transfer code and data to and from the processor over the two external port DMA channels.

DMA transfers incur low software overhead.

- Pack and unpack 8-, 16-, and 32- bit host data to and from 32- or 48-bit internal data.
- Use interprocessor messages and vector interrupts to ensure host commands execute efficiently.

- Control and monitor the operation of the processor.
- In a multiprocessor system, access both the slave and master processors.



Figure 8-1. External port and Host Interface

The host accesses the processor through its external port, over the external bus $(DATA_{31-0} \text{ and } ADDR_{23-0})$. The host interface is memory-mapped into the unified address space of the processor. Figure 8-1 shows the on-chip data paths for host-driven transfers.

Physical connection to the host interface is easy, requiring little additional hardware. Any host with a standard memory interface can easily connect to the processor bus through buffers.

Table 8-1 lists and describes the pins used to interface with a host.

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lable	8-1.	Host	interface	pins
				P

Pin	Туре	Definition
HBR	I/A	Host Bus Request.
		Host must assert this pin to request control of the processor's external bus.
		In a multiprocessing system, when the host asserts HBR, the processor that is bus mas- ter relinquishes the bus and asserts HBG.
		To relinquish the bus, the processor places the address, data select, and strobe lines in a high-impedance state.
		HBR has priority over all processor bus requests, BRx, in a multiprocessing system.
HBG	I/0	Host Bus Grant.
		The processor asserts HBG to acknowledge an HBR bus request and indicate that the host can take control of the external bus. The processor holds HBG low until the host releases HBR.
		In a multiprocessing system, only the master processor outputs HBG.
CS	I/A	Chip Select.
		Host asserts to select a processor.
A = Asynchronous; (a/d) = Active Drive; I=Input; O = Output; (o/d) = Open Drain; S = Synchronous		

Table 8-1. Host interface pins (Cont'd)

Pin	Туре	Definition	
REDY	0	Host Bus Acknowledge.	
		The processor deasserts REDY to add wait states to an access of its IOP registers by a host.	
		Open-drain output (o/d) is the default, but you can program the ADREDY bit in the SYSCON register for active drive (a/d).	
		The processor outputs REDY only if the host (or other processor) asserts the CS and HBR inputs.	
SBTS	I/S	Suspend Bus Tristate.	
		External devices can assert SBTS to place the external bus address, data selects, and strobes in a high-impedance state for the following cycle.	
		If the processor attempts to access external memory while SBTS is asserted, the processor halts, and the memory access does not finish until SBTS is deasserted.	
		Use <u>SBTS</u> only to recover from deadlock between a host and the processor.	
A = Async(o/d) = 0	chronous; cen Drain	(a/d) = Active Drive; I=Input; O = Output; : S = Synchronous	

The following terms are used throughout this chapter:

Bus slave or slave mode

When a processor does not control the external bus, it is bus slave (to another processor or to a host). The processor becomes a "host bus slave" when it asserts its HBG signal.

Bus transition cycle (BTC)

In a multiprocessor system, a cycle in which control of the external bus passes from one processor to another.

Cluster bus

In a multiprocessor system, the path connecting one processor's external bus to the other's. See also, *External bus*.

DMACx control registers

DMA control registers for the EPBx external port buffers: DMAC0 and DMAC1 correspond to EPB0 and EPB1, respectively (see Chapter 6, DMA, and Appendix E, Control and Status Registers, in *ADSP-21065L SHARC DSP Technical Reference*).

DMA transfers

Internal transfers of data blocks that the processor's DMA controller, not its core, handles.

External bus

The processor's ACK, $ADDR_{23-0}$, \overline{BMS} , \overline{CAS} , $DATA_{31-0}$, DQM, \overline{MS}_{3-0} , \overline{RAS} , \overline{RD} , SDA10, \overline{SBTS} , SDCKE, $SDCLK_{0-1}$, \overline{SDWE} , \overline{SW} , and \overline{WR} , signals.

External port FIFO buffers

EPBx buffers. A host or another processor uses these IOP registers for external port DMA transfers and single-word data transfers. These buffers are six-deep FIFOs.

Host A host microprocessor.

Host transfers

Asynchronous accesses of the processor by the host. After acquiring control of the processor's external bus, the host must assert the \overline{CS} pin of the processor it wants to access.

Host transition cycle (HTC)

A cycle in which control of the external bus passes from the processor to the host. During this cycle, the processor stops driving the $\overline{\text{RD}}$, $\overline{\text{WR}}$, $ADDR_{23-0}$, $\overline{\text{MS}}_{3-0}$ (except the $\overline{\text{MSx}}$ line connected to an SDRAM device), $\overline{\text{SW}}$, and $\overline{\text{DMAGx}}$ signals, which the host must then drive.

IOP register

One of the control, status, or data buffer registers of the processor's on-chip I/O processor.

Local bus

In a multiprocessor system, the path connecting one processor's external bus to local memory or to a system bus buffer. See also, *External bus, Cluster bus.*

Master processor

The ADSP-21065L that is bus master.

Multiprocessor system

A system with two processors, with or without a host. The processors connect directly over the external bus.

Multiprocessor memory space

Portion of the processor's memory map that includes the IOP registers of the other processor in a multiprocessing system. This address space is mapped into the processor's unified address space.

Processor

An ADSP-21065L.

Single-word data transfers

Reads and writes of the EPBx external port buffers, performed externally by a host or internally by the core. DMA must be disabled in the processor's DMACx control register.

Slave processor

An ADSP-21065L that is not bus master.



For operations that involve the host interface, the processor uses the system clock, which runs at 1xCLKIN. Hereafter, in this chapter, all clock cycle references are to 1xCLKIN, unless otherwise noted.

For details on clock cycles and data throughput, see Table 12-19 on page 12-62.

Host Control of the Processor

The HBR, HBG, and REDY signals enable a host to gain control of a processor and its external bus. Once granted control, the host can transfer 8-, 16-, or 32-bit data asynchronously to and from the processor.

Acquiring the Bus

To gain access to the processor,

1. The host asserts $\overline{\text{HBR}}$, the host bus request signal.

HBR has priority over all BRx multiprocessor bus requests. When asserted, HBR causes the current master processor to relinquish the bus to the host as soon as the current bus cycle finishes.

2. The current master processor asserts $\overline{\text{HBG}}$ as soon as the current bus operation finishes to signal that it is transferring control of the bus.

The cycle in which control of the bus transfers is called a *host transition cycle* (HTC).

Figure 8-2 on page 8-10 shows the timing for bus acquisition by the host.

3. The current master processor continues to assert HBG during the bus transition cycle (BTC), until the host deasserts HBR.

 $\overline{\text{HBG}}$ freezes processor/multiprocessor bus arbitration while the host owns the bus. While $\overline{\text{HBG}}$ is asserted, the other processor continues to assert and deassert its $\overline{\text{BRx}}$ line as in normal operation, but no BTCs occur.

The current master processor holds its \overline{BRx} line low the entire time the host controls the bus.

Host Interface

The host should use $\overline{\text{HBG}}$ to enable its signal buffers (see Figure 8-8 on page 8-45.)

Once it has gained control of the bus, the host can initiate asynchronous transfers. To do so, the host:

- 1. Asserts the \overline{CS} pin of the processor that it wants to access and performs the asynchronous read or write.
- Drives the ADDR₇₋₀ and either the M address field bits as 0 or any E address field bits as 1 (for details, see Table 5-3 on page 5-20), RD, WR, and SW signals during the HTC in which it gains control of the bus (see Figure 8-3 on page 8-13).

The host must continue to drive these signals for the entire time it owns the bus. In addition, it must either drive the $\overline{\text{MS}}_{3-0}$ lines (except the $\overline{\text{MS}}$ x line connected to an SDRAM device) and the $\overline{\text{DMAG1}}$ and $\overline{\text{DMAG2}}$ grant lines, or these lines must be pulled weakly up or down. (You need pull the $\overline{\text{DMAGx}}$ lines up or down weakly only if they connect externally.) The master processor places these lines in a high impedance state to enable the host to use them.



Figure 8-2. Example timing for bus acquisition

During read-modify-write operations, to avoid temporary loss of bus mastership, the host must continue asserting $\overline{\text{HBR}}$ until it completes the last data transfer.

The following restrictions apply to host acquisitions of the bus:

• If the host asserts HBR while the processor is in reset, the processor responds with HBG only after multiprocessor synchronization has finished. If the processor is ID0 (single-processor system), it responds with HBG immediately.

For details, see "Bus Arbitration Synchronization After Reset" on page 7-21.

- The host must not deassert HBR during a host access.
- If <u>SBTS</u> is asserted after <u>HBR</u>, the processor may enter slave mode and suspend any unfinished access to the external bus.

(For details, see "Resolving Bus Access Deadlock" on page 8-49.)

Once the it has finished its task, the host can deassert $\overline{\text{HBR}}$ to relinquish control of the bus. The master processor deasserts $\overline{\text{HBG}}$ in response.

In the next cycle, the master processor regains control of the bus, and normal multiprocessor arbitration resumes. The host must not deassert $\overline{\text{HBR}}$ until after it has completed its last data transfer with the processor.

Host Transfers

After acquiring control of the processor's external bus, the host must assert the $\overline{\text{CS}}$ pin of the processor it wants to access. Doing so informs the processor that it will be transferring data asynchronously with the host. The host must then drive the offset address of the IOP register it wants to access. To simplify hardware requirements for the external interface logic, the host need drive ADDR₇₋₀ only and either the *M* address field bits as 0 or the appropriate *E* address field bits as 1 (for *M* and *E* address field definitions, see Table 5-3 on page 5-20).

Asynchronous Transfer Timing

When a host asserts a processor's \overline{CS} chip select, the selected processor deasserts the REDY signal with a delay of approximately 10 ns. For exact timing specifications, see the processor's data sheet.

At this time, \overline{CS} , not \overline{RD} or \overline{WR} , causes the processor to deassert REDY because the host interface buffers for \overline{RD} and \overline{WR} may not be enabled if the bus master has not asserted \overline{HBG} .

The host can assert \overline{CS} before or after it asserts \overline{HBR} , but the processor will not reassert REDY until after the bus master has asserted \overline{HBG} and the host has applied a \overline{RD} or \overline{WR} strobe. This is true only if a \overline{RD} or \overline{WR} strobe is active when the processor asserts \overline{HBG} ; otherwise, the t_{TRDYHG} switching characteristic determines the timing. (See the timing section of the processor's data sheet.)

The processor asserts REDY before a $\overline{\text{RD}}$ or $\overline{\text{WR}}$ and deasserts REDY only if it is not ready to complete the read or write. The only exception occurs when the host first asserts $\overline{\text{CS}}$. The REDY pin defaults to open-drain output to facilitate interfacing to common buses. To change it to an active-drive output, set ADREDY=1 in the SYSCON register.



Figure 8-3. Example timing for host read and write cycles

Figure 8-3 shows the timing of a host write cycle. This timing is based on the example host interface hardware shown in Figure 8-8 on page 8-45.

A host write cycle follows this sequence:

1. The host asserts the address.

Since the system bus interface address comparator decodes $\overline{\text{HBR}}$ and $\overline{\text{CS}}$, the host need not supply them directly. The selected processor deasserts REDY immediately.

- 2. The host asserts \overline{WR} and drives data (according to the timing requirements specified in the data sheet).
- 3. The selected processor asserts REDY when it is ready to accept the data.

This occurs after the current bus master has completed its current transfer and has asserted $\overline{\text{HBG}}$. $\overline{\text{HBG}}$ enables the host interface buffers to drive onto the processor's bus.

- 4. The host deasserts \overline{WR} when REDY is high and stops driving data.
- 5. The selected processor latches data on the rising edge of \overline{WR} .

After the first word, the write sequence is:

- 6. The host asserts WR and drives data (according to the timing requirements specified in the processor's data sheet).
- 7. The processor deasserts REDY if it is not ready to accept data.
- 8. The host deasserts \overline{WR} when REDY is high and stops driving data.
- 9. The selected processor latches data on the rising edge of \overline{WR} .

In a multiprocessor system, if the ADREDY bit is cleared (0) on both processors, the host can assert both processor's \overline{CS} pins at the same time during a write, but not during a read because of bus conflict.

To enable full speed asynchronous writes, the processor latches data at the I/O pins in a four-level FIFO buffer, the *slave write FIFO* (see Figure 8-1 on page 8-2). This buffering enables the processor to resynchronize previously written words while a host is writing a new word, and it enables asynchronous writes to occur at speeds up to 1xCLKIN.

Figure 8-3 on page 8-13 also shows the timing of a host read cycle. This timing is based on the example host interface hardware shown in Figure 8-8 on page 8-45.

A host read cycle follows this sequence:

1. The host asserts the address.

The system bus interface address comparator decodes $\overline{\text{HBR}}$ and the appropriate $\overline{\text{CS}}$ line again. The selected processor deasserts REDY immediately and asserts $\overline{\text{HBG}}$.

- 2. The host asserts \overline{RD} .
- 3. The selected processor drives data onto the bus and asserts REDY when the data is available.
- 4. The host latches the data and deasserts $\overline{\text{RD}}$.

After the first word, the read sequence is:

- 5. The host asserts \overline{RD} .
- 6. The selected processor deasserts REDY then asserts REDY, driving data when it becomes available.
- 7. The host deasserts \overline{RD} when REDY is high and latches the data.

The maximum throughput for reads is one every two CLKIN cycles.

Data Transfers

The host or the bus master can read and write all of the I/O processor's IOP registers to:

- Control and configure the processor's operation (SYSCON and SYSTAT).
- Communicate with the processor's core (MSGRx).
- Set up DMA transfers (DMACx).
- Transfer data.

To do so, the host asserts the processor's \overline{CS} line and writes the offset address of the IOP register it wants to access in the lower eight bits of the external address bus and writes either 0 to the *M* address field bits or 1 to the appropriate *E* address field bits (see Table 5-3 on page 5-20).

These accesses are invisible to the processor's core because they use the external port and the on-chip I/O bus—not the DM bus or the PM bus (see Figure 8-1 on page 8-2). This is an important distinction because it enables the processor's core to continue executing program uninterrupted.

Writing to the IOP Registers

Because the external port buffers (EPBx), which are also IOP registers, are six-deep FIFO buffers, writes to them execute slightly differently than writes to the other IOP registers. And, the host uses them to perform DMA transfers. For details, see "Transfers Through the EPBx Buffers" on page 8-18.

When the host writes to a slave processor, the slave's I/O processor latches the address and data on-chip, buffering the address and data in a special set of FIFO buffers, the *slave write FIFO*, at the external port pins (see

Figure 8-1 on page 8-2). If the host attempts additional writes when this FIFO buffer is full, the processor deasserts REDY until the buffer is no longer full.

In the next cycle after the I/O processor latches the write data, the slave write FIFO attempts to complete the write internally to the target IOP register. This enables the host or master processor to perform writes at the full clock rate.

Writes to the IOP registers usually occur in the following one or two cycles. Writes take more than two cycles only if a full EPBx buffer delayed a write in the previous cycle.

If the EPBx buffer and slave write FIFO are full when the host attempts a write, the processor deasserts REDY until buffer space is available. The EPBx buffer usually empties out within one cycle, creating a *write latency*, unless higher priority, on-chip DMA transfers are in progress.

Data in the slave write FIFO delays a host read. This delay prevents the host from reading invalid data and from performing operations out of sequence.

Reading the IOP Registers

When the host or master processor reads a slave processor, the slave's I/O processor latches the address on-chip and deasserts REDY. When the slave processor reads the corresponding IOP register location, it drives the data off-chip and asserts REDY. Unlike writes, reads cannot be pipelined; they occur one at a time only.

Writes have a maximum pipelined throughput of one per CLKIN cycle, and reads have a maximum throughput of one every two CLKIN cycles. For details, see Chapter 12, System Design. Because of this low bandwidth, reads are not the most efficient method of transferring data out of a slave processor.

Transfers Through the EPBx Buffers

In addition to reads and writes of the other IOP registers, the host can transfer data to and from the processor's internal memory space through its external port FIFO buffers, EPB_0 and EPB_1 .

Through the EPBx buffers, the host can perform:

• Single-word transfers

The processor's core handles internal single-word transfers.

• DMA block transfers

The processor's DMA controller handles internal DMA transfers.

Each EPBx buffer has a read port and a write port. Both ports can connect internally to either the EPD (External Port Data) bus, the IOD (I/O Data) bus, the PM Data bus, or the DM Data bus as shown in Figure 8-1 on page 8-2.

When the host writes to a slave processor's EPBx buffers, the slave's processor latches and buffers the address and data on-chip, just as it does for writes to the other IOP registers. And, if additional writes occur when the slave write FIFO buffer is full, the processor deasserts REDY and waits for room in the buffer.

But because both of the EPBx buffers, which are part of the IOP register set, are six-location FIFOs, the host can perform up to six writes before encountering a delay, a write latency. (The external port FIFO buffers can be delayed for up to four CLKIN cycles if all of the serial port DMA channels are active or for up to four CLKIN cycles per chain during a DMA chaining operation.)

Single-Word Transfers

When the host writes a single data word to the EPBx buffers, the processor's core must read the data. Conversely, when the processor's core writes a single piece of data to one of the EPBx buffers, the host must perform an external read cycle to obtain it. Because the EPBx buffers are six-deep, bidirectional FIFOs, the host and the processor's core have extra time to read the data. This functionality enables efficient, continuous, single-word transfers to occur in real-time, with low latency and no DMA.

If the host attempts a read from an empty EPBx buffer, the processor holds off the access with the REDY signal until the buffer receives data from the core. If the processor's core attempts to write to a full EPBx buffer, the processor delays the access, and the core hangs until the host reads the buffer. To prevent the core from hanging, set the Buffer Hang Disable bit (BHD=1) in the SYSCON register. To determine the status of a particular EPBx buffer, read the appropriate DMACx register.

Similarly, if the host attempts a write to a full EPBx buffer, the processor holds off the access with REDY until the processor's core reads the buffer. If the core attempts to read from an empty buffer, the processor delays the access, and the core hangs until the host writes to the buffer. To prevent this hang condition, set BHD=1 in the SYSCON register. With BHD=1, however, reads may access invalid data, and writes may not finish.

To flush (clear) either EPBx buffer, write a 1 to the FLSH bit in the corresponding DMACx control register. The processor does not latch this bit internally, and it always read as 0. Status can change in the following cycle. Do not enable and flush an EPBx buffer in the same cycle.

To pack and unpack individual data words, you must set both the PMODE bits in the appropriate DMACx control register and the HBW bits in the SYSCON register. For details, see Table 8-2 on page 8-24.

Data Transfers

(and

For single-word transfers, you must also set the TRAN bit in the EPBx DMACx control register appropriately:

TRAN=1	For host reads of the EPBx register
TRAN=0	For host writes to the EPBx register
To pe	rform single-word, non-DMA transfers th

To perform single-word, non-DMA transfers through the EPBx buffers, you must clear the DMA enable bit (DEN=0) in the appropriate DMACx control register.

Interrupts for Single-Word Transfers. You can use the interrupts for the two external port DMA channels to control single-word data transfers between the host and the processor's core. To do so, set the DEN and INTIO bits in the DMACx control register:

DEN=0 Disable DMA

INTIO=1 Enable interrupt-driven I/O

For details, see Chapter 6, DMA, and Appendix E, Control and Status Registers, in *ADSP-21065L SHARC DSP Technical Reference*.

With this configuration, the interrupt is generated whenever data becomes available in the read port of the EPBx buffer or whenever the write port does not have new data to transmit. Then, either the processor's core or an external device, such as the host, can read or write the EPBx buffer. Generating interrupts this way is useful for implementing interrupt-driven I/O that the processor's core controls.

You can mask out (disable) this interrupt in the IMASK register. Before you re-enable it in IMASK, make sure you clear the corresponding IRPTL latch bit to clear any interrupt request that might have occurred in the interim.

DMA Transfers

The host can also set up DMA transfers to and from the processor's internal or external memory space. Once the host has gained control of the processor, it can access the on-chip DMA control and parameter registers to set up an external port DMA operation. This is the most efficient way to transfer blocks of data.

• DMA transfers to internal memory space.

The host can set up external port DMA channels to transfer data to and from the processor's internal memory space, or it can use the DMA request and grant lines (DMARx, DMAGx) to transfer data directly to or from the processor's internal memory space.

• DMA transfers to external memory space.

Using the DMA request and grant lines (\overline{DMARx} , \overline{DMAGx}), the host can set up an external port DMA channel to transfer data directly to or from the processor's external memory space.

Transfers to Internal Memory Space. To set up DMA channels to transfer data to and from internal memory space, the host must initialize the processor's control and parameter registers for the particular channel. Once the DMA channel is set up, the host simply reads from or writes to the corresponding EPBx buffer.

The hosts sets up a channel for either slave mode DMA or handshake mode DMA. To do so, the host sets the MASTER, HSHAKE, and EXTERN bits in the channel's DMACx register appropriately.

For slave mode DMA, set:

```
MASTER = 0HSHAKE = 0EXTERN = 0
```

Data Transfers

In slave mode DMA, if the buffer is empty (or full), the processor's DMA controller extends the access until data is available (or stored). This method enables fast and efficient data transfers.

To pack and unpack DMA data, you select the packing mode in the PMODE bits of the external port DMA control registers (DMAC0 and DMAC1) and the HBW bits in the SYSCON register. See Table 8-2 on page 8-24 for the available packing modes.

For handshake mode DMA, set:

```
MASTER = 0
HSHAKE = 1
EXTERN = 0
```

In handshake mode DMA, the host can also use the $\overline{\text{DMARx}}$ and $\overline{\text{DMAGx}}$ handshake signals for a DMA transfer, but not when it has asserted $\overline{\text{HBR}}$ to gain control of the bus.

DMA Transfers to External Memory Space. To use the processor's DMA controller to transfer data directly from the host to external memory space, you must use the *external handshake mode* for external port DMA channel 8 or 9.

For external handshake mode DMA, set:

```
MASTER =0
HSHAKE = 1
EXTERN = 1
```

This mode provides the $\overline{\text{DMAR}}x$ and $\overline{\text{DMAG}}x$ handshaking for this type of transfer.

These transfers have the following restrictions:

- The host cannot use $\overline{\text{HBR}}$ to gain control of the bus.
- Since the data passes through the DMA controller and not the processor, you cannot pack the data.

For details on using DMA, see Chapter 6, DMA.

Performing Broadcast Writes

Broadcast writes enable simultaneous transmission of data to both processors in a multiprocessing system. The host can perform broadcast writes to the same IOP register on both processors. You can use broadcast writes to implement semaphores in a multiprocessing system and to simultaneously download code or data to both processors. For details, see "Bus Lock and Semaphores" on page 7-34.

To implement broadcast writes, the host must assert \overline{CS} on both processors.

During a broadcast write, both processors:

- Accept the write as if either is the only device addressed.
- Use REDY to add wait states to the host's broadcast write if necessary.

The host must wire-OR both processors' REDY lines together and configure ADREDY in SYSCON for open-drain output.

In this configuration, REDY appears asserted only when both processors are ready. (This is true only if REDY is not actively pulled up.)

Data Packing

For accesses to all IOP registers, except the EPBx buffers, the processor packs and unpacks host data to and from 32-bit internal words. To specify the host's bus width, you set the HBW bits in the SYSCON register (see Table 8-3 on page 8-26).

For accesses to the EPBx buffers, the host interface has data packing logic to pack 8-, 16-, or 32-bit external host bus words into 32- or 48-bit internal words. The packing logic is reversible to unpack 32-bit or 48-bit internal data into 8-, 16-, or 32-bit external data. Bits in both the DMACx control registers and the SYSCON register determine the data packing mode for EPBx transfers.

To pack and unpack individual data words, you set both the PMODE bits in the appropriate DMACx control register and the HBW bits in the SYSCON register. The PMODE bits determine the width of internal words, and the HBW bits determine the width of external words. Table 8-2 shows the packing modes available with various combinations of the PMODE and HBW bits.

DMA Packing Mode		Host Bus Width			
PMODE	Internal bits	00 (32b)	01 (16b)	10 (8b)	
00	Invalid for host DMA transfers using the EPBx buffers. Use only with nonhost DMA transfers.			PBx buffers.	
01	32	No pack 16↔ 32		8 ↔ 32	
10	48	$32 \leftrightarrow 48$ $16 \leftrightarrow 48$		8 ↔ 48	
11	Identical to PMODE = 10				

	Table 8-2.	Packing	mode	bits	for	EPBx	transfers
--	------------	---------	------	------	-----	------	-----------

Packing Control Bits in SYSCON

Figure 8-4 shows the SYSCON register bits that affect host data packing and memory width and Table 8-3 on page 8-26 describes them.



Figure 8-4. SYSCON register bits

After reset, the SYSCON register initializes to 0x0000 0020, which causes the processor to assume an 8-bit bus for the host. To change this selection, you must write four 8-bit words to SYSCON (in the HBW bits), even if the host bus is 16- or 32-bits wide.

Bit	Name	Description
4 - 5	HBW	Host packing mode.
		Specifies the external word width of the host bus for host accesses to the processor's IOP registers.
		00= 32-bit host bus
		01= 16-bit host bus
		10= 8-bit host bus
		All IOP registers share one 16-bit write latch. The write latch transfers data to the appropriate channel only after it accumu- lates 16-bits. So, to prevent data corrup- tion, the host must write to the processor's IOP registers in 8-bit word pairs, maintain- ing control of the bus through both writes of a word pair.
		11= reserved; invalid value
		If the host access is a read or write of any IOP register other than the external port FIFO buffers (EPB ₀ or EPB ₁), the internal word width is always 32 bits, regardless of the width of the host bus.

Table 8-3. SYSCON control bits
Table 8-3. SYSCON control bits (Cont'd)

Bit	Name	Description	
6	HMSWF	Host packing order. Specifies the packing order of host-accessed words. The I/O processor ignores HMSWF for 32-to-48 bit packing. O= LSW first 1= MSW first	
7	HPFLSH	Host packing status flush. Resets the host packing status. Host accesses must not occur while the processor's core is writing the HPFLSH bit. A two cycle latency always occurs before the flush takes effect and the host can resume nor- mal operations. HPFLSH always reads as 0 .	
8	IMDW0 ¹	Internal memory block O data width. Selects the data word width for block O of internal memory. O= 32-bit data 1= 40-bit data	
9	IMDW1 ¹	Internal memory block 1 data width. Selects the data word width for block 1 of internal memory. O= 32-bit data 1= 40-bit data	

¹ This bit has no affect on fetches of 48-bit instructions in a memory block. For details, see Chapter 5, Memory.)

Packing Control Bits in DMACx

The PMODE and TRAN bits in the DMACx control register of each external port buffer (DMAC₀₋₁), which correspond to the EPB_{0-1} buffers, also affect the packing mode, as shown in Table 8-4.

Bit	Name	Description		
0	DEN	DMA enable for external port DMACx. O= disable DMA. 1= enable DMA Must clear to perform single-word, non-DMA trans- fers through the EPBx buffers.		
2	TRAN	DMA transfer direction for external port DMACx. 0= internal to external (transmit) 1= external to internal (receive) For single-word transfers, must set to 1 for host reads from an EPBx buffers or to 0 for host writes to an EPBx buffer.		
6 - 7	PMODE	 DMA packing mode for external port DMACx. Selects the DMA packing mode and specifies the word width of the processor's internal data bus. 00= Invalid for host transfers through the EPBx buffers 01= 32-bit internal words 1X= 48-bit internal words When using any of the valid PMODE packing modes for non-DMA, single-word transfers to or from an EPBx buffer, you must also set the TRAN bit appropriately. 		

Table 8-4. DMACx control bits

See Table 8-2 on page 8-24 for details on how the PMODE bits and HBW bits combine to affect the packing mode when using the EPBx buffers.

To change the host packing mode, follow these steps:

- 1. Write to the SYSCON register and change the value of HBW.
- 2. Read SYSCON to ensure that the write was successful.

Since this read functions as an interlock only, ignore the read data.

- 3. Repeat step 1 to flush the read since it might have occurred in the previous packing mode.
- 4. Wait four cycles.

During packed transfers with a slow host, the host can relinquish the bus before the I/O processor has finished packing the current word. That is, the host can release the bus after writing the first part of the word and reassert HBR later to write the second part of the word. You could implement this scheme to enable another processor to write to this processor without the write affecting the host packing operation.

Data Packing

Data Bus Lines and Host Bus Width

Table 8-5 shows which data bus lines the processor uses for different host bus widths and packing modes.

HBW	Data In	Data Out	
32 bits	Processor inputs and outp external bus (DATA ₃₁₋₀) as	outs 32-bit data over the s is.	
16 bits	Processor ignores upper 16 bits of the external bus (DATA ₃₁₋₁₆).	Processor outputs Os in the upper 16 bits of the exter- nal bus (DATA ₃₁₋₁₆).	
8 bits	Processor ignores upper 24 bits of the external bus (DATA ₃₁₋₈).	Processor outputs Os on the upper 24 bits of the exter- nal bus (DATA ₃₁₋₈).	

Table 8-5. Host bus width and data bus lines

If the host bus width is 32 bits and no packing (HBW = 00) is selected for an access, the processor inputs whatever data is on the external bus and drives $DATA_{31-0}$ with whatever data is in the corresponding memory bits.

If the host bus width is 16 bits and 32 or 48-bit packing (HBW=1x) is selected, the processor ignores the upper 16 bits of the 32-bit external data bus when inputting data, and it drives these bits as 0s when outputting data.

If the host bus width is 8 bits and 32 or 48-bit packing (HBW=1x) is selected, the processor ignores the upper 24 bits of the 32-bit external data bus when inputting data, and it drives these bits as 0s when outputting data.

Figure 8-5 shows how the processor transfers different data word sizes over the external port.



Figure 8-5. External port data alignment

32-Bit Data Packing and Unpacking

Using typical bus interface hardware as shown in Figure 8-8 on page 8-45, when a host reads a 32-bit word with 16-bit unpacking, the host performs the following sequence. (See Figure 8-6 on page 8-32 for an example timing diagram of this host read sequence.)

- 1. The host drives an address, asserting \overline{CS} , and asserts \overline{RD} to initiate a read cycle.
- 2. The selected processor deasserts REDY, latches the address, and performs an internal read to get the data.
- 3. When the processor has the data, it asserts REDY and drives the first 16-bit word.
- 4. The host latches the data and deasserts \overline{RD} .



Figure 8-6. Example timing for Host Interface data packing

- 5. The host initiates another read access, driving the address of the data to access and then asserting $\overline{\text{RD}}$.
- 6. The processor transmits the second 16-bit word.

Using typical bus interface hardware as shown in Figure 8-8 on page 8-45, when a the host writes a 32-bit word with 16-bit packing, the host performs the following sequence. (See Figure 8-6 on page 8-32 for an example timing diagram of this host write sequence.)

- 1. The host drives the write address, asserting \overline{CS} , and asserts \overline{WR} to initiate a write cycle.
- 2. The processor asserts REDY when it is ready to accept data.
- 3. The host drives the address and the first 16-bit word and deasserts \overline{WR} (high).
- 4. The processor latches the first 16-bit word.
- 5. The host drives the same address and asserts \overline{WR} again to initiate another write cycle for the second 16-bit word.
- 6. After the processor accepts the second word, it performs an internal write to its IOP register.

If it has not completed the internal write by the time the host tries another access and the slave write FIFO has no space, the processor delays that access with REDY.

While the processor is waiting for another word from the host to complete the packed word, the HPS bits in the SYSTAT register are nonzero. (See "SYSTAT Register Bits" on page 8-40.) Because the Host Interface has only one packing buffer, the host must complete each packed read or write before beginning another.

For 8-bit hosts, reads and writes follow these same sequences, except that 8-bit hosts must perform four reads or four writes to transfer a 32-bit word.

48-Bit Instruction Packing

Using the EPBx buffers, a host can also download and upload 48-bit instructions over its 8-, 16- or 32-bit bus.

A 32-bit host transfers 32-bit data on $DATA_{31-0}$. To transfer an odd number of instruction words, you must flush the packing buffer with a dummy access to remove the unused word.

The packing sequence for downloading instructions from a 32-bit host bus takes three cycles for every two words as shown in Table 8-6.

Transfer	Data bus lines 31-16	Data Bus Lines 15-0
First	Word 1; bits 47-32	Word 1; bits 31-16
Second	Word 2; bits 15-0	Word 1; bits 15-0
Third	Word 2; bits 47-32	Word 2; bits 31-16

Table 8-6. Host to processor, 32- to 48-bit word packing

For 32-to-48-bit packing, the processor ignores the HMSWF bit in the SYSCON register.

The packing sequence for downloading or uploading instructions over a 16-bit host bus takes three cycles for every word (see Table 8-7). The

HMSWF bit in SYSCON determines whether the I/O processor packs the most significant or least significant 16-bit word first.

Table 8-7. Host to processor, 16- to 48-bit word packing

Transfer	Data Bus Pins 15–0		
First	Word 1; bits 47-32		
Second	Word 1; bits 31-16		
Third	Word 1; bits 15-0		
HMSWF = 1 (host packing order is MSW)			

The packing sequence for downloading or uploading instructions over a 8-bit host bus takes six cycles for every word (see Table 8-8). The HMSWF bit in SYSCON determines whether the I/O processor packs the most significant or least significant 8-bit word first.

Table 8-8. Host to processor, 8- to 48-bit word packing

Transfer	Data Bus Pins 7-0
First	Word 1; bits 47-40
Second	Word 1; bits 39-32
Third	Word 1; bits 31-24
Fourth	Word 1; bits 23-16
Fifth	Word 1; bits 15-8
Sixth	Word 1; bits 7-0
HMSWF = 1 (host packing order is MSW)

Interprocessor Messages

Once granted control of the processor, the host can communicate with it by writing messages to its memory-mapped IOP registers. In a multiprocessor system, the host can access the IOP registers of both processors.

The MSGR₇₋₀ registers are general-purpose registers that you can use to pass messages between the host and the processor or to implement sema-phores and resource sharing between both processors.

You can use the MSGRx and VIRPT registers for message passing in the following ways:

• Message passing

The host can use any of the eight message registers, $MSGR_{7-0}$, to communicate with the processor.

• Vector interrupts

The host can write the address of an interrupt service routine to the VIRPT register to issue a vector interrupt to the processor. This causes an immediate high-priority interrupt on the processor that, when serviced, causes the processor to branch to the specified service routine.

The MSGRx and VIRPT registers also support shared-bus multiprocessing through the external port.

Since resources within a single processor can share these registers, conflicts can occur. Your system software is responsible for preventing such conflicts. For details, see Appendix E, Control and Status Registers, in *ADSP-21065L SHARC DSP Technical Reference*.

Message Passing (MSGRx)

The host has three software protocols available to it for communicating with the processor through the processor's MSGRx message registers:

• Vector-interrupt-driven

The host fills predetermined MSGRx registers with data and writes the address of the service routine to VIRPT to trigger a vector interrupt.

The service routine reads the data from the MSGRx registers and writes 0 to VIRPT to tell the host it is done. Alternatively, the service routine could signal the host using one of the processor's $FLAG_{3-0}$ pins.

• Register handshake

You designate four of the MSGRx registers as follows:

- A receive register (R)
- A receive handshake register (RH)
- A transmit register (T)
- A transmit handshake register (TH)

To pass data to the processor, the host writes data into T and then writes 1 into TH. When the processor sees 1 in TH, it reads the data from T and then writes 0 back to TH. When the host sees 0 in TH, it knows that the transfer has finished.

The processor follows the same sequence to pass data to the host through R and RH.

• Register write-back.

This method is similar to the register handshake method, but uses the T and R data registers only.

The host writes data to T. When the processor sees a non-zero value in T, it retrieves the value and writes 0 back to T.

The host uses a similar sequence to receive data.

This method works well only if the data to pass does not include 0.

Host Vector Interrupts (VIRPT)

The processor uses vector interrupts to respond to interprocessor commands from the host or from another ADSP-21065L. When the host writes an address to the processor's VIRPT register, it generates a vector interrupt.

When it services a vector interrupt, the processor automatically pushes the status stack and begins executing the service routine located at the address specified in VIRPT. The lower twenty-four bits of VIRPT contain the address. Optionally, you can use the upper eight bits as data for the interrupt service routine to read. At reset, the processor reinitializes VIRPT to its standard address in the interrupt vector table.

The minimum latency for vector interrupts is six cycles, five of which are NOPs. When the interrupt service routine reaches the RTI (return from interrupt) instruction, the processor automatically pops the status stack.

Make sure your system software checks the VIPD bit in the SYSTAT register. This bit reflects the status of the VIRPT register:

• If the host writes the VIRPT while a previous vector interrupt is pending, the new vector address replaces the pending one.

- If the host writes VIRPT while the processor is servicing an interrupt, the processor ignores the new vector address, so the host's write doesn't generate a new interrupt.
- A processor write to its own VIRPT register doesn't generate an interrupt.

Using the processor's vector interrupt feature, the host could perform the following procedure:

- 1. Poll the VIRPT register until it reads a certain token value (for example, 0).
- 2. Write the vector interrupt service routine address to VIRPT.

When the service routine is finished, the processor would write the token back to VIRPT to tell the host that it is finished.

3. Initiate another vector interrupt if necessary.

SYSTAT Register Bits

The SYSTAT register provides multiprocessing status information primarily. Figure 8-7 on page 8-43 shows the status bits in this register, and Table 8-9 describes them.

Bit	Name	Description		
0	HSTM	Host mastership.		
		Indicates whether the host has been granted control of the bus.		
		O= Host is not bus master		
		1= Host is bus master		
1	BSYN	Bus synchronization.		
		Indicates when the processor's bus arbitration logic is synchronized after reset. (See "Bus Arbitration Synchronization After Reset" on page 7-21 for detailed information.)		
		O= Bus arbitration logic is not synchronized		
		1= Bus arbitration logic is synchronized		
2-3	Reserve	d		
4 - 5	CRBM	Current bus master.		
		${ m ID}_{2-0}$ of the current bus master.		
		If CRBM = ID of this processor, this processor is the current bus master.		
		CRBM is valid only for ID ₂₋₀ > 0.		
		When ID ₂₋₀ = 000, CRBM is always <i>1</i> .		

Table 8-9. SYSTAT status bits

Bit	Name	Description				
6 - 7	Reserved					
8-9	IDC	ID code.				
		${\rm ID}_{1-0}$ pinouts of the processor.				
		00= reserved for single-processor systems only				
		01= ID1				
		10= ID2				
		11= reserved				
10-11	Reserve	eserved				
12	SWPD	Slave write pending data.				
		Indicates whether valid data is pending in the slave write FIFO.				
		O= No data pending				
		Cleared after processor transfers data in slave write FIFO to target IOP register.				
		1= Data pending				
		Set when the slave write FIFO receives new data.				

Table 8-9. SYSTAT status bits (Cont'd)

SYSTAT Register Bits

Table 8-9.	SYSTAT	status bits	(Cont'd)
------------	--------	-------------	----------

Bit	Name	Description			
13	VIPD	Vector interrupt pending.			
		Indicates that a pending vector interrupt has not yet been serviced.			
		0= No vector interrupt pending			
		Cleared on return from interrupt service routine.			
		1= Vector interrupt pending			
		Set when the VIRPT register has been wr ten.			
		The host or other processor that issued the vector interrupt monitors this bit to determine when the service routine has finished and when it can issue a new vector interrupt.			
14	HPS	Host packing status.			
		Indicates whether host word packing has fin- ished or the stage packing is in. (For details, see "Data Packing" on page 8-24.)			
		0= Fully packed			
		1= Partially packed			
15-31	Reserve	d			



Figure 8-7. SYSTAT register bits

Interfacing with the System Bus

Consider a multiprocessor subsystem, consisting of two processors with local memory, as one of several processing elements connected together over a system bus. The ISA bus and the PCI bus are examples of such systems.

In these subsystems, the processing elements arbitrate through an arbitration unit for control of the system bus. To arbitrate and become bus master, a device must be able to drive a bus request signal and respond to a bus grant signal. The arbitration unit, a device external to the processor, determines which request to grant in any given cycle.

Accessing the Cluster Bus and Slave Processors

Figure 8-8 on page 8-45 shows an example of a basic interface to a system bus that isolates the processor cluster bus from the system bus. The cluster bus connects two processors and an external memory device together.

Host Interface



Figure 8-8. Basic system bus interface with cluster bus

When the system is not accessing the processors, the cluster bus supports transfers between both processors and between the processors and the external memory device.

System accesses of the processors follow this procedure:

- 1. When the system wants to access a processor, it executes a read or write to the address range of the subsystem's IOP registers.
- 2. The address comparator in the system bus interface detects a local access and asserts $\overline{\text{HBR}}$ and the $\overline{\text{CS}}$ line of the appropriate processor.
- 3. The selected processor holds off the system bus with REDY until it is ready to accept the data.
- 4. The master processor asserts the $\overline{\text{HBG}}$ signal.

HBG enables the system bus buffers, while the read and write signals control the buffers' direction for data.

To avoid glitches on the $\overline{\text{HBR}}$ line when addresses are changing, an address latch enable signal from the system or the system read or write signals can qualify the address comparator. These methods cause the address comparator to deassert $\overline{\text{HBR}}$ each time the system deasserts a read or write or the address changes. Because these techniques deassert $\overline{\text{HBR}}$ with each access, the overhead of an HTC (Host Transition Cycle) occurs as part of each access. To avoid this type of overhead, latch $\overline{\text{HBG}}$ during long sequences of bus accesses.

Master Processor Accesses of the System Bus

Figure 8-9 on page 8-47 shows a more complex, bidirectional system interface in which a processor becomes bus master to access the system bus.



Figure 8-9. Bidirectional system bus interface

Before it begins the access, the processor generates the *system bus request signal* to request permission to become bus master. The system bus arbitration unit determines when to respond with the *system bus grant signal* on pin $FLAG_0$.

The method a processor uses to arbitrate for the system bus depends on whether its core or its DMA controller initiates the access.

Core Accesses of the System Bus

The processor's core uses one of two methods to access the system bus:

• The core sets a flag (FLAGx) and waits for the system bus grant signal through another FLAG.

This method avoids tying up the local bus during the wait. Tying the system bus grant signal to an interrupt pin enables the processor's core to continue doing useful work while it waits.

• The processor's core assumes that the system bus is available, and if it isn't, the core either waits or aborts the access.

The processor asserts one of its memory select lines $\overline{\text{MS}}_{3-0}$ to begin the access. Doing so also asserts the system bus request signal. If the system bus is unavailable (FLAG₀ is deasserted), the system bus interface asserts ACK to hold off the processor. Although this approach is simple, accesses to a busy system bus tie up both the processor and the cluster bus. To resolve this, you can use the Type 10 instruction (see page A-52, in *ADSP-21065L SHARC DSP Technical Reference*):

```
IF condition JUMP(addr), ELSE compute, DM(addr) = dreg;
```

In this example, the Type 10 instruction aborts the bus access if the condition, the system bus grant signal ($FLAG_0$), is false and causes a branch to a *try again later* routine. This method works well if the system bus grant signal ($FLAG_0$) is asserted most of the time.

If you don't use the Type 10 instruction and the processor's core attempts an access before the bus has been granted, the access can cause a deadlock condition.

Resolving Bus Access Deadlock

It's rare but possible for both the system and the processor to try to access each other's bus in the same cycle, causing a deadlock in which ACK remains deasserted, so neither access can finish.

Normally, the master processor, in response to an $\overline{\text{HBR}}$ request, asserts $\overline{\text{HBG}}$ after the completion of the current access. If it is accessing the system bus at the same time, however, the master processor does not assert $\overline{\text{HBG}}$ because the current access cannot finish.

To break this type of deadlock, once your software detects it (both sides have enabled a system bus to cluster bus buffer), assert the SBTS (Suspend Bus Three-state pin) input for one or more cycles. (For details, see page 8-50.)

When the host asserts both $\overline{\text{SBTS}}$ and $\overline{\text{HBR}}$, the processor enters slave mode and suspends its external access. This enables the system's access to the cluster bus to proceed after the processor asserts $\overline{\text{HBG}}$.

Apply the $\overline{\text{SBTS}}$ and $\overline{\text{HBR}}$ combination only when a processor's access to the system bus causes a deadlock. Do not apply it during a cluster bus transfer because doing so causes two assertions of the $\overline{\text{WR}}$ signal, once before $\overline{\text{SBTS}}$ is asserted and once after the access resumes. With transfers between two processors over the cluster bus, this procedure violates the slave's timing requirements.

Results of using the <u>SBTS</u>/<u>HBR</u> combination depend on the conditions under which it was applied:

- When the host asserts both <u>SBTS</u> and <u>HBR</u> in the same cycle that the processor is performing an external access, the external access is suspended until the host deasserts both <u>SBTS</u> and <u>HBR</u>.
- When the host asserts SBTS and HBR during an external DMA access, the processor does not assert HBG until the access has finished.

• When the host asserts SBTS and HBR while bus lock is set, the processor places its bus signals in a high impedance state, but does not enter slave mode.

The host can suspend a processor's access in progress and gain access to the processor's internal resources, if:

- The access originates from the processor's core, not its DMA controller;
- Bus lock is disabled.

To do so, the host performs this procedure:

1. After it asserts $\overline{\text{HBR}}$, the host asserts $\overline{\text{SBTS}}$ for one or more cycles.

If $\overline{\text{SBTS}}$ is asserted one or more cycles after the processor recognizes $\overline{\text{HBR}}$, the processor is guaranteed to assert $\overline{\text{HBG}}$ in the next cycle. The host must deassert $\overline{\text{SBTS}}$ between the time it receives $\overline{\text{HBG}}$ and the time it deasserts $\overline{\text{HBR}}$.

2. The host drives both $\overline{\text{RD}}$ and $\overline{\text{WR}}$ strobes to their correct value (within the setup time specified in the processor's data sheet) after the processor asserts $\overline{\text{HBG}}$.

The host can then perform as many accesses as needed.

The host has full control of the bus and can access the other the processor or other peripherals on the bus.

- 3. The host deasserts $\overline{\text{HBR}}$.
- 4. One cycle after deasserting HBG, the processor restarts its suspended access.

DMA Controller Accesses of the System Bus

Unlike with core accesses, with DMA controller accesses, you cannot use the SBTS and HBR combination to resolve a system bus deadlock because

once a DMA word transfer has begun in the processor, it must finish (the DMA controller must receive the ACK signal). If the host asserts $\overline{\text{SBTS}}$ and $\overline{\text{HBR}}$ during a DMA access, the master processor does not assert $\overline{\text{HBG}}$ until the access cycle has finished. Preventing the single DMA access from finishing can create a deadlock condition.

To prevent system bus deadlock when using DMA, your software must make sure that the system bus arbitration unit has asserted the system bus grant signal before it initiates the DMA sequence. If a higher priority access needs attention, to hold off the DMA sequence, the host can assert HBR at any time after a word has been transferred.

To prevent another deadlock, make sure the system bus arbitration unit asserts the system bus grant signal before the host deasserts $\overline{\text{HBR}}$. When the DMA sequence finishes, make sure the DMA interrupt service routine clears the external system bus request flag.

Because the system bus is likely to be substantially slower than the processor's cluster bus, using DMA handshake mode may improve performance on the cluster bus. In this case, you tie the system bus grant signal to the DMA request line, DMARx. Then the DMA controller initiates access to the cluster bus and the system bus only when the system bus is available.

Using a FIFO in the system bus interface to post DMA data from the cluster bus may also increase performance on the cluster bus, offsetting a slow system bus.

Uniprocessor to Microprocessor Bus Interface

One processor without external memory can connect more or less directly to a host's bus, requiring few or no buffers. This type of connection assumes that the processor can execute its application from internal memory most of the time, with only occasional need to request an external access. In this configuration, the host continuously asserts $\overline{\text{HBR}}$, unless it detects $\overline{\text{BR}}_1$ (the $\overline{\text{BRx}}$ line of the processor with ID1). Then, when the host is ready to give up its bus, it deasserts $\overline{\text{HBR}}$ to enable the processor to perform an external access.

Most of the time, however, the host can read or write to the processor at will. To do so, the host asserts \overline{CS} and initiates handshaking with REDY. In this scenario, the processor need not respond with \overline{HBG} .

9 SERIAL PORTS

The processor has two independent, synchronous serial ports, SPORT0 and SPORT1, that provide an I/O interface to peripheral devices.

Each serial port has a set of control registers and data buffers. With a range of clock and frame synchronization options, the SPORTs support a variety of serial communication protocols and provide a glueless hardware interface to industry-standard data converters and CODECs.

The processor's serial ports provide these features and capabilities:

• Two transmit and two receive channels per serial port.

Each serial port can transmit and receive data simultaneously for full duplex operation.

- Inexpensive eight- or six-line connection to peripheral devices for two-way communication.
- Independent transmit and receive functions.

Independent functioning provides greater flexibility for serial communications.

- Double buffering of data.
- Integral hardware for µ-law and A-law companding.
- Operation at processor's full clock rate.

This capability provides each with a maximum data rate of nM bit/s, where n equals the processor's input clock frequency.

- Core controlled interrupt-driven, single-word transfers to and from on-chip memory.
- DMA controller controlled block transfers to and from on-chip memory, including chained DMA operations of multiple data blocks.
- Three operation modes: standard, I²S, and multichannel.

In standard mode, one or both transmit channels can transmit, and one or both receive channels can receive.

In I²S mode, one or both transmit channels can transmit, and one or both receive channels can receive. Each channel either transmits or receives L and R channels.

In both standard and I^2S modes, when both A and B channels are used, they transmit or receive data simultaneously, sending or receiving bit 0 on the same edge of the serial clock, bit 1 on the next edge of the serial clock, and so on.

In multichannel mode, each SPORT can receive and transmit data selectively from channels of a time-division-multiplexed serial bit-stream—a useful option for T1 interfaces.

- Support for internally or externally generated serial clock and frame sync signals in a wide range of frequencies.
- Support for data words of 3- to 32-bits and MSB or LSB formats.



Figure 9-1. Serial port block diagram

Serial Port Connections

Figure 9-1 on page 9-3 shows the architecture of each serial port and Table 9-1 lists and describes the pins.

SPORTO		RT0	SPORT1	
Function	A Chn	B Chn	A Chn	B Chn
Transmit data	DTOA	DTOB	DT1A	DT1B
Transmit clock	TCLKO		TCLK1	
Transmit frame sync/ word select	TFSO		TFS1	
Receive data	DROA	DROB	DR1A	DR1B
Receive clock	RCLKO		RCLK1	
Receive frame sync	RFS0		RFS1	

Table 9-1. Serial port pins

A serial port receives serial data on its DR input and transmits serial data on its DT output. It can receive and transmit simultaneously for full duplex operation.

For non-multichannel mode the processor drives the DT pins only when actively transmitting data, (that is, a frame sync has been recognized and data has not finished transmitting). Otherwise, they are three-stated. In multichannel mode, DT is driven if the transmitter is active in that time slot. Otherwise, it is in a high impedance state (if it is in an inactive slot).

Serial communications are synchronized to a clock signal—a clock pulse must accompany every data bit. Each serial port can generate or receive its own transmit clock signal (TCLK) and receive clock signal (RCLK). You configure internally-generated serial clock frequencies in a serial port's TDIVx and RDIVx registers.

You can use frame synchronization to signal data, signaling either at the beginning of an individual word or at the beginning of a block of words. Configuration of the frame sync signals depends on the type of serial device connected to the processor. Each serial port can generate or receive its own transmit frame sync (TFS) signal and receive frame sync (RFS) signal. You configure internally-generated frame sync frequencies in a serial port's TDIVx and RDIVx registers.

Figure 9-1 on page 9-3 shows the components of a serial port. The processor's core writes data for transmission to the TX buffer. Serial port hardware compresses (optional) the data, then automatically transfers it to the transmit shift register. The transmit shift register shifts the data out on the SPORT's DT pin synchronously to the TCLK transmit clock. When using framing signals, the TFS signal indicates the beginning of the serial word transmission. With serial port enabled (SPEN=1), the processor always drives the DT pin, unless the channel is operating in multichannel mode and an inactive time slot occurs. (For details, see "Multichannel Mode" on page 9-67.)

Likewise, the receive shift register shifts in data from the SPORT's DR pin synchronously to the RCLK receive clock. When using framing signals, the RFS signal indicates the beginning of the serial word reception. When the receive shift register shifts in an entire word, serial port hardware expands (optional) the data, then automatically transfers it to the RX buffer.

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Because the processor's SPORTs are not UARTs, they cannot communicate with an RS-232 device or with any other asynchronous communications protocol.



(Cont'd)

You can, however, implement RS-232-compatible communications with the processor. To do so, use two of the $FLAG_{11-}$ $_0$ pins as asynchronous data receive and transmit signals. For details, see the appropriate chapter in *Digital Signal Processing Applications Using The ADSP-2100 Family, Volume 2.* Although these examples are 16-bit, fixed-point applications, you can easily modify the code to run on the ADSP-21065L.

SPORT Interrupts

Each serial port has a transmit DMA interrupt and a receive DMA interrupt. With serial port DMA disabled, interrupts occur for each data word the serial port transmits and receives. Table 9-2 shows the priority of the serial port interrupts.

Table 9-2.	SPORT	interrupts
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Interrupt ¹	Function	Priority
SPROI	SPORTO receive DMA channels 0 and 1	Highest
SPR1I	SPORT1 receive DMA channels 2 and 3	
SPTOI	SPORTO transmit DMA channels 4 and 5	
SPT1I	SPORT1 transmit DMA channels 6 and 7	
EPOI	Ext. port buffer O DMA channel 8	
EP1II	Ext. port buffer 1 DMA channel 9	Lowest

Interrupt names are defined in the def21065L.h include file supplied with the ADSP-21000 Family Development Software.

SPORT interrupts occur on the second system clock (CLKIN) after the serial port latches or drives out the last bit of the serial word.

SPORT RESET

You can reset the serial ports using either the hardware or the software method. Each method affects the serial ports differently.

Both methods disable the serial ports and clear the data buffer status bits. Re-enabling a serial port does not affect its data buffer status bits. But, regardless of whether a serial port is enabled or disabled, a write or read of its TX or RX buffers changes the corresponding data buffer status bits, incrementing or decrementing them, respectively. This is so, even when you write the RX buffer (increments the RXS status bits) or read the TX buffer (decrements the TXS status bits).

Table 9-3 shows the results of writing and reading full and empty TX and RX data buffers. Some results depend on the value of the BHD bit in the SYSCON register (see page 9-15 and page 9-86).

Operation	Full TX	Empty TX	Full RX	Empty RX
Write	Depends on BHD bit:	Increments status bits	Depends on BHD bit:	Increments status bits
	 Hangs pro- cessor 		 Hangs pro- cessor 	
	 Overwrites current contents of TX buffer 		 Overwrites current contents of RX buffer 	

Table 9-3. Results of TX and RX writes and reads

Operation	Full TX	Empty TX	Full RX	Empty RX
Read	Decrements status bits	Depends on BHD bit:	Decrements status bits	Depends on BHD bit:
		• Hangs pro- cessor		• Hangs pro- cessor
		• Reads invalid data		• Reads invalid data

Table 9-3. Results of TX and RX writes and reads (Cont'd)

When re-enabled (in the STCTLx or SRCTLx control register) after reset, a serial port configured for external clock and frame sync can start transmitting or receiving data two CLKIN cycles after becoming enabled.

Using the Hardware Reset Method

To perform a hardware reset, you use the processor's RESET pin.

A hardware reset clears the STCTLx and SRCTLx control registers (including the SPEN enable bits) and the TDIVx and RDIVx frame sync divisor registers to disable the serial port.

This method aborts any ongoing operations.

Using the Software Reset Method

To perform a software reset, you clear the serial port's enable bit (SPEN) in the STCTLx and SRCTLx control registers.

A software reset disables the serial port and clears all data buffer status bits.

This method aborts any ongoing operations.

SPORT Control Registers and Data Buffers

Each SPORT has a set of control and configuration registers and data buffers, as shown in Table 9-4. These registers and buffers are part of the IOP register set.

Register	Function		
STCTLX	SPORT transmit control register		
TXx_z ¹	Transmit data buffer		
TDIVx	Transmit clock and frame sync divisors		
MTCSx	Multichannel transmit select		
MTCCSx	Multichannel transmit compand select		
SRCTLX	SPORT receive control register		
RXx_z ¹	Receive data buffer		
RDIV×	Receive clock and frame sync divisors		
MRCS×	Multichannel receive select		
MRCCS×	Multichannel receive companding select		
KEYWDx	SPORT receive comparison register		
IMASKx	SPORT receive comparison mask		

lable 9-4 NPORT control and data register	
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¹ x = Serial port 0 or 1; z = Channel A or B

Table 9-5 shows the memory-mapped address and reset initialization value of each SPORT register. All of these registers are 32 bits wide.

Register	Address	Reset	Description
STCTLO	0×00E0	0x0000 0000	SPORTO transmit control reg- ister
SRCTLO	0×00E1	0x0000 0000	SPORTO receive control reg- ister
TXO_A	0x00E2	None	SPORTO transmit data buffer; A data
RXO_A	0x00E3	None	SPORTO receive data buffer; A data
TDIVO	0×00E4	None	SPORTO transmit divisor
Reserved	0x00E5		
RDIVO	0×00E6	None	SPORTO receive divisor
Reserved	0×00E7		
MTCSO	0×00E8	None	SPORTO multichannel transmit select
MRCSO	0x00E9	None	SPORTO multichannel receive select
MTCCSO	0×00EA	None	SPORTO multichannel transmit compand select
MRCCSO	0×00EB	None	SPORTO multichannel receive compand select
KEYWDO	0×00EC	None	SPORTO receive comparison register

Table 9-5. SPORT registers memory-mapped addresses and reset values
Register	Address	Reset	Description
IMASKO	0x00ED	None	SPORTO receive comparison mask register
ТХО_В	0x00EE	None	SPORTO transmit data buffer; B data
RXO_B	0x00EF	None	SPORTO receive data buffer; B data
STCTL1	0x00F0	0×0000 0000	SPORT1 transmit control reg- ister
SRCTL1	0x00F1	0×0000 0000	SPORT1 receive control reg- ister
TX1_A	0x00F2	None	SPORT1 transmit data buffer; A data
RX1_A	0x00F3	None	SPORT1 receive data buffer; A data
TDIV1	0×00F4	None	SPORT1 transmit divisor
Reserved	0x00F5		
RDIV1	0x00F6	None	SPORT1 receive divisor
Reserved	0x00F7		
MTCS1	0x00F8	None	SPORT1 multichannel transmit select
MRCS1	0x00F9	None	SPORT1 multichannel receive select
MTCCS1	0x00FA	None	SPORT1 multichannel transmit compand select

Table 9-5. SPORT registers memory-mapped addresses and reset values

Register	Address	Reset	Description
MRCCS1	0x00FB	None	SPORT1 multichannel receive compand select
KEYWD1	0x00FC	None	SPORT1 receive comparison register
IMASK1	0x00FD	None	SPORT1 receive comparison mask register
TX1_B	0x00FE	None	SPORT1 transmit data buffer; B data
RX1_B	0x00FF	None	SPORT1 receive data buffer; B data

Table 9-5. SPORT registers memory-mapped addresses and reset values

To program the SPORT control registers, you write to the appropriate address in memory. Applications can use the symbolic names of the registers and individual control bits. The file def21065L.h, provided in the INCLUDE directory of the ADSP-21000 Family Development Software, contains the #define definitions for these symbols. See Appendix E, Control and Status Registers, in ADSP-21065L SHARC DSP Technical Reference, for a listing of the file's contents.

All control and status bits in the SPORT registers are active high unless otherwise noted.

Because the SPORT registers are memory-mapped, you cannot write them with data coming directly from memory. Instead, you must write or read them from or to the processor's core registers, usually one of the Register File's general-purpose universal registers (R15–R0).

External devices, such as another ADSP-21065L or a host, can write and read the SPORT control registers to set up a serial port DMA operation, for example.

When changing operating modes, write the serial port's control register, STCTLx or SRCTLx, with all 0s to clear it before you write the new mode to the register.

Register Writes and Effect Latency

The processor completes internal writes to SPORT registers at the end of the same CLKIN cycle in which they begin. So the newly written value is available in the register on the next cycle. But when a write to one of the STCTLx or SRCTLx control registers immediately follows a read of the same register, the write takes at least two cycles to finish.

After a write to a SPORT register, control and mode bit changes take effect by the end of the second CLKIN cycle after the write has finished. Two CLKIN cycles after they are enabled (in the STCTLx or SRCTLx register), the serial ports can start transmitting or receiving, losing no serial clock cycles from that point on.

Transmit and Receive Data Buffers (TX, RX)

TX0_A and TX0_B are the transmit data buffers for SPORT0, and TX1_A and TX1_B are the transmit data buffers for SPORT1. Either the DMA controller or the processor's core program must load these 32-bit buffers with the data to transmit.

RX0_A and RX0_B are the receive data buffers for SPORT0, and RX1_A and RX1_B are the receive data buffers for SPORT1. The receive shift register automatically loads these 32-bit buffers when the serial port has received an entire word. The receive and transmit buffers right-justify words containing less than thirty-two bits.

TX Buffer Operation

Because they have a data register and an output shift register, the TX buffers behave like two-location FIFOs (see Figure 9-1 on page 9-3).

You can store only two 32-bit words in a TX buffer at a time. When the TX buffer is loaded and the serial port has transmitted the previous word, the TX buffer automatically loads its contents into the transmit shift register. This transfer generates an interrupt, signaling that the TX buffer is *not full* and ready to accept the next word. When serial port DMA is enabled or the corresponding mask bit in the IMASK register is set, this interrupt does not occur.

When a transmit frame synch occurs and the TX buffer contains no new data, the processor sets the transmit underflow status bit (TUVF) in the transmit control register. The TUVF status bit is *sticky* (the application must explicitly clear the bit), and you must disable the serial port to clear it.

RX Buffer Operation

Because they have two data register and an input shift register, the RX buffers behave like three-location FIFOs (see Figure 9-1 on page 9-3).

You can store two 32-bit words in an RX buffer while the receive shift register is shifting in a third word. The third word overwrites the second if the processor's core or the DMA controller has not read the first word. When this occurs, the processor sets the receive overflow status bit (ROVF) in the receive control register. The RX buffer can receive almost three entire words without an internal read before overflow occurs. The processor generates the overflow status on the last bit of third word. The ROVF status bit is *sticky*, and you must disable the serial port to clear it.

When the RX buffer has received a word (the buffer is *not empty)*, it generates an interrupt. When serial port DMA is enabled or the corresponding bit in the IMASK register is set, the processor masks this interrupt.

Reading and Writing RX, TX

If the processor's core attempts to read from an empty RX buffer or to write to a full TX buffer, the processor delays the access until the external I/O device accesses the buffer. This delay is called a core processor hang. To avoid hanging the processor's core, read the buffer's full or empty status (in STCTLx or SRCTLx) before accessing a TX or RX buffer. To prevent this type of hang condition globally, set the BHD (Buffer Hang Disable) bit in the SYSCON register (see Table 9-3 on page 9-7).

The processor updates the status bits in STCTLx and SRCTLx during core reads and writes, even when the serial port is disabled. For details, see page 9-7.

Make sure your application disables a serial port when it writes to the serial port's RX buffer or reads from the serial port's TX buffer; for example, if it tests the results of companding.

Transmit and Receive Control Registers (STCTL, SRCTL)

The main control registers for each serial port are the transmit control register, STCTLx, and the receive control register, SRCTLx. See Table 9-6 and Table 9-7 on page 9-21 for the bit definitions of these registers. For default bit values, see Figure 9-2 on page 9-18, Figure 9-3 on page 9-19, Figure 9-4 on page 9-20, Figure 9-5 on page 9-23, Figure 9-6 on page 9-24, and Figure 9-7 on page 9-25. Some bit definitions depend on the mode of operation for which the serial port is configured.

Bit	I ² S Mode	Standard Mode	Multichannel Mode
0	SPEN_A	SPEN_A	Reserved
1	Reserved	DTYPE	DTYPE
2	Reserved	DTYPE	DTYPE
3	Reserved	SENDN	SENDN

Table 9-6. STCTLx transmit control bits

SPORT Control Registers and Data Buffers

Bit	I ² S Mode	Standard Mode	Multichannel Mode
4	SLEN _O	SLEN ₀	SLEN _o
5	SLEN ₁	SLEN ₁	SLEN ₁
6	SLEN ₂	SLEN ₂	SLEN ₂
7	SLEN ₃	SLEN ₃	SLEN ₃
8	SLEN ₄	SLEN ₄	SLEN ₄
9	РАСК	PACK	РАСК
10	MSTR	ICLK	Reserved
11	OPMODE	OPMODE	OPMODE
12	Reserved	CKRE	CKRE
13	Reserved	TFSR	Reserved
14	Reserved	ITFS	Reserved
15	DITFS	DITFS	DITFS
16	L_FIRST	LTFS	LTFS
17	Reserved	LAFS	Reserved
18	SDEN_A	SDEN_A	SDEN_A
19	SCHEN_A	SCHEN_A	SCHEN_A
20	SDEN_B	SDEN_B	MFD
21	SCHEN_B	SCHEN_B	MFD

Table 9-6. STCTLx transmit control bits (Cont'd)

Bit	I ² S Mode	Standard Mode	Multichannel Mode
22	FS_BOTH	FS_BOTH	MFD
23	Reserved	Reserved	MFD
24	SPEN_B	SPEN_B	CHNL
25	Reserved	Reserved	CHNL
26	TUVF_B	TUVF_B	CHNL
27	TXS_B	TXS_B	CHNL
28	TXS_B	TXS_B	CHNL
29	TUVF_A	TUVF_A	TUVF_A
30	TXS_A	TXS_A	TXS_A
31	TXS_A	TXS_A	TXS_A

Table 9-6. STCTLx transmit control bits (Cont'd)



Figure 9-2. STCTLx transmit control register—Standard mode



Figure 9-3. STCTLx transmit control register—I²S mode



Figure 9-4. STCTLx transmit control register—multichannel mode

Bit	I ² S Mode	Standard Mode	Multichannel Mode
0	SPEN_A	SPEN_A	Reserved
1	Reserved	DTYPE	DTYPE
2	Reserved	DTYPE	DTYPE
3	Reserved	SENDN	SENDN
4	SLEN ₀	Slen _o	SLEN _o
5	SLEN ₁	SLEN ₁	SLEN ₁
6	SLEN ₂	SLEN ₂	SLEN ₂
7	SLEN ₃	SLEN ₃	SLEN ₃
8	SLEN ₄	SLEN ₄	SLEN ₄
9	РАСК	PACK	РАСК
10	MSTR	ICLK	ICLK
11	OPMODE	OPMODE	OPMODE
12	Reserved	CKRE	CKRE
13	Reserved	RFSR	Reserved
14	Reserved	IRFS	IRFS
15	Reserved	Reserved	IMODE
16	L_FIRST	LRFS	LRFS

Table 9-7. SRCTLx transmit control bits

SPORT Control Registers and Data Buffers

Bit	I ² S Mode	Standard Mode	Multichannel Mode
17	Reserved	LAFS	Reserved
18	SDEN_A	SDEN_A	SDEN_A
19	SCHEN_A	SCHEN_A	SCHEN_A
20	SDEN_B	SDEN_B	IMAT
21	SCHEN_B	SCHEN_B	Reserved
22	SPL	SPL	Reserved
23	Reserved	MCE	MCE
24	SPEN_B	SPEN_B	NCH
25	Reserved	Reserved	NCH
26	ROVF_B	ROVF_B	NCH
27	RXS_B	RXS_B	NCH
28	RXS_B	RXS_B	NCH
29	ROVF_A	ROVF_A	ROVF_A
30	RXS_A	RXS_A	RXS_A
31	RXS_A	RXS_A	RXS_A

Table 9-7. SRCTLx transmit control bits (Cont'd)



Figure 9-5. SRCTLx receive control registers-Standard mode



Figure 9-6. SRCTLx receive control registers—I²S mode



Figure 9-7. SRCTLx receive control registers—multichannel mode

Bit definitions of the STCTLx and SRCTLx control register parameters are:

CHNL

Current channel selected.

Multichannel mode only. STCTLx register.

Read-only, sticky status bits.

Identifies the currently selected transmit channel slot (0 to 31).

CKRE

Frame sync clock edge.

Standard and multichannel modes only. STCTLx and SRCTLx registers.

Selects the active edge of the serial port clock on which to sample or drive data and frame syncs.

In standard mode only, you can set this parameter separately for transmit and receive channels.

0 = Falling edge

1 = Rising edge

(Frame sync is level-sensitive, not edge-sensitive.)

DITFS

Data independent TFS.

All operation modes. STCTLx register.

Selects when the processor generates the transmit frame sync signal.

0 = Data dependent TFS.

TFS signal generated only when new data is in SPORT channel's transmit data buffer and TDIV period occurs as programmed in the TDIV register.

1 = Data independent TFS.

TFS signal generated regardless of the validity of the data present in SPORT channel's transmit data buffer. The processor generates the TFS signal at the frequency specified by the value you load in the TDIV register.

DTYPE

Data type.

Standard and multichannel modes only. STCTLx and SRCTLx registers.

Selects the companding and MSB format of serial words loaded into the TX and RX buffers. (The transmit shift register does not 0-fill or sign-extend TX data words.)

Selection differs between modes.

For standard mode, selection of companding mode and MSB format are exclusive:

00 =Right justify; fill unused MSBs with 0s.

01 =Right justify; sign-extend into unused MSBs.

10 =Compand using μ _law. (Primary channels only)

11 =Compand using A_law. (Primary channels only)

For multichannel mode, selection of companding mode and MSB format are independent:

x0 =Right justify; fill unused MSBs with 0s.

x1 =Right justify; sign-extend into unused MSBs.

 $0x = Compand using \mu_law.$

1x =Compand using A_law.

FS_BOTH

Frame sync both.

I²S and standard modes only. STCTLx register.

Selects when during transmission to issue the word select.

0 = Issue word select if data in either transmit channel.

1 = Issue word select only if data in both transmit channels.

ICLK Transmit and receive clock sources.

Standard and multichannel modes only. STCTLx and SRCTLx registers.

Selects the clock source to use to transmit and to receive data. In standard mode only, you can set this parameter separately for transmit and receive channels.

0 = Use an external clock.

1 = Use processor's internal clock.

IMAT Receive comparison accept data.

Multichannel mode only. SRCTLx register.

Selects the method to use for evaluating whether to accept received data.

0 = Accept the received data if the KEYWD compares false.

1 = Accept the received data if the KEYWD compares true.

IMODE

Receive comparison enable.

Multichannel mode only. SRCTLx register.

Enables and disables the receive comparison option.

0 = Disable receive comparison.

1 = Enable receive comparison.

IRFS RFS source.

Standard and multichannel modes only. SRCTLx register.

Selects the source to generate frame sync signals for received data.

0 = Use external source.

1 = Use processor's internal serial clock.

ITFS TFS source.

Standard mode only. STCTLx register.

Selects the source to generate frame sync signals for transmit data.

0 = Use external source.

1 = Use processor's internal serial clock.

LAFS Late TFS/RFS.

Standard mode only. STCTLx and SRCTLx registers.

Selects when to generate the receive frame sync signal.

- 0 = Generate early, during the serial clock cycle immediately preceding the first data bit.
- 1 = Generate late, during the first bit of each data word.

L_FIRST

Left/right channel transmit/receive first.

I²S mode only. STCTLx and SRCTLx registers.

Selects which I²S channel to transmit or receive first.

0 = Right channel first.

1 = Left channel first.

LRFS Active state RFS.

Standard and multichannel modes only. SRCTLx register.

Selects the logic level of the received frame sync signals. Active high (0) is the default.

0 = Active high.

1 = Active low (inverted).

LTFS Active state TFS.

Standard and multichannel modes only. STCTLx register.

Selects the logic level of the transmit frame sync signals. Active high (0) is the default.

0 = Active high.

1 = Active low (inverted).

MCE Multichannel mode enable.

Standard and multichannel modes only. SRCTLx register.

One of two configuration bits that enable and disable multichannel mode on receive serial port channels. See also, OPMODE.

0 = Disable multichannel operation.

1 = Enable multichannel operation if OPMODE=0.

MFD Multichannel frame delay.

Multichannel mode only. STCTLx register.

Sets the interval, in number of serial clock cycles, between the transmit frame sync pulse and the first data bit. Provides support for different types of T1 interface devices.

Valid values range from 0 to 15.

0 = No delay; frame sync pulse concurrent with first data bit.

1:15 =

Corresponding number of intervening serial clock cycles.

MSTR

SPORT transmit and receive master mode.

I²S mode only. STCTLx and SRCTLx registers.

Selects the clock and word-select source for transmitting or for receiving.

- 0 = Use external clock and word-select source; transmitter or receiver is slave.
- 1 = Use internal clock and word-select source; transmitter or receiver is master.
- NCH Number of channel slots.

Multichannel mode only. SRCTLx register.

Selects the number of channel slots (maximum of 32) to use for multichannel operation.

Use this formula to calculate the value for NCH:

NCH = Actual number of channel slots -1.

Valid values for actual number of channel slots range from 1 to 32.

OPMODE

SPORT operation mode.

All operation modes. STCTLx and SRCTLx registers.

Enables and disables I²S operation mode. When this bit is set, the processor ignores the MCE bit.

 $0 = \text{Disable I}^2 \text{S mode.}$

Depending on the MCE bit, sets the channel in either standard mode or multichannel mode.

 $1 = \text{Enable I}^2 \text{S mode.}$

PACKPacking 16/32 bit.

All operation modes. STCTLx and SRCTLx registers.

Selects whether the serial port packs external words of 16 bits or less into internal 32-bit words and vice versa.

0 = Disable packing.

1 = Enable packing.

RFSR RFS requirement.

Standard mode only. SRCTLx register.

Selects whether receive serial port communications require frame sync signals.

0 = Not required.

(Only a single frame sync signal required to initiate communications; ignored after first bit received.)

1 = Every data word requires a frame sync signal.

ROVFReceive overflow status.

All operation modes. SRCTLx register.

Read-only, sticky status bit.

Indicates when the channel has received new data while the RXS buffer is full. New data overwites existing data.

0 = No new data.

1 =New data.

RXS Receive data buffer status.

All operation modes. SRCTLx register.

SPORT Control Registers and Data Buffers

Read-only, sticky status bit.

Indicates the status of the channel's receive buffer contents.

00 =Buffer empty.

01 =Reserved.

10 =Buffer partially full.

11 =Buffer full.

SCHEN

SPORT DMA chaining.

All operation modes for primary (A) SPORT channels. I²S and standard modes only for secondary (B) SPORT channels. STCTLx and SRCTLx registers.

Enables and disables SPORT DMA chaining.

0 = Disable DMA chaining.

1 = Enable DMA chaining.

SDEN SPORT DMA enable.

All operation modes for primary (A) SPORT channels. I²S and standard modes only for secondary (B) SPORT channels. STCTLx and SRCTLx registers.

Enables and disables SPORT DMA.

0 = Disable DMA.

1 = Enable DMA.

SENDN

Endian data word format.

Standard and multichannel modes only. STCTLx and SRCTLx registers.

Selects whether the serial word is transmitted or received MSB or LSB first.

0 = MSB first.

1 = LSB first.

SLEN Serial word length.

All operation modes. STCTLx and SRCTLx registers.

Selects the number of bits the serial word contains. The SPORTs handle serial words containing from 3 to 32 bits.

Use this formula to calculate the value for SLEN:

```
SLEN = Actual serial word length -1
```

 M_{L} SLEN \neq 0 or 1

SPEN SPORT enable.

I²S and standard modes only. STCTLx and SRCTLx registers.

Enables and disables the SPORT. Performs a software reset.

0 = Disable SPORT.

Aborts any ongoing operation and clears the status bits.

1 = Enable SPORT.

SPORTS ready to transmit or receive two cycles after enabling.

SPL SPORT loopback mode.

I²S and standard modes only. SRCTLx register.

Sets the channel in or out of loopback mode. Loopback mode enables developers to run internal tests and to debug applications.

0 = Disable loopback mode.

1 = Enable loopback mode.

TFSR Transmit frame sync requirement.

Standard mode only. STCTLx register.

Selects whether transmit serial port communications require frame sync signals.

0 = Not required.

(Only a single frame sync signal required to initiate communications; ignored after first bit transmitted.)

1 = Every data word requires a frame sync signal.

TUVF Transmit underflow status.

All operation modes. STCTLx register.

Read-only, sticky status bit.

Indicates whether the TFS signal (from internal or external source) occurred while the TXS buffer was empty. The SPORTs transmit data whenever they detect a TFS signal.

0 = No TFS signal occurred.

1 = TFS signal occurred.

TXS Transmit data buffer status.

All operation modes. STCTLx register.

Read-only, sticky status bit.

Indicates the status of the channel's transmit buffer contents.

00 =Buffer empty.

01 =Reserved.

10 =Buffer partially full.

11 =Buffer full.



Hereafter in this chapter, unless referring to a specific case, registers and control parameters are referred to by the descriptive part of their symbolic names only or with x or _z included to indicate serial port and/or channel specification, respectively. (For example, SRCTLx, SPEN, or SCHEN_Z.)

However to use the symbolic names in your application, you must write the correct symbolic name in its entirety. For example, SPEN_A or SPEN_B, not SPEN or SPEN_Z; STCTL1 or STCTL0, not STCTLx or STCT1.

Control Register Status Bits

The STCTLx and SRCTLx status bits are read-only, sticky bits that provide information about the status of a particular SPORT channel.

The STCTLx and SRCTLx status bits are:

•	CHNL	Current Channel Selected status bits
•	ROVF	Receive Overflow status bit
•	RXS	Receive Data Buffer status bits
•	TUVF	Transmit Underflow status bit
•	TXS	Transmit Data Buffer status bits

Current Channel Selected Status Bits (CHNL)

During multichannel operation, the CHNL status bits indicate which of the thirty-two channel slots $(CHNL_{31-0})$ the serial port is currently selected.

Receive Overflow Status Bit (ROVF)

The processor sets the ROVF bit whenever the serial port receives new data while the RX buffer is full. In this case, the new data overwrites the existing data.

Receive Data Buffer Status Bits (RXS)

The RXS status bits indicate whether the RX buffer is full (11), empty (00), or partially full (10).

You can test the RXS status bits to determine if the RX data buffer has free space or if it contains data. To test for space, test for $RXS_0=0$. To test for data, test for $RXS_1=1$.

Transmit Underflow Status Bit (TUVF)

The processor sets the TUVF bit whenever the TFS signal occurs (generated either internally or by an external source) while the TX buffer is empty.

You can suppress this behavior when using internally generated TFS. To do so, you clear the DITFS control bit (DITFS=0). Setting DITFS to 0 selects data-dependent frame syncs. In this mode, the processor generates the transmit frame sync signal (TFS) only when the TX buffer contains new data, so the serial port transmits new data only.

Setting DITFS to 1 selects data-independent frame syncs. In this mode, the processor generates the TFS signal whether or not the TX buffer contains new data, and the serial port transmits the contents of the TX buffer regardless. Typically, serial port DMA keeps the TX buffer full, and when the DMA operation finishes, the serial port continuously transmits the last word in the TX buffer.

Transmit Data Buffer Status Bits (TXS)

The TXS status bits indicate whether the TX data buffer is full (11), empty (00), or partially full (10).

You can test the TXS status bits to determine if the TX data buffer has free space or if it contains data. To test for space, test for $TXS_0=0$. To test for data, test for $TXS_1=1$.

Clock and Frame Sync Frequencies (TDIV, RDIV)

The TDIV and RDIV registers contain divisor values, which determine the frequencies at which internally generated clocks and frame syncs operate.

Figure 9-8 shows and Table 9-8 lists and defines the contents of theTDIV0 and TDIV1 registers.

T11 0 0	<u>т</u> •	1	•	1.	C 11
Table 9-8	Iransmit	divisor	register	bit	tields
14010 / 01	11 anomne	a 1,1001	regiocer	010	iiciao

Bits	Name	Definition
15-0	TCLKDIV	Transmit clock divisor
31-16	TFSDIV	Transmit frame sync divisor



Figure 9-8. TDIVx transmit divisor registers

Figure 9-9 shows and Table 9-9 lists and defines the contents of the RDIV0 and RDIV1 registers.

Bits	Name	Definition
15-0	RCLKDIV	Receive clock divisor
31-16	RFSDIV	Receive frame sync divisor

Table 9-9. Receive divisor register bit fields



Figure 9-9. RDIVx receive divisor registers

The TCLKDIV and RCLKDIV bit fields specify the number of times to divide the processor's system clock (CLKIN) to generate the transmit and receive clocks. The divisor is a 16-bit value, which provides a wide range of serial clock rates.

SPORT Control Registers and Data Buffers

Use this equation to calculate the serial clock frequency:

serial clock frequency = $\frac{2xfCLKIN}{(xCLKDIV + 1)}$

 f_{CLKIN} is the 1x frequency for the processor, and xCLKDIV is at least equal to 1.

Use this equation to calculate the value of xCLKDIV, given the CLKIN frequency and target serial clock frequency:

xCLKDIV= $\frac{2 \times \text{fCLKIN}}{\text{serial clock frequency}} - 1$

When frame sync is internally generated, TFSDIV and RFSDIV specify the number of transmit or receive clock cycles the processor counts before it generates a TFS or RFS pulse. You can use a frame sync this way to initiate periodic transfers. The processor counts serial clock cycles whatever the clock source, internal or external.

Use this equation to calculate the number of serial clock cycles between frame synch pulses:

```
No. cycles between frame sync assertions = xFSDIV + 1
```

Use this equation to determine the value of xFSDIV, given the serial clock frequency and target frame sync frequency:

 $xFSDIV = \frac{serial clock frequency}{frame sync frequency} - 1$

The frame sync is continuously active if xFSDIV=0. However, to avoid causing an external device to abort the current operation or causing other unpredictable results, use a value for xFSDIV such that

 $FSDIV \ge SLEN = serial word length -1$

(Use the value of the SLEN field in the transmit or receive control register.)

If not using the serial port, you can use the xFSDIV divisor as a counter for dividing an external clock or for generating a periodic pulse or periodic interrupt. For this function, the serial port must be enabled.

Restrictions on Using Maximum Clock Rate

A delay occurs between the arrival of the transmit clock signal at the TCLKx pin and the output of serial data. This delay may limit the operating speed of the receiver. For exact timing specifications, see the data sheet.

For reliable operation, we recommend that you use full-speed, serial clocks only when receiving with an externally generated clock and externally generated frame sync (ICLK=0, IRFS=0).

Externally-generated, late transmit frame syncs (LAFS) experience a similar delay between their arrival and data output, which can also limit the maximum speed of serial clocks. For exact timing specifications, see the data sheet.

Although the serial ports handle words with lengths of three to thirty-two bits, transmitting or receiving words smaller than four bits at the processor's full serial clock rate may cause loss of data when DMA chaining is enabled. Chaining takes over the processor's internal I/O bus for several cycles while the DMA controller loads new TCB parameters. During this period, receive data in the RX buffer may be overwritten.

Data Word Formats

The DTYPE, PACK, SENDN, and SLEN bits of the STCTLx and SRCTLx control registers format data words transmitted through the serial ports.

Data Type (DTYPE)

The DTYPE field of the STCTLx and SRCTLx control registers, shown in Table 9-10, specifies the justification format and the companding format of the data when the serial port is configured for standard or multichannel operation.

For standard operation, the DTYPE field specifies one of four data formats. Data justification and companding formats are separate and exclusive options.

DTYPE	Data Formatting
00	Right justify; fill unused MSBs with zeros (0)
01	Right justify; extend sign into unused MSBs
10	Compand using μ -law
11	Compand using A-law

Table 9-10. Data formats for nonmultichannel operation

The RX and TX shifter registers apply these formats to serial data words when they are loaded into the RX and TX buffers. (Since only the significant bits of the serial data word are transmitted, the TX shift register does not actually zero-fill or sign-extend TX data words.)

For multichannel operation, the DTYPE field specifies one of four data types, as shown in Table 9-11. Because the justification and companding

format options function independently, the low bit specifies the justification format, and the high bit specifies the companding format.

DTYPE	Data Formatting
×0	Right justify; fill unused MSBs with zeros (O)
x1	Right justify; extend sign into unused MSBs
0 x	Compand using μ -law
1x	Compand using A-law

Table 9-11. Data formats for multichannel operation

The multichannel compand select registers, MTCCSx and MRCCSx, enable companding on specific transmit and receive channel slots. (For details, see "Channel Selection Registers (MTCSx, MRCSx, MTCCSx, MRCCSx)" on page 9-72.) Linear transfers occur on a channel slot that is active and has companding disabled. Companded transfers occur on a channel slot that is active and has companding enabled.

In STCTLx, bit 0 of DTYPE selects transmit sign extension for all transmit channels. In SRCTLx, bit 0 of DTYPE selects receive sign extension for all receive channels. With bit 0 set, sign extension occurs on selected channels that have companding disabled. If this bit is cleared, the data word contains 0s in its MSBs.

Companding

Companding (compressing and expanding) is the process of logarithmically encoding and decoding data to minimize the number of bits that must be transmitted.

The processor's serial ports support the two most widely used companding algorithms—A-law and μ -law—according to ITU G.711 specification. In standard and multichannel modes, you can select a companding algorithm

independently for each SPORT. (In standard mode, only the primary channels support companding.)The DTYPE field in the STCTLx and SRCTLx control registers selects the companding algorithm.

With companding enabled, the data in the Rx0_A or Rx1_A buffer is the right-justified, sign-extended expanded value of the eight LSBs received. Likewise, a write to Tx0_A and Tx1_A compresses the 32-bit value into eight LSBs (sign-extended to the width of the transmit word) before transmission. If the 32-bit value is greater than the13-bit A-law or 14-bit μ -law maximum, the TX buffer automatically compresses it to the maximum value.

Because the values in the TX and RX buffers are companded in place, you can use the companding hardware without transmitting (or receiving) data, for example, during testing or debugging. This operation requires a single cycle of overhead. For companding to execute properly, program the SPORT registers prior to loading data values into the SPORT buffers.

To compand data in place:

1. Enable companding.

Set the DTYPE field of the STCTLx transmit control register appropriately.

2. Write a 32-bit data word to TX.

(Companding is calculated in this cycle.)

3. Wait one cycle.

You can either insert a NOP instruction or not. Either way, the processor's core is held off for one cycle. (This delay enables the serial port companding hardware to reload TX with the companded value.)

4. Read the 8-bit companded value from TX.
To expand data in place, use the same procedure, but replace TX with RX. When performing this procedure, make sure to set the serial word length (SLEN) in the SRCTLx control register appropriately.

With companding enabled, interfacing the processor's serial ports to a code requires little additional programming effort. With companding disabled, two formats for received data words of fewer than 32 bits are available (for details, see "Data Type (DTYPE)" on page 9-44).

Data Packing and Unpacking (PACK)

You can pack received data words of sixteen bits or less into 32-bit internal data words, and unpack 32-bit internal data words into 16-bit data words for transmission.

The PACK bit in the SRCTLx and STCTLx control registers enable word packing and unpacking.

In SRCTLx:

PACK=1 Pack two words received successively into a single 32-bit word.

In STCTLx:

PACK=1 Unpack each 32-bit word into two 16-bit words and transmit.

Packing right-justifies the first 16-bit (or smaller) data word in bits 15-0 of the packed word and right-justifies the second 16-bit (or smaller) word in bits 31-16. This procedure reverses during transmit (unpacking) operations.

You can compand and pack/unpack data concurrently.

With packing enabled, 32-bit packed words, not each 16-bit data word, generates the transmit and receive interrupts.



Using short word space addresses, you can read and write 16-bit data words that have been packed into 32-bit words and stored in normal word space in internal memory.

Endian Format (SENDN)

Endian format determines whether the processor transmits the serial word MSB-first or LSB-first.

The SENDN bit in the STCTLx and SRCTLx control registers select endian format.

SENDN_z=0 Transmit or receive serial words MSB-first.

SENDN_z=1 Transmit or receive serial words LSB-first.

Word Length (SLEN)

The serial ports handle word lengths that range from three to thirty-two bits.

The five-bit SLEN field in the STCTLx and SRCTLx control registers configures the word length. The processor uses this value to determine how many bits to shift into or out of the shift register.

The value of SLEN is equal to the word length minus one:

```
SLEN = Serial Word Length -1

M SLEN ≠ 0 or 1
```

The RX and TX buffers right-justify words smaller than thirty-two bits, so they occupy the least significant bit positions.

Transmitting or receiving words smaller than four bits at the processor's full clock rate can cause loss of data when DMA chaining is enabled. Because chaining takes over the processor's internal I/O bus for several cycles while the DMA controller loads new TCB chain parameters, received data in the RX buffer may be overwritten during this period.

Clock Signal Options

Each serial port has a transmit clock signal TCLKx and a receive clock signal RCLKx.

The ICLK and CKRE bits of the STCTLx and SRCTLx control registers configure the clock signals for standard and multichannel operation modes only.

The ICLK bits select the source of the transmit and receive clock signals. The CKRE bits select which clock edge (rising or falling) to use for synchronizing transmit and receive frames and for sampling data.

You configure the serial clock frequency in the TDIVx and RDIVx registers.

To use a single clock for both input and output, tie the receive clock pin to the transmit clock pin.

Internal vs. External Clocks

You can configure an internal or external clock source for the transmit and receive operations independently. The ICLK bit in the STCTLx and SRCTLx control registers selects the clock source.

When ICLK=1, the processor generates the clock signal, and the TCLKx or RCLKx pins are output pins.

The value of the serial clock divisor TCLKDIV or RCLKDIV in the TDIVx or RDIVx register, sets the clock frequency.

When ICLK=0, the processor accepts the clock signal as an input on the TCLKx or RCLKx pins.



In this mode, the processor ignores the serial clock divisors in the TDIVx and RDIVx registers.

The processor does not require synchronization between an externally generated serial clock and its system clock.

Frame Sync Options

Framing signals indicate the beginning of each serial word transfer. For frame sync operation, the processor supports a variety of framing options. Framing options on transmit and receive serial port channels are independent and configured separately in the STCTRLx and SRCTLx control registers.

The processor supports these frame sync options:

- Frame sync requirement (TFSR/RFSR)
- Frame sync source (ITFS/IRFS)
- Frame sync active state (LTFS/LRFS)
- Frame sync clock edge (CKRE)
- Frame sync insert (LAFS)
- Frame sync data dependency (DITFS)

Frame Sync Requirement (TFSR/RFSR)

Using frame sync signals is optional in serial port communications. In standard mode only, the TFSR (transmit frame sync required) and RFSR (receive frame sync required) control bits determine whether frame sync signals are required.

When TFSR=1 or RFSR=1, every data word requires a frame sync signal. To enable continuous transmissions from the ADSP-21065L, the processor must load each new data word into the TX buffer before shifting out and transmitting the last bit of the previous word. (See "Frame Sync Data Dependency (DITFS)" on page 9-57.)

When TFSR=0 or RFSR=0, data words do not require the corresponding frame sync signal, but initiating communications requires a single frame sync. After the processor transfers the first bit, it ignores the frame sync signal and continuously transmits data words unframed.

When DMA is enabled with frame syncs not required, chaining may hold off DMA requests or the DMA controller may not service requests frequently enough to guarantee continuous, unframed data flow.

Figure 9-10 on page 9-54 shows framed serial transfers, which have the following characteristics:

- TFSR and RFSR bits in STCTLx, SRCTLx control registers determine framed or unframed mode.
- Framed mode requires a framing signal for every word. Unframed mode ignores the framing signal after the first word.
- Unframed mode is appropriate for continuous reception.
- Active-low or active-high frame syncs selected with LTFS and LRFS bits of STCTLx, SRCTLx control registers.



Figure 9-10. Framed vs. unframed data

Frame Sync Source (ITFS/RTFS)

In standard mode and multichannel mode (receive only), you can configure an internal or external frame sync source for transmit and receive operations independently.

When ITFS=1 or IRFS=1, the processor generates the corresponding frame sync signal internally, and the TFSx pin or RFSx pin becomes an output pin. The value of the frame sync divisor TFSDIV or RFSDIV in the TDIVx or RDIVx registers determines the frequency of the frame sync signal.

When ITFS=0 or IRFS=0, the processor accepts the corresponding frame sync signal as an input on the TFSx pin or RFSx pin and ignores the frame sync divisors in the TDIVx or RDIVx register.

All of the various frame sync options are available whether the signal is generated internally or externally.

Frame Sync Active State (LTFS/RTFS)

In standard mode and multichannel mode, you can configure the logic level of frame sync signals for active high operation or for active low (inverted) operation.

When LTFS=0 or LRFS=0, the corresponding frame sync signal is active high. This value is the default configuration, and a processor reset initializes the LTFS and LRFS bits to 0.

When LTFS=1 or LRFS=1, the corresponding frame sync signal is active low.

Frame Sync Clock Edge (CKRE)

In standard mode and multichannel mode, you can configure on which edge of serial port clock signals the processor samples data and frame syncs—either on the rising edge or on the falling edge.

For transmit data and frame syncs, setting CKRE=1 selects the rising edge of TCLKx. CKRE=0 selects the falling edge of TCLKx. Data and frame sync signals change state on whatever clock edge is not selected.

For receive data and frame syncs, setting CKRE=1 causes the processor to clock data in on the rising edge of RCLKx. CKRE=0 causes the processor to clock data in on the falling edge of RCLKx.

If you connect the transmit and receive functions of two serial ports together, make sure you configure the connections with the same value for CKRE, so the processor drives internally generated signals on one edge and samples received signals on the opposite edge.

Frame Sync Insert (LAFS)

In standard mode, you can configure when the processor generates frame sync signals (for multichannel mode, MFD=1, see page 9-67). Frame sync signals can occur during the first bit of each data word (*late*) or during the serial clock cycle immediately preceding the first bit (*early*).

Setting LAFS=0 selects early frame sync mode (normal operation). In this mode, the first bit of the transmit data word is available (and the first bit of the receive data word is latched) in the serial clock cycle after the frame sync is asserted, and the frame sync is not checked again until the entire word has been transmitted (or received). (In multichannel operation, this occurs when frame delay is 1.)

In *early* frame sync mode, if data transmission is continuous (the first bit of the next word immediately follows the last bit of each word), the frame sync signal occurs during the last bit of each word. In *early* frame sync mode, the processor asserts internally generated frame syncs for one clock cycle.

Setting LAFS=1 selects *late* frame sync mode. In this mode, the first bit of the transmit data word is available (and the first bit of the receive data word is latched) in the same serial clock cycle that the frame sync is asserted. (In multichannel operation, this occurs when frame delay is 0.)

Serial clock edges latch receive data bits, but the frame sync signal is checked during the first bit of each word only. In *late* frame sync mode, the processor continues to assert internally generated frame syncs for the entire length of the data word. Externally generated frame syncs are checked during the first bit only. Figure 9-11 illustrates the two modes of frame signal timing:

- LAFS bits of STCTLx, SRCTLx control registers. LAFS=0 for early frame syncs, LAFS=1 for late frame syncs.
- Early framing: frame sync precedes data by one cycle. Late framing: frame sync checked on first bit only.
- Data transmitted MSB-first (SENDN=0) or LSB-first (SENDN=1).
- Frame sync and clock generated internally or externally.



Figure 9-11. Normal vs. alternate frame

Frame Sync Data Dependency (DITFS)

In all operation modes, you can configure the conditions that govern when the processor outputs internally-generated transmit frame sync (TFS) signal. Normally, the processor outputs a TFS only when the TX buffer has data ready to transmit (data-dependent transmit frame sync). DITFS (dataindependent transmit frame sync) mode enables the processor to continuously generate the TFS signal, with or without new data.

When DITFS=0, the processor outputs TFS only when the TX buffer contains a new data word. Once loaded into the TX buffer, a new data word is transmitted two cycles after the processor generates the next TFS. Datadependent mode provides the method to transmit data at specific times only.

When DITFS=1, the processor outputs TFS at its programmed interval, regardless of whether new data is available in the TX buffer. In data-independent mode, with each assertion of TFS, the processor transmits whatever data is present in the TX buffer. When old data is retransmitted, the processor sets the transmit underflow status bit (TUVF) in the STCTLx control register. The processor also sets the TUVF status bit if the TX buffer does not have new data when an externally generated TFS occurs. In data-independent mode, the first internally generated TFS is delayed until data has been loaded into the TX buffer.

With DITFS=1, initiating a transfer requires a single write to the TX data register.

Standard Mode

In standard mode, you can enable either one or both of the SPORTs' transmit channels. The frame sync source determines their transmit configuration.

When using both transmitters simultaneously, both TX buffers must contain data. For continuous transmission, both TX buffers must contain new data.

The receiving SPORT receives on both Rx_A and Rx_B. But only a SPORT with DMA enabled generates DMA requests or DMA interrupts upon receiving data.

Each SPORT transmit and receive channel has its own channel enable, DMA enable, and chaining enable bits in its STCTLx and SRCTLx control register.

The SPORTs support companding on the primary channels, Tx_A and Rx_A, only.

Enabling Standard Mode (OPMODE, MCE)

You enable standard mode with the OPMODE and MCE bits (STCTLx and SRCTLx). To do so, set both bits to 0.

Frame Sync Configuration (FS_BOTH)

In standard mode, FS_BOTH (STCTLx) specifies when the processor generates the transmit frame sync signal.

- FS_BOTH=0 Generate frame sync when data is available in either transmit channel.
- FS_BOTH=1 Generate frame sync only when data is available in both transmit channels.

When both transmitters are transmitting simultaneously (FS_BOTH=1), the processor generates frame syncs only when both transmitters contain data. For continuous transmission when using both transmitters simultaneously, both transmitters must contain new data.

To implement this mode, you must also configure the processor for data-dependent TFS and as TFS source:

```
DITFS=0
ITFS=1
```

Setting the Serial Clock Frequency (CLKDIV)

You can set the serial clock frequency for the processors internal clocks. For details see, "Clock and Frame Sync Frequencies (TDIV, RDIV)" on page 9-39.

I²S Mode

I²S mode supports the Inter-IC sound bus protocol developed for exchanging audio data between digital audio processors over a serial link.

The I²S bus transmits audio data and control signals over separate lines. The data line carries two multiplexed data channels, the left channel and the right channel.

In I²S mode:

- Both SPORT transmit channels (Tx_A and Tx_B) always transmit simultaneously, each transmitting left and right I²S channels.
- Both SPORT receive channels (Rx_A and Rx_B) always receive simultaneously, each receiving left and right I²S channels.
- Data always transmits in MSB format.
- You can select either DMA-driven or interrupt-drive data transfers.
- TFS and RFS are the transmit and receive word select signals.
- Multichannel operation and companding are not supported.

Each SPORT transmit and receive channel has its own channel enable, DMA enable, and chaining enable bits in its STCTLx and SRCTLx control register.

Setting the Internal Serial Clock Rate

You can program the serial clock rate (xCLKDIV value) for internal clocks in the CLKDIV registers. For details, see "Clock and Frame Sync Frequencies (TDIV, RDIV)" on page 9-39.

In I²S mode, you must load both the TDIV register and the RDIV register with the same value as SLEN. For example, for 8-bit data words (SLEN=7), you must set TFSDIV = 7 and RFSDIV = 7.

I²S Control Bits

Several bits in the STCTLx and SRCTLx control registers enable and configure I²S operation:

- Operation mode (OPMODE)
- Multichannel enable (MCE)
- Word length (SLEN)
- I²S channel transfer order (L_FIRST)
- Frame sync (word select) generation (FS_BOTH)
- Master mode enable (MSTR)
- DMA enable (SDEN)
- DMA chaining enable (SCHEN)

Enabling I²S mode (OPMODE, MCE)

You enable I^2S mode with the OPMODE and MCE bits (STCTLx and SRCTLx). With SPENx=1, set

OPMODE=1	Enable I ² S	mode
----------	-------------------------	------

MCE=0 Disable multichannel mode

Setting the Word Length (SLEN)

The SPORTs handle data words containing from 3 to 32 bits. You can set the number of bits transmit and receive data words contain. For details, see "Word Length (SLEN)" on page 9-48.

The transmitter always sends the MSB of the next word one clock cycle after the word select (TFS) signal changes.

In I²S mode, you must load the FSDIV register with the same value as SLEN. For example, for 8-bit data words (SLEN=7), you must set FSDIV= 7. For details, see "Clock and Frame Sync Frequencies (TDIV, RDIV)" on page 9-39.

Selecting the $\mathsf{I}^2\mathsf{S}$ Transmit and Receive Channel Order (L_FIRST)

You can configure which I²S channel each SPORT channel transmits or receives first. By default, the SPORT channels transmit and receive on the right I²S channel first. The left and right I²S channels are time-duplexed data channels.

To select the channel order, set the L_FIRST bit:

L_FIRST=0 Transmit or receive on right channel first.

L_FIRST=1 Transmit or receive on left channel first.

Selecting the Frame Sync options (FS_BOTH)

The processor uses TFS and RFS as transmit and receive word select signals. You can configure when the processor generates the transmit word select signal based on the data in the transmit channels.

- FS_BOTH=0 Generate word select signal if either transmit channel contains data.
- FS_BOTH=1 Generate word select signal only if both transmit channels contain data.

The word select signal changes one clock cycle before the MSB of the data word transmits, enabling the slave transmitter to derive synchronous timing of the serial data and enabling the receiver to store the previous data word and clear its input for the next one.

When using both transmitters (FS_BOTH=1) and MSTR=1 and DITFS=0, the processor generates a frame sync signal only when both transmit buffers contain data because both transmitters share the same CLKDIV and TFS. So, for continuous transmission, both transmit buffers must contain new data. To enable continuous transmission when only one transmit buffer contains new data, set FS_BOTH=0.

When using both transmitters and MSTR=1 and DITFS=1, the processor generates a frame sync signal at the frequency set by FSDIV=x whether or not the transmit buffers contain new data. In this case, the processor ignores the FS_BOTH bit. The DMA controller or the application is responsible for filling the transmit buffers with data.

Enabling SPORT Master Mode (MSTR)

You can configure the SPORTs transmit and receive channels for master or slave mode. In master mode, the processor generates the word select and serial clock signals for the transmitter or receiver internally. In slave mode, an external source generates the word select and serial clock signals for the transmitter or receiver.

- MSTR=0 Use external word select and clock source; transmitter or receiver is slave.
- MSTR=1 Use processor's internal clock for word select and clock source; transmitter or receiver is master.

Enabling SPORT DMA (SDEN)

You can enable or disable DMA independently on any of the SPORT's transmit and receive channels.

- SDEN_z=0 Disables DMA and set channel in interrupt-driven data transfer mode.
- SDEN_z=1 Enable DMA and set channel in DMA-driven data transfer mode.

Interrupt-Driven Data Transfer Mode. In this mode, both transmitters share a common interrupt vector and both receivers share a common interrupt vector.

The SPORT generates an interrupt whenever the transmit buffer has a vacancy or whenever the receive buffer has data. To determine the source of an interrupt, applications must check the TXSx or RXSx data buffer status bits, respectively.

DMA-Driven Data Transfer Mode. Each transmitter and receiver has its own set of DMA registers. (For details, see Chapter 6, DMA.) The same DMA channel drives both the left and right I²S channels for the transmitter or for the receiver. The software application must demultiplex the left and right channel data received by the RX buffer.

Both transmitters share a common interrupt vector and both receivers share a common interrupt vector. The DMA controller generates an interrupt at the end of DMA transfer only. Figure 9-12 shows the relationship between FS (word select), serial clock, and I^2S data. Timing for word select is the same as for frame sync. (Note that this example uses early frame sync.)



Figure 9-12. Word select timing in I²S mode

Multichannel Mode

The processor's serial ports support multichannel operation, which enables a SPORT to communicate in a time-division-multiplexed (TDM) serial system.

In multichannel communications, each data word in the serial bit stream occupies one channel slot. Data word 0 occupies channel slot 0, data word 1 occupies channel slot 1, ..., and data word n occupies channel slot n. In this way, each data word in the stream belongs to the next consecutive channel slot so that, for example, a 24-word block of data contains one word for each of 24 channel slots.

A SPORT can automatically select words for particular channel slots while ignoring others. The processor supports up to thirty-two channel slots for transmitting or receiving—each SPORT can receive and transmit data selectively from any of the thirty-two channel slots.

On each channel slot, a SPORT can:

- Transmit data
- Receive data
- Transmit and receive data
- Do nothing

Multichannel mode also supports data companding and DMA transfers.

In this mode only, if the SPORT is enabled, the processor puts the DT pin in a high-impedance state when an inactive channel slot occurs.



In multichannel mode, the TCLKx pin is always an input and must connect to its corresponding RCLKx pin.

Figure 9-13 shows example timing for a multichannel transfer, which has the following characteristics:

- Uses TDM method, where serial data is sent or received on different channel slots sharing the same serial bus.
- The number of channel slots is selected with the NCH bits of SRCTLx: NCH=(# of channels) 1.
- Can independently select transmit and receive channels.
- RFS signals start of frame.
- TFS is used as "Transmit Data Valid" for external logic; active only during transmit channels.
- Example: Receive on channels 0 and 2 and transmit on channels 1 and 2.





Frame Syncs in Multichannel Mode

All receiving and transmitting devices in a multichannel system must have the same timing reference. The RFS signal provides this reference, indicating the start of a block (or frame) of multichannel data words.

With multichannel mode enabled, the SPORT's transmitter and receiver both use RFS as a frame sync, whether RFS is internally or externally generated. The RFS signal synchronizes the channel slots and restarts each multichannel sequence. RFS assertion occurs at the beginning of the channel 0 data word.

TFS functions as a transmit data valid signal, which is active during transmission of an enabled word. Since the processor puts the serial port's DTx pin in a high-impedance state when the time slot is inactive, the TFS signal specifies whether or not the processor is driving the DTx pin. The processor drives TFS in multichannel mode, whether or not ITFS=0 (external TFS source).

Transmission begins after the TX transmit buffer is loaded and the processor generates the TFS signal. With serial port DMA enabled, transmission can occur several cycles after the multichannel transmission is enabled. If your application requires a deterministic start time, have it preload the TX buffer.

In multichannel mode, TFS remains unconnected normally, and the serial ports' RFS pins connect together.

Multichannel Control Bits

Several bits in the STCTLx and SRCTLx control registers enable and configure multichannel operation:

- Operation mode (OPMODE)
- Multichannel enable (MCE)

Multichannel Mode

- Number of channel slots (NCH)
- Current channel slot indicator (CHNL)
- Multichannel frame delay (MFD)
- Channel slot transmit/receive select (MTCS/MRCS)
- Channel slot transmit/receive compand select (MTCCS/MRCCS)

Operation Mode (OPMODE)

The operation mode bit enables and disables I²S mode and redefines the SPORT control bits accordingly. The multichannel enable (MCE) bit affects SPORT operation only when I²S mode is disabled.

Multichannel Enable (MCE)

Setting the MCE bit enables multichannel mode only when OPMODE=0.

- MCE=1 Enable multichannel operation.
- MCE=0 Disable all multichannel operations.

Multichannel operation activates three cycles after MCE is set. Internally generated frame sync signals activate four cycles after MCE is set.

Setting the MCE bit enables multichannel operation for the SPORTs primary set of transmit and receive channels. Therefore, if the receiving SPORT is in multichannel mode, the transmitting SPORT is too.

Number of Channel Slots

The five-bit NCH field (SRCTLx) sets the number of channel slots to use in multichannel operation. Set NCH to the actual number of channels minus one:

```
NCH = Number of Channels -1
```

The SPORTs support up to thirty-two channel slots.

Current Channel Selected

The five-bit CHNL field (STCTLx) indicates which channel slot is currently selected during multichannel operation. This field is a read-only status indicator. CHNL(4:0) increments modulo NCH(4:0) as the SPORT services each channel slot.

Multichannel Frame Delay

The four-bit MFD field (STCTLx) specifies a delay, in number of serial clock cycles, between the frame sync pulse and the first data bit in multichannel mode. Multichannel frame delay enables the processor to work with different types of T1 interface devices.

- MFD=0 No delay; frame sync concurrent with the first data bit.
- MFD=x Frame sync delayed × clock cycles.

The maximum is 15 clock cycles. Because blocks of data occur back to back, new frame sync may occur before data from the last frame has been received.

When the processor is RFS source in a multiprocessor system and the system's serial clock is equal to CLKIN (processor clock), use an MFD \geq 1. Otherwise, the system's master processor will not recognize the first frame sync after multichannel operation has been enabled. (It will, however, recognize all succeeding frame syncs.)

Channel Selection Registers (MTCSx, MRCSx, MTCCSx, MRCCSx)

You can enable and disable specific channel slots individually to select which words are received and transmitted during multichannel communications.

The processor transmits and receives only data words from enabled channel slots and ignores data words on disabled channel slots. The SPORTs support a maximum of thirty-two channel slots for transmitting and for receiving.

The multichannel selection registers enable and disable (activate and deactivate) individual transmit and receive channel slots and enable and disable companding on them. Table 9-12 lists the registers for each serial port.

Register	Selects…
MTCSx	Multichannel transmit select. Specifies the active transmit channels.
MRCSx	Multichannel receive select. Specifies the active receive channels.
MTCCSx	Multichannel transmit compand select. Specifies which active channels are companded.
MRCCSx	Multichannel receive compand select. Specifies which active receive channels are com- panded.

Table 9-12. Multichannel selection register definitions

Each register has thirty-two bits that correspond to the thirty-two channel slots. Setting a bit activates the corresponding channel slot, so the SPORT

selects the data word it contains from the multiple-word data block. For example, setting bit 0 selects data word 0, setting bit 12 selects data word 12, and so on.

Setting a particular bit to 1 in the MTCSx register causes the SPORT to transmit the data word in that channel slot's position in the data stream. Clearing the bit to 0 puts the SPORT's DT (data transmit) pin into Hi-Z during the time of that channel slot.

Setting a particular bit to 1 in the MRCSx register causes the SPORT to receive the data word in that channel slot's position in the data stream. The processor loads the received word into the RX buffer. Clearing the bit to 0 causes the SPORT to ignore the data.

You can also select companding on a per channel basis. The MTCCSx and MRCCSx registers specify companding for any active channel slots. Setting a bit to 1 in these registers causes the SPORT to compand the data word using either the A-law or μ -law companding algorithm. All channels configured for companding must use the same companding algorithm. (To select the companding algorithm, see "Data Type (DTYPE)" on page 9-44).

SPORT Receive Comparison Registers (KEYWDx and IMASKx)

In SPORT multichannel mode (MCE=1), the 32-bit receive comparison (KEYWDx) and receive comparison mask (IMASKx) registers aid multi-processor communications.

The KEYWDx register stores the pattern against which to match the incoming data. The corresponding IMASKx register specifies which bits in the received data to compare. Setting a bit in IMASKx to 1 masks the corresponding bit in the KEYWDx register, removing it from comparison.

The receiving processor compares the received data with the data pattern in its KEYWDx register. Depending on the results, the processor accepts the received data or ignores it. On acceptance, depending on the SDENx setting in SRCTLx, the receiver either requests a DMA transfer to internal memory or generates an interrupt.

These bits (SRCTL) control the operation of the receive comparison in multichannel mode, as shown in Table 9-13.

IMODE	IMAT	Selects…	
0	х	Receive comparison disabled.	
1	0	Accept receive data if the KEYWD compares false.	
1	1	Accept receive data if the KEYWD compares true.	

Table 9-13. SRCTL control bits for receive comparison

With receive comparison enabled, companding is disabled on both transmitter and receiver.

The MTCCSx register, which selects multichannel companding when receive comparison is disabled, determines whether the DSP performs a KEYWD comparison for the enabled received channel slots.

MTCCSx=0	On channel slot x, disable receive comparison and always
	accept received data.

MTCCSx=1 On channel slot ×, enable comparison and accept or reject received data based on comparison results and IMAT value (SRCTLx).

The receive comparison feature enables the SPORT to determine whether to generate either a DMA request or an interrupt when received data matches a specified condition on a specified channel. Otherwise, every time it received data the SPORT would have to interrupt the processor, which would have to determine whether the data was meant for it. And SPORT data is often in transit to other than the processor. With the receive comparison feature, you can program a SPORT on a particular processor to interrupt only on messages meant for its processor.

For example, consider two ADSP-21065s (A and B) which use SPORT0 in multichannel mode for interprocessor communications. Processors A and B use channel slots 0 and 1, respectively, to transmit control information between them. To transmit data, processor A uses channel slots 2 through 16, and processor B uses channel slots 17 through 31.

Because channel slots 0 and 1 carry control information between the processors, receive comparison on incoming data is enabled only on these channel slots. Initially, receive may be disabled on channel slots 2 through 31. In this example, the programmed key word for processor B to compare against is START TRANSMIT TO B.

To check for this keyword, processor B:

- 1. Sets the KEYWDx register to START TRANSMIT TO B.
- 2. In IMASKx, sets bits 31:16 to 0 and sets bits 15:0 to 1

This step enables receive comparison on bits 31:16 only. Assume that the code for START TRANSMIT TO B uses bits 31:16 only and that bits 15:0 indicate the transmission source and data channel slots.

3. Sets the IMODE and IMAT (SRCTLx) bits to 1.

This step enables the SPORT to generate either an interrupt or DMA request only if the incoming data matches the KEYWDx.

4. Sets bits 0 and 1 of MTCCSx to 1 and clears the remaining bits 31:2.

This step enables comparison only on channel slots 0 and 1.

Multichannel Mode

Communication between the two processors follows this sequence:

- 1. Until it receives the START TRANSMIT TO B keyword, processor B ignores all transmissions that it receives.
- 2. To initiate transmission to B, processor A sends the START TRANS-MIT TO B keyword on channel slot 0.
- 3. When processor B's receive comparison logic recognizes the START TRANSMIT TO B keyword, the SPORT interrupts its processor.
- 4. Processor B analyzes the remaining 16-bits and determines that the transmit source is processor A and that the data is on channel slots 2:16.
- 5. Because processor A is using channel slots 2 through 16 to transmit data, processor B enables receive channel slots 2 through 16 and sends a READY TO RECEIVE DATA message to processor A on channel slot 1.
- 6. After receiving this message, processor A sends the data on channel slots 2 through 16.

If the transfer protocol uses a fixed number of bytes in each message, to confirm that the data transferred accurately, processor B can return a checksum message to processor A after receiving A's message.

Moving Data Between SPORTs and Memory

You can transfer transmit and receive data between the SPORTs and onchip memory in one of two ways: with single-word, core transfers or with DMA block transfers. Both methods are interrupt-driven and use the same internally generated interrupts.

When serial port DMA is disabled (STCTLx or SRCTLx), the SPORT generates an interrupt every time it receives a data word or starts to transmit a data word.

SPORT DMA provides a mechanism for receiving or transmitting an entire block of serial data before the SPORT generates the interrupt. The processor's on-chip DMA controller handles the DMA transfer, enabling the core to continue executing program until the entire block of data has been transmitted or received. Service routines that operate on blocks of data instead of single words significantly reduce overhead.

DMA Block Transfers

The processor's on-chip DMA controller enables automatic DMA transfers between internal memory and the two serial ports.

Eight DMA channels support serial port operations—each SPORT has two channels for receiving data and two channels for transmitting data. Table 9-14 on page 9-78 lists each serial port DMA channels and its data buffer.

Moving Data Between SPORTs and Memory

Channe1	Data Buffer	Description	Priority
1	Rx0_A	SPORTO Receive, A data	Highest
2	RxO_B	SPORTO Receive, B data	
3	Rx1_A	SPORT1 Receive, A data	
4	Rx1_B	SPORT1 Receive, B data	
5	Tx0_A	SPORTO Transmit, A data	
6	Tx0_B	SPORTO Transmit, B data	
7	Tx1_A	SPORT1 Transmit, A data	
8	Tx1_B	SPORT1 Transmit, B data	
9	EPBO	External port FIFO buffer O	
10	EPB1	External port FIFO buffer 1	Lowest

Table 9-14. DMA serial port channels

Because of their relatively low service rate and their inability to hold off incoming data, the SPORT DMA channels have higher priority than external port DMA channels. Because they have higher priority, the DMA controller performs SPORT DMA transfers first when it receives multiple DMA requests in the same cycle.

Although DMA transfers always use 32-bit words, the serial ports can handle word sizes from 3 to 32 bits. If serial words are 16 bits or smaller, the SPORTs can pack them into 32-bit words for each DMA transfer. You configure packing with the PACK bit in the STCTLx and SRCTLx control registers. With packing enabled (PACK=1), the SPORT generates the transmit and receive interrupts for the 32-bit packed words, not for each 16-bit serial word.

The following sections describe serial port DMA operations. For details on other DMA operations, see Chapter 6, DMA.

Setting Up DMA on SPORT Channels

Each SPORT DMA channel has an enable bit SDEN in its STCTLx and SRCTLx control registers.

When DMA is disabled for a particular channel, the SPORT generates an interrupt every time it receives a data word or starts transmitting a data word (see "Single-Word Transfers" on page 9-86).

Each channel also has a DMA chaining enable bit SCHEN in its STCTLx and SRCTLx control registers. For details, see "SPORT DMA Chaining" on page 9-85.

To set up a serial port DMA channel, you write a set of memory buffer parameters to the SPORT DMA parameter registers shown in Table 9-15 on page 9-80. Note that xy in the register names in the Register column indicates four registers, and each corresponds to a different DMA channel. For example, IIRxy represents IIR0A – DMA channel 0, IIR0B – DMA channel 1, IIR1A – DMA channel 2, and IIR1B – DMA channel 3. For a complete list of these registers, see the Symbol Definitions File (def21065L.h) in the ADSP-21065L SHARC DSP Technical Reference.

Moving Data Between SPORTs and Memory

Register	Description	
SPORT Rxy Channels		
IIRxy	DMA chn. index; Start address for data buffer	
IMRxy	DMA chn. modify; Address increment	
CRxy	DMA chn. count; Number of words to transmit	
CPRxy	DMA chn. chain pointer; Address next set of data buffer parameters	
GPRxy	DMA channel general purpose	
	SPORT Txy Channels	
IITxy	DMA channel index; Start address for data buffer	
IMTxy	DMA channel modify; Address increment	
СТху	DMA channel count; Number of words to transmit	
СРТху	DMA channel chain pointer; Address next set of data buffer parameter	
GPTxy	DMA channel general purpose	

Table 9-15. SPORT DMA parameter registers

You must load the II, IM, and C registers with a starting address for the buffer, an address modifier, and a word count, respectively. You can program these registers from the processor or from an external processor.

Once you set up and enable serial port DMA, the processor's DMA controller automatically transfers received data words in the RX buffer to the buffer in internal memory. Likewise, when the serial port is ready to transmit data, the DMA controller automatically transfers a word from internal memory to the TX buffer. The controller continues these transfers until the entire data buffer is received or transmitted—when the count register reaches zero.

When the count register of an active DMA channel reaches zero (0), the SPORT generates the corresponding interrupt.

SPORT DMA Parameter Registers

A DMA channel consists of a set of parameter registers that implement a data buffer in internal memory and the hardware that the serial port uses to request DMA service.

The parameter registers for each SPORT DMA channel are shown in Table 9-15 on page 9-80. These registers are part of the processor's memory-mapped IOP register set, and their addresses are shown in Table 9-16 on page 9-82.

The DMA channels operate similarly to the processor's data address generators (DAGs). Each channel has an index register (II) and a modify register (IM) for setting up a data buffer in internal memory. You must initialize the index register with the starting address of the data buffer. After it transfers each serial I/O word to or from the SPORT, to generate the address for the next DMA transfer, the DMA controller adds the modify value to the index register. The modify value in the IM register is a signed integer, which provides capability for both incrementing and decrementing the buffer pointer.

Each DMA channel has a count register C, which you must initialize with a word count that specifies the number of words to transfer. The count register decrements after each DMA transfer on the channel. When the word count reaches zero, the SPORT generates the interrupt for the channel and automatically disables the DMA channel. The DEN bit in the SxCTLx register is not cleared and should be cleared before a new DMA is started.

Moving Data Between SPORTs and Memory

Each SPORT DMA channel also has a chain pointer register CP and a general-purpose register GP. The CP register functions in chained DMA operations (see "SPORT DMA Chaining" on page 9-85), and you can use the GP register for any purpose.

Register	Address	DMA Chn.	SPORT Chn.
IIROB	0x0030	1	RxO_B
IMROB	0x0031	1	RxO_B
CROB	0x0032	1	RxO_B
CPROB	0x0033	1	RxO_B
GPROB	0x0034	1	RxO_B
Reserved 0x0035 - 0x0036			
DMASTAT	0x0037	DMA channel	status register
IIR1B	0x0038	3	Rx1_B
IMR1B	0x0039	3	Rx1_B
CR1B	0x003A	3	Rx1_B
CPR1B	0x003B	3	Rx1_B
GPR1B	0x003C	3	Rx1_B
Reserved 0x003D - 0x003F			
IIEPO	0×0040	8	EPBO
IMEPO	0×0041	8	EPBO

Table 9-16. Addresses of DMA parameter registers
Register	Address	DMA Chn.	SPORT Chn.
CEPO	0x0042	8	EPBO
CPEPO	0x0043	8	EPBO
GPEPO	0×0044	8	EPBO
EIEPO	0x0045	8	EPBO
EMEPO	0×0046	8	EPBO
ECEPO	0×0047	8	EPBO
IIEP1	0x0048	9	EPB1
IMEP1	0x0049	9	EPB1
CEP1	0×004A	9	EPB1
CPEP1	0×004B	9	EPB1
GPEP1	0×004C	9	EPB1
EIEP1	0×004D	9	EPB1
EMEP1	0×004E	9	EPB1
ECEP1	0×004F	9	EPB1
IITOB	0x0050	5	Tx0_B
IMTOB	0x0051	5	Tx0_B
СТОВ	0x0052	5	Tx0_B
СРТОВ	0x0053	5	Tx0_B
GPTOB	0×0054	5	Tx0_B

Table 9-16. Addresses of DMA parameter registers (Cont'd)

Register	Address	DMA Chn.	SPORT Chn.		
Reserved 0x0055 - 0x0057					
IIT1B	0x0058	7	Tx1_B		
IMT1B	0x0059	7	Tx1_B		
CT1B	0x005A	7	Tx1_B		
CPT1B	0x005B	7	Tx1_B		
GPT1B	0x005C	7	Tx1_B		
Reserved Ox	005D - 0x005F				
IIROA	0x0060	0	RxO_A		
IMROA	0x0061	0	RxO_A		
CROA	0x0062	0	Rx0_A		
CPROA	0x0063	0	Rx0_A		
GPROA	0×0064	0	RxO_A		
Reserved Ox	0065 - 0x0067				
IIR1A	0x0068	2	Rx1_A		
IMR1A	0x0069	2	Rx1_A		
CR1A	0x006A	2	Rx1_A		
CPR1A	0x006B	2	Rx1_A		
GPR1A	0x006C	2	Rx1_A		
Reserved 0x006D - 0x006F					

Table 9-16. Addresses of DMA parameter registers (Cont'd)

Register Address		DMA Chn.	SPORT Chn.	
IITOA	0x0070	4	Tx0_A	
IMTOA	0x0071	4	Tx0_A	
СТОА	0x0072	4	Tx0_A	
СРТОА	0x0073	4	Tx0_A	
GPTOA	0×0074	4	Tx0_A	
Reserved Ox	:0075 - 0x0077	,		
IIT1A	0x0078	6	Tx1_A	
IMT1A	0x0079	6	Tx1_A	
CT1A	0x007A	6	Tx1_A	
CPT1A	0x007B	6	Tx1_A	
GPT1A	0×007C	6	Tx1_A	

Table 9-16. Addresses of DMA parameter registers (Cont'd)

SPORT DMA Chaining

In chained DMA operations, the processor's DMA controller automatically sets up another DMA transfer when the contents of the current buffer have been transmitted (or received). The chain pointer register (CP) functions as a pointer to the next set of buffer parameters stored in memory. The DMA controller automatically downloads these buffer parameters to set up the next DMA sequence. For details, see Chapter 6, DMA.

DMA chaining occurs independently for the transmit and receive channels of each serial port. Each SPORT DMA channel has a chaining enable bit SCHEN (STCTLx and SRCTLx).

SCHEN_z=0 Disable DMA chaining

SCHEN_z=1 Enable DMA chaining

(You can also write all 0s to the address field of the chain pointer register (CP) to disable chaining.)

Single-Word Transfers

The SPORTs can also transfer individual data words, generating interrupts for each 32-bit word transfer.

When a serial port is enabled and DMA is disabled (STCTLx or SRCTLx), the SPORT generates DMA interrupts whenever:

- The RX buffer has received an entire word.
- The TX buffer is not full.

This behavior enables you to use single-word interrupts to implement interrupt-driven I/O on the serial ports.

Whenever the processor's core program reads a word from a serial port's RX buffer or writes a word to its TX buffer, make sure it checks the buffer's full/empty status first to avoid hanging the core. (This can happen to an external device too, such as a host processor, when it is reading or writing a serial port buffer.) To check buffer status, read the RXS bits or the TXS bits in the SRCTLx or STCTLx control register.

Reading from an empty RX buffer or writing to a full TX buffer causes the processor (or external device) to hang, waiting for the status to change. To prevent this hang condition, in the SYSCON register, set the BHD (Buffer Hang Disable) bit to 1.

The processor updates the status bits in STCTLx and SRCTLx during core reads and writes, even when the serial port is disabled. For details, see page 9-7.

Multiple interrupts can occur if both SPORTs transmit or receive data in the same cycle. You can mask out any interrupt in the IMASK register. If you re-enable the interrupt in IMASK later, clear the corresponding interrupt latch bit in IRPTL in case the interrupt occurred while it was masked.

With serial port data packing enabled (PACK=1), the SPORT generates the transmit and receive interrupts for the 32-bit packed words, not for each 16-bit serial word.

SPORT Loopback

In standard and I²S modes, the SPL bit (SPORT loopback mode) in the SRCTLx control register configures the serial port for internal loopback connection. SPORT loopback mode enables you to test the serial port's internal operation.

- SPL=0 Disable SPORT loopback mode.
- SPL=1 Enable SPORT loopback mode.

With loopback enabled, the DRx, RCLKx, and RFSx signals of the SPORT's receive section internally connect to the DTx, TCLKx, and TFSx signals of the transmit section. The DTx, TCLKx, and TFSx signals are active and available at their respective pins, while the processor ignores the DRx, RCLKx, and RFSx pins.

In loopback mode, you can use only the transmit clock and transmit frame sync options, and you must make sure that you set up the serial port correctly in the STCTLx and SRCTLx control registers.

Loopback mode does not support multichannel operation.

SPORT Pin Driver Considerations

The processor has very fast drivers on all output pins, including the serial ports. If connections on the data, clock, or frame sync lines are longer than six inches, we recommend that you use a series termination for strip lines on point-to-point connections. Because of the edge rates, this hard-ware may be necessary even for low-speed serial clocks.

SPORT Programming Examples

The processor provides three ways to control serial port communications and memory-to-SPORT data transfers:

- Single-word transfers under core processor control with no interrupts.
- Single-word transfers under core processor control with interrupts.
- DMA transfers with interrupts.

The three examples presented next illustrate each of these methods. Each example uses SPORT0 to transmit eight 32-bit words from a data buffer in internal memory.

Each of the three control schemes also operates in multichannel mode and with any of the serial clock and frame sync options.

Single-Word Transfers Without Interrupts

The processor's core will stall (i.e. hang) when it attempts to write data to a full TX buffer or read data from an empty RX buffer. This provides a very simple method of controlling the SPORT—placing the instruction that writes data to TX or reads data from RX in a loop. Program execution will stall at this instruction, until the SPORT is ready to transmit new data or has received new data.

Listing 9-1 on page 9-90 shows the code for this example, which sets up a loop to transmit data out of SPORT0. Although this technique provides a very simple programming solution, it prevents the processor's core from handling any other tasks while waiting for the serial port. The interrupt-driven technique described in the following section alleviates this.

Listing 9-1. SPORT transmit example code

```
/*
                                                              */
SPORT Transmit Example: Uses the feature that the processor core will
stall when attempting to write to a full TX register. This example
sets up a loop to transmit the data in the memory buffer source.
/*
                                                              */
#define N 8
#include "def21065L.h" /* Use symbolic register name */
.segment/dm dm32_b1; /* Data segment name described in ldf file */
.var source[N]= 0x11111111, 0x22222222, 0x333333333, 0x4444444
             0x55555555, 0x66666666, 0x7777777, 0x888888888;
.endseq:
.segment/pm rst_svc; /* Reset vector from ldf file */
                  /* First location is used for booting */
nop;
 jumpstart;
.endseg;
/* ______Main Routine______*/
.segment/pm pm48_1b0; /* Main code segment from ldf file. */
start:r0=0x00270007; /* TDIV0 register: TCLKDIV=7,TFSDIV=39 */
      dm(TDIV0)=r0; /* sclock=CLKIN/8, framerate=sclock/20 */
      r0=0x000064f1: /* STCTL0 register */
                     /* SPEN=1, (SPORT enabled) */
      dm(STCTL0)=r0;
                     /* SLEN=15. (16-bit word) */
                     /* ICLK=1, (internal tx clock) */
                     /* TFSR=1. (require TFS) */
                     /* ITFS=1, (internal TFS) */
                     /* DITFS=0, (data-depedent FS) */
                 /* Pointer to source: i0=b0 automatically */
      b0=source:
      10=@source:
```

```
lcntr=N, do tx_loop until lce;
r0=dm(i0,1); /* Get data from source buffer. */
tx_loop: dm(TX0_A)=r0; /* Write transmit register, core */
/* will wait until SPORT output */
/* buffer is not full */
idle;
.endseg;
/*
```

Single-Word Transfers with Interrupts

While the non-interrupt-driven solution of the previous example provides a very simple control scheme, it prevents the processor's core from handling any additional tasks while it is stalled. In most real-time applications, the DSP must process data while new data is being received. It may also need to perform background tasks between data transfers.

In most systems, therefore, the DSP processor must be able to continue executing its program at all times. Using the serial port receive and transmit interrupts allows this to happen, by interrupting the core processor only when a new data word has been received or when a new data word can be transmitted. The interrupt service routine then performs the data transfer between internal memory and the serial port's TX or RX buffer.

Listing 9-2 shows the code for this example. Note that the interrupt used is the SPORT0 Transmit DMA Channel interrupt (SPT0I)—when serial port DMA is disabled, this interrupt becomes a single-word transmit interrupt.

Listing 9-2. SPORT interrupt-driven transmit example

/* *	/
2106x Interrupt Driven SPORT Transmit Example	
This example uses interrupts to notify the core when new data is	
required. The buffer "source" is transmitted.	
/**	/
#define N 8	
#include "def21065L.h"/*Use symbolic register names */	
.segment/dm dm32_b1; /* Data segment name described in ldf file *	/

```
.var source[N]= 0x11111111. 0x22222222. 0x333333333. 0x4444444
            0x55555555, 0x66666666, 0x7777777, 0x888888888
.endseq:
.segment/pm rst_svc; /* Reset vector from ldf file. */
     .endseq:
.segment/pm spt0_svc; /* SPORTO TX interrupt vector. */
     jump sOtx:
.endseq:
        ____Main routine____
/* _____
.segment/pm pm48_1b0; /*Main code segment from ldf file */
start:r0=0x00270007; /* TDIV0 register: TCLKDIV=7,TFSDIV=39 */
     dm(TDIV0)=r0; /* sclock=2CLKIN/8, framerate=sclock/20 */
     r0=0x000064f1; /* STCTL0 register */
     dm((STCTLO)=r0 /* SPEN=1, (SPORT enabled) */
                  /* SLEN=15. (16-bit word) */
                   /* ICLK=1, (internal tx clock) */
                   /* TFSR=1. (require TFS) */
                   /* ITFS=1, (internal TFS) */
                   /* DITFS=0. (data dependent FS) */
                  /* Pointer to source; i0=b0 automatically. */
     b0=source;
     10=@source:
     bit set imask SPTOI;/* Enable SPORTO TX interrupt */
     bit set model IRPTN:
     rO=dm(i0,1; /* Write first value to TXO to kick off SPORT
*/
     dm(TXO A) = r0:
     wait: idle:
     ______SPORTO Transmit Interrupt Routine_____*/
/*
sOtx: rti (db):
     r0=dm(i0,1); /* Get data from source buffer */
     dm(TX0_A)=ro; /* Write transmit register */
.endseq:
/*
                                           */
```

DMA Transfers with Interrupts

This example shows how to use the processor's on-chip DMA controller to handle serial port I/O. The DMA controller performs the data transfers between internal memory and the SPORTs, providing the most efficient way to handle input and output of multiple-word blocks of data. Once it has been set up, the DMA controller operates independently from the processor's core. It interrupts core execution only when an entire block of data has been received (or transmitted). This frees the core to continue with other tasks.

Listing 9-3 shows the code for this example, which uses the serial port's loopback mode. The program first sets up the SPORT1 DMA channels by loading values into the DMA parameter registers, then writes to the SRCTL1 and STCTL1 registers and waits to be interrupted.

Listing 9-3. SPORT DMA-driven loopback example

/*____ */

ADSP-21065L DMA-Driven SPORT Loopback Example:

This example sets up a SPORT DMA transfer and receive for serial port 1 in the loopback mode. The buffer "source" is DMAed out of the sport. The loopback DMA programming mode internally attaches DT1, TFS1, and TCLK1 to DR1, RFS1, and RCLK1. The receive DMA places the data in the buffer "destination".

SPORT Programming Examples

```
.segment/pm rst_svc; /* Reset vector from ldf. file.*/
                   /* First location is used for booting.*/
  nop:
  jump start;
.endseg;
.segment/pm spr1_svc; /* SPORT1 rx interrupt vector.*/
  jump s1rx;
.endseg:
/* _____ main routine_____
                                                    */
.segment/pm pm48 1b0:/* Main code segment from ldf. file */
start:r0=source;
 dm(IIT1A)=r0: /* Set DMA tx index to start of source buffer */
 rO=destination;
               /* Set DMA rx index to start of dest. buffer */
 dm(IIR1A)=r0;
 r0=1;
 dm(IMT1A)=r0; /* Set DMA modify (stride) to 1.*/
 dm(IIR1A)=r0:
 r0=@source:
 dm(CT1A)=r0; /* Set DMA count to length of data buffer */
 dm(CR1A)=r0;
               /* SRCTL1 Register: */
 r0=0x004421f1:
                 /* SPEN=1, (SPORT1 enabled) */
 dm(SRCTL1)=r0;
                 /* SLEN=31, (32-bit word) */
                 /* RFSR=1. (require RFS) */
                 /* SDEN=1, (rx DMA enable) */
                 /* SPL=1. (loop back DT to DR & TFS to RFS) */
 r0=0x000465f1; /* STCTL1 Register: */
 dm(STCTL1)=r0; /* SPEN=1, (SPORT1 enabled) */
              /* SLEN=31,(32-bit word) */
              /* ICLK=1, (internal tx clock) */
              /* TFSR=1. (require TFS) */
              /* ITFS=1, (internal TFS) */
              /* DITFS=0,(data dependent FS),all other bits=0 */
              /* SDEN=1. (tx dma enable). this kicks it off */
```

Serial Ports

bit set imask SPR1I; /* Enable SPORT1 rx interrupt */
bit set model IRPTEN;/* Global interrupt enable */
wait:idle; /* Wait for SPORT1 rx interrupt */
jump wait; /* Ends up here after entire DMA complete */
/*______SPORT1 Receive Interrupt Routine______*/
slrx:rti; /* This interrupt will occur only once */
.endseg;
/*______*/

SPORT Programming Examples

10 SDRAM INTERFACE

The processor's SDRAM interface enables it to transfer data to and from synchronous DRAM (SDRAM) at 2xCLKIN. The synchronous approach coupled with 2xCLKIN frequency supports data transfer at a high throughput—up to 264M bytes/sec. All inputs are sampled and all outputs are valid at the rising edge of the clock SDCLK.

The processor's SDRAM controller provides a glueless interface with standard SDRAMs and supports:

• 16M, 64M, and 128M SDRAMs and x4, x8, x16, or x32 configurations.

You can connect up to eight x4 (excluding 128M devices), four x8, two x16, or one x32 SDRAM to the processor's external port, $ADDR_{23-0}$ bus.

- Up to 16 Mwords of SDRAM in external memory.
- Zero wait state, 66 Mwords/sec. with some access types.
- Full page burst length only for page read and write operations.
- SDRAM page sizes of 1024, 512, and 256 words.
- A programmable refresh counter to coordinate between varying clock frequencies and the SDRAM's required refresh rate.
- Buffering for multiple SDRAMs connected in parallel.
- Shared SDRAM devices in a multiprocessing system.

- A separate A10 pin that enables applications to precharge SDRAM before issuing a refresh command.
- Connection to any one of the processor's external memory banks.
- Self-refresh, low-power mode.
- Two power-up options.

Figure 10-1 shows a block diagram of the processor's SDRAM interface. In this uniprocessor example, the SDRAM interface connects to four $1M \times 8 \times 2$ SDRAM devices to provide applications, in effect, use of 2M of 32-bit words. The same address and control bus feeds all four SDRAM devices.



Figure 10-1. The processor's SDRAM interface

Figure 10-2 shows another uniprocessor example in which the SDRAM interface connects to multiple banks of SDRAM to provide 512M of SDRAM in \times 4 I/O configuration, which results in 16M \times 32-bit words. In this example, OxA and OxB output from the registered buffers are the same signal, but buffered separately. In the registered buffers, a delay of one clock cycle occurs between input (Ix) and its corresponding output (OxA or OxB).



Figure 10-2. Uniprocessor system with multiple SDRAM devices

Table 10-1 lists and describes the processor's SDRAM pins and their connections.

Pin	Туре	Description	
CAS	I/0/Z	SDRAM Column Address Select pin. Connect to SDRAM's CAS buffer pin.	
DQM	0 / Z	SDRAM Data Mask pin. Connect to SDRAM's DQM buffer pin.	
		The processor drives this pin high during reset, until SDRAM is started.	
MSx	0/Z	Memory select lines of external memory bank configured for SDRAM. Connect to SDRAM's CS (chip select) pin.	
RAS	I/0/Z	SDRAM Row Address Select pin. Connect to SDRAM's RAS pin.	
SDA10	0/Z	SDRAM A10 pin. SDRAM interface uses this pin to retain control of the SDRAM device during host bus requests. Connect to SDRAM's A10 pin	
SDCKE	I/0/Z	SDRAM Clock Enable pin. Connect to SDRAM's CKE pin.	
SDCLKO	0/S/Z	SDRAM SDCLKO output pin. Connect to the SDRAM's CLK pin.	
SDCLK1	0/S/Z	SDRAM SDCLK1 output pin. Connect to the SDRAM's CLK pin.	
SDWE	I/0/Z	SDRAM Write Enable pin. Connect to SDRAM's $\overline{\text{WE}}$ or $\overline{\text{W}}$ buffer pin.	
I = Input; O = Output; S = Synchronous; Z = Hi-Z			

Table 10-1. SDRAM pin connections

The following terms are used throughout this chapter:

Bank Activate command

Activates the selected bank and latches in a new row address. It must be applied before a read or write command.

Burst length

Determines the number of words the SDRAM inputs or outputs after detecting a write or read command, respectively.

The processor supports full-page mode only.

During a full-page burst cycle, the SDRAM generates all subsequent addresses internally by incrementing the column address sequentially.

See also, page size.

Burst Stop command

One of several ways to terminate a burst read or write operation.

Terminates the current burst operation, but leaves the bank open for future reads or writes to the same page of the active bank.

Burst type

Determines the order in which the SDRAM delivers or stores burst data after detecting a read or write command, respectively.

The processor supports sequential accesses only.

\overline{CAS} latency (also t_{AA} , t_{CAC} , CL)

The delay, in clock cycles, between when the SDRAM detects the read command and when it provides the data at its output pins.

The speed grade of the device and the application's clock frequency determine the value of the \overline{CAS} latency.

The application must program the \overline{CAS} latency value into the IOCTL register after power up.

CBR Automatic refresh (\overline{CAS} before \overline{RAS}) mode.

In this mode, the SDRAM drives its own refresh cycle with no external control input. At cycle end, all SDRAM banks are precharged (idle).

DQM Data I/O Mask function.

Asserted during a precharge command or when a burst stop command interrupts a burst write.

When asserted during a write cycle, this signal interrupts and disables the write operation immediately.

IOCTL register

IOP register that contains programmable SDRAM control and configuration parameters that support different vendor's timing and power-up sequence requirements.

Mode register

The SDRAM's configuration register that contains user-defined parameters (corresponds to the processor's IOCTL register). After initial power-up and before executing a read or write command, the application must program the Mode register.

Page size

The size, in words, of the SDRAM's page. The processor supports 1024-, 512-, and 256-word page sizes.

For 128M SDRAM devices with 2K page size, the SDRAM controller stops the burst after the first 1K words.

Programmable option in the IOCTL register.

Precharge command

Precharges (closes) an active bank.

SDRDIV

Programmable Refresh Counter.

An IOP register containing a refresh counter value.

Clock supplied to the SDRAM can vary between 20 and 60MHz. This counter enables applications to coordinate CLK rate with the SDRAM's required refresh rate.

Self-Refresh

The SDRAM's internal timer initiates automatic refresh cycles periodically, without external control input. Places the SDRAM device in a low-power mode.

Programmable option in the IOCTL register.

t_{RAS} Active Command time.

Required delay between issuing an activate command and issuing a precharge command. A vendor-specific value.

Programmable option in the IOCTL register.

t_{RC} Bank Cycle time.

Required delay between successive Bank Activate commands to the same bank. A vendor-specific value. Equal to $t_{RP}+t_{RAS}$.

The processor fixes the value of this parameter, so it is a nonprogrammable option. \mathbf{t}_{RCD} RAS to CAS delay.

Required delay between a Bank Activate command and the start of the first read or write operation. A vendor-specific value. Equal to \overline{CAS} latency.

The processor fixes the value of this parameter, so it is a nonprogrammable option.

 \mathbf{t}_{RP} Precharge time.

Required delay between issuing a precharge command and issuing an activate command. A vendor-specific value.

Programmable option in the IOCTL register.

SDRAM Control Register (IOCTL)

SDRAMs are available from several vendors—IBM, Micron Electronics, Texas Instruments, and others. Each vendor has different requirements for the power-up sequence and timing parameters— t_{RAS} (Active to Precharge command delay) and t_{RP} (Precharge to Active command delay)—for their SDRAM product.

To support multiple vendors, the processor's IOCTL register, shown in Figure 10-3 on page 10-12, contains programmable SDRAM control bits. The IOCTL register is an I/O processor register, which does not support bitwise operations.

To meet your SDRAM's particular requirements, set the corresponding IOCTL control bits accordingly, as shown in Table 10-2. The IOP address of the IOCTL register is 0x2E.

Bit	Name	Description
10	DSDCTL	Disable SDCLKO, RAS, CAS, SDWE, DQM, SDCKE. Disables all SDRAM signals. O= enable 1= disable
11	DSDCK1	Disable SDCLK1. Disables SDCLK1 signal only. O= enable 1= disable

Table 10-2. IOCTL control bits

SDRAM Control Register (IOCTL)

Bit	Name	Description
12-14	SDPGS	SDRAM page size. 000=1024 words 001=512 words 010=256 words others = reserved
15	SDSRF	SDRAM self-refresh mode. O= disable 1= enable This control bit always reads zero (0).
16-17	SDCL	SDRAM CAS latency. Sets the delay, in number of clock cycles, between the time the SDRAM detects the read command and the time the data is available at its outputs. 01= 1 cycle 10= 2 cycles 11= 3 cycles
18-20	SDTRAS	SDRAM t _{RAS} spec in number of clock cycles.
21-23	SDTRP	SDRAM, t _{RP} spec in number of clock cycles.
24	SDPM	<pre>SDRAM power-up option. Specifies the sequence of commands in the SDRAM power-up cycle. 0= precharge, 8 CBR ref, mode reg set 1= precharge, mode reg set, 8 CBR ref</pre>

Table 10-2. IOCTL control bits (Cont'd)

Bit	Name	Description		
25-27	SDBS	SDRAM Bank select.		
		Specifies the processor's external memory bank to which the SDRAM connects.		
		000=no SDRAM		
		100=bank0		
		101=bank1		
		110=bank2		
		111=bank3		
28	SDBUF	SDRAM Buffer.		
		Enables/disables pipelining of address and control signals when using external buff- ering between the processor and SDRAM. Supports multiple SDRAMs connected in par- allel.		
		0= disable		
		1= enable		
29-30	SDBN	SDRAM number of banks.		
		Specifies the number of banks the SDRAM contains.		
		00= 2 banks		
		01= 4 banks		
		1x= reserved		
31	SDPSS	Start SDRAM power up sequence.		
		Write 1 to initiate power up sequence. SDPSS always reads as $0.$		

Table 10-2. IOCTL control bits (Cont'd)

See Chapter 11, Programmable Timers and I/O Ports, for the definition of bits 7:0.



Figure 10-3. IOCTL Register Definition

Configuring SDRAM Operation

The processor's IOCTL register stores the configuration of the SDRAM interface. Writing some configuration parameters initiates commands that take effect immediately.

Before starting the SDRAM power-up sequence, your application must write all of the SDRAM configuration parameter values to the IOCTL register, and, at initial power-up, set the SDRDIV register.

In the SDRDIV register, a memory-mapped IOP register, you set the value for the SDRAM refresh counter.

In the IOCTL register, you program the parameter bits to:

- Set the SDRAM clock enables (DSDCTL and DSDCK1).
- Select the number of banks the SDRAM contains (SDBN).
- Select the external memory bank configured for and connected to the SDRAM (SDBS).
- Set the SDRAM buffering option (SDBUF).
- Select the \overline{CAS} latency value (SDCL).
- Select the SDRAM page size (SDPGS).
- Select the SDRAM power-up mode (SDPM).
- Start the SDRAM power-up sequence (SDPSS).
- Start SDRAM self-refresh mode (SDSRF).
- Set the Active Command delay (SDTRAS).
- Set the Precharge delay (SDTRP).

Configuring SDRAM Operation

Setting the Refresh Counter Value (SDRDIV)

Since the clock supplied to the SDRAM can vary between 20MHz and 60MHz, the processor provides a programmable refresh counter, SDRDIV, to coordinate the supplied clock rate with the SDRAM device's required refresh rate.

Your application must write to SDRDIV the delay, in number of clock cycles, that must occur between consecutive refresh commands.



Write this value to the SDRDIV register before writing the SDRAM parameter values to the IOCTL register.

To calculate the value of the refresh counter for which to program the SDRDIV register, use this equation:

 $SDRDIV = [(2 \times f_{CLKIN})/(SDRAM refresh rate)] - CL - t_{RP} - 4$

Where:

CL=	CAS latency programmed in the IOCTL register.
t _{RP} =	$t_{\rm RP}$ spec programmed in the IOCTL register.

For example, for an IBM SDRAM with:

Ref. rate=	4096 cycles/64ms.
CLKIN=	33 MHz
CL=	2
t _{RP} =	2

The equation yields:

 $[(2x30x(10^{6}))/(4096/64x(10^{-3}))]-2-2-4 = 930$ (decimal)

Setting the SDRAM Clock Enables (DSDCTL and DSDCK1)

Systems with several SDRAM devices connected in parallel that require buffering between the processor and multiple SDRAM devices may also generate increased clock loads.

To meet higher clock load requirements, the processor provides two SDRAM clock control pins, SDCLK0 and SDCLK1. These pins eliminate the need for off-chip clock buffers.

The DSDCTL and DSDCK1 bits in the IOCTL register provide control for the SDRAM clock control pins.

The DSDCTL bit enables you to Hi-Z all of the SDRAM control pins DQM, CAS, RAS, SDWE, and SDCKE and the SDCLK0 pin:

DSDCTL=0	Enable	all	SDRAM	control	pins.
----------	--------	-----	-------	---------	-------

DSDCTL=1 Disable all SDRAM control pins.

The DSDCK1 bit enables you to Hi-Z the SDCLK1 pin only:

DSDCK1=1 Disable SDCLK1.

If your system does not use SDRAM, set both DSDCTL and DSDCK1 to 1.

If your system uses SDRAM, but the clock load is minimal, set DSDCTL to 0 and DSDCK1 to 1 This setting enables the SDCLK0 pin and all related SDRAM control pins, but disables (puts in Hi-Z) the second clock pin SDCLK1.

If your system uses SDRAM and the clock load is heavy—such as a system using registered buffers and eight ×4 SDRAMs to get ×32-bit data—set both DSDCTL and DSDCK1 to 0. This setting enables SDCLK0, SDCLK1, and all SDRAM control pins. In this configuration, SDCLK0 and SDCLK1 can each share half of the clock load. See Figure 10-2 on page 10-3.

Setting the Number of SDRAM Banks (SDBN)

The SDBN bit defines for the processor's SDRAM controller the number of banks your SDRAM device contains.

The SDRAM controller uses this value and the value you assign to the SDPGS (page size) bit to map the address bits on the processor's internal 32-bit address (DMA/PMA/EPA) bus into SDRAM column address, row address, and bank select address.

The SDBN bits in the IOCTL register select the number of banks the SDRAM contains:

SDBN=00	2 banks.
SDBN=01	4 banks.
SDBN=1x	Reserved.

Setting the External Memory Bank (SDBS)

When you use SDRAM, you must connect its \overline{CS} line to one of the processor's external memory banks \overline{MS}_{3-0} and, in the IOCTL register, configure that bank for SDRAM operation.

SDRAM Interface

Make sure your application programs a zero (0) wait state for the external memory bank to which the SDRAM device maps. That is, set EBXWS=000 in the WAIT register.



You cannot use external handshake and paced master mode DMA on the external memory bank to which you map an SDRAM device.

The SDBS bits in the IOCTL register configure one of the processor's external memory banks for SDRAM operation:

SDBS=000	No SDRAM
SDBS=100	Bank 0.
SDBS=101	Bank 1.
SDBS=110	Bank 2.
SDBS=111	Bank 3.

Setting the SDRAM Buffering Option (SDBUF)

To meet overall system timing requirements, systems that employ several SDRAM devices connected in parallel may require buffering between the processor and multiple SDRAM devices.

To meet such timing requirements and enable intermediary buffering, the processor supports pipelining of SDRAM address and control signals.

The pipeline bit SDBUF in the IOCTL register enables this mode:

SDBUF=0	Disable pipelining.
SDBUF=1	Enable pipelining.

When SDBUF=1, the SDRAM controller delays the data in write accesses one cycle, enabling the processor to latch the address and controls externally. In read accesses, the SDRAM controller samples data one cycle later.

Selecting the CAS Latency Value (SDCL)

The \overline{CAS} latency value defines the delay, in number of clock cycles, between the time the SDRAM detects the read command and provides the data at its output pins. This parameter enables your application to match SDRAM operation with the processor's ability to latch the data output.

CAS latency does not apply to write cycles.

The SDCL bits in the IOCTL register select the \overline{CAS} latency value:

SDCL=01	1 clock cycle.
SDCL=10	2 clock cycles.
SDCL=11	3 clock cycles.

Generally, the frequency of the operation determines the value of the \overline{CAS} latency. For more details, see the documentation that accompanied your SDRAM device.

Selecting the SDRAM's Page Size (SDPGS)

The processor supports full-page burst length only. The SDPGS bit defines for the processor's SDRAM controller the page size, in number of words, of the SDRAM's banks.

The SDRAM controller uses this value and the value you assign to the SDBN (number of banks) bit to map the address bits on the processor's internal 32-bit address (DMA/PMA/EPA) bus into SDRAM column address, row address, and bank select address.

Page length depends on the I/O organization and column addressing of the SDRAM's internal banks. For example, a 16Mb SDRAM organized as $2 \text{ M} \times 4 \text{ I/O} \times 2$ Banks has a page size of 1024 words.

The SDPGS bits in the IOCTL register select the SDRAM page length:

 SDPGS=000
 1024 words.

 SDPGS=001
 512 words.

 SDPGS=010
 256 words.

All other values are reserved.

Setting the SDRAM Power-Up Mode (SDPM)

To avoid unpredictable start-up modes, SDRAM devices must follow a specific initialization sequence during power up. The processor provides two commonly used power-up options. This parameter enables your application to accommodate power-up requirements of your SDRAM.

The SDPM bit in the IOCTL register selects the SDRAM power-up mode:

SDPM=0	The SDRAM controller issues, in this order: A precharge command Eight CBR refresh cycles An MRS (Mode Register Set) command
SDPM=1	The SDRAM controller issues, in this order: A precharge command An MRS (Mode Register Set) command Eight CBR refresh cycles

For details, see the documentation that accompanied your SDRAM device.

Starting the SDRAM Power-Up Sequence (SDPSS)

Before starting the power-up sequence, your application must write the IOCTL register to configure the SDRAM parameters. Whenever it does, your application must write to all of the register bits, regardless of the number of parameter values that will not change.

To start the SDRAM power-up sequence, you write a 1 to the SDPSS bit in the IOCTL register. The initialization sequence executed during power-up depends on the value of the SDPM bit (page 10-19).



Make sure your application initializes the SDRDIV register before it starts the power-up sequence. After power up, make sure it waits one cycle before it writes the IOCTL register to issue another SDRAM command.

The SDPSS bit always reads as zero (0).

For more details, see the documentation that accompanied your SDRAM device.

Starting Self-Refresh mode (SDSRF)

The processor supports SDRAM self-refresh mode. In self-refresh mode, the SDRAM performs refresh operations internally, without external control, reducing the SDRAM's power consumption

The SDSRF bit in the IOCTL register enables and disables the self-refresh option:

SDSRF=0	Disable self-refresh mode.
SDSRF=1	Enable self-refresh mode.

When SDSRF=1, the processor's SDRAM controller issues a Sref command to the SDRAM device or devices, putting them into self-refresh mode immediately. For details, see "Sref (Self-Refresh)" on page 10-39.

Selecting the Active Command Delay (SDTRAS)

The t_{RAS} value (Active Command delay) defines the required delay, in number of clock cycles, between the time the SDRAM controller issues a Bank Activate command and the time it issues a Precharge command.

This parameter enables your application to accommodate your SDRAM's timing requirements.

The SDTRAS bits in the IOCTL register select the t_{RAS} value. For example:

SDTRAS=001	1 clock cycle.
SDTRAS=010	2 clock cycles.
SDTRAS=111	7 clock cycles.

For more details, see the documentation that accompanied your SDRAM device.

Selecting the Precharge Delay (SDTRP)

The t_{RP} value (Precharge delay) defines the required delay, in number of clock cycles, between the time the SDRAM controller issues a Precharge command and the time it issues a Bank Activate command.

This parameter enables your application to accommodate your SDRAM's timing requirements.

Configuring SDRAM Operation

The SDTRP bits in the IOCTL register select the t_{RP} value. For example:

SDTRP=001	1 clock cycle.
SDTRP=010	2 clock cycles.
SDTRP=111	7 clock cycles.
SDRAM Controller Operation

For page read and write operations, the processor's SDRAM controller programs the SDRAM device for full page burst length. Since all SDRAM devices can terminate an active burst sequence and start a new one, the SDRAM controller issues all commands to support this operation.

For page read and write operations, the SDRAM starts the access at the column address defined at the beginning of the cycle in the ADDR bits.

Table 10-3 lists the data throughput rates for the processor's core or DMA read/write accesses to SDRAM. All clock cycles are 2xCLKIN and these data assume:

- CAS latency = 2 cycles (SDCL=2)
- No SDRAM buffering (SDBUF=0)
- RAS precharge (t_{RP}) = 2 cycles (SDTRP=2)
- Active command time (t_{RAS}) = 3 cycles (SDTRP=3).

Accesses	Operations	Page	Throughput per 2xCLKIN (32-bit words) ^{1, 2}
Sequential, uninterrupted	Read	Same	1 word/1 cycle
Sequential, uninterrupted	Write	Same	1 word/1 cycle
Nonsequential, uninterrupted	Read	Same	1 word/4 cycles (CL+2)
t_{RAS} = Active to precharge time; t_{RP} = Precharge time; $CL = \overline{CAS}$ latency			

Table 10-3. Throughput for core or DMA read/write operations

Accesses	Operations	Page	Throughput per 2xCLKIN (32-bit words) ^{1, 2}
Nonsequential, uninterrupted	Write	Same	1 word/1 cycle
Both	Alternating read/write	Same	Average rate = 2.5 cycles per word (reads = 4 cycles; writes = 1 cycle)
Nonsequential	Reads	Different	1 word/8 cycles (t _{RP} +2CL+2)
Nonsequential	Writes	Different	1 word/5 cycles (t _{RP} +CL+1)
Autorefresh before read	Reads	Different	1 word/13 cycles (2t _{RP} +t _{RAS} +2CL+2)
Autorefresh before write	Writes	Different	1 word/10 cycles (2t _{RP} +t _{RAS} +CL+1)
t_{RAS} = Active to precharge time; t_{RP} = Precharge time; $CL = \overline{CAS}$ latency			

Table 10-3. Throughput for core or DMA read/write operations

¹ For 48-bit words, add one clock cycle to the throughput value or to the average access rate.

² With SDRAM buffering enabled (SDBUF=1), replace any instance of (CL) with (CL+1)...

DMA Operation

For DMA mode data transfers to or from SDRAM, one full page can be accessed at full throughput if the external address incrementor = 1. If the external address incrementor is >1, one full page can be written at full throughput, but reads incur overhead.

When a *page miss* occurs, before executing the read/write command, the SDRAM controller executes a Burst Stop command followed by a Precharge and a Bank Activate command.

For an SDRAM read, a latency (equal to \overline{CAS} latency) exists from the start of the read command until data is available from the SDRAM. For the first read in a sequence of reads, the latency will always exist. Subsequent reads will not have a latency if the address is sequential and uninterrupted.

Multiprocessing Operation

In a multiprocessing environment, both processors share the SDRAM. While the bus master always drives SDRAM input signals (including clock), the slave processor tracks the commands the master processor issues to the SDRAM. This tracking helps to synchronize the SDRAM refresh counters and to avoid needless refreshing operations.

When one processor receives bus mastership from the other, it executes a Precharge command before its first access to SDRAM only if the previous master had accessed SDRAM. The application must initialize the relevant bits in the IOCTL and SDRDIV registers of both processors to the same values.

If the system uses no SDRAM (as indicated in IOCTL), bus transition proceeds normally (see Chapter 7, Multiprocessing).

Accessing SDRAM

To access SDRAM, the SDRAM controller multiplexes the internal 32-bit nonmultiplexed address into a row address, a column address, and a bank select address for the SDRAM device, as shown in Figure 10-4.

25	24	23	0
Men	hory	\longleftrightarrow Row Addr \longleftrightarrow \Leftrightarrow SDRAM \longleftrightarrow Column Addr \leftarrow	<
nk Se	elect	Bank Select	
آ = 00	MS ₀		
01 = Ī	MS ₁		
10 = İ	MS ₂		
11 = Ī	MS ₃		
	25 Mennik Se 00 = 1 01 = 1 10 = 1 11 = 1	$\begin{array}{c c} 25 & 24 \\ \hline \textbf{Memory} \\ \textbf{nk Select} \\ 00 = \overline{\text{MS}}_0 \\ 01 = \overline{\text{MS}}_1 \\ 10 = \overline{\text{MS}}_2 \\ 11 = \overline{\text{MS}}_3 \end{array}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Figure 10-4. Multiplexed 32-bit SDRAM address

Based on the values you program into the IOCTL register for page size and number of SDRAM banks, the SDRAM controller maps the lower ADDR bits into the column address, the next bit or bits into the bank select address, and the remaining higher order bits into the row address.

Table 10-4 shows how the SDRAM controller maps the SDRAM address bits on the processor's internal address bus to its external address pins that connect to SDRAM.

SDRAM (pg × banks)	Column Address (Page Access)	Bank Select	Row Address (Bank Activate)
256×2	IA[7:0]→EA[7:0]	IA[8]→EA[13]	IA[21:9]→EA[12:0]
512×2	IA[8:0]→EA[8:0]	IA[9]→EA[13]	IA[22:10]→EA[12:0]
1K×2	IA[9:0]→EA[9:0]	IA[10]→EA[13]	IA[23:11]→EA[12:0]
EA = External address pins; IA = Internal address bus.			

Table 10-4. SDRAM address mapping

SDRAM (pg × banks)	Column Address (Page Access)	Bank Select	Row Address (Bank Activate)
256×4	IA[7:0]→EA[7:0]	IA[9:8]→EA[13:12]	IA[21:10]→EA[11:0]
512×4	IA[8:0]→EA[8:0]	IA[10:9]→EA[13:12]	IA[22:11]→EA[11:0]
1K×4 IA[9:0]→EA[9:0] IA[11:10]→EA[13:12] IA[23:12]→EA[11:0]			
EA = External address pins; IA = Internal address bus.			

Table 10-4. SDRAM address mapping (Cont'd)

For 2 banked memories, connect A13 with the SDRAM's bank select pin. For 4 banked memories, connect A13:12 with the SDRAM's bank select pins.

DQM Operation

ad

The processor's DQM (Data I/O Mask) pin enables the SDRAM controller to interrupt a burst write operation.

For write cycles, DQM has a latency of zero (0) cycles and operates like a word mask, permitting data writes when sampled low and blocking data writes when sampled high.

Executing a Parallel Refresh Command

The processor provides a separate A10 pin (SDA10) to enable applications to execute a parallel refresh command with any non-SDRAM access. This pin enables an application to precharge the SDRAM before it issues a refresh command.

Connecting this pin to the SDRAM's A10 line and using it, instead of $ADDR_{10}$, to precharge the SDRAM device enables the processor to retain control of the SDRAM device while a host requests and controls the external $ADDR_{23-0}$ bus.

Entering and Exiting Self-Refresh Mode

Writing 1 to the SDSRF bit in the IOCTL register causes the SDRAM controller to issue a Sref command to the SDRAM device. When the Sref command is issued depends on whether or not the processor's core or DMA controller is engaged in an external SDRAM access.

If no external SDRAM access is in progress, the SDRAM controller issues the Sref command immediately. Otherwise, it delays issuing the Sref command until the processor's core or DMA controller completes its current SDRAM access and any subsequent access requests.

Once the SDRAM device enters into self-refresh mode, the SDRAM controller resets the SDSRF bit in the IOCTL register. The SDSRF bit always reads as 0, regardless of a pending request. The SDRAM controller ignores another self-refresh request (SDSRF=1) when the SDRAM device is already in self-refresh mode.

The application cannot clear the SDSRF bit (SDSRF=0) to cancel self-refresh mode. The SDRAM device exits self-refresh mode only when it receives a core or DMA access request from the SDRAM controller.

Powering Up After Reset

After reset, once the application has written the IOCTL register, the controller initiates the power-up sequence. The SDPM bit of the IOCTL register determines the exact sequence. In a multiprocessing environment, either processor initiates the power-up sequence. A software reset does not reset the controller and will not reinitiate a power-up sequence.

SDRAM Controller Commands

This section provides a description of each of the commands the processor's on-chip SDRAM controller uses to manage the SDRAM interface. These commands are transparent to applications.

The SDRAM commands are:

• Act (bank activate)

Activates a page in the required bank.

• Bstop (burst stop)

Terminates the currently executing burst read or write operation.

• MRS (mode register self-refresh)

Initializes the SDRAM operation parameters during the power-up sequence.

• Pre (precharge)

Precharges the active bank.

- Read/write
- Ref (refresh)

Causes the SDRAM to enter refresh mode and generate all addresses internally.

• Sref (self-refresh)

Places the SDRAM in self-refresh mode, in which it controls its refresh operations internally.

• NOP (no operation)

If a read or write is followed by a NOP, the SDRAM will start the full page burst.

Act (Bank Activate)

A Bank Activate command is required if the next data access is in a different page.

The SDRAM controller executes a Pre command followed by an Act command to activate the page in the required bank. Only one bank at a time can be active.

Pin	State
$\overline{\text{MS}}_{\mathbf{X}}^{1}$	Low
CAS	High
RAS	Low
SDWE	High
SDCKE	High

The SDRAM pin state during the Act command is:

¹ X = One of the processor's external memory banks configured for SDRAM.

Bstop (Burst Stop)

A Burst Stop command terminates the currently executing burst read or burst write operation prematurely, but leaves the bank open for future reads or writes to the same page of the active bank.

Pin	State
$\overline{\text{MS}}_{x}^{1}$	Low
CAS	High
DQM	High (write only)
RAS	High
SDWE	Low
SDCKE	High

The SDRAM pin state during the Bstop command is:

¹ X = One of the processor's external memory banks configured for SDRAM.

MRS (Mode Register Set)

Part of the power-up sequence. Initializes the SDRAM operation parameters.

MRS uses SDRAM address bits A0-A13 as data input.

To start the power-up sequence, you write 1 to the SDPSS bit in the IOCTL register. The SDPM bit specifies the exact sequence of commands The SDRAM controller uses in the power-up procedure.

MRS initializes the following parameters:

- Burst length Full page; bits 2:0; fixed in processor.
- Burst type Sequential; bit 3; fixed in processor.

- Ltmode CAS latency mode; bits 6:4; programmable in the IOCTL register.
- Bits(13:7) Always 0; fixed in processor.

While executing the MRS command, the SDRAM controller sets the unused address pins to zero (0). During the two clock cycles following MRS, the processor does not issue any other command.

The SDRAM pin state during the MRS command is:

Pin	State
$\overline{\text{MS}}_{\mathbf{X}}^{1}$	Low
CAS	Low
RAS	Low
SDWE	Low
SDCKE	High

X = One of the processor's external memory banks configured for SDRAM.

Pre (Precharge)

Precharges the active bank.

The SDRAM controller executes this command if the data to access falls in a different bank or in a different page within the same bank.

After power-up, the SDRAM controller issues a Pre command to all banks.

Pin	State
$\overline{\text{MS}}_{x}^{1}$	Low
CAS	High
RAS	Low
SDWE	Low
SDCKE	High
SDA10	High

The SDRAM pin state during the Pre command is:

¹ X = One of the processor's external memory banks configured for SDRAM.

Read/Write

The SDRAM controller executes a Read/Write command if the next read/write data falls in the currently active page.

Read Commands

For the Read command, the SDRAM controller asserts the \overline{CAS} , \overline{MSx} , and SDA10 pins to enable the SDRAM to latch the column address. The column address determines the burst start address.

Figure 10-5 shows an example timing of a read command that reads four sequential addresses and terminates with a burst stop (Bstop) command. The t_{RCD} parameter determines the delay between Act and Read commands. Data is available after the t_{RCD} and \overline{CAS} latency requirements are met.



Figure 10-5. Example timing of a read command

The SDRAM pin state during the Read command is:

Pin	State
$\overline{\text{MS}}_{x}^{1}$	Low
CAS	Low
RAS	High
SDWE	High
SDCKE	High
SDA10	Low

¹ X = One of the processor's external memory banks configured for SDRAM.

Write Commands

For the Write command, \overline{CAS} , \overline{MSx} , \overline{SDWE} , and $\overline{SDA10}$ are asserted low to enable the SDRAM to latch the column address. Data is also asserted in the same cycle. The burst start address is set according to the column address.

Figure 10-6 shows an example timing of a write command interrupted by another write command that writes to a nonsequential address then to two sequential addresses.



Figure 10-6. Example timing of a write interrupted by another write

Pin	State
$\overline{\text{MS}}_{x}^{1}$	Low
CAS	Low
RAS	High
SDWE	Low
SDCKE	High
SDA10	Low

The SDRAM pin state during the Write command is:

¹ X = One of the processor's external memory banks configured for SDRAM.

DMA Transfers

While a DMA channel is performing reads from SDRAM, the SDRAM controller issues a Read command if at least one location is available in the external port DMA buffer FIFO (EPBx). The SDRAM controller permits the burst to continue if the next access is to a sequential address.

While a DMA channel is performing writes to SDRAM, the SDRAM controller issues a Write command if at least one word is available in the EPBx buffer. Whenever data is unavailable to write, the SDRAM controller asserts a Burst Stop command.

Interrupting a Burst Read or Write

In general, a Read interrupts a previous Read when the next access is a nonsequential address, but a *page miss* does not occur. When a *page miss* does occur, the SDRAM controller issues the command sequence—Bstop, Pre, and Act—to the SDRAM before it issues a Read or Write command.

If a Write (on page) interrupts a burst Read in progress, the SDRAM controller asserts a Burst Stop command and waits until the external data bus is three-stated before it issues a Write command.

Either a Read or another Write (if it is nonsequential) or a Bstop interrupts a burst Write in progress. If the internal refresh counter asserts a refresh request, it delays any new access until the SDRAM controller executes a Ref command.

A special situation occurs when the \overline{CAS} latency = 1 and the processor must perform this sequence of operations:

- 1. Page write to location xyz.
- 2. No SDRAM operation by the core or DMA controller.
- 3. Page read from location *abc*.

Normally, to perform this sequence, the SDRAM controller issues these commands:

- 4. Write
- 5. Bstop
- 6. Read

The burst stop command asserts DQM to mask write data within the burst stop cycle. But since the DQM standard is always DQM latency = 2, with \overline{CAS} latency = 1 (SDCL=1), no data is available at the SDRAM output pins for the read.

To avoid this situation, the SDRAM controller inserts a NOP between a Burst Stop command and a Read command only when the \overline{CAS} latency is 1 (SDCL=1):

- 1. Write
- 2. Bstop

- 3. NOP
- 4. Read

Ref (Refresh)

Requests the SDRAM to perform a CBR (\overline{CAS} before \overline{RAS}) transaction. Ref causes the SDRAM to generate all addresses internally.

Before executing the Ref command, the SDRAM controller executes a Pre command to the active bank (after t_{RAS} min). It executes the next Act command only after a minimum delay equal to t_{RC} .

The SDRAM pin state during the Ref command is:

Pin	State
$\overline{\text{MS}}_{\mathbf{X}}^{1}$	Low
CAS	Low
RAS	Low
SDWE	High
SDCKE	High

¹ X = One of the processor's external memory bank s configured for SDRAM.

The IOP address of the SDRDIV register maps to 0x20.

Setting the Delay Between Ref Commands

You use the processor's SDRDIV register to set the number of clock cycles between two Ref commands. Your application must program the SDRDIV register before it writes to the IOCTL register. The SDRAM controller makes an internal CBR Ref request to the SDRAM based on this value. Before servicing a refresh request, the SDRAM controller completes a current burst. The master processor always executes a refresh command.

Multiprocessing Operation

In a multiprocessing environment, both processors share the SDRAM. While the bus master always drives SDRAM input signals (including clock), the slave processor tracks the commands the master processor issues to the SDRAM. This tracking helps to synchronize the SDRAM refresh counters and to avoid needless refreshing operations.

When one ADSP-21065L receives bus mastership from the other, it executes a Precharge command before its first access to SDRAM only if the previous master accessed SDRAM.

If the Ref request arrives from the refresh counter during a bus transition cycle, the new bus master immediately issues a Ref command. The new bus master is aware of the Ref request because the refresh counter runs on both processors. The refresh counters on both processors reload synchronously because the slave watches the external SDRAM control pins to see when the master has executed the refresh command.

The master processor retains mastership of the SDRAM control pins (RAS, \overline{CAS} , \overline{SDWE} , SDCKE, SDCLK, DQM, \overline{MSx} , SDA10) when the host assumes control of the system bus— \overline{HBG} is asserted. This enables the master processor to issue Ref commands as necessary.

Sref (Self-Refresh)

The Sref command causes the SDRAM to perform refresh operations internally, without any external control. Before executing the Sref command, the SDRAM precharges the active bank.

Writing a 1 to the SDSRF bit of the IOCTL register enables Sref mode.

The SDRAM controller automatically asserts an Sref exit cycle if an SDRAM access occurs during the Sref period. After executing a Sref exit command, the SDRAM controller waits for 2 + t_{RC} cycles to execute a CBR (CAS before RAS) refresh cycle. After the CBR refresh command, the SDRAM controller waits for t_{RC} number of cycles before executing a bank activate command.

To reduce system power demand, three cycles after entering SREF, the SDRAM controller holds SDCLKx low, and two cycles before exiting SREF, it restores SDCLKx.

The SDRAM pin state during the Sref command is:

Pin	State				
$\overline{\text{MS}}_{\mathbf{X}}^{1}$	Low ²				
CAS	Low				
RAS	Low				
SDWE	High				
SDCKE	Low				

¹ X = One of the processor's external memory bank s configured for SDRAM.

² The processor asserts MSx high for two cycles when exiting self-refresh mode.

For details on SDRAM controller operation on entry and exit from self-refresh mode, see "Entering and Exiting Self-Refresh Mode" on page 10-28.

SDRAM Timing Specifications

To support key timing requirements and power-up sequences for different SDRAM vendors, the processor provides programmability for t_{RAS} and t_{RP} and a power-up sequence mode (see the IOCTL register bit definitions).

Your application must set, in the IOCTL register, the \overline{CAS} latency based on the frequency of the operation. (For details, see your SDRAM vendor's data sheet.)

For other parameters, the SDRAM controller assumes:

- Bank cycle time $t_{RC} = t_{RAS} + t_{RP}$
- \overline{RAS} to \overline{CAS} delay $t_{RCD} = \overline{CAS}$ latency

Bit definitions for the SYSCON register are shown in Figure 10-4 on page 10-26.

SDRAM Timing Specifications

11 PROGRAMMABLE TIMERS AND I/O PORTS

The processor has two identical timer blocks, each of which has two basic functions:

- Pulse Width Waveform Generation/ PWMOUT (PWMOUT mode)
- Pulse Width Count/Capture. (WIDTH_CNT mode)

You can configure the timer in either mode. The timer has one input/output pin—PWM_EVENTx. This pin functions as an output pin in the PWMOUT mode and as an input pin in the WIDTH_CNT mode. To implement these functions, each timer has three registers—TPERIODx, TPWIDTHx, and TCOUNTx.

All timer counters are 32-bits wide and use the processor's 2xCLKIN internal clock, which evaluates to a maximum period of 71.5 sec $((2^{32}-1) * 16.67 \text{ ns internal clock cycles})$ for the timer count.

To enable or disable the timer, you set or clear the TIMENx bit in the MODE2 register. Figure 11-1 on page 11-2 shows the timer's enable and disable timing.



Figure 11-1. Timer enable and disable timing

PWMOUT Mode

In PWMOUT mode, the PWM_EVENTx is an output pin. To select it, you set the PWMOUTx bit high in the MODE2 register. The registers TPERIODx and TPWIDTHx contain the values of the timer count period and PWM output pulse width respectively.

To avoid unpredictable results of the PWM_EVENTx signal:

- Initialize TPWIDTHx and TPERIODx before enabling the timer.
- Do not alter TPWIDTHx and TPERIODx while the timer is enabled.
- Make sure the value of TPWIDTHx is less than the value of TPERIODx.

When the timer is enabled in this mode, the PWM_EVENTx is pulled low each time the TCOUNTx (up counter) value equals the TPERIODx value, and it is pulled high when the TCOUNTx value equals the TPWIDTHx value. TCOUNTx is reset once to 0x0000 0001 when the timer is enabled and each time TCOUNTx reaches the TPERIODx value. See Figure 11-1 on page 11-2.

When TCOUNTx equals TPERIODx, a timer interrupt (if enabled) is generated, and the CNT_EXPx/CNT_OVFx bit in the STKY register is set. The CNT_EXPx/CNT_OVFx bit is a sticky bit, and software must reset it explicitly. At reset, its value is 0. Figure 11-2 shows the timer flow.



Figure 11-2. Timer Flow Diagram-PWMOUT Mode

WIDTH_CNT Mode

In the WIDTH_CNT mode, the PWM_EVENTx is an input pin. To select this mode, you set the PWMOUTx bit low in the MODE2 register.

When enabled in this mode, the timer resets TCOUNTx to 0x0000 0001 when it detects the leading edge of the PWM_EVENTx pin and starts counting (increments).

When it detects the trailing edge, the timer captures the current value of the TCOUNTx into the TPWIDTHx register. At the leading edge, the timer transfers the current value of the TCOUNTx into the TPERIODx register. This timing, shown in Figure 11-3, assumes the leading edge is set as $0 \rightarrow 1$.



Figure 11-3. WIDTH_CNT mode timing

In this case, your software application can measure both the pulse width and the pulse period values, which are available in the TPWIDTHx and the TPERIODx registers, respectively. To control the definition of leading edge and trailing edge of the PWM_EVENTx, you set the PULSE_HIx bit in the MODE2 register.

TPERIODx and TPWIDTHx are read-only registers when the timer is enabled in WIDTH_CNT mode.

A timer interrupt (if enabled) is generated when the timer captures either the pulse width or the pulse period value, which depends on the value of the PERIOD_CNTx bit in the MODE2 register.

If the PERIOD_CNTx is set high, the interrupt and the PULSE_CAPx bits (in the STKY register) get set when the pulse period value is captured. If the PERIOD_CNTx is set low, then the interrupt and the PULSE_CAPx are set when the pulse width value is captured.

A timer interrupt (if enabled) is also generated if the counter TCOUNTx reaches a value of 0xFFFF FFFF:

- Before the edge for the pulse period is detected if PERIOD_CNTx is high
- Before the edge for the pulse width is detected if the PERIOD_CNTx is low.

In addition, the status bit CNT_EXPx/CNT_OVFx in the STKY register is set, indicating that TCOUNTx overflowed before the timer counted the maximum $(2^{32}-2)$ intervening clock cycles.

PULSE_CAPx and CNT_EXPx/CNT_OVFx are sticky bits, and software has to explicitly clear them.

Note that the TPERIODx, TPWIDTHx and TCOUNTx (x=0,1) are all IOP memory mapped registers, not universal registers. Figure 11-4 on page 11-7 shows the timer flow.



Figure 11-4. Timer Flow Diagram-WIDTH_CNT Mode

Timer Control Bits and the Interrupt Vectors

This section describes the timer control bit definitions and the MODE2 register definitions.

TIMENx

Timer enable (x=0,1)

0 = Disable

1 = Enable

PWMOUTx

PWMOUT/WIDTH_CNT control (x=0,1)

1 = PWM_EVENT is a PWMOUT output.

0 = PWM_EVENT is an WIDTH_CNT input. (default)

PULSE_HIx (x=0,1)

Applies to the WIDTH_CNT mode only

0 = 0 to 1 transition is leading edge in the WIDTH_CNT mode.

1 = 1 to 0 transition is leading edge in the WIDTH_CNT mode.

PERIOD_CNTx

Enable period count (applicable only to the WIDTH_CNT mode)

0 = Enable width count.

Interrupt and the PULSE_CAPx bits are set when pulse width is captured.

1 = Enable period count.

Interrupt and the PULSE_CAPx bits are set when pulse period is captured.

INT_HIx

Interrupt vector location. (x=0,1)

The two timers generate interrupts, and these can be latched either at bit 4 (TMZHI) or at bit 23 (TMZLI) of the IRPTL register, as shown in Table 11-1. In addition, these interrupts can be masked using the IMASK register.

Table 11-1. Timer status

INT_HI1	INT_HIO	Status
0	0	Both timers latch to TMZLI
0	1	timer1 => TMZLI, timer0 => TMZHI
1	0	timer1 => TMZHI, timer0 => TMZLI
1	1	Both timers latch to TMZHI

Timer Interrupts and the Status Stack

Only the timer interrupt on the TMZHI bit pushes the status stack, so, in the above combinations, 00 will not push the status stack, but both 01 and 10 will push the status stack, depending on which timer is programmed to cause the TMZHI interrupt. When using the 11 combination, interrupts generated by either timer push the status stack.

When using the 00 and 11 combinations, the processor latches a logical OR function of the two timer interrupts into the interrupt latch register. The software checks the CNT_EXPx and the EDGE_CAPx bits, determines the source of the interrupt, and takes appropriate action.

Figure 11-5 on page 11-10 shows the mapping of the MODE2 register.



Figure 11-5. MODE2 Register

The STKY Register

Table 11-2 shows the CNT_EXPx and the PULSE_CAPx status bits in the STKY register.

Bit	Name	Description
12	PULSE_CAPO	Pulse captured bit for timer O.
13	CNT_EXPO/CNT_OVFO	Counter expired/counter over- flowed bit for timer O.
14	PULSE_CAP1	Pulse captured bit for timer 1.
15	CNT_EXP1/CNT_OVF1	Counter expired/counter over- flowed bit for timer 1.

Table 11-2. Timer status bits in the STKY register

Timer Registers and their Values at Reset

The TCOUNTx, TPWIDTHx, and TPERIODx registers are memory mapped. While TPERIODx and TPWIDTHx are read/write registers, TCOUNTx is read-only.

The timer enable signal gates the timer clock, interrupts, and the edge detect logic. In PWMOUT mode, TPWIDTHx and TPERIODx must be initialized before the timer is enabled. The timer is disabled at reset, and, at that time, TPERIODx, TCOUNTx and TPWIDTHx are unknown.

Timer Control Bits and the Interrupt Vectors

Table 11-3 summarizes the IOP register addresses for the timer registers.

Register	Address
TPERIODO	0x28
TPWIDTHO	0x29
TCOUNTO	0x2a
TPERIOD1	0x2b
TPWIDTH1	0x2c
TCOUNT1	0x2d

Table 11-3. IOP register addresses

Programmable I/O Ports

The processor has twelve flag pins $FLAG_{11-0}$, which are programmable, general-purpose I/O ports.

The MODE2 register configures the functionality, or direction, of the pins FLAG₃₋₀, and the ASTAT register reflects the value of these flag bits.

The functionality of the $FLAG_{11-4}$ pins is similar to that of the $FLAG_{3-0}$, but the IOP registers IOCTL and IOSTAT contain their control and status bits.

You cannot execute the bitwise operations, such as BIT TST, BIT CLR, and so on, directly on the IOP registers. To perform these operations on the $FLAG_{4-11}$ pins, you must first transfer the contents of the IOSTAT register (shown in Figure 11-6) to the Register File or to another universal register.

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0



Figure 11-6. IOSTAT register

Programmable I/O Ports

ASTAT is a universal register, so the status on $FLAG_{3-0}$ can be checked and manipulated using the bitwise operations directly. This is the difference between the $FLAG_{3-0}$ and the rest of the FLAG pins.

For detailed description of the IOCTL register, where the directions on the I/O ports are set, see Chapter 10, SDRAM Interface.

For a description of the IOSTAT register, see Figure 11-6.

The IOP address locations for the IOCTL and the IOSTAT registers are 0x2e and 0x2f respectively.

12 SYSTEM DESIGN

This chapter provides hardware, software, and system design information to aid users in developing systems built on the ADSP-21065L Digital Signal Processor.

This chapter describes the processor's pins and shows how to use these signals in your system. This information includes:

- Pin definitions, connections, and states during and after reset.
- Operation of XTAL and CLKIN pins
- Operation of the interrupt and timer pins
- Operation of the FLAG₁₁₋₀ pins
- Operation of the JTAG interface pins
- Operation of the EZ-ICE Emulator pins
- Input signal conditioning
- High frequency design considerations
- Booting procedures

Figure 12-1 shows example pin connections in a single-processor system. Figure 7-1 on page 7-2 shows example pin connections in a multiprocessor system.



Figure 12-1. Basic single-processor system
This section lists and describes the processor's pins. Synchronous inputs (S) must meet timing requirements with respect to CLKIN (or to TCK for TMS and TDI). Asynchronous inputs (A) can be asserted asynchronously to CLKIN (or to TCK for TRST).

The following tables list and describe the processor's pins:

•	External port pins	Table 12-1 on page 12-4
•	Host interface pins	Table 12-2 on page 12-7
•	SDRAM interface pins	Table 12-3 on page 12-10
•	Serial port pins	Table 12-4 on page 12-11
•	System control pins	Table 12-5 on page 12-13
•	JTAG and emulator pins	Table 12-6 on page 12-19

• Miscellaneous pins Table 12-7 on page 12-20

Tie or pull up unused inputs to $V_{\mbox{\scriptsize DD}}$ or $G_{\mbox{\scriptsize ND}},$ except for

- ADDR₂₃₋₀
- DATA₃₁₋₀
- FLAG₁₁₋₀
- <u>SW</u>
- Inputs that have internal pull-up or pull-down resistors (CPA, ACK, DTxX, DRxX, TCLKx, RCLKx, TMS, and TDI)

Leave these pins floating. These pins have a logic-level hold circuit that prevents their input from floating internally.

Table 12-1. External port pin definitions

Pins	Туре	Function	
ADDR ₂₃₋₀	I/0/Z	External bus address.	
		Output addresses for external memory and peripherals.	
		In multiprocessor systems, the bus master outputs addresses for reads and writes of the IOP registers of the other processor.	
		The processor inputs addresses while a host or multiprocessing bus master reads or writes its internal IOP registers.	
DATA ₃₁₋₀	I/0/Z	External bus data.	
		Input and output data and instructions.	
		 Bits 31:0 of the bus transfer 32-bit floating- or fixed-point data or 32-bit packed data. 	
		 Bits 15:0 of the bus transfer 16-bit packed data. 	
		 Bits 7:0 of the bus transfer 8-bit packed data. 	
		 In EPROM boot mode, bits 7:0 of the bus transfer 8-bit data. 	
		Pull-up resistors on unused DATAx pins are unnecessary.	
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>			

Pins	Туре	Function	
DMAG	0/Z	DMA grant 1. DMA channel 9.	
DMAG ₂	0/Z	DMA grant 2. DMA channel 8.	
DMAR	I/A	DMA request1. DMA channel9.	
DMAR ₂	I/A	DMA request 2. DMA channel 8.	
MS ₃₋₀	0/Z	Memory select lines. Asserted as chip selects for the corre- sponding banks of external memory. You must define the memory banks in the SYSCON reg- ister. These lines are decoded memory address lines that change at the same time as the other address lines. These lines remain inactive while no access to external memory occurs. They are active, however, during execution of a conditional memory access instruction, whether or not the condition is true. In multiprocessing systems, the master pro- cessor outputs the $\overline{\rm MS}_{3-0}$ lines.	
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>			

Table 12-1. External port pin definitions (Cont'd)

Pins	Туре	Function
SBTS	I/S	Suspend bus three-state.
		External devices can assert this pin to place the external bus address, data, selects, and strobes-but not the SDRAM con- trol pins-in a high-impedance state for the following cycle.
		Any attempt to access external memory while SBTS is asserted stops the processor and suspends the memory access. The processor completes the memory access when SBTS is deasserted.
		Use <u>SBTS</u> to recover from deadlock between a host and processor only.
SW	I/0/Z	Synchronous write select.
		Interfaces with synchronous memory devices, including another processor, to provide early indication of an impending write cycle.
		The processor asserts this pin when a write cycle is pending. If \overline{WR} is not asserted later in the write cycle (for example, in a conditional write instruction), the application can abort the cycle.
		In multiprocessing systems, the master pro- cessor outputs SW, and the slave inputs SW to determine if the multiprocessor memory access is a read or write.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Table 12-1. External port pin definitions (Cont'd)

Table 12-1. External	port p	pin	definitions	(Cont'd)
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Pins	Туре	Function
		The processor asserts \overline{SW} at the same time as the address output.
		A host using synchronous writes must assert SW when writing to the processor.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Table 12-2.	Host	interface	pin	definitions
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Pins	Туре	Function
АСК	I/0/Z	Memory acknowledge.
		External devices can deassert ACK to add wait states to an external memory access. This enables I/O devices, memory control- lers, and other peripherals to delay com- pleting the access.
		The processor deasserts ACK as an output to add wait states to a synchronous access of its IOP registers.
		In multiprocessing systems, the slave deas- serts the master processor's ACK input to add wait states to an access of the master processor's IOP registers. The keeper latch on the master processor's ACK pin maintains the input at the level to which it was driven.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Pins	Туре	Function	
		In multiprocessor systems, the ACK signal is an input to the master processor and does not float while not driven because the master's keeper latch on this pin is weak. During reset, the master processor pulls the ACK pin high with an internal 2 k Ω equivalent resistor and holds it high with its internal keeper latch. This eliminates need for an external pull-up resistor on the ACK line.	
CS	I/A	Chip select. The host asserts this line to select the processor.	
HBG	I/O	Host bus grant. Acknowledges an HBR bus request and gives the host permission to take control of the processor's external bus. The processor holds HBG low until the host releases HBR. In multiprocessing systems, the master pro- cessor outputs HBG.	
(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)			

Table 12-2. Host interface pin definitions (Cont'd)

Pins	Туре	Function
HBR	I/A	Host bus request.
		The host processor must assert this line to request control of the processor's external bus.
		In multiprocessing systems, the master pro- cessor relinquishes the bus and asserts HBG in response to this request.
		To relinquish the bus, the master processor places the address, data, select, and strobe lines in a high-impedance state, but continues to drive the SDRAM control pins.
		In multiprocessing systems, HBR has prior- ity over all processor bus requests (BRx).
REDY(o/d)	0	Host bus acknowledge.
		the processor deasserts this line to add wait states to an asynchronous access of its IOP registers made by the host proces- sor.
		By default, the output is open drain (o/d). To change output to active drive (a/d), set the ADREDY bit in the SYSCON register.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Table 12-2. Host interface pin definitions (Cont'd)

Table 12-3. SDRAM interface pin definitions

Pins	Туре	Function	
CAS	I/0/Z	SDRAM column address strobe. Used in conjunction with MSx, RAS, SDCLKx, SDWE, and sometimes SDA10, defines the operation for the SDRAM to perform.	
DQM	0/Z	SDRAM data mask. In write mode, this signal has a latency of zero and is used to block write operations.	
RAS	I/0/Z	SDRAM row address strobe. Used in conjunction with CAS, MSx, SDCLKx, SDWE, and sometimes SDA10, defines the operation for the SDRAM to perform.	
SDA10	0/Z	SDRAM A10 pin. Enables applications to refresh an SDRAM in parallel with a host access.	
SDCLKxO/S/ZSDRAM 2x clock output.In systems with multiple SDRAM devices con nected in parallel, supports the corre- sponding increase in clock load requirements, eliminating need of off-chip clock buffers.Applications can disable either SDCLK1 or both SDCLKx pins.			
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>			

Pins	Туре	Function	
SDCKE	I/0/Z	SDRAM clock enable.	
		Enables and disables the CLK signal.	
		Used to enter self-refresh.	
SDWE	I/0/Z	SDRAM write enable.	
		Used in conjunction with CAS, MSx, RAS, SDCLKx, and sometimes SDA10, defines the operation for the SDRAM to perform.	
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>			

Table 12-3. SDRAM interface pin definitions (Cont'd)

Table 12-4. Serial	port p	oin de	finitions
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Pins	Туре	Function
DR _x _X	Ι	Data receive.
		SPORTs 0/1, channels A /B.
		Each DRxX pin has a 50 k Ω internal pull-up resistor.
DT _{x-} X	0	Data transmit.
		SPORTs 0/1, channels A /B.
		Each DTxX pin has a 50 k Ω internal pull-up resistor.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Pins	Туре	Function
RCLKx	I/O	Receive clock for SPORTs 0 and 1. Each RCLK pin has a 50 k Ω internal pull-up resistor
RFSx	I/0	Receive frame sync for SPORTs 0 and 1.
TCLKx	I/O	Transmit clock for SPORTs O and 1. Each TCLK pin has a 50 k Ω internal pull-up resistor.
TFSx	I/0	Transmit frame sync for SPORTs 0 and 1.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Table 12-4. Serial port pin definitions (Cont'd)

Pins	Туре	Function
BMS	I/0/Z	Boot memory select.
		This is a system configuration selection that you need to hard wire.
		• Output
		Used as chip select for boot EPROM devices when BSEL=1.
		In multiprocessor systems, the master processor outputs BMS.
		• Input
		When asserted, indicates no booting will occur.
		The processor will begin executing instructions from external memory.
		When an output, this pin is three-statable in EPROM boot mode only. For details, see "Booting" on page 12-49.
BMSTR	0	Bus master output.
		Used in multiprocessor systems only.
		Indicates whether the processor is current bus master of the shared external bus.
		The processor asserts this pin high only while it is bus master. Do not connect to BMSTR on another ADSP-21065L.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Table 12-5. System control pin definitions

Pins	Туре	Function
BR ₂₋₀	I/0/S	Multiprocessing bus requests.
		In multiprocessing systems, each processor uses this line to arbitrate for bus mas- tership.
		Each processor drives its own \overline{BRx} line only according to the value of its ID_{2-0} inputs and monitors the other \overline{BRx} line. For details, see Chapter 7, Multiprocessing.
		In single-processor systems, tie both $\overline{\mathrm{BR}}$ x pins to VDD.
BSEL	Ι	EPROM boot select.
		When BSEL is high, the processor is con- figured for booting from an 8-bit EPROM.
		When BSEL is low, both BSEL and BMS inputs determine the booting mode. For details, see the BMS pin description.
CLKIN	Ι	Clock in.
		Used in conjunction with XTALx, configures the processor to use either its internal clock generator or an external clock source. (Use an external clock crystal rated at 1x frequency.)
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Table 12-5. System control pin definitions (Cont'd)

Pins	Туре	Function
CLKIN (Cont'd)	Ι	 Internal clock generator
		Connecting the necessary components to CLKIN and XTALx enables the internal clock generator.
		The processor's internal clock generator multiplies the 1x clock to generate 2x clock for its core and SDRAM interface.
		 The processor drives 2x clock out on the SDCLKx pins for the SDRAM interface to use.
		• External clock source
		Connecting the 1x external clock to CLKIN while leaving XTALx unconnected configures the processor to use the external clock source.
		The instruction cycle rate is equal to 2x CLKIN.
		You cannot halt, change, or operate CLKIN below the specified frequency.
(a/d)=Active (o/d)=Open d SBTS is asse	<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>	

Table 12-5. System control pin definitions (Cont'd)

Table 12-5. System contro	l pin definitions	(Cont'd)
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Pins	Туре	Function
CPA (o/d)	I/O	Core priority access. Enables the slave processor's core to interrupt background DMA transfers and gain access to the external bus. $\overline{\text{CPA}}$ is an open drain output that connects to both processors in a multiprocessor system. It has a 5 K Ω pull-up resistor. If your system doesn't require core access priority, leave the $\overline{\text{CPA}}$ pin unconnected.
FLAG ₁₁₋₀	I/0/A	 Flag pins. Provide twelve additional general-purpose, programmable I/O ports. Each is configured through control bits as either an input or output port: As an input, you can use a flag to test a condition. As an output, you can use a flag to signal external peripherals.
ID ₁₋₀	I	Multiprocessing ID. Determines which multiprocessor bus request (\overline{BRx}) pin the processor uses: $01 = \overline{BR_1}$ $10 = \overline{BR_2}$ Since these lines are a system configura- tion selection, hard wire them or change them at reset only.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Pins	Туре	Function
IRQ ₂₋₀	I/A	Interrupt request lines.
		erther edge-triggered or lever-sensitive.
PWM_EVENT ₁₋₀	I/0/A	PWM output/event capture.
		IN PMWOUT mode, this pin is an output that functions as a timer counter.
		In WIDTH_CNT mode, this pin is an input that functions as a pulse counter/event capture.
RD	I/0/Z	Memory read strobe.
		Asserted when the processor reads from external memory devices or from the other processor in a multiprocessor system.
		External devices, including another pro- cessor, must assert RD to read from the processor's IOP register.
		In multiprocessing systems, the master processor outputs RD, and the slave inputs RD.
		Except during a host transition cycle (HTC), do not deassert the RD strobe (low-to-high transition) while ACK or REDY are deasserted. Doing so causes the pro- cessor to hang.
		Operation of the $\overline{\text{RD}}$ signal changes when a host asserts $\overline{\text{CS}}$. For details, see "Host Transfers" on page 8-11.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Table 12-5. System control pin definitions (Cont'd)

Table 12-5. System contro	l pin definitions	(Cont'd)
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Pins	Туре	Function
RESET	I/A	Processor reset.
		Resets the processor to a known state and begins execution at the program memory location specified by the hardware reset vector address.
		In single-processor systems, the processor owns the external bus during reset and does not arbitrate for control of the bus afterwards.
		Applications must assert this input at power-up.
WR	I/0/Z	Memory write strobe.
		Asserted when the processor writes to external memory devices or to the other processor.
		External devices, including another pro- cessor, must assert WR to write to the pro- cessor's IOP registers.
		In multiprocessing systems, the master processor outputs WR, and the slave inputs WR.
		Except during a Host Transition Cycle (HTC), do not deassert the WR strobe (low-to-high transition) while ACK or REDY are deasserted (low). Doing so causes the processor to hang.
		Operation of the $\overline{\rm WR}$ signal changes when a host asserts $\overline{\rm CS}$. For details, see "Host Transfers" on page 8-11.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Table 12-5. System control pin definitions (Cont'd)

Pins	Туре	Function
XTAL	0	Crystal oscillator terminal. Used in conjunction with CLKIN to enable the processors internal clock generator or to disable it to use an external clock source.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Table 12-6	. JTAG and	emulator p	oin definitions
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Pins	Туре	Function
<u>EMU</u> (0/D)	0	Emulation status.
		Connect to the ADSP-21065L EZ-ICE target only.
ТСК	Ι	Test clock (JTAG).
		Provides an asynchronous clock for the JTAG boundary scan.
TDI	I/S	Test data input (JTAG).
		Serial data input to the boundary scan path.
		This pin has an internal 20 k Ω pull-up resistor.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Pins	Туре	Function
TDO	0	Test data output (JTAG).
		Serial scan output from the boundary scan path.
TMS	I/S	Test mode select (JTAG).
		Controls the test state machine.
		This pin has an internal 20 k Ω pull-up resistor.
TRST	I/A	Test reset (JTAG).
		Resets the test state machine.
		After power-up, applications must assert (pulse) or hold this pin low. Do not leave this pin unconnected.
		This pin has an internal 20 k Ω pull-up resistor.
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		

Table 12-6. JTAG and emulator pin definitions (Cont'd)

Table 12-7. Miscellaneous pin definitions

Pins	Туре	Function
GND	G	Power supply return
NC	_	Do not connect
VDD	Ρ	Power supply
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Syn; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>		



Figure 12-2 shows how the processor transfers different data word sizes over the external port.

Figure 12-2. External port alignment

Pin States After Reset

Table 12-8 shows the state of each pin during and immediately after processor reset.

Pin	Туре	State	
Driven only in a high-im	Driven only by the processor that is bus master; otherwise put in a high-impedance state.		
АСК	I/O/S	If bus master, pulled high with 2k Ω pull-up resistor	
ADDR ₂₃₋₀	I/0/Z	Driven	
BMSTR	0	If bus master, driven high; otherwise, driven low	
BR ₂₋₁	I/0	If bus master, $\overline{\text{BR}}_{1}$ driven low; otherwise, driven high	
CAS	I/0/Z	Driven high	
DMAG ₂₋₁	0/Z	Driven high	
DQM	0/Z	Driven high until SDRAM power-up sequence started	
HBG	I/0/Z	Driven high	
MS ₃₋₀	0/Z	Driven high	
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Synchronous; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>			

Table 12-8. Pin states during and after RESET

Pin	Туре	State	
RAS	I/0/Z	Driven high	
RD	I/0/Z	Driven high	
SDA10	0/Z	Driven	
SDCKE	I/0/Z	Driven high	
SDCLKx	0/S/Z	Driven	
SDWE	I/0/Z	Driven high	
SW	I/0/Z	Driven high	
WR	I/0/Z	Driven high	
	Independent of bus master		
BMS	I/0/Z	Input if BSEL =0;output if BSEL=1	
BSEL	Ι	Input	
CLKIN	Ι	Input	
CPA (o/d)	I/0/Z	Hi-Z	
CS	Ι	Input	
DATA ₃₁₋₀	I/0/Z	Hi-Z	
DMAR ₂₋₁	Ι	Inputs	
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Synchronous; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>			

Table 12-8. Pin states during and after RESET (Cont'd)

Pin States After Reset

Pin	Туре	State	
FLAG ₁₁₋₀	I/0/A	Inputs	
HBR	I/A	Inputs	
ID ₁₋₀	Ι	Inputs	
IRQ ₂₋₀	I/A	Inputs	
PWM_EVENT ₁₋₀	I/0/A	Inputs at RESET	
REDY (o/d)	0/Z	Hi-Z	
RESET	I/A	Input	
SBTS	I/S	Input; Puts the master processor in high-impedance state during reset.	
XTAL	0	Output	
	Serial Ports		
DRx_X	Ι	Input	
DTx_X	0	Hi-Z (for multichannel)	
RCLKx	I/0	Hi-Z	
TCLKx	I/0	Hi-Z	
RFSx	I/0	Hi-Z	
TFSx	I/0	Hi-Z	
<pre>(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Synchronous; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)</pre>			

Table 12-8. Pin states during and after RESET (Cont'd)

Pin	Туре	State
		JTAG and Emulator
EMU	0	Hi-Z
ТСК	Ι	Input
TDI	I/S	Input
TDO	0	Hi-Z
TMS	I/S	Input
TRST	I/A	Input
(a/d)=Active drain; A=Asynchronous; G=Ground; I=Input; (o/d)=Open drain; O=Output; P=Power supply; S=Synchronous; Z=Hi-Z (when SBTS is asserted or when the processor is bus slave)		

Table 12-8. Pin states during and after RESET (Cont'd)

Pin Operation

This section describes the operation of and interactions between particular pins.

XTAL and CLKIN

The processor receives its 1x clock input, which can be up to 30MHz, on the CLKIN pin. It has an on-chip clock generator that uses an on-chip phase-locked loop to generate its internal clock. The generator multiplies the 1x CLKIN signal to generate 2x clock for core operations. The processor drives out the 2x clock over its SDCLKx pins for SDRAM to use.

You can use either an external clock oscillator or a crystal and the internal oscillator to generate internal clock. For multiprocessor systems, you must use an external clock oscillator.

Table 12-9 defines the CLKIN frequency of various operations when the processor is configured to use a crystal and the internal clock oscillator to generate its internal clock. The CLKIN frequency, in turn, defines the cycle frequency (1x or 2x) of these operations.

Operation	CLKIN Frequency
FLAGX	2Χ
Host (asynchronous)	1 X
ĪRQx	2Х
Master processor	1X
Multiprocessing	1X
SDRAM	2X

Table 12-9. CLKIN frequencies for processor operations

Operation	CLKIN Frequency	
Serial ports	1 X	
Wait states (external memory)	1 X	

Table 12-9. CLKIN frequencies for processor operations (Cont'd)

To enable the on-chip generator, connect CLKIN and XTAL to the necessary external components (for details, see the processor's data sheet). To use 1x clock, connect CLKIN to an external clock oscillator, and leave XTAL unconnected.

Because the on-chip generator's phase-locked loop requires some time to achieve phase lock, CLKIN must be valid for a minimum time period during reset before the application deasserts the RESET signal. For details, see the processor's data sheet.

Input Synchronization Delay

The processor has several asynchronous inputs— $\overline{\text{RESET}}$, $\overline{\text{TRST}}$, $\overline{\text{HBR}}$, $\overline{\text{CS}}$, $\overline{\text{DMAR}}_{2-1}$, and $\overline{\text{IRQ}}_{2-0}$, and, when configured as inputs, PWM_EVENTx and FLAG₁₁₋₀. Applications can assert these inputs in arbitrary phase to the processor clock, CLKIN. The processor synchronizes the inputs before it recognizes them. The delay associated with recognition is called *synchronization delay*.

For the processor to recognize any asynchronous input in a particular cycle, the input must be valid before the recognition phase. If an input does not meet the setup time on a given cycle, the processor may recognize it in the current cycle or during the next cycle (see Table 12-9 for cycle definitions).

So, to ensure recognition of an asynchronous input, make sure your application asserts the input for at least one full processor cycle in addition to the setup and hold time, except for $\overline{\text{RESET}}$, which you must assert for at least four processor cycles. For details, see the processor's data sheet.

External Interrupt and Timer Pins

You can use the processor's external interrupt (\overline{IRQx}) pins, FLAGx pins, and PWM_EVENT pins to send and receive control signals to and from other devices in the system.

The $\overline{\text{IRQ}}_{2-0}$ pins receive hardware interrupt signals. Devices that require the processor to perform some task on demand can generate interrupts. A memory-mapped peripheral, for example, can generate an interrupt to alert the processor that it has data available. For details, see Chapter 3, Program Sequencing.

The PWM_EVENT₁₋₀ timer pins are programmable and function independently in either pulse width generation mode or in pulse count and capture mode. In pulse width generation mode, the timer pins output a modulated waveform with an arbitrary pulse width, and in pulse count and capture mode, they measure the high or low pulse width or period of an input waveform.

Both modes generate timer INT_HIx interrupts, which indicate to other devices that the programmed time period has expired. For details see, Chapter 11, Programmable Timers and I/O Ports.

Flag Pins

The $FLAG_{11-0}$ pins enable single-bit signaling between the processor and other devices. For example, the processor can raise an output flag to interrupt a host

Each flag pin is programmable as either an input or output port. You can condition many processor instructions on a flag's input value to facilitate

efficient communication and synchronization between dual processors or with other interfaces.

All flag pins are bidirectional and have the same functionality. But the control and status bits for $FLAG_{3-0}$ and $FLAG_{11-4}$ are located in different registers.

The control and status bits for $FLAG_{3-0}$ are in the MODE2 register and ASTAT register, respectively. Because both of these registers are universal registers, you can execute the bit wise operations, BIT, BIT TST, CLR, and so on, directly on them.

To program the direction of the $FLAG_{3-0}$ pins, set or clear the control bits in the MODE2 register, as shown in Table 12-10.

Bit	Name	Description
15	FLGOO	FLGOO direction select. O = input 1 = output
16	FLG10	FLG10 direction select. 0 = input 1 = output
17	FLG20	FLG20 direction select. O = input 1 = output
18	FLG30	FLG30 direction select. 0 = input 1 = output

Table 12-10. MODE2 control bits for the FLAG₃₋₀ pins

At reset, the processor clears the MODE2 register, configuring all flags as inputs.

The control and status pins for $FLAG_{11-4}$ are in the IOCTL register and IOSTAT register, respectively. Because both of these registers are IOP registers, you cannot execute the bitwise operations—BIT TST, BIT, CLR, and so on—directly on them. To execute these operations on the $FLAG_{11-4}$ pins, first you must transfer the contents of the flag's status bit in the IOSTAT register to the Register File or to another universal register. (For IOSTAT register bit descriptions, see Appendix E, Control and Status Registers, in *ADSP-21065L SHARC DSP Technical Reference*.)

To program the direction of the $FLAG_{11-4}$ pins, set or clear the control bits in the IOCTL register, as shown in Table 12-11.

Bit	Name	Description
0	FLG40	FLAG40 direction set.
		0 = input
		1 = output
1	FLG50	FLAG50 direction set.
		0 = input
		1 = output
2	FLG60	FLAG60 direction set.
		0 = input
		1 = output
3	FLG70	FLAG70 direction set.
		0 = input
		1 = output

Table 12-11. IOCTL control bits for the FLAG₁₁₋₄ pins

Bit	Name	Description
4	FLG80	FLAG80 direction set. 0 = input
		1 = output
5	FLG90	FLAG90 direction set. O = input 1 = output
6	FLG100	FLAG100 direction set. 0 = input 1 = output
7	FLG110	FLAG110 direction set. 0 = input 1 = output

Table 12-11. IOCTL control bits for the FLAG₁₁₋₄ pins (Cont'd)

At reset, the processor clears the IOCTL register, configuring all flags as inputs.

Flag Inputs

When a flag is programmed as an input, the processor stores its value in a bit in either the ASTAT register or the IOSTAT register, depending on the particular flag ($FLAG_{3-0}$ or $FLAG_{11-4}$).

Each cycle, the processor updates the flag's status bit with the input value of its pin. Since flag inputs can be asynchronous to the processor clock, if the rising edge of the input misses the setup requirement for the cycle, a

Pin Operation

one-cycle delay occurs before a change on the pin appears in either ASTAT or IOSTAT, as shown in Table 12-12.

Register	Bit	Name	Description
ASTAT	19	FLG00	FLAGO value
	20	FLG10	FLAG1 value
	21	FLG20	FLAG2 value
	22	FLG30	FLAG3 value
IOSTAT	0	FLG40	FLAG4 value
	1	FLG50	FLAG5 value
	2	FLG60	FLAG6 value
	3	FLG70	FLAG7 value
	4	FLG80	FLAG8 value
	5	FLG90	FLAG9 value
	6	FLG100	FLAG10 value
	7	FLG110	FLAG11 value

Table 12-12. FLAGxO status bits

When a flag pin is configured as an input, its status bit in ASTAT or IOSTAT is read-only. Otherwise, you can read and write the status bit. You can specify the bit states of the ASTAT and IOSTAT flags as conditions in conditional instructions. For details, see "Flag Pins" on page 12-28.

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When an interrupt service routine pushes ASTAT or IOSTAT onto the status stack, the flag bits in ASTAT and IOSTAT are not affected.

The values of these bits carry over from the main program to the service routine and from the service routine back to the main program (in a pop of the status stack). For details, see "Status Stack Save and Restore" on page 3-48.

Flag Outputs

When a flag is configured as an output, the state of the pin corresponds to the value of the flag's status bit in either the ASTAT or the IOSTAT register.

Your application can set or clear the ASTAT or IOSTAT flag bits to provide a signal to the other processor or to a peripheral. Figure 12-3 on page 12-34 shows the timing of a flag output.



Figure 12-3. Flag output timing

Pushing or popping the ASTAT or IOSTAT register on and off the Status Stack does not change the value of the ASTAT or IOSTAT flag bits.

JTAG Interface Pins

The JTAG test access port consists of the TCK, TMS, TDI, TDO, and TRST pins. For testing purposes, you can connect the JTAG port to a controller that performs a boundary scan. The processor's EZ-ICE Emulator uses this port to access on-chip emulation features. To enable the use of the emulator, you must include a connector for its in-circuit probe in your target system. For details, see the "EZ-ICE Emulator" on page 12-36.

For proper processor operation, your application must assert (pulse or hold low) the JTAG TRST input after power-up. Otherwise, the JTAG port enters an undefined state, which can cause the processor to drive out on the I/O pins rather than put them in a high-impedance state at reset as normal.

You can use a jumper to ground on the EZ-ICE target board connector to hold TRST low. (See Figure 12-4 on page 12-38.)

Do not leave this pin unconnected!

EZ-ICE Emulator

The processor's EZ-ICE Emulator is a development tool for debugging programs running in real time on your ADSP-21065L target system hardware.

By connecting directly to the target processor through its JTAG interface, the EZ-ICE Emulator provides a controlled environment for observing, debugging, and testing activities in a target system.

The EZ-ICE emulator can monitor system behavior while running at full speed. It enables you to examine and alter memory locations and processor registers and stacks.

Controlling the target system's processor through the processor's IEEE 1149.1 JTAG Test Access Port, the EZ-ICE ensures non-intrusive in-circuit emulation. The EZ-ICE emulator does not impact target loading or timing, and its in-circuit probe connects to an IBM PC host computer equipped with an ISA bus plug-in board.

Target systems must have a 14-pin, male connector that accepts the EZ-ICE emulator's in-circuit probe, a 14-pin, female plug.

Target Board Connector for EZ-ICE Probe

The EZ-ICE Emulator uses the processor's IEEE 1149.1 JTAG test access port to monitor and control the target board processor during emulation.

The EZ-ICE probe uses a 14-pin connector (a pin strip header) such as that shown in Figure 12-4 on page 12-38 to provide the target system access to the processor's CLKIN, TMS, TCK, TRST, TDI, TDO, EMU, and GND signals. The EZ-ICE probe plugs directly into this connector for chip-on-board emulation.

If you intend to use the processor's EZ-ICE Emulator, you must add this connector to your target board design. Be sure to provide enough room in your system to plug the EZ-ICE probe into the 14-pin connector. Make the length of the traces between the connector and the processor's JTAG pins as short as possible.

The 14-pin, two-row pin strip header is keyed at the pin 3 location—you must remove pin 3 from the header. Table 12-13 provides the pin dimension and spacing requirements for the pin strip header used to connect to the EZ-ICE probe.

Dimension	Specification
Diameter	0.025 inches
Length	0.20 inches
Spacing between pins	0.1 x 0.1 inches
Clearance above tallest component under probe	0.10 inches

Table 12-13. Pin specifications for pin strip header

Pin strip headers are available from several vendors, such as 3M, McKenzie, and Samtec.



Figure 12-4. Target board connector for EZ-ICE Emulator (jumpers in place)

The BTMS, BTCK, BTRST, and BTDI signals enable you to use the test access port for board-level testing. When not using the connector for emulation, place jumpers between the BXXX pins and their counterpart pins as shown in Figure 12-4.

If you do not intend to use the test access port for board testing, tie $\overline{\text{BTRST}}$ to GND and tie or pull up BTCK to VDD. For proper operation of the processor, your application must assert or hold the $\overline{\text{TRST}}$ pin low after power-up (through $\overline{\text{BTRST}}$ on the connector). None of the BXXX pins (pins 5, 7, 9, 11) are connected on the EZ-ICE probe.

Table 12-14 shows the termination of the JTAG signals on the EZ-ICE probe.
Signal	Termination
TMS	Driven through 22 Ω resistor (16 mA driver)
ТСК	Driven at 10 MHz through 22 Ω resistor (16 mA driver)
TRST	Driven through 22 Ω resistor (16 mA driver) (pulled up by an on-chip 20k Ω resistor)
	Driven low until the EZ-ICE software turns on the EZ-ICE probe. After software start-up, TRST is driven high.
TDI	Driven through 22 Ω resistor (16 mA driver)
TDO	One TTL load, split termination (160/220)
CLKIN	One TTL load, split termination (160/220)
EMU	Active low. 4.7 k Ω pull-up resistor, one TTL load (open drain output from the processor)

Table 12-14. Termination of EZ-ICE signals

Figure 12-5 on page 12-40 shows JTAG scan path connections for systems that contain two processors.



Figure 12-5. JTAG scan path connections for multiprocessor systems

Connecting CLKIN to pin 4 of the EZ-ICE header is optional. The emulator uses CLKIN only when performing synchronous multiprocessor operations, such as starting, stopping, and single-stepping two processors. If you do not need these operations to execute synchronously on both processors, tie pin 4 on the EZ-ICE header to ground.

If you need to execute synchronous multiprocessor operations, and CLKIN is connected, clock skew between both processors and the CLKIN pin on the EZ-ICE header must be minimal. A clock skew that is too large can hold off synchronous operations between processors by one cycle. Since, in this configuration, TCK, TMS, CLKIN (optional), and EMU are critical signals in terms of clock skew, make sure to lay them out as short as possible on your board.

If you do not need to execute synchronous multiprocessor operations, and CLKIN is not connected, use appropriate parallel termination on TCK and TMS. In this configuration, TDI, TDO, and $\overline{\text{TRST}}$ are not critical signals in terms of clock skew.

Input Signal Conditioning

The processor is a CMOS device. It has input conditioning circuits that filter or latch input signals to reduce susceptibility to reflections. This section describes why these circuits are necessary and how they affect input signals.

A typical CMOS input consists of an inverter with specific N and P device sizes that cause a switching point of approximately 1.4V. This level is the selected midpoint of the standard TTL interface specification of V_{IL} =0.8V and V_{IH} =2.0V.

Because the input inverter has a fast response to input signals and external glitches wider than approximately 1 ns, filter circuits and hysteresis are added after the input inverter on some processor inputs.

Hysteresis is used only on the $\overline{\text{RESET}}$ input signal. Hysteresis raises the switching point of the input inverter to slightly above 1.4V for a rising edge and lowers it to slightly below 1.4V for a falling edge. The value of the hysteresis is approximately \pm 0.1V.

Hysteresis is intended to prevent the multiple triggering of signals, which are allowed to rise slowly, as might be expected on a reset line with a delay implemented by an RC input circuit. Hysteresis is not intended to reduce the affect of ringing on input signals with fast edges since the amount of hysteresis allowed on a CMOS chip is too small to make much difference. The tolerance of the V_{IL} and V_{IH} TTL input levels under worst case conditions limits the amount of hysteresis. For exact specifications, see the processor's data sheet.

High Frequency Design Issues

Because the processor can operate at very fast clock frequencies, designers must consider signal integrity and noise problems when designing and laying out a circuit board. The following sections discuss these topics and suggest various techniques to use when designing and debugging systems.

Clock Specifications and Jitter

The clock signal must be free of ringing and jitter. Clock jitter is easily introduced into a system in which more than one clock frequency exists (Figure 12-6). Since high frequency jitter on the clock to the processor can result in abbreviated internal cycles, make sure to keep the jitter to less than 0.5 ns for a \leq 33 MHz clock.

Never share a clock buffer IC with a signal of a different clock frequency. Doing so introduces excessive jitter.



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Figure 12-6. Clock with two frequency inputs

Keep system components that operate at different frequencies separated physically at distances as far as possible.

The clock supplied to the processor must have a rise time of ≤ 3 ns and meet or exceed a high and low voltage of 2.0V and 0.4V, respectively.

Clock Distribution

Multiprocessor systems must maintain low clock skew between both processors when they are communicating synchronously over the external bus. Make sure you route the clock in a controlled-impedance transmission line that is properly terminated either at the end of the line (see Figure 12-7) or at the source (see Figure 12-8 on page 12-44).

• *End-of-line termination* is appropriate only when the distance between the processors is very small. This is so because devices that are at a different wire distance from each other on a printed circuit board (PCB) transmission line will receive a skewed clock. This condition is called the *propagation delay*. The typical propagation delay of a PCB transmission line is 5 to 6 inches/ns.



Figure 12-7. End-of-line termination clock distribution method

• For *source termination*, Figure 12-8 on page 12-44 shows an example of series-terminated transmission lines for clock distribution. This configuration enables identical delays in each path.



Figure 12-8. Source termination clock distribution method

When using source termination, make sure you follow these guidelines:

• Connect each device at the end of the transmission line.

The end of the line is the only point where the signal has a single transition.

- Route the traces so that the delay through each matches the others.
- When using a line impedance higher than 50Ω , keep clock signal traces in the PCB layer closest to the ground plane, so delays remain stable and crosstalk low.
- When placing more than one device at the end of the line, keep the wire length between them short and their impedance (capacitance) high.
- Place the matched inverters in the same IC and specify them for a low skew (<1 ns) with respect to each other.

Specify this skew as small as possible since it subtracts from the margin on most specifications.

Point-to-Point Connections on Serial Ports

Although you can operate the processor's serial ports at a slow rate, the output drivers still have fast edge rates and, for longer distances, might require source termination.

You can add a series termination resistor near the pin for point-to-point connections. Typically, serial port applications use this termination method when distances are greater than six inches. For details, see the processor's data sheet. For more information on transmission line termination, see "Recommended Reading" on page 12-47.

Signal Integrity

We recommend that you try to reduce the capacitive loading on high-speed signals as much as possible. Using a buffer for devices that operate with wait states, you can reduce the load on buses. This in turn reduces the capacitance on signals tied to zero-wait-state devices, allowing these signals to switch faster with fewer noise-producing current spikes.

To reduce ringing, minimize the signal run length (inductance). Take extra care with certain signals, such as the read and write strobes ($\overline{\text{RD}}$, $\overline{\text{WR}}$) and acknowledge (ACK). In a multiprocessor system, since each processor can drive the read or write strobes, we recommend that you add some damping resistance in the signal path if the line length is greater than six inches. Doing so, however, will incur additional signal delay. Make sure you carefully analyze the time budget for these signals.

Other Recommendations and Suggestions

• Use more than one ground plane on the PCB to reduce crosstalk.

Be sure to use lots of vias between the ground planes. One VDD plane is sufficient. Place these planes in the center of the PCB.

High Frequency Design Issues

• To reduce crosstalk, keep critical signals such as clocks, strobes, and bus requests on a signal layer next to a ground plane and away from or perpendicular to other non-critical signals.

For example, data outputs switch at the same time that the processor samples \overline{BRx} inputs. If your layout permits crosstalk between them, your system could have problems with bus arbitration.

- If possible, position the processors on both sides of the board to reduce area and distances.
- Lower transmission line impedances reduce crosstalk and provide better control of impedance and delay.
- Experiment with the board and isolate crosstalk and noise issues from reflection issues.

To do so, drive a signal wire from a pulse generator and study the reflections while other components and signals are passive.

Decoupling Capacitors and Ground Planes

Use planes for the ground and power supplies.

We recommend that you use a minimum of eight bypass capacitors (0.02 μ F ceramic), placed very close to the V_{DD} pins of the package (see Figure 12-9 on page 12-47). Use short and fat traces for this. Tie the ground end of the capacitors directly to the ground plane. Tie the positive (+) end of each capacitor directly to the power plane, as near as possible to the processor's VDD pins. We recommend a surface-mount capacitor because of its lower series inductance.

Connect the power plane to the power supply pins directly, with minimum trace length. To avoid reducing their effectiveness, make sure the ground planes are not densely perforated with vias or traces. In addition, populate the board with several large tantalum capacitors.



Figure 12-9. Bypass capacitor placement

Oscilloscope Probes

When making high-speed measurements, use a "bayonet" or similarly short (< 0.5 inch) ground clip attached to the tip of the oscilloscope probe. Use a low-capacitance active probe with 3 pF or less of loading. If you use a standard ground clip with four inches of ground lead, you will see ringing on the displayed trace and the signal will appear to have excessive overshoot and undershoot. To see signals accurately, you need a 1 GHz or better sampling oscilloscope.

Recommended Reading

For further reading, we recommend the following books. These books are technical references that cover the problems encountered in state-of-the-art, high-frequency digital circuit design, and are excellent sources of practical ideas for problem solving.

Buchanan, James E. Signal and Power Integrity in Digital Systems; TTL, CMOS, & BICMOS. McGraw-Hill. ISBN 0-07-008734-2

Johnson and Graham. *High-Speed Digital Design: A Handbook of Black Magic*. Prentice Hall, Inc. ISBN 0-13-395724-1

High Frequency Design Issues

These books cover these topics:

- High-Speed properties of logic gates
- Measurement techniques
- Transmission lines
- Ground planes and layer stacking
- Terminations
- Vias
- Power systems
- Connectors
- Ribbon cables
- Clock Distribution
- Clock Oscillators

Booting

You can automatically download programs to the processor's internal memory after power-up or after a software reset. This process is called *booting*.

The processor supports these boot modes:

• EPROM boot mode

The processor reads data from an 8-bit external EPROM through the external port.

• Host boot mode

The processor accepts data from an 8-, 16-, or 32-bit host microprocessor or other external device.

The processor also has a no boot mode. In this mode, the processor starts executing instructions from address 0x0002 0004 in external memory.

Each boot mode packs boot data into 48-bit instructions and uses DMA channel 8 to transfer the instructions to internal memory.

You use the primary configuration of DMA channel 8 (and EPB0) for EPROM and host booting. The DMAC0 control register is specially initialized for booting in each case.

With either boot method, after the boot process loads 256 words into memory locations 0x8000 through 0x80FF, the processor begins executing instructions. Because most applications require more than 256 words of instructions and initialization data, these 256 words typically serve as a loading routine for the application. Analog Devices supplies a loading routine (Loader Kernel) that can load an entire program. This routine comes with the development tools. For details, see the documentation for the development tools.

Selecting the Boot Mode

Used in conjunction, the \overline{BMS} and BSEL pins select the processor's boot mode as shown in Table 12-15 and Table 12-16.

Pin	Туре	Description			
BMS	I/0/Z ¹	Boot Memory Select mode.			
		 When BSEL is low, BMS is an input pin, and it selects between Host boot mode and Nonboot mode (the processor executes from external memory). 			
		For No boot mode, connect \overline{BMS} to ground.			
		For Host boot mode, connect \overline{BMS} to VDD.			
		 When BSEL is high, BMS is an output pin, and the processor starts up in EPROM boot mode. 			
		Connect BMS to the EPROM's chip select.			
BSEL	Ι	EPROM Boot Select mode.			
		Because this signal is a system configuration selection, we recommend that you hardwire it.			
		 When BSEL is high, the processor starts up in EPROM boot mode. 			
		The processor assumes the EPROM's data bus is 8-bits wide.			
		Connect BSEL to the processor's data bus in LSB alignment.			
		 When BSEL is low, BMS determines the booting mode. 			
		Connect BSEL to ground.			

Table 12-15. Boot mode pins

¹ Hi-Z only in EPROM boot mode, when pin is an output.

BSEL	BMS	Description				
0	0	No boot mode.				
		The processor executes from external memory at location 0x20004.				
0	1	Host boot mode.				
		The processor defaults to an 8-bit host bus width.				
1	output	EPROM boot mode.				
		The processor assumes an 8-bit EPROM data bus width.				
		Connect to the data bus in LSB alignment.				

Table 12-16. Boot mode pin configurations

For either of the power-up boot modes, the processor does not execute the instruction at address 0×0000 8004 during the boot sequence. So, make sure your application does not use that address for loading the kernel.

EPROM Booting

Setting the BSEL input high and the \overline{BMS} input low selects EPROM booting through the external port.

You must connect the byte-wide boot EPROM to $DATA_{7-0}$. Connect the lowest address pins of the processor to the EPROM's address lines. Connect the EPROM's chip select to \overline{BMS} and its output enable to \overline{RD} .

In a multiprocessor system, only the master processor drives the \overline{BMS} output. This enables you to wire-OR both \overline{BMS} signals for a single, common boot EPROM.

You can boot both processor's from a single EPROM, using the same code or different code for each processor.

Booting

During reset, a 2 k Ω equivalent resistor pulls the processor's ACK line high internally, and an internal keeper latch holds it high. So, you do not need to use an external pull-up resistor on the ACK line at any time.

Bootstraping (256 instructions)

In EPROM boot mode, the external port DMA channel 8 (DMAC0) becomes active following reset.

DMAC0 initializes to 0x02A1 to:

- Enable external port DMA.
- Select DTYPE for instruction words.
- Ignore packing mode bits (PMODE) and force 8-to-48 bit packing with least-significant-word first.

The RBWS and RBWM fields of the WAIT register initialize to generate six wait states (seven cycles total) for the EPROM access in external memory. (Wait states defined for external memory banks are applied to BMS-asserted accesses.)

The RBWM field's initial value selects internal wait and external acknowledge. Initially, the processor asserts ACK (high), but if another device drives ACK low during EPROM boot, the processor could latch ACK low. The processor responds to the deasserted (low) ACK as a hold off from the EPROM, inserting wait states continually and preventing completion of the EPROM boot. To avoid this type of boot hold off, set the value of RBWM in the WAIT register to internal wait mode (01) early in the 256 word boot process.

Table 12-17 on page 12-53 shows how the parameter registers for DMAC0 initialize at reset for EPROM booting. The count register (CEP0) initializes to 0×0100 for transferring 256 words to internal memory. The external count register (ECEP0), which the DMA controller uses

to generate external addresses, initializes to 0×0600 (that is, 0×0100 words with six bytes per word).

Register	Initialization Value
ΙΙΕΡΟ	0x0000 8000
IMEPO	Uninitialized. Value increments +1 automatically
CEPO	0x0100 (256 instruction words)
СРЕРО	Unintialized
GPEPO	Unintialized
EIEPO	0×8000 0000
EMEPO	Uninitialized. Value increments +1 automatically
ECEPO	0x0600 (256 words × 6 bytes/word)

Table 12-17. DMAC0 parameter register initialization

At system start-up, when the processor's RESET input goes inactive, the following sequence occurs:

1. The processor goes into an idle state identical to that initiated by the IDLE instruction.

The processor sets the program counter (PC) to address 0x0000 8004.

- 2. The DMA parameter registers for DMA channel 8 initialize to the values in Table 12-17).
- 3. BMS becomes the boot EPROM chip select.
- 4. Eight-bit master mode DMA transfers from EPROM to internal memory begin on the external port data (EPD) lines 7:0.

Booting

- 5. The external address lines (ADDR₂₃₋₀) start at 0×000000 and increment after each access.
- 6. The $\overline{\text{RD}}$ strobe asserts the same as in normal memory accesses, with six wait states (seven cycles).

The processor's DMA controller continues to read the 8-bit EPROM words, pack them into 48-bit instruction words, and transfer them to internal memory, until it has loaded 256 words. The BMS pin automatically selects the EPROM, and the processor disables the other memory select pins. The DMA external count register (ECEP0) decrements after each EPROM transfer.

When ECEP0 reaches zero (0), the processor:

- 1. Stops DMA transfers.
- 2. Activates the external port DMA channel 8 interrupt (EP0I).
- 3. Deactivates BMS and activates normal external memory selects.
- 4. Vectors to the EP0I interrupt vector at 0x0000 8040.

At this point, the processor has completed its boot sequence and is executing instructions normally.

Make sure the first instruction at the EP0I interrupt vector location, address $0 \times 0000 8040$, is an RTI (Return from Interrupt). This instruction returns execution to the reset routine at location $0 \times 0000 8005$, where normal program execution can resume. After this, your application can write a different service routine at the EP0I vector location $0 \times 0000 8040$.

Remember, for either of the power-up boot modes, the processor does not execute the instruction at address 0×0000 8004 during the boot sequence. So, make sure your application does not use that address for loading the kernel.

Loading the Remaining EPROM Data

The EPROM boot mode only loads 256 instructions during bootstraping. If you must load your entire application into internal memory from the EPROM, the processor must access the boot EPROM after bootstraping has finished. To do so, you use the BSO (Boot Select Override) bit in the SYSCON register.

Setting BS0=1 overrides the external memory selects and asserts the \overline{BMS} pin for an external port DMA transfer. Code your bootstrap program to set the BSO bit in SYSCON first and then set up an external port DMA channel to read the rest of the EPROM's contents.

Setting BS0=1 disables the PMODE packing mode bits in the DMAC0 (DMA channel 8) control register and forces 8-to-48 bit packing for reads. (Except for host transfers, eight-bit packing is available only during EPROM booting or on DMA reads when BS0=1.) While one external port DMA channel is operating with BS0=1, you cannot use the other external port DMA channel for non-BMS accesses.

When BSO=1, only a DMA transfer, not an access by the processor's core, asserts \overline{BMS} . So, your bootstrap program, if it is running on the processor's core, can perform other external accesses to nonboot memory.

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With BSO=1, you can also use external port DMA channel 9 for DMA reads or writes. With DMA channel 9, you can use any of the PMODE bit modes, but not 8-bit packing. DMA channel 9 provides a way to boot from a wider (16- or 32-bit) ROM for a faster boot, but this requires a custom loader kernel.

Writing to BMS Memory Space

You can also write to processor's \overline{BMS} space using the boot select override (BSO mode). The BSO bit in the SYSCON register enables software to assert the \overline{BMS} pin. In many systems, applications may need to update or modify the boot data. In such systems, a writable EEPROM or FLASH memory may substitute for the EPROM.

To write to memory with the <u>BMS</u> line asserted, use DMA channel 9, not DMA channel 8. With BS0=1, use DMA channel 8 only for reads. This access limitation occurs because DMA channel 8 is hardwired for a special 8-bit boot read mode. When BS0=1, a write with DMA channel 8 results in illegal chip operation.

When BSO=1, you can use DMA channel 9 with any of the modes available in the DMACx register for reads or writes, with any packing mode, and with any data or instructions. Because BMS space is 8-bits wide and no 8-bit packing mode is available for these writes, you must use the Shifter to place data in the correct location for each write.

Booting From the Host

Booting the processor from a 8-bit host occurs over the external port's data and address buses. The processor's BSEL and \overline{BMS} pin select between EPROM booting and host booting. For host booting, BSEL must be low and \overline{BMS} high.

Configured for host booting, the processor enters slave mode after reset and waits for the host to download the boot program.

After reset, the processor goes into an idle state identical to that initiated by the IDLE instruction, with the program counter (PC) set to address 0×0000 8004. The parameter registers for external port DMA channel 8 initialize as shown in Table 12-18 on page 12-57, but no DMA transfers start. DMAC0 initializes to 0x00A1, to:

- Enable external port DMA.
- Select DTYPE for instruction words.
- Set PMODE for 8-to-48 bit word packing.
- Select least-significant-word first format.

Because the host is accessing the EPB0 external port buffer, you must set the HBW (host bus width) bits in the SYSCON register and the PMODE bits in the DMAC0 control register (for details see, "Data Packing" on page 8-24). To change the packing mode, the host must write to DMAC0 to change the PMODE bit. It must write four 8-bit words to the SYSCON register to change the HBW bit values.

Register	Initialization Value
ΙΙΕΡΟ	0x0000 8000
IMEPO	Uninitialized. Value incremented +1 automatically
CEPO	0x0100 (256 instruction words)
СРЕРО	Unintialized
GPEPO	Unintialized
EIEPO	Unintialized
EMEPO	Uninitialized
ECEPO	Uninitialized

Table 12-18. Initialization values of DMAC0 parameter registers for host booting

The host asserts the processor's $\overline{\text{HBR}}$ input to initiate the boot operation. After the host receives the $\overline{\text{HBG}}$ signal from the processor, it can perform one of two actions:

- Write directly to EPB0, the external port DMA buffer 0 (which corresponds to DMA channel 8) to start downloading instructions.
- Write to any of the IOP control registers to change the processor's reset initialization conditions. To do so, the host must use DATA₇₋₀ or, if HBW is configured for a 16-bit host, DATA₁₅₋₀.

When the processor's DMA controller has downloaded 256 instructions, the processor:

- 1. Stops DMA transfers.
- 2. Activates the external port DMA channel 8 interrupt (EP0I).
- 3. Vectors to the EP0I interrupt vector at 0x0000 8040.

Make sure the first instruction at the EP0I interrupt vector location, address $0 \times 0000 \ 8040$, is an RTI (Return from Interrupt). RTI returns execution to the reset routine at location $0 \times 0000 \ 8005$ to resume normal program execution. After that, your application can write a different service routine at the EP0I vector location $0 \times 0000 \ 8040$. These 256 instructions must load the rest of your program.

Because only external port DMA channel 8 has its IMASK bit set to enable a DMA done interrupt, you must use this channel for the initial instruction download.

Multiprocessor Booting

You can boot multiprocessor systems from a host or from an external EPROM.

Multiprocessor Host Booting

To boot two processors from a host, you must configure each processor's BSEL and \overline{BMS} pins for host booting: BSEL = 0 and \overline{BMS} = 1

After system power-up, each processor is in the idle state, and the \overline{BRx} bus request lines are high. To boot each processor, the host must assert the \overline{HBR} input, assert each processor's \overline{CS} pin, and download instructions as described in "Booting From the Host" on page 12-56.

Multiprocessor EPROM Booting

In a multiprocessor system, to boot sequentially from one EPROM, both processors:

- Arbitrate for the bus.
- DMA transfer the 256 word boot stream after becoming bus master.
- Release the bus.
- Execute the loaded instructions.

To drive the chip select pin of the EPROM, you can wire-OR together the \overline{BMS} signals from both processors. The processors can boot in turn, according to their priority. The last one to finish booting must inform the other (which may be in the idle state) that program execution can begin (if both processors intend to start executing instructions simultaneously).

Booting



Figure 12-10 shows an example system that uses this *processors-take-turns* technique.

Figure 12-10. Two processors booting from one EPROM

When two processors boot from one EPROM, they can boot with either identical code or with different code. If the processors load different code, your application can use a jump table (based on processor ID) to select the code for each processor.

No Boot Mode

In no boot mode, the processor starts fetching and executing instructions at address 0×0002 0004 in external memory space.

For no boot mode, set BSEL=0, $\overline{BMS}=0$, and all DMA control and parameter registers to their default initialization values. For details on data packing, see "Data Packing" on page 8-24.

Locating the Interrupt Vector Table

If the processor boots externally from an EPROM or from the host, the interrupt vector table is located in internal memory space. If the processor does not boot, but executes from external memory, the vector table must be located in the external memory space.

You can use the IIVT bit in the SYSCON register to override the location of the interrupt vector table when the processor is configured for no boot mode:

IIVT=0	Located in external memory at 0x0002	0000
IIVT=1	Located in internal memory at 0x0000	8000

If the processor boots from an external source (any mode other than no boot mode), IIVT has no effect.

IIVT defaults to zero (0).

Data Delays, Latencies, and Throughput

Table 12-19 specifies, in number of 2xCLKIN cycles, data delays and throughput for the processor, excluding SDRAM operations. Table 12-20 on page 12-64 specifies, in number of 2xCLKIN cycles, data delays and throughput for SDRAM operations. Table 12-21 on page 12-65 specifies, in number of 2xCLKIN cycles, latencies and throughputs for the processor.

Data delay and latency are the number of 2xCLKIN cycles (after the first cycle) required to complete an operation. So, a zero-wait-state memory has a data delay of zero (0) cycles, and a single-wait-state memory has a data delay of one (1) cycle.

Throughput is the maximum rate in 2xCLKIN cycles at which the processor performs an operation. Data delay and throughput are the same whether the access is from a host or from another processor.

Operation	Min. Delay	Max. Throughput
Core accesses to external memory space	0	2
Syn. accesses to slave's IOP registers ¹ Read (transfer out) Write (transfer in)	0 4 ^{2,3}	4 2
Slave mode DMA transfers		
Read (transfer out) Write (transfer in)	_	4 ⁴ 2

Table 12-19. Data delays and throughputs

Operation	Min. Delay	Max. Throughput
Master mode DMA transfers		
Read (transfer out)	_	2
Write (transfer in)	_	2
Handshake mode DMA transfers ⁵ in/out	6	2
Ext. handshake mode DMA transfers ⁶ in/out	6	2

Table 12-19. Data delays and throughputs (Cont'd)

¹ If MSWS (multiprocessor memory space wait states) is enabled, add 2 cycles to the throughput of synchronous writes to multiprocessor memory space.

- ² Delay is between data in the IOP register and at the external port (the write to the IOP register occurs in the 2nd cycle after the write to the eternal port finished).
- ³ For asynchronous accesses, add 2 cycles.
- ⁴ The speed of these transfers is limited by the read of the slave's DMA FIFO buffer.
- ⁵ Delay is between DMA data and $\overline{\text{DMAR}}x$.
- 6 Delay is between $\overline{\text{DMAR}}$ and the external transfer.

For a \overline{CAS} latency of 2 cycles (SDCL=2), no SDRAM buffering (SDBUF=0), a RAS precharge (t_{RP}) of 2 cycles (SDTRP=2), and an active command time (t_{RAS}) of 3 cycles (SDTRP=3), Table 12-20 on page 12-64 shows the throughput for SDRAM operations.

Data Delays, Latencies, and Throughput

Table 12-20. SDRAM throughput for core and DMA read/write operations

Accesses	Operations	Page	Throughput per 2xCLKIN (32-bit words) ¹ , ²
Sequential, uninterrupted	Read	Same	1 word/1 cycle
Sequential, uninterrupted	Write	Same	1 word/1 cycle
Nonsequential, uninterrupted	Read	Same	1 word/4 cycles (CL+2)
Nonsequential, uninterrupted	Write	Same	1 word/1 cycle
Both	Alternating read/write	Same	Average rate = 2.5 cycles per word (reads = 4 cycles; writes = 1 cycle)
Nonsequential	Reads	Different	1 word/8 cycles (t _{RP} +2CL+2)
Nonsequential	Writes	Different	1 word/5 cycles (t _{RP} +CL+1)
Autorefresh before read	Reads	Different	1 word/13 cycles (2t _{RP} +t _{RAS} +2CL+2)
Autorefresh before write	Writes	Different	1 word/10 cycles (2t _{RP} +t _{RAS} +CL+1)
$CL = \overline{CAS}$ latency; t_{RAS} = Active to precharge time; t_{RP} = Precharge time			

¹ For 48-bit words, add one clock cycle to the throughput value or the average access rate.

² For SDRAM buffering enabled (SDBUF=1), replace any instance of (CL) with (CL+1)..

Operation	Min. Latency	Max. Throughput
Interrupts (IRQ ₂₋₀)	3	NA
Multiprocessor bus requests ($\overline{\mathrm{BR}}_{2\text{-}1}$)	2	NA
Host bus request (HBR)	2	NA
SYSCON effect latency	1	NA
Host packing status update (SYSTAT)	0	NA
DMA packing status update (DMACx)	1	NA
DMA chain initialization	7 - 11	NA
Vector interrupt (VIRPT)	6	NA
Serial ports ¹	70	64

Table 12-21. Latencies and throughputs

¹ 32-bit words, processor core to processor core.

Execution Stalls

Table 12-22 lists the events that can stall program execution in the processor's core and the length of the stall in number of 2xCLKIN cycles.

Component	Cycles	Cause
DAGs	1	Register conflict
DMA	1	Accessing a DMA parameter register dur- ing DMA address generation. For example, writing to the register during a regis- ter update, or reading
	1	Accessing a DMA parameter register dur- ing DMA chaining.
	n	Writing/reading a DMA buffer that is full/empty.
IOP Registers	n	Both PM and DM buses accessing IOP reg- isters. Both must complete their access.
	n	Conflict with slave access.

Table 12-22.	Events the	hat cause	core com	ponents t	o stall
				P	

Component	Cycles	Cause
Memory	1	Both the PM and DM data buses accessing the same block of internal memory.
	n	Conflicting accesses of external memory. Stalls until the PM and DM buses com- plete their accesses.
	n	Accesses to external memory. Stalls until the I/O buffers are cleared.
	n	External accesses when the processor does not own the external bus.
	n	External accesses. Stalls until access finishes (wait states, idle cycles, …)
Program Sequencer	1	Accesses of program data memory with cache miss.
	2	Nondelayed branches.
	2	Normal interrupts.
	5	Vector interrupt (VIRPT)
	1	Short loops with small iterations.
	n	IDLE instruction.

Table 12-22. Events that cause core components to stall (Cont'd)

Execution Stalls

13 PROGRAMMING CONSIDERATIONS

This chapter summarizes important information to keep in mind when you write application software for the ADSP-21065L.

Extra Cycle Conditions

All instructions can execute in a single cycle but may take longer under certain conditions:

- Nondelayed branches
- Accesses of program memory data with cache miss
- Loop accesses of program memory data
- Execution of one- and two-instruction loops
- Writes to DAG registers
- Wait state programming

Nondelayed Branches

A nondelayed branch instruction (JUMP, CALL, RTS or RTI) fetches but does not execute the next two instructions. The processor aborts execution of the next two instructions and executes two NOPs instead.

To avoid this two-cycle delay, your application can use a delayed branch, which executes the next two instructions after it before the branch operation actually occurs. In this case, because the processor executes the two extra instructions before taking the branch, program flow deviates from the apparent order of operations.

For details, see Chapter 3, Program Sequencing.

Program Memory Data Accesses with Cache Miss

The processor checks the instruction cache on every program memory data access. If the needed instruction is in the cache, the fetch from the cache occurs in parallel with the PM bus data access, and the instruction executes in a single cycle. However, if the Program Sequencer does not cache the instruction, the processor must wait for the PM bus data access to finish before it can fetch the next instruction. This results in a minimum delay of one cycle. However, a PM bus data access that uses external memory with wait states can increase this delay. This delay occurs even if the PM bus data access is based on a conditional that evaluates to false.

For details, see Chapter 3, Program Sequencing.

Loop Accesses of Program Memory Data

During the execution of a PM bus data access, the processor caches an instruction that it needs to fetch. Because of the execution pipeline, this instruction is usually two memory locations after the PM bus data access. If the PM bus data access is in a loop, a cache miss usually occurs on the first iteration of the loop, and cache hits occur on subsequent iterations. This results in one extra cycle during execution of the loop.

However, certain cases require fetching different instructions from the cache during different iterations. In these cases, the number of cache misses, and therefore the number of extra cycles, increases. Table 13-1 on page 13-3 lists these special cases. The values listed in this table are based on the worst-case scenario, so actual performance of the cache for a given application may be higher.

Misses	# Instructions	Address of PM Data Access		
0	>2	Not at eor (e -1)		
1	≥2	At e or (e -1)		
2	1	At the single loop location		
e = loop end address				

Table 13-1. Cases that increase cache misses and extra cycles

Two Misses. If the program memory data access occurs in the last two instructions of a loop, a cache miss always occurs on the first and last iterations of the loop to add two extra cycles.

On the first iteration, the processor needs to fetch the first or second instruction from the top of the loop.

On the last iteration, the processor needs to fetch one of the two instructions following the loop.

At each of these points, a cache miss occurs the first time the code containing the loop executes.

Three Misses. If a loop contains only one instruction, and that instruction requires a PM bus data access, three cache misses can occur.

On the first iteration, if the loop iterates three times or more, the processor needs to fetch the loop instruction again.

On the next-to-last iteration, the processor needs to fetch the next instruction after the loop.

On the last instruction, the processor needs to fetch the second instruction after the loop.

In each case, a cache miss occurs the first time the code containing the loop executes.

For details, see Chapter 3, Program Sequencing.

Using One- and Two-Instruction Loops

Counter-based loops that have only one or two instructions can cause delays if they do not execute a minimum number of times. The processor checks the termination condition two cycles before it exits the loop. In short loops, the processor has already looped back when it tests the termination condition. So, if the termination condition tests true, the processor must abort the two instructions in the pipeline and execute NOPs instead.

Specifically, executing a one-instruction loop one or two times or executing a two-instruction loop only once incurs two cycles of overhead because both loops result in two aborted instructions after the last iteration. These overhead cycles are additional to extra cycles that a PM bus data access inside the loop generates. To avoid this kind of overhead, use straight-line code instead of loops.

For details, see Chapter 3, Program Sequencing.

Writing to a DAG Register

When an instruction that uses any register in a DAG for data addressing, modifying instructions, or indirectly jumping follows an instruction that writes to the same DAG register, the processor inserts a NOP cycle between the two instructions. It does so because both operations need the same bus in the same cycle, and it must delay the second operation. For example:

```
L2=8;
DM(I0,M1)=R1;
```

Because L2 is in the same DAG as I0 (and M1), the processor inserts an extra cycle after the write to L2.

For details, see Chapter 4, Data Addressing.

Programming Wait States

You can program an external memory access to include a specific number of wait states and bus idle cycles and to wait for an external ACK signal before completing the access.

If you program internal wait states and bus idle cycles only, the length of the delay is exactly the number of wait states and bus idle cycles (1 wait state = 1 cycle).

If you program the external ACK signal, either alone or in combination with programmed wait states, the length of the delay varies depending on the external system.

For details, see Chapter 5, Memory.

Component Considerations

Other programming considerations include operations that interact with specific processor components:

- Computation units
- Data Address Generators
- Memory

Computation Units

For detailed information on the processor's computation units, see Chapter 2, Computation Units. Programming considerations include:

- Compute operations
- Restrictions on delayed branching
- Writing twice to the same location in the Register File

Compute Operations

In fixed-point to floating-point conversion, the rounding boundary is always 40 bits even if the RND32 bit is set.

The ALU Zero flag (AZ) signifies floating-point underflow as well as a zero result.

Transfers between MR registers and the Register File are considered multiplier operations. For details, see Appendix E, Control and Status Registers, in *ADSP-21065L SHARC DSP Technical Reference*.
Restrictions on Delayed Branching

The processor executes sequentially a delayed branch instruction and the next two consecutive instructions. The processor delays servicing any interrupt that occurs between a delayed branch instruction and either of the next two consecutive instructions until it completes the branch.

You can use delayed branching with the JUMP, CALL, RTS, and RTI instructions with some restrictions.

For delayed JUMPs, you cannot use these instructions in the two locations immediately following the jump:

- Other JUMP, CALL, RTS, or RTI instructions
- DO UNTIL

For delayed CALL, RTS, or RTI operations, you cannot use these instructions in the two locations immediately following the CALL, RTS, or RTI instruction:

- Other JUMP, CALL, RTS, or RTI instructions
- DO UNTIL
- Pushes and pops of the PC stack
- Writes to the PC stack or PC stack pointer

Writing Twice to the Same Location in the Register File

If two writes to the same Register File location take place in the same cycle, only the write with higher precedence actually occurs. The source of the write data determines the precedence of the writer operation.

Component Considerations

From highest to lowest, the order of precedence is:

- Data memory (DM bus) or universal register
- Program memory (PM bus)
- ALU
- Multiplier
- Shifter

Data Address Generators

For detailed information on the processor's data address generators (DAGs), see Chapter 4, Data Addressing. Programming considerations include:

- Illegal DAG register transfers
- Initializing circular buffers

Illegal DAG Register Transfers

The following instructions execute, but cause incorrect results. The assembler does not support these instructions:

• An instruction that stores a DAG register in memory using indirect addressing from the same DAG, with or without updating the index register (I).

In this case, the instruction writes the wrong data to memory or updates the wrong index register.

DM(M2,I1)=I0; or DM(I1,M2)=I0;

• An instruction that loads a DAG register from memory using indirect addressing from the same DAG and updates the I index register.

In this case, the instruction either loads the DAG register or updates the index register, but not both.

L2=DM(I1,M0);

Initializing Circular Buffers

To set up a circular buffer, you initialize an L register with a positive, nonzero value and load the corresponding (same-numbered) B register with the base address of the buffer.

The base address, or starting address, is the lowest address of the buffer.

The processor automatically loads the corresponding I (index) register with the same starting address.

Memory

For detailed information on the processor's on-chip SRAM memory, see Chapter 5, Memory. Programming considerations include:

- Mixing 32- and 48-bit words in one memory block
- Performing dual data accesses
- Reading 16-bit short words
- Restrictions on memory access space

Performing Dual Data Accesses

The processor's PM and DM buses enable the processor's core to simultaneously access instructions and data from both memory blocks. The processor's core fetches instructions over the PM bus or from the instruction cache. The core can access data over both the DM bus (using DAG1) and the PM bus (using DAG2).

You can configure the processor's two memory blocks to store different combinations of 48-bit instruction words and 32-bit data words. To achieve maximum efficiency (single-cycle execution of dual-data-access instructions), however, configure one block to contain a mix of instructions and PM bus data and configure the other block to contain DM bus data only.

Reading 16-Bit Short Words

The processor automatically extends short words read into universal registers into 32-bit integers. Depending on the value of the SSE bit in the MODE1 register, the processor either zero-fills or sign-extends the upper sixteen bits of the 32-bit integer.

Restrictions on Memory Access Space

With a few limitations, you can use the processor's three internal buses, PM, DM, and I/O to access the processor's memory map:

- The DM bus can access all memory spaces.
- The PM bus can access internal memory space and the lowest 15.75 megawords of external memory space only.
- The I/O bus can access all memory spaces except the memory-mapped IOP registers in internal memory space.

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